



# TMS570LS3137-EP 16 位和 32 位 RISC 闪存微控制器

## 1 器件概述

### 1.1 特性

- 用于安全关键型应用的高性能微控制器
  - 运行在锁步中的双中央处理单元 (CPU)
  - 闪存和 RAM 接口上的 ECC
  - 内置 CPU 和片上 RAM 自检
  - 带有错误引脚的错误信令模块
  - 电压和时钟监视
- ARM® Cortex™ – R4F 32 位 RISC CPU
  - 带有 8 级管线的高效 1.66DMIPS/MHz
  - 支持单精度和双精度的浮点运算单元 (FPU)
  - 12 区域内存保护单元
  - 带有第三方支持的开放式架构
- 运行条件
  - 高达 180MHz 系统时钟
  - 内核电源电压 (VCC): 标称值 1.2V
  - I/O 电源电压 (VCCIO): 标称值 3.3V
  - ADC 电源电压 (V<sub>CCAD</sub>): 3.0 至 5.25V
  - 采用 IP 模块门级设计, 工作温度范围为 -40°C 至 125°C, 仅包含闪存, MibADC 定时器, nPORRST、N2HET 和 FlexRay
- 集成存储器
  - 支持 ECC 的 3MB 程序闪存
  - 256KB 且支持 ECC 的 RAM
  - 支持 ECC、用于仿真 EERPOM 的 64KB 闪存
- 16 位外部存储器接口
- 通用平台架构
  - 系列间一致的存储器映射
  - 实时中断定时器 (RTI) 操作系统 (OS) 定时器
  - 96 通道矢量中断模块 (VIM)
  - 2 通道循环冗余校验器 (CRC)
- 直接内存访问 (DMA) 控制器
  - 16 通道和 32 控制数据包
  - 针对控制数据包 RAM 的奇偶校验保护
  - 由专用 MPU 保护的 DMA 访问
- 带有内置跳周检测器的调频锁相环 (FMPPLL)
- 独立的非调制 PLL
- IEEE 1149.1 JTAG, 边界扫描和 ARM CoreSight™ 组件
- JTAG 安全模块
- 跟踪和校准功能
  - 嵌入式跟踪宏单元 (ETM-R4)
  - 数据修改模块 (DMM)
  - RAM 跟踪端口 (RTP)
  - 参数覆盖模块 (POM)
- 多通信接口
  - 10/100Mbps 以太网 MAC (EMAC)
    - 符合 IEEE 802.3 标准 (只适用于 3.3V I/O)
    - 支持媒介独立接口 (MII), 精简媒介独立接口 (RMII) 和管理数据输入输出 (MDIO)
  - 带有 2 个通道的 FlexRay 控制器
    - 带有奇偶检验保护的 8KB 消息 RAM
    - 专用传输单元 (FTU)
  - 3 个 CAN 控制器 (DCAN)
    - 64 个邮箱, 每个邮箱均具有奇偶校验保护
    - 与 CAN 协议 2.0B 版兼容
  - 本地互连网络 (LIN) 接口控制器
    - 与 LIN 协议版本 2.1 兼容
    - 可被配置为第二个 SCI
  - 标准串行通信接口 (SCI)
  - 内部集成电路 (I<sup>2</sup>C)
  - 3 个多通道经缓冲串行外设接口 (MibSPI)
    - 128 个字, 每个字具有奇偶校验保护
  - 2 个标准串行外设接口 (SPI)
- 2 个高端定时器模块 (N2HET)
  - N2HET1: 32 个可编程通道
  - N2HET2: 18 个可编程通道
  - 160 个字指令 RAM, 每个都带有奇偶校验保护
  - 每个 N2HET 包括硬件角发生器
  - 针对每个 N2HET (HTU) 的具有 MPU 的专用传输单元
- 2 个 10 或 12 位多通道经缓冲 ADC 模块
  - ADC1: 24 个通道
  - ADC2: 与 ADC1 共用的 16 个通道
  - 64 个结果缓冲器, 每个缓冲器具有奇偶校验保护
- 16 个能够生成中断的通用输入/输出引脚 (GPIO)
- 封装
  - 337 球状引脚栅格阵列 (SnPb)(GWT)



## 1.2 应用范围

- 刹车系统（防抱死制动系统和电子稳定性控制）
- 电动助力转向
- 混合动力汽车 (HEV) 和电动汽车 (EV) 反向器系统
- 电池管理系统
- 主动驾驶员辅助系统
- 航天和航空电子设备
- 轨道交通
- 越野车
- 支持国防、航天和医疗应用
  - 受控基线
  - 同一组装和测试场所
  - 同一制造场所
  - 支持温度范围  $-55^{\circ}\text{C}$  至  $125^{\circ}\text{C}$
  - 延长的产品生命周期
  - 延长的产品变更通知
  - 产品可追溯性

## 1.3 说明

TMS570LS3137-EP 器件是一款用于安全系统的高性能 系列微控制器。此安全架构包括：

- 以锁步模式运行的双核 CPU
- CPU 和内存内置自检 (BIST) 逻辑
- 闪存和数据 SRAM 上的 ECC
- 外设存储器的奇偶校验
- 外设 I/O 上的回路功能

TMS570LS3137-EP 器件集成了 ARM Cortex-R4F 浮点 CPU，此 CPU 可提供一个高效的 1.66 DMIPS/MHz，并且 具有能够以高达 180 MHz 运行的配置，从而提供高达 298 DMIPS。此器件支持字不变大端序 [BE32] 格式。

TMS570LS3137-EP 器件具有 3MB 的集成闪存以及 256KB 的数据 RAM，这些闪存和 RAM 支持单位错误校正和双位错误检测。这个器件上的闪存存储器是一个由 64 位宽数据总线接口实现的非易失性、电可擦除并且可编程的存储器。为了实现所有读取、编程和擦除操作，此闪存运行在一个 3.3V 电源输入上（与 I/O 电源一样的电平）。当处于管线模式中时，闪存可在高达 180MHz 的系统时钟频率下运行。在字节、半字、字和双字模式中，SRAM 支持单循环读取和写入访问。

TMS570LS3137-EP 器件特有针对基于实时控制应用的外设，其中包括 2 个下一代高端定时器 (N2HET) 时序协处理器和 2 个支持多达 24 个输入的 12 位模数转换器 (ADC)。

N2HET1 是一款高级智能定时器，此定时器能够为实时应用提供精密的计时功能。该定时器为软件控制型，采用一个精简指令集，并具有一个专用的定时器微级机和一个连接的 I/O 端口。N2HET 可被用于脉宽调制输出，捕捉或比较输入，GPIO。N2HET 特别适合于要求多个传感器信息并且用复杂和准确时间脉冲来驱动致动器的应用。一个高端定时器传输单元 (HTU) 能够执行 DMA 类型处理来与主存储器之间传输 N2HET 数据。一个内存保护单元 (MPU) 被内置于 HTU 内。

此器件具有 2 个 12 位分辨率 MibADC，每个 MibADC 具有 24 个通道和受 64 字奇偶校验保护的缓冲器 RAM。MibADC 通道可被独立转换或者可针对顺序转换序列由软件成组。16 个通道可在两个 MibADC 间共用。有三个独立的组。当被触发或者针对连续转换模式进行配置后，每个序列可被转换一次。

此器件有多个通信接口：3 个 MibSPI，1 个 LIN，1 个 SCI，3 个 DACN，1 个 I<sup>2</sup>C。SPI 为相似移位寄存器类型器件之间串行高速通信的提供了一个便捷方法。LIN 支持本地互联标准 2.0 并可被用作一个使用标准不归零码 (NRZ) 格式的全双工模式 UART。

DCAN 支持 CAN 2.0 (A 和 B) 协议标准并使用一个串行、多主控通信协议，此协议用高达 1Mbps 的稳健耐用通信速率有效支持分布式实时控制。DCAN 非常适合于工作于嘈杂和恶劣环境中的系统（例如，汽车网络互连和工业领域），此类系统需要可靠的串行通信或多路复用布线。

I2C 模块是一个多主控通信模块，此模块通过 I<sup>2</sup>C 串行总线在微控制器和一个 I<sup>2</sup>C 兼容器件之间提供一个接口。此 I<sup>2</sup>C 支持 100Kbps 和 400Kbps 的速度。

此调频锁相环 (FMPLL) 时钟模块被用来将外部频率基准与一个内部使用的更高频率相乘。这个器件上有两个 FMPLL 模块。当被启用时，这些模块提供 7 个可能的时钟源中的两个到全局时钟模块 (GCM)。此 GCM 管理可用时钟源与器件时钟域间的映射。

此器件还有一个外部时钟前置分频器 (ECP) 模块，当被启用时，此模块在 ECLK 引脚/焊球上输出一个连续外部时钟。ECLK 频率是一个外设接口时钟 (VCLK) 频率的用户可编程比例。这个可被外部监视的低频输出作为此器件运行频率的指示器。

直接内存访问 (DMA) 控制器有 16 个通道，32 个控制数据包和针对其内存的奇偶校验保护。在 DMA 中内置了一个 MPU 来将 DMA 限制在存储器的指定区域，并且保护存储器系统的剩余部分不受 DMA 故障的影响。

错误信令模块 (ESM) 监控所有器件错误并在检测到一个故障时确定是生成一个中断还是触发一个外部 ERROR 引脚。可从外部监视此 ERROR 引脚，将其作为一个微控制器内故障条件的指示器。

外部存储器接口 (EMIF) 提供芯片外扩展功能，此功能可实现与同步 DRAM (SDRAM) 器件、异步存储器、外设或现场可编程门阵列 (FPGA) 器件的对接。

执行几个接口来提高应用代码的调试能力。除了内置的 ARM Cortex-R4F CoreSight 调试特性，一个外部跟踪宏单元 (ETM) 提供程序执行的指令和数据跟踪。为了实现仪器测量的目的，执行了一个 RAM 跟踪端口模块 (RTP) 来支持由 CPU 或者任何其它主控所访问的 RAM 和外设的高速跟踪。一个数据修改模块 (DMM) 提供向器件内存写入外部数据的功能。RTP 和 DMM 对于应用代码的程序执行时间没有影响或者只有很小的影响。一个参数覆盖模块 (POM) 可将闪存访问重新路由至内部存储器或 EMIF。这个重新路由可对照生产代码对参数和表格进行动态校准，而无需重建代码以明确访问 RAM 或停止处理器来重新编辑数据闪存。

借助集成的安全特性和通信与控制外设的广泛选择，器件是针对具有安全关键要求的高性能实时控制应用的理想解决方案。

**表 1-1. 器件信息<sup>(1)</sup>**

| 订货编号              | 封装          | T <sub>A</sub> |
|-------------------|-------------|----------------|
| TMS5703137CGWTQEP | NFBGA (337) | -40°C 至 105°C  |
| TMS5703137CGWTMEP |             | -55°C 至 125°C  |

(1) 更多信息请参见 节 9，机械封装和可订购产品信息。

## 1.4 功能方框图

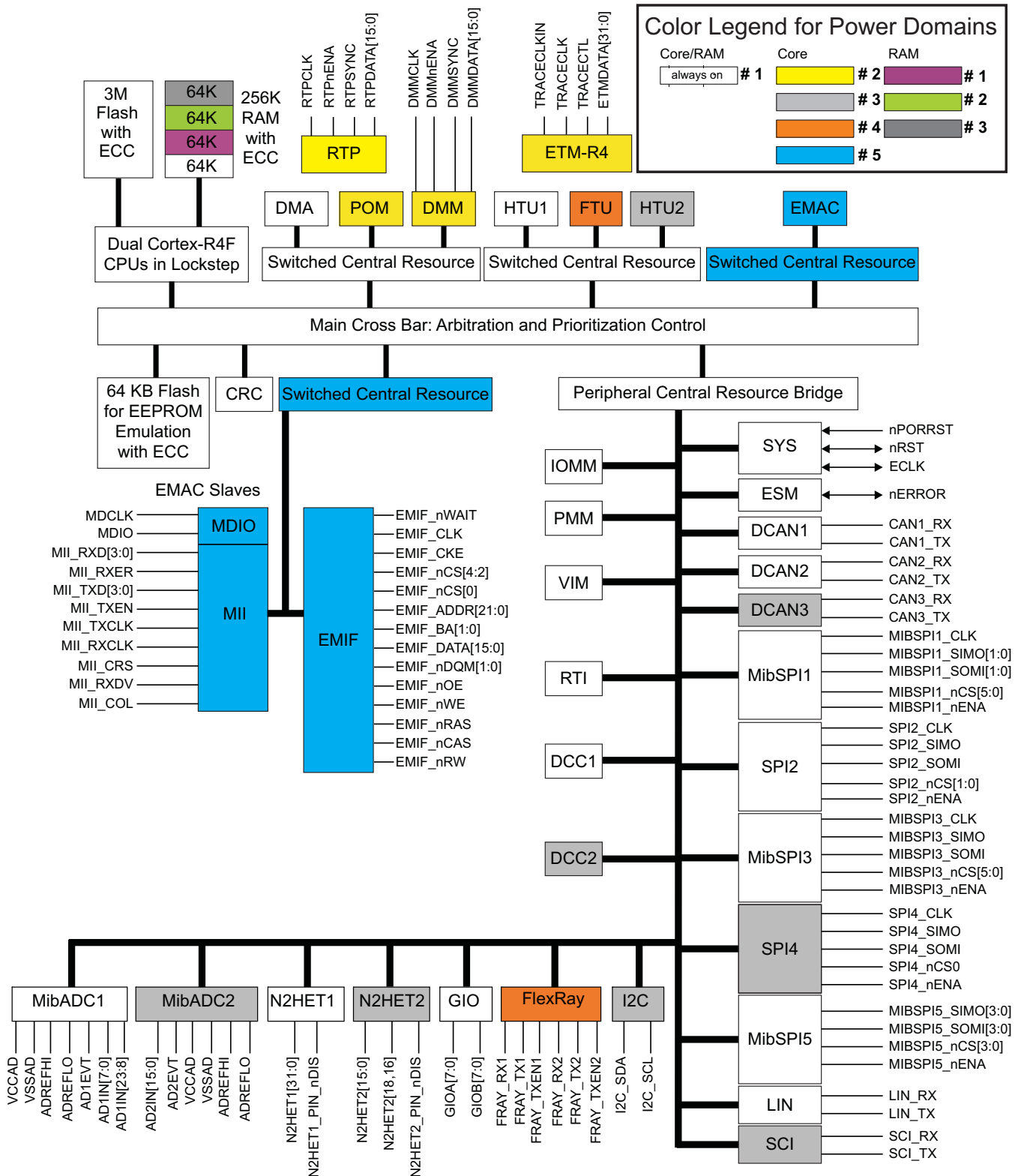


图 1-1. 功能方框图

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### 3 Device Comparison Table

#### 3.1 Device Comparison

To compare the TMS570LS3137-EP with other devices, see [Compare](#) on the product folder.



## 4 Pin Configuration and Functions

### 4.1 Pin Diagrams

**337-Ball Grid Array  
GWT BGA Package  
Top View**

|    | A           | B              | C              | D             | E                           | F                           | G                           | H               | J               | K                           | L                           | M                           | N                            | P                            | R                            | T                     | U                     | V                    | W                     |    |
|----|-------------|----------------|----------------|---------------|-----------------------------|-----------------------------|-----------------------------|-----------------|-----------------|-----------------------------|-----------------------------|-----------------------------|------------------------------|------------------------------|------------------------------|-----------------------|-----------------------|----------------------|-----------------------|----|
| 19 | VSS         | VSS            | TMS            | N2HET1 [10]   | MIBSPI5 NCS[0]              | MIBSPI1 SIMO                | MIBSPI1 NENA                | MIBSPI5 CLK     | MIBSPI5 SIMO[0] | N2HET1 [28]                 | DMM DATA[0]                 | CAN3RX                      | AD1EVT                       | AD1IN[15] / AD2IN[15]        | AD1IN[22] / AD2IN[06]        | AD1IN [06]            | AD1IN[11] / AD2IN[11] | VSSAD                | VSSAD                 | 19 |
| 18 | VSS         | TCK            | TDO            | nTRST         | N2HET1 [08]                 | MIBSPI1 CLK                 | MIBSPI1 SOMI                | MIBSPI5 NENA    | MIBSPI5 SOMI[0] | N2HET1 [0]                  | DMM DATA[1]                 | CAN3TX                      | NC                           | AD1IN[08] / AD2IN[08]        | AD1IN[14] / AD2IN[14]        | AD1IN[13] / AD2IN[13] | AD1IN [04]            | AD1IN [02]           | VSSAD                 | 18 |
| 17 | TDI         | RST            | EMIF_ADDR[21]  | EMIF_nWE      | MIBSPI5 SOMI[1]             | DMM_CLK                     | MIBSPI5 SIMO[3]             | MIBSPI5 SIMO[2] | N2HET1 [31]     | EMIF_nCS[3]                 | EMIF_nCS[2]                 | EMIF_nCS[4]                 | EMIF_nCS[0]                  | NC                           | AD1IN [05]                   | AD1IN [03]            | AD1IN[10] / AD2IN[10] | AD1IN [01]           | AD1IN[09] / AD2IN[09] | 17 |
| 16 | RTCK        | FRAY TXEN1     | EMIF_ADDR[20]  | EMIF_BA[1]    | MIBSPI5 SIMO[1]             | DMM_NENA                    | MIBSPI5 SOMI[3]             | MIBSPI5 SOMI[2] | DMM_SYNC        | NC                          | NC                          | NC                          | NC                           | NC                           | AD1IN[23] / AD2IN[07]        | AD1IN[12] / AD2IN[12] | AD1IN[19] / AD2IN[03] | ADREFLO              | VSSAD                 | 16 |
| 15 | FRAY RX1    | FRAY TX1       | EMIF_ADDR[19]  | EMIF_ADDR[18] | ETM DATA[06]                | ETM DATA[05]                | ETM DATA[04]                | ETM DATA[03]    | ETM DATA[02]    | ETM DATA[16] / EMIF_DATA[0] | ETM DATA[17] / EMIF_DATA[1] | ETM DATA[18] / EMIF_DATA[2] | ETM DATA[19] / EMIF_DATA[3]  | NC                           | NC                           | AD1IN[21] / AD2IN[05] | AD1IN[20] / AD2IN[04] | ADREFHI              | VCCAD                 | 15 |
| 14 | N2HET1 [26] | nERROR         | EMIF_ADDR[17]  | EMIF_ADDR[16] | ETM DATA[07]                | VCCIO                       | VCCIO                       | VCCIO           | VCC             | VCC                         | VCCIO                       | VCCIO                       | VCCIO                        | VCCIO                        | NC                           | NC                    | AD1IN[18] / AD2IN[02] | AD1IN [07]           | AD1IN [0]             | 14 |
| 13 | N2HET1 [17] | N2HET1 [19]    | EMIF_ADDR[15]  | NC            | ETM DATA[12] / EMIF_BA[0]   | VCCIO                       |                             |                 |                 |                             |                             |                             |                              | VCCIO                        | ETM DATA[01]                 | NC                    | AD1IN[17] / AD2IN[01] | AD1IN[16] / AD2IN[0] | NC                    | 13 |
| 12 | ECLK        | N2HET1 [04]    | EMIF_ADDR[14]  | NC            | ETM DATA[13] / EMIF_nOE     | VCCIO                       |                             | VSS             | VSS             | VCC                         | VSS                         | VSS                         |                              | VCCIO                        | ETM DATA[0]                  | MIBSPI5 NCS[3]        | NC                    | NC                   | NC                    | 12 |
| 11 | N2HET1 [14] | N2HET1 [30]    | EMIF_ADDR[13]  | NC            | ETM DATA[14] / EMIF_nDQM[1] | VCCIO                       |                             | VSS             | VSS             | VSS                         | VSS                         | VSS                         |                              | VCCPLL                       | ETM TRACE CTL                | NC                    | NC                    | NC                   | NC                    | 11 |
| 10 | CAN1TX      | CAN1RX         | EMIF_ADDR[12]  | NC            | ETM DATA[15] / EMIF_nDQM[0] | VCC                         |                             | VCC             | VSS             | VSS                         | VSS                         | VCC                         |                              | VCC                          | ETM TRACE CLKOUT             | NC                    | NC                    | MIBSPI3 NCS[0]       | GIOB[3]               | 10 |
| 9  | N2HET1 [27] | FRAY TXEN2     | EMIF_ADDR[11]  | NC            | ETM DATA[08] / EMIF_ADDR[5] | VCC                         |                             | VSS             | VSS             | VSS                         | VSS                         | VSS                         |                              | VCCIO                        | ETM TRACE CLKIN              | NC                    | NC                    | MIBSPI3 CLK          | MIBSPI3 NENA          | 9  |
| 8  | FRAY RX2    | FRAY TX2       | EMIF_ADDR[10]  | NC            | ETM DATA[09] / EMIF_ADDR[4] | VCCP                        |                             | VSS             | VSS             | VCC                         | VSS                         | VSS                         |                              | VCCIO                        | ETM DATA[31] / EMIF_DATA[15] | NC                    | NC                    | MIBSPI3 SOMI         | MIBSPI3 SIMO          | 8  |
| 7  | LINRX       | LINTX          | EMIF_ADDR[9]   | NC            | ETM DATA[11] / EMIF_ADDR[3] | VCCIO                       |                             |                 |                 |                             |                             |                             |                              | VCCIO                        | ETM DATA[30] / EMIF_DATA[14] | NC                    | NC                    | N2HET1 [09]          | nPORRST               | 7  |
| 6  | GIOA[4]     | MIBSPI5 NCS[1] | EMIF_ADDR[8]   | NC            | ETM DATA[11] / EMIF_ADDR[2] | VCCIO                       | VCCIO                       | VCCIO           | VCCIO           | VCC                         | VCC                         | VCCIO                       | VCCIO                        | VCCIO                        | ETM DATA[29] / EMIF_DATA[13] | NC                    | NC                    | N2HET1 [05]          | MIBSPI5 NCS[2]        | 6  |
| 5  | GIOA[0]     | GIOA[5]        | EMIF_ADDR[7]   | EMIF_ADDR[1]  | ETM DATA[20] / EMIF_DATA[4] | ETM DATA[21] / EMIF_DATA[5] | ETM DATA[22] / EMIF_DATA[6] | FLTP2           | FLTP1           | ETM DATA[23] / EMIF_DATA[7] | ETM DATA[24] / EMIF_DATA[8] | ETM DATA[25] / EMIF_DATA[9] | ETM DATA[26] / EMIF_DATA[10] | ETM DATA[27] / EMIF_DATA[11] | ETM DATA[28] / EMIF_DATA[12] | NC                    | NC                    | MIBSPI3 NCS[1]       | N2HET1 [02]           | 5  |
| 4  | N2HET1 [16] | N2HET1 [12]    | EMIF_ADDR[6]   | EMIF_ADDR[0]  | NC                          | NC                          | NC                          | N2HET1 [21]     | N2HET1 [23]     | NC                          | NC                          | NC                          | NC                           | NC                           | EMIF_nCAS                    | NC                    | NC                    | NC                   | NC                    | 4  |
| 3  | N2HET1 [29] | N2HET1 [22]    | MIBSPI3 NCS[3] | SPI2 NENA     | N2HET1 [11]                 | MIBSPI1 NCS[1]              | MIBSPI1 NCS[2]              | GIOA[6]         | MIBSPI1 NCS[3]  | EMIF_CLK                    | EMIF_CKE                    | N2HET1 [25]                 | SPI2 NCS[0]                  | EMIF_nWAIT                   | EMIF_nRAS                    | NC                    | NC                    | NC                   | N2HET1 [06]           | 3  |
| 2  | VSS         | MIBSPI3 NCS[2] | GIOA[1]        | SPI2 SOMI     | SPI2 CLK                    | GIOB[2]                     | GIOB[5]                     | CAN2TX          | GIOB[6]         | GIOB[1]                     | KELVIN_GND                  | GIOB[0]                     | N2HET1 [13]                  | N2HET1 [20]                  | MIBSPI1 NCS[0]               | NC                    | TEST                  | N2HET1 [01]          | VSS                   | 2  |
| 1  | VSS         | VSS            | GIOA[2]        | SPI2 SIMO     | GIOA[3]                     | GIOB[7]                     | GIOB[4]                     | CAN2RX          | N2HET1 [18]     | OSCIN                       | OSCOU                       | GIOA[7]                     | N2HET1 [15]                  | N2HET1 [24]                  | NC                           | N2HET1 [07]           | N2HET1 [03]           | VSS                  | VSS                   | 1  |
|    | A           | B              | C              | D             | E                           | F                           | G                           | H               | J               | K                           | L                           | M                           | N                            | P                            | R                            | T                     | U                     | V                    | W                     |    |

NOTE: Balls can have multiplexed functions. Only the default function is depicted in above diagram, except for the EMIF signals that are multiplexed with ETM signals.



### 4.1.1 Pin Attributes

4.1.1.1 identifies the external signal names, the associated pin/ball numbers along with the mechanical package designator, the pin/ball type (Input, Output, IO, Power or Ground), whether the pin/ball has any internal pullup/pulldown, whether the pin/ball can be configured as a GPIO, and a functional pin/ball description. The first signal name listed is the primary function for that terminal. The signal name in Bold is the function being described. Refer to the TMS570LS31X/21X Technical Reference Manual ([SPNU499](#)) for information on how to select between different multiplexed functions.

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#### NOTE

All I/O signals except nRST are configured as inputs while nPORRST is low and immediately after nPORRST goes High.

All output-only signals are configured as inputs while nPORRST is low, and are configured as outputs immediately after nPORRST goes High.

While nPORRST is low, the input buffers are disabled, and the output buffers are tri-stated.

In the Pin Functions table below, the "Default Pull State" is the state of the pullup or pulldown while nPORRST is low and immediately after nPORRST goes High. The default pull direction may change when software configures the pin for an alternate function. The "Pull Type" is the type of pull asserted when the signal name in bold is enabled for the given pin.

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#### 4.1.1.1 GWT Package

##### 4.1.1.1.1 Multi-Buffered Analog-to-Digital Converters (MibADC)

**Table 4-1. GWT Multi-Buffered Analog-to-Digital Converters (MibADC1, MibADC2)**

| Pin                                          |         | Signal Type | Default Pull State | Pull Type          | Description                       |
|----------------------------------------------|---------|-------------|--------------------|--------------------|-----------------------------------|
| Signal Name                                  | 337 GWT |             |                    |                    |                                   |
| ADREFHI <sup>(1)</sup>                       | V15     | Input       | -                  | None               | ADC high reference supply         |
| ADREFLO <sup>(1)</sup>                       | V16     | Input       |                    |                    | ADC low reference supply          |
| VCCAD <sup>(1)</sup>                         | W15     | Power       |                    |                    | Operating supply for ADC          |
| VSSAD                                        | V19     | Ground      | -                  | None               | ADC supply power                  |
|                                              | W16     |             |                    |                    |                                   |
|                                              | W18     |             |                    |                    |                                   |
|                                              | W19     |             |                    |                    |                                   |
| AD1EVT                                       | N19     | I/O         | Pull Down          | Programmable, 20uA | ADC1 event trigger input, or GPIO |
| MIBSPI3NCS[0]/AD2EVT/GIOB[2]/N2HET2_PIN_nDIS | V10     | I/O         | Pull Up            | Programmable, 20uA | ADC2 event trigger input, or GPIO |
| AD1IN[0]                                     | W14     | Input       | -                  | None               | ADC1 analog input                 |
| AD1IN[1]                                     | V17     |             |                    |                    |                                   |
| AD1IN[2]                                     | V18     |             |                    |                    |                                   |
| AD1IN[3]                                     | T17     |             |                    |                    |                                   |
| AD1IN[4]                                     | U18     |             |                    |                    |                                   |
| AD1IN[5]                                     | R17     |             |                    |                    |                                   |
| AD1IN[6]                                     | T19     |             |                    |                    |                                   |
| AD1IN[7]                                     | V14     |             |                    |                    |                                   |
| AD1IN[8] / AD2IN[8]                          | P18     | Input       | -                  | None               | ADC1/ADC2 shared analog inputs    |
| AD1IN[9] / AD2IN[9]                          | W17     |             |                    |                    |                                   |
| AD1IN[10] / AD2IN[10]                        | U17     |             |                    |                    |                                   |
| AD1IN[11] / AD2IN[11]                        | U19     |             |                    |                    |                                   |
| AD1IN[12] / AD2IN[12]                        | T16     |             |                    |                    |                                   |
| AD1IN[13] / AD2IN[13]                        | T18     |             |                    |                    |                                   |
| AD1IN[14] / AD2IN[14]                        | R18     |             |                    |                    |                                   |
| AD1IN[15] / AD2IN[15]                        | P19     |             |                    |                    |                                   |
| AD1IN[16] / AD2IN[0]                         | V13     |             |                    |                    |                                   |
| AD1IN[17] / AD2IN[1]                         | U13     |             |                    |                    |                                   |
| AD1IN[18] / AD2IN[2]                         | U14     |             |                    |                    |                                   |
| AD1IN[19] / AD2IN[3]                         | U16     |             |                    |                    |                                   |
| AD1IN[20] / AD2IN[4]                         | U15     |             |                    |                    |                                   |
| AD1IN[21] / AD2IN[5]                         | T15     |             |                    |                    |                                   |
| AD1IN[22] / AD2IN[6]                         | R19     |             |                    |                    |                                   |
| AD1IN[23] / AD2IN[7]                         | R16     |             |                    |                    |                                   |

(1) The ADREFHI, ADREFLO, VCCAD and VSSAD connections are common for both ADC cores.

#### 4.1.1.1.2 Enhanced High-End Timer Modules (N2HET)

**Table 4-2. GWT Enhanced High-End Timer Modules (N2HET)**

| Pin                                 |         | Signal Type | Default Pull State | Pull Type          | Description                                                                                                                                                        |
|-------------------------------------|---------|-------------|--------------------|--------------------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| Signal Name                         | 337 GWT |             |                    |                    |                                                                                                                                                                    |
| N2HET1[0]/SPI4CLK                   | K18     | I/O         | Pull Down          | Programmable, 20uA | N2HET1 time input capture or output compare, or GIO.<br><br>Each terminal has a suppression filter that ignores input pulses smaller than a programmable duration. |
| N2HET1[1]/SPI4NENA/N2HET2[8]        | V2      |             |                    |                    |                                                                                                                                                                    |
| N2HET1[2]/SPI4SIMO[0]               | W5      |             |                    |                    |                                                                                                                                                                    |
| N2HET1[3]/SPI4NCS[0]/N2HET2[10]     | U1      |             |                    |                    |                                                                                                                                                                    |
| N2HET1[4]                           | B12     |             |                    |                    |                                                                                                                                                                    |
| N2HET1[5]/SPI4SOMI[0]/N2HET2[12]    | V6      |             |                    |                    |                                                                                                                                                                    |
| N2HET1[6]/SCIRX                     | W3      |             |                    |                    |                                                                                                                                                                    |
| N2HET1[7]/N2HET2[14]                | T1      |             |                    |                    |                                                                                                                                                                    |
| N2HET1[8]/MIBSPI1SIMO[1]            | E18     |             |                    |                    |                                                                                                                                                                    |
| N2HET1[9]/N2HET2[16]                | V7      |             |                    |                    |                                                                                                                                                                    |
| N2HET1[10]                          | D19     |             |                    |                    |                                                                                                                                                                    |
| N2HET1[11]/MIBSPI3NCS[4]/N2HET2[18] | E3      |             |                    |                    |                                                                                                                                                                    |
| N2HET1[12]                          | B4      |             |                    |                    |                                                                                                                                                                    |
| N2HET1[13]/SCITX                    | N2      |             |                    |                    |                                                                                                                                                                    |
| N2HET1[14]                          | A11     |             |                    |                    |                                                                                                                                                                    |
| N2HET1[15]/MIBSPI1NCS[4]            | N1      |             |                    |                    |                                                                                                                                                                    |
| N2HET1[16]                          | A4      |             |                    |                    |                                                                                                                                                                    |
| N2HET1[17]                          | A13     |             |                    |                    |                                                                                                                                                                    |
| N2HET1[18]                          | J1      |             |                    |                    |                                                                                                                                                                    |
| N2HET1[19]                          | B13     |             |                    |                    |                                                                                                                                                                    |
| N2HET1[20]                          | P2      |             |                    |                    |                                                                                                                                                                    |
| N2HET1[21]                          | H4      |             |                    |                    |                                                                                                                                                                    |
| N2HET1[22]                          | B3      |             |                    |                    |                                                                                                                                                                    |
| N2HET1[23]                          | J4      |             |                    |                    |                                                                                                                                                                    |
| N2HET1[24]/MIBSPI1NCS[5]            | P1      |             |                    |                    |                                                                                                                                                                    |
| N2HET1[25]                          | M3      |             |                    |                    |                                                                                                                                                                    |
| N2HET1[26]/                         | A14     |             |                    |                    |                                                                                                                                                                    |
| N2HET1[27]                          | A9      |             |                    |                    |                                                                                                                                                                    |
| N2HET1[28]/                         | K19     |             |                    |                    |                                                                                                                                                                    |
| N2HET1[29]                          | A3      |             |                    |                    |                                                                                                                                                                    |
| N2HET1[30]                          | B11     |             |                    |                    |                                                                                                                                                                    |
| N2HET1[31]                          | J17     |             |                    |                    |                                                                                                                                                                    |
| GIOA[5]/EXTCLKIN/N2HET1_PIN_nDIS    | B5      | I/O         | Pull Down          | Programmable, 20uA |                                                                                                                                                                    |

Table 4-2. GWT Enhanced High-End Timer Modules (N2HET) (continued)

| Pin                                          |         | Signal Type | Default Pull State | Pull Type          | Description                                                                                                                                                 |
|----------------------------------------------|---------|-------------|--------------------|--------------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------|
| Signal Name                                  | 337 GWT |             |                    |                    |                                                                                                                                                             |
| GIOA[2]/N2HET2[0]                            | C1      | I/O         | Pull Down          | Programmable, 20uA | N2HET2 time input capture or output compare, or GIO. Each terminal has a suppression filter that ignores input pulses smaller than a programmable duration. |
| EMIF_ADDR[0]/N2HET2[1]                       | D4      |             |                    |                    |                                                                                                                                                             |
| GIOA[3]/N2HET2[2]                            | E1      |             |                    |                    |                                                                                                                                                             |
| EMIF_ADDR[1]/N2HET2[3]                       | D5      |             |                    |                    |                                                                                                                                                             |
| GIOA[6]/N2HET2[4]                            | H3      |             |                    |                    |                                                                                                                                                             |
| EMIF_BA[1]/N2HET2[5]                         | D16     |             |                    |                    |                                                                                                                                                             |
| GIOA[7]/N2HET2[6]                            | M1      |             |                    |                    |                                                                                                                                                             |
| EMIF_nCS[0]/RTP_DATA[15]/N2HET2[7]           | N17     |             |                    |                    |                                                                                                                                                             |
| N2HET1[1]/SPI4NENA/N2HET2[8]                 | V2      |             |                    |                    |                                                                                                                                                             |
| EMIF_nCS[3]/RTP_DATA[14]/N2HET2[9]           | K17     |             |                    |                    |                                                                                                                                                             |
| N2HET1[3]/SPI4NCS[0]/N2HET2[10]              | U1      |             |                    |                    |                                                                                                                                                             |
| EMIF_ADDR[6]/RTP_DATA[13]/N2HET2[11]         | C4      |             |                    |                    |                                                                                                                                                             |
| N2HET1[5]/SPI4SOMI[0]/N2HET2[12]             | V6      |             |                    |                    |                                                                                                                                                             |
| EMIF_ADDR[7]/RTP_DATA[12]/N2HET2[13]         | C5      |             |                    |                    |                                                                                                                                                             |
| N2HET1[7]/N2HET2[14]                         | T1      |             |                    |                    |                                                                                                                                                             |
| EMIF_ADDR[8]/RTP_DATA[11]/N2HET2[15]         | C6      |             |                    |                    |                                                                                                                                                             |
| N2HET1[9]/N2HET2[16]                         | V7      |             |                    |                    |                                                                                                                                                             |
| N2HET1[11]/MIBSPI3NCS[4]/N2HET2[18]          | E3      |             |                    |                    |                                                                                                                                                             |
| MIBSPI3NCS[0]/AD2EVT/GIOB[2]/N2HET2_PIN_nDIS | V10     | I/O         | Pull Up            | Programmable, 20uA |                                                                                                                                                             |

#### 4.1.1.1.3 General-Purpose Input / Output (GPIO)

**Table 4-3. GWT General-Purpose Input / Output (GPIO)**

| Pin                                          |         | Signal Type | Default Pull State | Pull Type            | Description                                                                                                               |
|----------------------------------------------|---------|-------------|--------------------|----------------------|---------------------------------------------------------------------------------------------------------------------------|
| Signal Name                                  | 337 GWT |             |                    |                      |                                                                                                                           |
| GIOA[0]                                      | A5      | I/O         | Pull Down          | Programmable, 20uA   | General-purpose I/O. All GPIO terminals are capable of generating interrupts to the CPU on rising / falling / both edges. |
| GIOA[1]                                      | C2      |             |                    |                      |                                                                                                                           |
| GIOA[2]/N2HET2[0]                            | C1      |             |                    |                      |                                                                                                                           |
| GIOA[3]/N2HET2[2]                            | E1      |             |                    |                      |                                                                                                                           |
| GIOA[4]                                      | A6      |             |                    |                      |                                                                                                                           |
| GIOA[5]/EXTCLKIN/N2HET1_PIN_nDIS             | B5      |             |                    |                      |                                                                                                                           |
| GIOA[6]/N2HET2[4]                            | H3      |             |                    |                      |                                                                                                                           |
| GIOA[7]/N2HET2[6]                            | M1      |             |                    |                      |                                                                                                                           |
| GIOB[0]                                      | M2      |             |                    |                      |                                                                                                                           |
| GIOB[1]                                      | K2      |             |                    |                      |                                                                                                                           |
| GIOB[2]                                      | F2      |             |                    |                      |                                                                                                                           |
| GIOB[3]                                      | W10     |             |                    |                      |                                                                                                                           |
| GIOB[4]                                      | G1      |             |                    |                      |                                                                                                                           |
| GIOB[5]                                      | G2      |             |                    |                      |                                                                                                                           |
| GIOB[6]                                      | J2      |             |                    |                      |                                                                                                                           |
| GIOB[7]                                      | F1      |             |                    |                      |                                                                                                                           |
| MIBSPI3NCS[0]/AD2EVT/GIOB[2]/N2HET2_PIN_nDIS | V10     |             | Pull Up            | Fixed 20uA pull down | GIOB[2] is input only on this terminal. When GIOB[2] function is selected, the pull is a fixed pull down                  |

#### 4.1.1.1.4 FlexRay Interface Controller (FlexRay)

**Table 4-4. FlexRay Interface Controller (FlexRay)**

| Pin         |         | Signal Type | Default Pull State | Pull Type    | Description                         |
|-------------|---------|-------------|--------------------|--------------|-------------------------------------|
| Signal Name | 337 GWT |             |                    |              |                                     |
| FRAYRX1     | A15     | Input       | Pull Up            | Fixed, 100uA | FlexRay data receive (channel 1)    |
| FRAYTX1     | B15     | Output      | None               | -            | FlexRay data transmit (channel 1)   |
| FRAYTXEN1   | B16     | Output      |                    |              | FlexRay transmit enable (channel 1) |
| FRAYRX2     | A8      | Input       | Pull Up            | Fixed, 100uA | FlexRay data receive (channel 2)    |
| FRAYTX2     | B8      | Output      | None               | -            | FlexRay data transmit (channel 2)   |
| FRAYTXEN2   | B9      | Output      |                    |              | FlexRay transmit enable (channel 2) |

#### 4.1.1.1.5 Controller Area Network Controllers (DCAN)

**Table 4-5. GWT Controller Area Network Controllers (DCAN)**

| Pin         |         | Signal Type | Default Pull State | Pull Type          | Description            |
|-------------|---------|-------------|--------------------|--------------------|------------------------|
| Signal Name | 337 GWT |             |                    |                    |                        |
| CAN1RX      | B10     | I/O         | Pull Up            | Programmable, 20uA | CAN1 receive, or GPIO  |
| CAN1TX      | A10     |             |                    |                    | CAN1 transmit, or GPIO |
| CAN2RX      | H1      |             |                    |                    | CAN2 receive, or GPIO  |
| CAN2TX      | H2      |             |                    |                    | CAN2 transmit, or GPIO |
| CAN3RX      | M19     |             |                    |                    | CAN3 receive, or GPIO  |
| CAN3TX      | M18     |             |                    |                    | CAN3 transmit, or GPIO |

#### 4.1.1.1.6 Local Interconnect Network Interface Module (LIN)

**Table 4-6. GWT Local Interconnect Network Interface Module (LIN)**

| Pin         |         | Signal Type | Default Pull State | Pull Type          | Description           |
|-------------|---------|-------------|--------------------|--------------------|-----------------------|
| Signal Name | 337 GWT |             |                    |                    |                       |
| LINRX       | A7      | I/O         | Pull Up            | Programmable, 20uA | LIN receive, or GPIO  |
| LINTX       | B7      |             |                    |                    | LIN transmit, or GPIO |

#### 4.1.1.1.7 Standard Serial Communication Interface (SCI)

**Table 4-7. GWT Standard Serial Communication Interface (SCI)**

| Pin              |         | Signal Type | Default Pull State | Pull Type          | Description           |
|------------------|---------|-------------|--------------------|--------------------|-----------------------|
| Signal Name      | 337 GWT |             |                    |                    |                       |
| N2HET1[6]/SCIRX  | W3      | I/O         | Pull Down          | Programmable, 20uA | SCI receive, or GPIO  |
| N2HET1[13]/SCITX | N2      |             |                    |                    | SCI transmit, or GPIO |

#### 4.1.1.1.8 Inter-Integrated Circuit Interface Module (I2C)

**Table 4-8. GWT Inter-Integrated Circuit Interface Module (I2C)**

| Pin                              |         | Signal Type | Default Pull State | Pull Type          | Description               |
|----------------------------------|---------|-------------|--------------------|--------------------|---------------------------|
| Signal Name                      | 337 GWT |             |                    |                    |                           |
| MIBSPI3NCS[2]/I2C_SDA/N2HET1[27] | B2      | I/O         | Pull Up            | Programmable, 20uA | I2C serial data, or GPIO  |
| MIBSPI3NCS[3]/I2C_SCL/N2HET1[29] | C3      |             |                    |                    | I2C serial clock, or GPIO |

#### 4.1.1.1.9 Standard Serial Peripheral Interface (SPI)

**Table 4-9. GWT Standard Serial Peripheral Interface (SPI)**

| Pin                              |         | Signal Type | Default Pull State | Pull Type          | Description                             |
|----------------------------------|---------|-------------|--------------------|--------------------|-----------------------------------------|
| Signal Name                      | 337 GWT |             |                    |                    |                                         |
| SPI2CLK                          | E2      | I/O         | Pull Up            | Programmable, 20uA | SPI2 clock, or GPIO                     |
| SPI2NCS[0]                       | N3      |             |                    |                    | SPI2 chip select, or GPIO               |
| SPI2NENA/SPI2NCS[1]              | D3      |             |                    |                    | SPI2 chip select, or GPIO               |
| SPI2NENA/SPI2NCS[1]              | D3      |             |                    |                    | SPI2 enable, or GPIO                    |
| SPI2SIMO[0]                      | D1      |             |                    |                    | SPI2 slave-input master-output, or GPIO |
| SPI2SOMI[0]                      | D2      |             |                    |                    | SPI2 slave-output master-input, or GPIO |
| N2HET1[0]/SPI4CLK                | K18     | I/O         | Pull Down          | Programmable, 20uA | SPI4 clock, or GPIO                     |
| N2HET1[3]/SPI4NCS[0]/N2HET2[10]  | U1      |             |                    |                    | SPI4 chip select, or GPIO               |
| N2HET1[1]/SPI4NENA/N2HET2[8]     | V2      |             |                    |                    | SPI4 enable, or GPIO                    |
| N2HET1[2]/SPI4SIMO[0]            | W5      |             |                    |                    | SPI4 slave-input master-output, or GPIO |
| N2HET1[5]/SPI4SOMI[0]/N2HET2[12] | V6      |             |                    |                    | SPI4 slave-output master-input, or GPIO |



#### 4.1.1.1.10 Multi-Buffered Serial Peripheral Interface Modules (MibSPI)

**Table 4-10. GWT Multi-Buffered Serial Peripheral Interface Modules (MibSPI)**

| Pin                                          |         | Signal Type                          | Default Pull State           | Pull Type                    | Description                          |                                      |
|----------------------------------------------|---------|--------------------------------------|------------------------------|------------------------------|--------------------------------------|--------------------------------------|
| Signal Name                                  | 337 GWT |                                      |                              |                              |                                      |                                      |
| MIBSPI1CLK                                   | F18     | I/O                                  | Pull Up                      | Programmable, 20uA           | MibSPI1 clock, or GPIO               |                                      |
| MIBSPI1NCS[0]/MIBSPI1SOMI[1]                 | R2      |                                      |                              |                              | MibSPI1 chip select, or GPIO         |                                      |
| MIBSPI1NCS[1]/N2HET1[17]                     | F3      |                                      |                              |                              |                                      |                                      |
| MIBSPI1NCS[2]/N2HET1[19]                     | G3      |                                      |                              |                              |                                      |                                      |
| MIBSPI1NCS[3]/N2HET1[21]                     | J3      |                                      |                              |                              |                                      |                                      |
| N2HET1[15]/MIBSPI1NCS[4]                     | N1      |                                      | Pull Down                    | Programmable, 20uA           | MibSPI1 chip select, or GPIO         |                                      |
| N2HET1[24]/MIBSPI1NCS[5]                     | P1      |                                      | Pull Up                      | Programmable, 20uA           | MibSPI1 enable, or GPIO              |                                      |
| MIBSPI1NENA/N2HET1[23]                       | G19     |                                      |                              |                              | MibSPI1 slave-in master-out, or GPIO |                                      |
| MIBSPI1SIMO[0]                               | F19     |                                      | Pull Down                    | Programmable, 20uA           | MibSPI1 slave-in master-out, or GPIO |                                      |
| N2HET1[8]/MIBSPI1SIMO[1]                     | E18     |                                      |                              |                              | MibSPI1 slave-out master-in, or GPIO |                                      |
| MIBSPI1SOMI[0]                               | G18     |                                      | Pull Up                      | Programmable, 20uA           | MibSPI1 slave-out master-in, or GPIO |                                      |
| MIBSPI1NCS[0]/MIBSPI1SOMI[1]                 | R2      |                                      |                              |                              | I/O                                  | Pull Up                              |
| MIBSPI3CLK                                   | V9      |                                      | MibSPI3 chip select, or GPIO |                              |                                      |                                      |
| MIBSPI3NCS[0]/AD2EVT/GIOB[2]/N2HET2_PIN_nDIS | V10     |                                      |                              |                              |                                      |                                      |
| MIBSPI3NCS[1]/N2HET1[25]/MDCLK               | V5      |                                      |                              |                              |                                      |                                      |
| MIBSPI3NCS[2]/I2C_SDA/N2HET1[27]             | B2      |                                      |                              |                              |                                      |                                      |
| MIBSPI3NCS[3]/I2C_SCL/N2HET1[29]             | C3      | Pull Down                            | Programmable, 20uA           | MibSPI3 chip select, or GPIO |                                      |                                      |
| N2HET1[11]/MIBSPI3NCS[4]/N2HET2[18]          | E3      |                                      |                              | Pull Up                      |                                      | Programmable, 20uA                   |
| MIBSPI3NENA/MIBSPI3NCS[5]/N2HET1[31]         | W9      | MibSPI3 enable, or GPIO              |                              |                              |                                      |                                      |
| MIBSPI3NENA/MIBSPI3NCS[5]/N2HET1[31]         | W9      | MibSPI3 slave-in master-out, or GPIO |                              |                              |                                      |                                      |
| MIBSPI3SIMO[0]                               | W8      | MibSPI3 slave-out master-in, or GPIO |                              |                              |                                      |                                      |
| MIBSPI3SOMI[0]                               | V8      | I/O                                  | Pull Up                      | Programmable, 20uA           |                                      | MibSPI5 clock, or GPIO               |
| MIBSPI5CLK/DMM_DATA[4]                       | H19     |                                      |                              |                              |                                      | MibSPI5 chip select, or GPIO         |
| MIBSPI5NCS[0]/DMM_DATA[5]                    | E19     |                                      |                              |                              |                                      |                                      |
| MIBSPI5NCS[1]/DMM_DATA[6]                    | B6      |                                      |                              |                              |                                      |                                      |
| MIBSPI5NCS[2]/DMM_DATA[2]                    | W6      |                                      |                              |                              |                                      |                                      |
| MIBSPI5NCS[3]/DMM_DATA[3]                    | T12     |                                      |                              |                              | MibSPI5 enable, or GPIO              |                                      |
| MIBSPI5NENA/DMM_DATA[7]/                     | H18     |                                      |                              |                              |                                      |                                      |
| MIBSPI5SIMO[0]/DMM_DATA[8]                   | J19     |                                      |                              |                              |                                      | MibSPI5 slave-in master-out, or GPIO |
| MIBSPI5SIMO[1]/DMM_DATA[9]                   | E16     |                                      |                              |                              |                                      |                                      |
| MIBSPI5SIMO[2]/DMM_DATA[10]                  | H17     |                                      |                              |                              |                                      |                                      |
| MIBSPI5SIMO[3]/DMM_DATA[11]                  | G17     |                                      |                              |                              |                                      |                                      |
| MIBSPI5SOMI[0]/DMM_DATA[12]                  | J18     |                                      |                              |                              |                                      |                                      |
| MIBSPI5SOMI[1]/DMM_DATA[13]                  | E17     |                                      |                              |                              |                                      |                                      |
| MIBSPI5SOMI[2]/DMM_DATA[14]                  | H16     |                                      |                              |                              |                                      |                                      |
| MIBSPI5SOMI[3]/DMM_DATA[15]                  | G16     |                                      |                              |                              |                                      |                                      |

#### 4.1.1.1.11 Ethernet Controller

**Table 4-11. GWT Ethernet Controller: MDIO Interface**

| Pin                            |         | Signal Type | Default Pull State | Pull Type   | Description              |
|--------------------------------|---------|-------------|--------------------|-------------|--------------------------|
| Signal Name                    | 337 GWT |             |                    |             |                          |
| MIBSPI3NCS[1]/N2HET1[25]/MDCLK | V5      | Output      | Pull Up            | -           | Serial clock output      |
| MIBSPI1NCS[2]/N2HET1[19]/MDIO  | G3      | I/O         | Pull Up            | Fixed, 20uA | Serial data input/output |

**Table 4-12. GWT Ethernet Controller: Reduced Media Independent Interface (RMII)**

| Pin                                                |         | Signal Type | Default Pull State | Pull Type   | Description                                                                  |
|----------------------------------------------------|---------|-------------|--------------------|-------------|------------------------------------------------------------------------------|
| Signal Name                                        | 337 GWT |             |                    |             |                                                                              |
| N2HET1[12]/MII_CRS/RMII_CRS_DV                     | B4      | Input       | Pull Down          | Fixed, 20uA | RMII carrier sense and data valid                                            |
| N2HET1[28]/MII_RX_CLK/RMII_REFCLK/MII_RX_AVCLK4    | K19     |             |                    |             | RMII synchronous reference clock for receive, transmit and control interface |
| AD1EVT/MII_RX_ER/RMII_RX_ER                        | N19     |             |                    |             | RMII receive error                                                           |
| N2HET1[24]/MIBSPI1NCS[5]/MII_RXD[0]/RMII_RXD[0]    | P1      |             |                    |             | RMII receive data                                                            |
| N2HET1[26]/MII_RXD[1]/RMII_RXD[1]                  | A14     | Output      | Pull Up            | -           | RMII transmit data                                                           |
| MIBSPI5SOMI[0]/DMM_DATA[12]/MII_TXD[0]/RMII_TXD[0] | J18     |             |                    |             |                                                                              |
| MIBSPI5SIMO[0]/DMM_DATA[8]/MII_TXD[1]/RMII_TXD[1]  | J19     |             |                    |             | RMII transmit enable                                                         |
| MIBSPI5CLK/DMM_DATA[4]/MII_TXEN/RMII_TXEN          | H19     |             |                    |             |                                                                              |

**Table 4-13. GWT Ethernet Controller: Media Independent Interface (MII)**

| Pin                                             |         | Signal Type | Default Pull State | Pull Type   | Description                     |
|-------------------------------------------------|---------|-------------|--------------------|-------------|---------------------------------|
| Signal Name                                     | 337 GWT |             |                    |             |                                 |
| MIBSPI1NCS[1]/N2HET1[17]/MII_COL                | F3      | Input       | Pull Up            | -           | Collision detect                |
| N2HET1[12]/MII_CRS/RMII_CRS_DV                  | B4      |             | Pull Down          | Fixed, 20uA | Carrier sense and receive valid |
| N2HET1[28]/MII_RX_CLK/RMII_REFCLK/MII_RX_AVCLK4 | K19     | I/O         | Pull Down          | -           | MII output receive clock        |
| N2HET1[30]/MII_RX_DV                            | B11     | Input       | Pull Down          | Fixed, 20uA | Received data valid             |
| AD1EVT/MII_RX_ER/RMII_RX_ER                     | N19     |             |                    |             | Receive error                   |
| N2HET1[28]/MII_RX_CLK/RMII_REFCLK/MII_RX_AVCLK4 | K19     | I/O         | Pull Up            | Fixed, 20uA | Receive clock                   |
| N2HET1[24]/MIBSPI1NCS[5]/MII_RXD[0]/RMII_RXD[0] | P1      |             |                    |             | Receive data                    |
| N2HET1[26]/MII_RXD[1]/RMII_RXD[1]               | A14     | Input       | Pull Up            | Fixed, 20uA | Receive data                    |
| MIBSPI1NENA/N2HET1[23]/MII_RXD[2]               | G19     |             |                    |             |                                 |
| MIBSPI5NENA/DMM_DATA[7]/                        | H18     | I/O         | Pull Down          | -           | MII output transmit clock       |
| N2HET1[10]/MII_TX_CLK/MII_TX_AVCLK4             | D19     |             |                    |             | Transmit clock                  |
| N2HET1[10]/MII_TX_CLK/MII_TX_AVCLK4             | D19     | I/O         | Pull Down          | -           | Transmit data                   |
| MIBSPI5SOMI[0]/DMM_DATA[12]/RMII_TXD[0]         | J18     |             |                    |             |                                 |
| MIBSPI5SIMO[0]/DMM_DATA[8]/RMII_TXD[1]          | J19     | Output      | Pull Up            | -           | Transmit data                   |
| MIBSPI1NCS[0]/MIBSPI1SOMI[1]/MII_TXD[2]         | R2      |             |                    |             |                                 |
| N2HET1[8]/MIBSPI1SIMO[1]/MII_TXD[3]             | E18     | Output      | Pull Down          | -           | Transmit enable                 |
| MIBSPI5CLK/DMM_DATA[4]/RMII_TXEN                | H19     |             | Pull Up            | -           |                                 |

#### 4.1.1.1.12 External Memory Interface (EMIF)

**Table 4-14. External Memory Interface (EMIF)**

| Pin                                |         | Signal Type | Default Pull State | Pull Type          | Description                                                                                                                                                               |
|------------------------------------|---------|-------------|--------------------|--------------------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| Signal Name                        | 337 GWT |             |                    |                    |                                                                                                                                                                           |
| EMIF_CKE                           | L3      | Output      | Pull Down          | Programmable, 20uA | EMIF Clock Enable                                                                                                                                                         |
| EMIF_CLK                           | K3      | I/O         |                    |                    | EMIF clock. This is an output signal in functional mode. It is gated off by default, so that the signal is tri-stated. PINMUX29[8] must be cleared to enable this output. |
| EMIF_nWE/EMIF_RNW                  | D17     | Output      | Pull Up            | Programmable, 20uA | EMIF Read-Not-Write                                                                                                                                                       |
| ETMDATA[13]/EMIF_nOE               | E12     |             | Pull Down          | Programmable, 20uA | EMIF Output Enable                                                                                                                                                        |
| EMIF_nWAIT                         | P3      | I/O         | Pull Up            | Fixed, 20uA        | EMIF Extended Wait Signal                                                                                                                                                 |
| EMIF_nWE/EMIF_RNW                  | D17     | Output      | Pull Up            | Programmable, 20uA | EMIF Write Enable.                                                                                                                                                        |
| EMIF_nCAS                          | R4      | Output      |                    |                    | EMIF column address strobe                                                                                                                                                |
| EMIF_nRAS                          | R3      | Output      |                    |                    | EMIF row address strobe                                                                                                                                                   |
| EMIF_nCS[0]/RTP_DATA[15]/N2HET2[7] | N17     | Output      | Pull Down          | Programmable, 20uA | EMIF chip select, SDRAM                                                                                                                                                   |
| EMIF_nCS[2]                        | L17     | Output      | Pull Up            | Programmable, 20uA | EMIF chip selects, asynchronous<br>This applies to chip selects 2, 3 and 4                                                                                                |
| EMIF_nCS[3]/RTP_DATA[14]/N2HET2[9] | K17     | Output      | Pull Down          | Programmable, 20uA |                                                                                                                                                                           |
| EMIF_nCS[4]/RTP_DATA[7]            | M17     | Output      | Pull Up            | Programmable, 20uA |                                                                                                                                                                           |

**Table 4-14. External Memory Interface (EMIF) (continued)**

| Pin                       |         | Signal Type | Default Pull State | Pull Type          | Description                                                                                                   |                                   |
|---------------------------|---------|-------------|--------------------|--------------------|---------------------------------------------------------------------------------------------------------------|-----------------------------------|
| Signal Name               | 337 GWT |             |                    |                    |                                                                                                               |                                   |
| ETMDATA[15]/EMIF_nDQM[0]  | E10     | Output      | Pull Down          | Programmable, 20uA | EMIF Data Mask or Write Strobe. Data mask for SDRAM devices, write strobe for connected asynchronous devices. |                                   |
| ETMDATA[14]/EMIF_nDQM[1]  | E11     | Output      |                    |                    |                                                                                                               |                                   |
| ETMDATA[12]/EMIF_BA[0]    | E13     | Output      |                    |                    |                                                                                                               | EMIF bank address or address line |
| EMIF_BA[1]/N2HET2[5]      | D16     | Output      |                    |                    |                                                                                                               | EMIF bank address or address line |
| EMIF_ADDR[0]/N2HET2[1]    | D4      | Output      |                    |                    | EMIF address                                                                                                  |                                   |
| EMIF_ADDR[1]/N2HET2[3]    | D5      | Output      |                    |                    |                                                                                                               |                                   |
| ETMDATA[11]/EMIF_ADDR[2]  | E6      | Output      |                    |                    |                                                                                                               |                                   |
| ETMDATA[10]/EMIF_ADDR[3]  | E7      | Output      |                    |                    |                                                                                                               |                                   |
| ETMDATA[9]/EMIF_ADDR[4]   | E8      | Output      |                    |                    |                                                                                                               |                                   |
| ETMDATA[8]/EMIF_ADDR[5]   | E9      | Output      |                    |                    |                                                                                                               |                                   |
| EMIF_ADDR[6]/RTP_DATA[13] | C4      | Output      |                    |                    |                                                                                                               |                                   |
| EMIF_ADDR[7]/RTP_DATA[12] | C5      | Output      |                    |                    |                                                                                                               |                                   |
| EMIF_ADDR[8]/RTP_DATA[11] | C6      | Output      |                    |                    |                                                                                                               |                                   |
| EMIF_ADDR[9]/RTP_DATA[10] | C7      | Output      |                    |                    |                                                                                                               |                                   |
| EMIF_ADDR[10]/RTP_DATA[9] | C8      | Output      |                    |                    |                                                                                                               |                                   |
| EMIF_ADDR[11]/RTP_DATA[8] | C9      | Output      |                    |                    |                                                                                                               |                                   |
| EMIF_ADDR[12]/RTP_DATA[6] | C10     | Output      |                    |                    |                                                                                                               |                                   |
| EMIF_ADDR[13]/RTP_DATA[5] | C11     | Output      |                    |                    |                                                                                                               |                                   |
| EMIF_ADDR[14]/RTP_DATA[4] | C12     | Output      |                    |                    |                                                                                                               |                                   |
| EMIF_ADDR[15]/RTP_DATA[3] | C13     | Output      |                    |                    |                                                                                                               |                                   |
| EMIF_ADDR[16]/RTP_DATA[2] | D14     | Output      |                    |                    |                                                                                                               |                                   |
| EMIF_ADDR[17]/RTP_DATA[1] | C14     | Output      | Pull Down          | -                  |                                                                                                               |                                   |
| EMIF_ADDR[18]/RTP_DATA[0] | D15     | Output      |                    |                    |                                                                                                               |                                   |
| EMIF_ADDR[19]/RTP_nENA    | C15     | Output      |                    |                    |                                                                                                               |                                   |
| EMIF_ADDR[20]/RTP_nSYNC   | C16     | Output      |                    |                    |                                                                                                               |                                   |
| EMIF_ADDR[21]/RTP_CLK     | C17     | Output      |                    |                    |                                                                                                               |                                   |
| ETMDATA[16]/EMIF_DATA[0]  | K15     | I/O         | Pull Down          | Fixed, 20uA        | EMIF Data                                                                                                     |                                   |
| ETMDATA[17]/EMIF_DATA[1]  | L15     | I/O         |                    |                    |                                                                                                               |                                   |
| ETMDATA[18]/EMIF_DATA[2]  | M15     | I/O         |                    |                    |                                                                                                               |                                   |
| ETMDATA[19]/EMIF_DATA[3]  | N15     | I/O         |                    |                    |                                                                                                               |                                   |
| ETMDATA[20]/EMIF_DATA[4]  | E5      | I/O         |                    |                    |                                                                                                               |                                   |
| ETMDATA[21]/EMIF_DATA[5]  | F5      | I/O         |                    |                    |                                                                                                               |                                   |
| ETMDATA[22]/EMIF_DATA[6]  | G5      | I/O         |                    |                    |                                                                                                               |                                   |
| ETMDATA[23]/EMIF_DATA[7]  | K5      | I/O         |                    |                    |                                                                                                               |                                   |
| ETMDATA[24]/EMIF_DATA[8]  | L5      | I/O         |                    |                    |                                                                                                               |                                   |
| ETMDATA[25]/EMIF_DATA[9]  | M5      | I/O         |                    |                    |                                                                                                               |                                   |
| ETMDATA[26]/EMIF_DATA[10] | N5      | I/O         |                    |                    |                                                                                                               |                                   |
| ETMDATA[27]/EMIF_DATA[11] | P5      | I/O         |                    |                    |                                                                                                               |                                   |
| ETMDATA[28]/EMIF_DATA[12] | R5      | I/O         |                    |                    |                                                                                                               |                                   |
| ETMDATA[29]/EMIF_DATA[13] | R6      | I/O         |                    |                    |                                                                                                               |                                   |
| ETMDATA[30]/EMIF_DATA[14] | R7      | I/O         |                    |                    |                                                                                                               |                                   |
| ETMDATA[31]/EMIF_DATA[15] | R8      | I/O         |                    |                    |                                                                                                               |                                   |

#### 4.1.1.1.13 Embedded Trace Macrocell for Cortex-R4F CPU (ETM-R4F)

**Table 4-15. Embedded Trace Macrocell for Cortex-R4F CPU (ETM-R4F)**

| Pin                       |         | Signal Type | Default Pull State | Pull Type   | Description            |
|---------------------------|---------|-------------|--------------------|-------------|------------------------|
| Signal Name               | 337 GWT |             |                    |             |                        |
| ETMTRACECLKIN/EXTCLKIN2   | R9      | Input       | Pull Down          | Fixed, 20uA | ETM Trace Clock Input  |
| ETMTRACECLKOUT            | R10     | Output      | Pull Down          | -           | ETM Trace Clock Output |
| ETMTRACECTL               | R11     | Output      | Pull Down          | -           | ETM trace control      |
| ETMDATA[0]                | R12     |             |                    |             | ETM data               |
| ETMDATA[1]                | R13     |             |                    |             |                        |
| ETMDATA[2]                | J15     |             |                    |             |                        |
| ETMDATA[3]                | H15     |             |                    |             |                        |
| ETMDATA[4]                | G15     |             |                    |             |                        |
| ETMDATA[5]                | F15     |             |                    |             |                        |
| ETMDATA[6]                | E15     |             |                    |             |                        |
| ETMDATA[7]                | E14     |             |                    |             |                        |
| ETMDATA[8]/EMIF_ADDR[5]   | E9      |             |                    |             |                        |
| ETMDATA[9]/EMIF_ADDR[4]   | E8      |             |                    |             |                        |
| ETMDATA[10]/EMIF_ADDR[3]  | E7      |             |                    |             |                        |
| ETMDATA[11]/EMIF_ADDR[2]  | E6      |             |                    |             |                        |
| ETMDATA[12]/EMIF_BA[0]    | E13     |             |                    |             |                        |
| ETMDATA[13]/EMIF_nOE      | E12     |             |                    |             |                        |
| ETMDATA[14]/EMIF_nDQM[1]  | E11     |             |                    |             |                        |
| ETMDATA[15]/EMIF_nDQM[0]  | E10     |             |                    |             |                        |
| ETMDATA[16]/EMIF_DATA[0]  | K15     |             |                    |             |                        |
| ETMDATA[17]/EMIF_DATA[1]  | L15     |             |                    |             |                        |
| ETMDATA[18]/EMIF_DATA[2]  | M15     |             |                    |             |                        |
| ETMDATA[19]/EMIF_DATA[3]  | N15     |             |                    |             |                        |
| ETMDATA[20]/EMIF_DATA[4]  | E5      |             |                    |             |                        |
| ETMDATA[21]/EMIF_DATA[5]  | F5      |             |                    |             |                        |
| ETMDATA[22]/EMIF_DATA[6]  | G5      |             |                    |             |                        |
| ETMDATA[23]/EMIF_DATA[7]  | K5      |             |                    |             |                        |
| ETMDATA[24]/EMIF_DATA[8]  | L5      |             |                    |             |                        |
| ETMDATA[25]/EMIF_DATA[9]  | M5      |             |                    |             |                        |
| ETMDATA[26]/EMIF_DATA[10] | N5      |             |                    |             |                        |
| ETMDATA[27]/EMIF_DATA[11] | P5      |             |                    |             |                        |
| ETMDATA[28]/EMIF_DATA[12] | R5      |             |                    |             |                        |
| ETMDATA[29]/EMIF_DATA[13] | R6      |             |                    |             |                        |
| ETMDATA[30]/EMIF_DATA[14] | R7      |             |                    |             |                        |
| ETMDATA[31]/EMIF_DATA[15] | R8      |             |                    |             |                        |

#### 4.1.1.1.14 RAM Trace Port (RTP)

**Table 4-16. RAM Trace Port (RTP)**

| Pin                                |         | Signal Type | Default Pull State | Pull Type          | Description                   |
|------------------------------------|---------|-------------|--------------------|--------------------|-------------------------------|
| Signal Name                        | 337 GWT |             |                    |                    |                               |
| EMIF_ADDR[21]/RTP_CLK              | C17     | I/O         | Pull Down          | Programmable, 20uA | RTP packet clock, or GPIO     |
| EMIF_ADDR[19]/RTP_nENA             | C15     | I/O         |                    |                    | RTP packet handshake, or GPIO |
| EMIF_ADDR[20]/RTP_nSYNC            | C16     | I/O         |                    |                    | RTP synchronization, or GPIO  |
| EMIF_ADDR[18]/RTP_DATA[0]          | D15     | I/O         |                    |                    | RTP packet data, or GPIO      |
| EMIF_ADDR[17]/RTP_DATA[1]          | C14     |             |                    |                    |                               |
| EMIF_ADDR[16]/RTP_DATA[2]          | D14     |             |                    |                    |                               |
| EMIF_ADDR[15]/RTP_DATA[3]          | C13     |             |                    |                    |                               |
| EMIF_ADDR[14]/RTP_DATA[4]          | C12     |             |                    |                    |                               |
| EMIF_ADDR[13]/RTP_DATA[5]          | C11     |             |                    |                    |                               |
| EMIF_ADDR[12]/RTP_DATA[6]          | C10     |             |                    |                    |                               |
| EMIF_nCS[4]/RTP_DATA[7]            | M17     |             |                    |                    |                               |
| EMIF_ADDR[11]/RTP_DATA[8]          | C9      |             |                    |                    |                               |
| EMIF_ADDR[10]/RTP_DATA[9]          | C8      |             |                    |                    |                               |
| EMIF_ADDR[9]/RTP_DATA[10]          | C7      |             |                    |                    |                               |
| EMIF_ADDR[8]/RTP_DATA[11]          | C6      |             |                    |                    |                               |
| EMIF_ADDR[7]/RTP_DATA[12]          | C5      |             |                    |                    |                               |
| EMIF_ADDR[6]/RTP_DATA[13]          | C4      |             |                    |                    |                               |
| EMIF_nCS[0]/RTP_DATA[15]/N2HET2[7] | N17     |             |                    |                    |                               |
| EMIF_nCS[3]/RTP_DATA[14]/N2HET2[9] | K17     |             |                    |                    |                               |

#### 4.1.1.1.15 Data Modification Module (DMM)

**Table 4-17. Data Modification Module (DMM)**

| Pin                         |         | Signal Type | Default Pull State | Pull Type          | Description                  |
|-----------------------------|---------|-------------|--------------------|--------------------|------------------------------|
| Signal Name                 | 337 GWT |             |                    |                    |                              |
| DMM_CLK                     | F17     | I/O         | Pull Up            | Programmable, 20uA | DMM clock, or GPIO           |
| DMM_nENA                    | F16     |             |                    |                    | DMM handshake, or GPIO       |
| DMM_SYNC                    | J16     |             |                    |                    | DMM synchronization, or GPIO |
| DMM_DATA[0]                 | L19     |             |                    |                    | DMM data, or GPIO            |
| DMM_DATA[1]                 | L18     |             |                    |                    |                              |
| MIBSPI5NCS[2]/DMM_DATA[2]   | W6      |             |                    |                    |                              |
| MIBSPI5NCS[3]/DMM_DATA[3]   | T12     |             |                    |                    |                              |
| MIBSPI5CLK/DMM_DATA[4]      | H19     |             |                    |                    |                              |
| MIBSPI5NCS[0]/DMM_DATA[5]   | E19     |             |                    |                    |                              |
| MIBSPI5NCS[1]/DMM_DATA[6]   | B6      |             |                    |                    |                              |
| MIBSPI5NENA/DMM_DATA[7]     | H18     |             |                    |                    |                              |
| MIBSPI5SIMO[0]/DMM_DATA[8]  | J19     |             |                    |                    |                              |
| MIBSPI5SIMO[1]/DMM_DATA[9]  | E16     |             |                    |                    |                              |
| MIBSPI5SIMO[2]/DMM_DATA[10] | H17     |             |                    |                    |                              |
| MIBSPI5SIMO[3]/DMM_DATA[11] | G17     |             |                    |                    |                              |
| MIBSPI5SOMI[0]/DMM_DATA[12] | J18     |             |                    |                    |                              |
| MIBSPI5SOMI[1]/DMM_DATA[13] | E17     |             |                    |                    |                              |
| MIBSPI5SOMI[2]/DMM_DATA[14] | H16     |             |                    |                    |                              |
| MIBSPI5SOMI[3]/DMM_DATA[15] | G16     |             |                    |                    |                              |

#### 4.1.1.1.16 System Module Interface

**Table 4-18. GWT System Module Interface**

| Pin         |         | Signal Type | Default Pull State | Pull Type | Description                                                                                                                                                                                                                                                                                                                                                                                                 |
|-------------|---------|-------------|--------------------|-----------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| Signal Name | 337 GWT |             |                    |           |                                                                                                                                                                                                                                                                                                                                                                                                             |
| nPORRST     | W7      | Input       | Pull Down          | 100uA     | Power-on reset, cold reset<br>External power supply monitor circuitry must drive nPORRST low when any of the supplies to the microcontroller fall out of the specified range. This terminal has a glitch filter. See <a href="#">§ 6.8</a> .                                                                                                                                                                |
| nRST        | B17     | I/O         | Pull Up            | 100uA     | System reset, warm reset, bidirectional.<br>The internal circuitry indicates any reset condition by driving nRST low.<br>The external circuitry can assert a system reset by driving nRST low. To ensure that an external reset is not arbitrarily generated, TI recommends that an external pull-up resistor is connected to this terminal. This terminal has a glitch filter. See <a href="#">§ 6.8</a> . |
| nERROR      | B14     | I/O         | Pull Down          | 20uA      | ESM Error Signal<br>Indicates error of high severity. See <a href="#">§ 6.18</a> .                                                                                                                                                                                                                                                                                                                          |

#### 4.1.1.1.17 Clock Inputs and Outputs

**Table 4-19. GWT Clock Inputs and Outputs**

| Pin                              |         | Signal Type | Default Pull State | Pull Type          | Description                                              |
|----------------------------------|---------|-------------|--------------------|--------------------|----------------------------------------------------------|
| Signal Name                      | 337 GWT |             |                    |                    |                                                          |
| OSCIN                            | K1      | Input       | -                  | -                  | From external crystal/resonator, or external clock input |
| KELVIN_GND                       | L2      | Input       |                    |                    | Kelvin ground for oscillator                             |
| OSCOU                            | L1      | Output      |                    |                    | To external crystal/resonator                            |
| ECLK                             | A12     | I/O         | Pull Down          | Programmable, 20uA | External prescaled clock output, or GIO.                 |
| GIOA[5]/EXTCLKIN/N2HET1_PIN_nDIS | B5      | Input       | Pull Down          | 20uA               | External clock input #1                                  |
| ETMTRACECLKIN/EXTCLKIN2          | R9      | Input       |                    |                    | External clock input #2                                  |
| VCCPLL                           | P11     | 1.2V Power  |                    | -                  | Dedicated core supply for PLL's                          |



#### 4.1.1.1.18 Test and Debug Modules Interface

**Table 4-20. GWT Test and Debug Modules Interface**

| Pin         |         | Signal Type | Default Pull State | Pull Type    | Description              |
|-------------|---------|-------------|--------------------|--------------|--------------------------|
| Signal Name | 337 GWT |             |                    |              |                          |
| TEST        | U2      | I/O         | Pull Down          | Fixed, 100uA | Test enable              |
| nTRST       | D18     | Input       |                    |              | JTAG test hardware reset |
| RTCK        | A16     | Output      | -                  | None         | JTAG return test clock   |
| TCK         | B18     | Input       | Pull Down          | Fixed, 100uA | JTAG test clock          |
| TDI         | A17     | I/O         | Pull Up            |              | JTAG test data in        |
| TDO         | C18     | I/O         | Pull Down          |              | JTAG test data out       |
| TMS         | C19     | I/O         | Pull Up            |              | JTAG test select         |

#### 4.1.1.1.19 Flash Supply and Test Pads

**Table 4-21. GWT Flash Supply and Test Pads**

| Pin         |         | Signal Type | Default Pull State | Pull Type | Description                                                                                                                                                                       |
|-------------|---------|-------------|--------------------|-----------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| Signal Name | 337 GWT |             |                    |           |                                                                                                                                                                                   |
| VCCP        | F8      | 3.3V Power  | -                  | None      | Flash pump supply                                                                                                                                                                 |
| FLTP1       | J5      |             |                    |           | Flash test pads. These terminals are reserved for TI use only. For proper operation these terminals must connect only to a test pad or not be connected at all [no connect (NC)]. |
| FLTP2       | H5      |             |                    |           |                                                                                                                                                                                   |

#### 4.1.1.1.20 No Connects

**Table 4-22. No Connects**

| Pin         |         | Signal Type | Default Pull State | Pull Type | Description                                                                                                                                                                                                                                                                                          |
|-------------|---------|-------------|--------------------|-----------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| Signal Name | 337 GWT |             |                    |           |                                                                                                                                                                                                                                                                                                      |
| NC          | A8      | -           | -                  | -         | No Connects. These balls are not connected to any internal logic and can be connected to the PCB ground without affecting the functionality of the device. Any other ball marked as "NC" may be internally connected to some functionality. It is recommended for such balls to be left unconnected. |
| NC          | B8      | -           | -                  | -         |                                                                                                                                                                                                                                                                                                      |
| NC          | B9      | -           | -                  | -         |                                                                                                                                                                                                                                                                                                      |
| NC          | D6      | -           | -                  | -         |                                                                                                                                                                                                                                                                                                      |
| NC          | D7      | -           | -                  | -         |                                                                                                                                                                                                                                                                                                      |
| NC          | D8      | -           | -                  | -         |                                                                                                                                                                                                                                                                                                      |
| NC          | D9      | -           | -                  | -         |                                                                                                                                                                                                                                                                                                      |
| NC          | D10     | -           | -                  | -         |                                                                                                                                                                                                                                                                                                      |
| NC          | D11     | -           | -                  | -         |                                                                                                                                                                                                                                                                                                      |
| NC          | D12     | -           | -                  | -         |                                                                                                                                                                                                                                                                                                      |
| NC          | D13     | -           | -                  | -         |                                                                                                                                                                                                                                                                                                      |
| NC          | E4      | -           | -                  | -         |                                                                                                                                                                                                                                                                                                      |
| NC          | F4      | -           | -                  | -         |                                                                                                                                                                                                                                                                                                      |
| NC          | G4      | -           | -                  | -         |                                                                                                                                                                                                                                                                                                      |
| NC          | K4      | -           | -                  | -         |                                                                                                                                                                                                                                                                                                      |
| NC          | K16     | -           | -                  | -         |                                                                                                                                                                                                                                                                                                      |
| NC          | L4      | -           | -                  | -         |                                                                                                                                                                                                                                                                                                      |
| NC          | L16     | -           | -                  | -         |                                                                                                                                                                                                                                                                                                      |
| NC          | M4      | -           | -                  | -         |                                                                                                                                                                                                                                                                                                      |
| NC          | M16     | -           | -                  | -         |                                                                                                                                                                                                                                                                                                      |
| NC          | N4      | -           | -                  | -         |                                                                                                                                                                                                                                                                                                      |
| NC          | N16     | -           | -                  | -         |                                                                                                                                                                                                                                                                                                      |
| NC          | N18     | -           | -                  | -         |                                                                                                                                                                                                                                                                                                      |
| NC          | P4      | -           | -                  | -         |                                                                                                                                                                                                                                                                                                      |
| NC          | P15     | -           | -                  | -         |                                                                                                                                                                                                                                                                                                      |
| NC          | P16     | -           | -                  | -         |                                                                                                                                                                                                                                                                                                      |
| NC          | P17     | -           | -                  | -         |                                                                                                                                                                                                                                                                                                      |
| NC          | R1      | -           | -                  | -         |                                                                                                                                                                                                                                                                                                      |
| NC          | R14     | -           | -                  | -         |                                                                                                                                                                                                                                                                                                      |
| NC          | R15     | -           | -                  | -         |                                                                                                                                                                                                                                                                                                      |
| NC          | T3      | -           | -                  | -         |                                                                                                                                                                                                                                                                                                      |
| NC          | T4      | -           | -                  | -         |                                                                                                                                                                                                                                                                                                      |
| NC          | T5      | -           | -                  | -         |                                                                                                                                                                                                                                                                                                      |
| NC          | T6      | -           | -                  | -         |                                                                                                                                                                                                                                                                                                      |
| NC          | T7      | -           | -                  | -         |                                                                                                                                                                                                                                                                                                      |
| NC          | T8      | -           | -                  | -         |                                                                                                                                                                                                                                                                                                      |
| NC          | T9      | -           | -                  | -         |                                                                                                                                                                                                                                                                                                      |
| NC          | T10     | -           | -                  | -         |                                                                                                                                                                                                                                                                                                      |
| NC          | T11     | -           | -                  | -         |                                                                                                                                                                                                                                                                                                      |
| NC          | T13     | -           | -                  | -         |                                                                                                                                                                                                                                                                                                      |
| NC          | T14     | -           | -                  | -         |                                                                                                                                                                                                                                                                                                      |
| NC          | U3      | -           | -                  | -         |                                                                                                                                                                                                                                                                                                      |
| NC          | U4      | -           | -                  | -         |                                                                                                                                                                                                                                                                                                      |

Table 4-22. No Connects (continued)

| Pin         |         | Signal Type | Default Pull State | Pull Type | Description                                                                                                                                                                                                                                                                                          |
|-------------|---------|-------------|--------------------|-----------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| Signal Name | 337 GWT |             |                    |           |                                                                                                                                                                                                                                                                                                      |
| NC          | U6      | -           | -                  | -         | No Connects. These balls are not connected to any internal logic and can be connected to the PCB ground without affecting the functionality of the device. Any other ball marked as "NC" may be internally connected to some functionality. It is recommended for such balls to be left unconnected. |
| NC          | U7      | -           | -                  | -         |                                                                                                                                                                                                                                                                                                      |
| NC          | U8      | -           | -                  | -         |                                                                                                                                                                                                                                                                                                      |
| NC          | U9      | -           | -                  | -         |                                                                                                                                                                                                                                                                                                      |
| NC          | U10     | -           | -                  | -         |                                                                                                                                                                                                                                                                                                      |
| NC          | U11     | -           | -                  | -         |                                                                                                                                                                                                                                                                                                      |
| NC          | V3      | -           | -                  | -         |                                                                                                                                                                                                                                                                                                      |
| NC          | V4      | -           | -                  | -         |                                                                                                                                                                                                                                                                                                      |
| NC          | V11     | -           | -                  | -         |                                                                                                                                                                                                                                                                                                      |
| NC          | V12     | -           | -                  | -         |                                                                                                                                                                                                                                                                                                      |
| NC          | W4      | -           | -                  | -         |                                                                                                                                                                                                                                                                                                      |
| NC          | W11     | -           | -                  | -         |                                                                                                                                                                                                                                                                                                      |
| NC          | W12     | -           | -                  | -         |                                                                                                                                                                                                                                                                                                      |
| NC          | W13     | -           | -                  | -         |                                                                                                                                                                                                                                                                                                      |

**4.1.1.1.21 Supply for Core Logic: 1.2V nominal**

Table 4-23. GWT Supply for Core Logic: 1.2V nominal

| Pin         |         | Signal Type | Default Pull State | Pull Type | Description |
|-------------|---------|-------------|--------------------|-----------|-------------|
| Signal Name | 337 GWT |             |                    |           |             |
| VCC         | F9      | 1.2V Power  | -                  | None      | Core supply |
| VCC         | F10     |             |                    |           |             |
| VCC         | H10     |             |                    |           |             |
| VCC         | J14     |             |                    |           |             |
| VCC         | K6      |             |                    |           |             |
| VCC         | K8      |             |                    |           |             |
| VCC         | K12     |             |                    |           |             |
| VCC         | K14     |             |                    |           |             |
| VCC         | L6      |             |                    |           |             |
| VCC         | M10     |             |                    |           |             |
| VCC         | P10     |             |                    |           |             |

#### 4.1.1.1.22 Supply for I/O Cells: 3.3V nominal

**Table 4-24. GWT Supply for I/O Cells: 3.3V nominal**

| Pin         |         | Signal Type | Default Pull State | Pull Type | Description               |
|-------------|---------|-------------|--------------------|-----------|---------------------------|
| Signal Name | 337 GWT |             |                    |           |                           |
| VCCIO       | F6      | 3.3V Power  | -                  | None      | Operating supply for I/Os |
| VCCIO       | F7      |             |                    |           |                           |
| VCCIO       | F11     |             |                    |           |                           |
| VCCIO       | F12     |             |                    |           |                           |
| VCCIO       | F13     |             |                    |           |                           |
| VCCIO       | F14     |             |                    |           |                           |
| VCCIO       | G6      |             |                    |           |                           |
| VCCIO       | G14     |             |                    |           |                           |
| VCCIO       | H6      |             |                    |           |                           |
| VCCIO       | H14     |             |                    |           |                           |
| VCCIO       | J6      |             |                    |           |                           |
| VCCIO       | L14     |             |                    |           |                           |
| VCCIO       | M6      |             |                    |           |                           |
| VCCIO       | M14     |             |                    |           |                           |
| VCCIO       | N6      |             |                    |           |                           |
| VCCIO       | N14     |             |                    |           |                           |
| VCCIO       | P6      |             |                    |           |                           |
| VCCIO       | P7      |             |                    |           |                           |
| VCCIO       | P8      |             |                    |           |                           |
| VCCIO       | P9      |             |                    |           |                           |
| VCCIO       | P12     |             |                    |           |                           |
| VCCIO       | P13     |             |                    |           |                           |
| VCCIO       | P14     |             |                    |           |                           |

#### 4.1.1.1.23 Ground Reference for All Supplies Except VCCAD

**Table 4-25. GWT Ground Reference for All Supplies Except VCCAD**

| Pin         |         | Signal Type | Default Pull State | Pull Type | Description      |
|-------------|---------|-------------|--------------------|-----------|------------------|
| Signal Name | 337 GWT |             |                    |           |                  |
| VSS         | A1      | Ground      | -                  | None      | Ground reference |
| VSS         | A2      |             |                    |           |                  |
| VSS         | A18     |             |                    |           |                  |
| VSS         | A19     |             |                    |           |                  |
| VSS         | B1      |             |                    |           |                  |
| VSS         | B19     |             |                    |           |                  |
| VSS         | H8      |             |                    |           |                  |
| VSS         | H9      |             |                    |           |                  |
| VSS         | H11     |             |                    |           |                  |
| VSS         | H12     |             |                    |           |                  |
| VSS         | J8      |             |                    |           |                  |
| VSS         | J9      |             |                    |           |                  |
| VSS         | J10     |             |                    |           |                  |
| VSS         | J11     |             |                    |           |                  |
| VSS         | J12     |             |                    |           |                  |
| VSS         | K9      |             |                    |           |                  |
| VSS         | K10     |             |                    |           |                  |
| VSS         | K11     |             |                    |           |                  |
| VSS         | L8      |             |                    |           |                  |
| VSS         | L9      |             |                    |           |                  |
| VSS         | L10     |             |                    |           |                  |
| VSS         | L11     |             |                    |           |                  |
| VSS         | L12     |             |                    |           |                  |
| VSS         | M8      |             |                    |           |                  |
| VSS         | M9      |             |                    |           |                  |
| VSS         | M11     |             |                    |           |                  |
| VSS         | M12     |             |                    |           |                  |
| VSS         | V1      |             |                    |           |                  |
| VSS         | W1      |             |                    |           |                  |
| VSS         | W2      |             |                    |           |                  |

## 5 Specifications

### 5.1 Absolute Maximum Ratings

over operating free-air temperature<sup>(1)</sup>

|                     |                                                                                            | MIN  | MAX  | UNIT |
|---------------------|--------------------------------------------------------------------------------------------|------|------|------|
| Supply voltage      | $V_{CC}^{(2)}$                                                                             | −0.3 | 1.43 | V    |
|                     | $V_{CCIO}, V_{CCP}^{(2)}$                                                                  | −0.3 | 4.6  |      |
|                     | $V_{CCAD}$                                                                                 | −0.3 | 5.5  |      |
| Input voltage       | All input pins                                                                             | −0.3 | 4.6  | V    |
|                     | ADC input pins                                                                             | −0.3 | 5.5  |      |
| Input clamp current | $I_{IK}$ ( $V_I < 0$ or $V_I > V_{CCIO}$ )<br>All pins, except AD1IN[23:0] and AD2IN[15:0] | −20  | 20   | mA   |
|                     | $I_{IK}$ ( $V_I < 0$ or $V_I > V_{CCAD}$ )<br>AD1IN[23:0] and AD2IN[15:0]                  | −10  | 10   |      |
|                     | Total                                                                                      | −40  | 40   |      |
| $T_J$               | Operating junction temperature                                                             | −55  | 150  | °C   |
| $T_{stg}$           | Storage temperature                                                                        | −65  | 150  | °C   |

- (1) Stresses beyond those listed under *Absolute Maximum Ratings* may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under *Recommended Operating Conditions* is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
- (2) Maximum-rated conditions for extended periods may affect device reliability. All voltage values are with respect to their associated grounds.

### 5.2 ESD Ratings

|                                   |                                                         | VALUE       | UNIT  |
|-----------------------------------|---------------------------------------------------------|-------------|-------|
| $V_{ESD}$ Electrostatic discharge | Human Body Model (HBM), per AEC Q100-002 <sup>(1)</sup> |             | ±2000 |
|                                   | Charged Device Model (CDM),<br>per AEC Q100-011         | All pins    | ±500  |
|                                   |                                                         | Corner pins | ±750  |

- (1) AEC Q100-002 indicates HBM stressing is done in accordance with the ANSI/ESDA/JEDEC JS-001 specification.

### 5.3 Power-On Hours (POH)

POH is a function of voltage and temperature. Usage at higher voltages and temperatures will result in a reduction in POH to achieve the same reliability performance.<sup>(1)(2)(3)(4)</sup>

| NOMINAL CVDD VOLTAGE (V) | JUNCTION TEMPERATURE ( $T_J$ ) | LIFETIME POH <sup>(5)</sup> |
|--------------------------|--------------------------------|-----------------------------|
| 1.2                      | 105 °C                         | 100K                        |

- (1) This information is provided solely for your convenience and does not extend or modify the warranty provided under TI's standard terms and conditions for TI semiconductor products.
- (2) To avoid significant degradation, the device power-on hours (POH) must be limited to those specified in this table.
- (3) Logic functions and parameter values are not assured out of the range specified in the recommended operating conditions.
- (4) Notations in this table cannot be deemed a warranty or deemed to extend or modify the warranty under TI's standard terms and conditions for TI semiconductor products.
- (5) POH represent device operation under the specified nominal conditions continuously for the duration of the calculated lifetime.

### 5.4 Recommended Operating Conditions

over operating free-air temperature range (unless otherwise noted)<sup>(1)</sup>

|             |                                     | MIN  | NOM     | MAX  | UNIT |
|-------------|-------------------------------------|------|---------|------|------|
| $V_{CC}$    | Digital logic supply voltage (Core) | 1.14 | 1.2     | 1.32 | V    |
| $V_{CCPLL}$ | PLL supply voltage                  | 1.14 | 1.2     | 1.32 | V    |
| $V_{CCIO}$  | Digital logic supply voltage (I/O)  | 3    | 3.3     | 3.6  | V    |
| $V_{CCAD}$  | MibADC supply voltage               | 3    | 3.3/5.0 | 5.25 | V    |
| $V_{CCP}$   | Flash pump supply voltage           | 3    | 3.3     | 3.6  | V    |
| $V_{SS}$    | Digital logic supply ground         |      | 0       |      | V    |

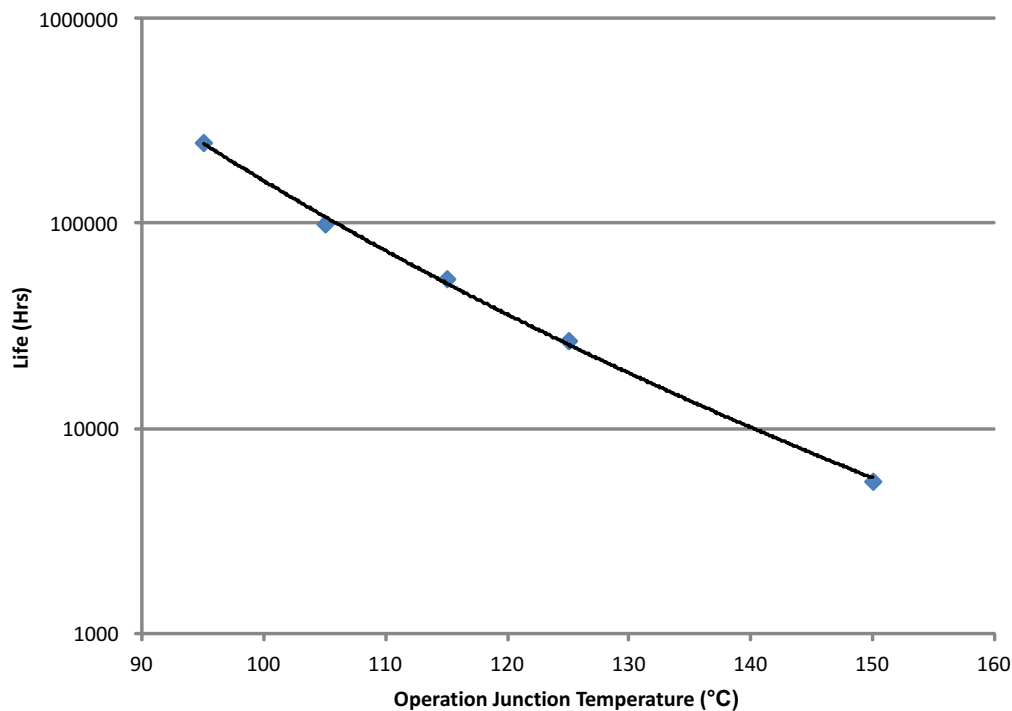
- (1) All voltages are with respect to  $V_{SS}$ , except  $V_{CCAD}$ , which is with respect to  $V_{SSAD}$

## Recommended Operating Conditions (continued)

over operating free-air temperature range (unless otherwise noted)<sup>(1)</sup>

|                      |                                                                                                    | MIN               | NOM | MAX               | UNIT |
|----------------------|----------------------------------------------------------------------------------------------------|-------------------|-----|-------------------|------|
| V <sub>SSAD</sub>    | MibADC supply ground                                                                               | −0.1              |     | 0.1               | V    |
| V <sub>ADREFHI</sub> | A-to-D high-voltage reference source                                                               | V <sub>SSAD</sub> |     | V <sub>CCAD</sub> | V    |
| V <sub>ADREFLO</sub> | A-to-D low-voltage reference source                                                                | V <sub>SSAD</sub> |     | V <sub>CCAD</sub> | V    |
| V <sub>SLEW</sub>    | Maximum positive slew rate for V <sub>CCIO</sub> , V <sub>CCAD</sub> and V <sub>CCP</sub> supplies |                   |     | 1                 | V/μs |
| T <sub>A</sub>       | Operating free-air temperature                                                                     | −55               |     | 125               | °C   |
| T <sub>J</sub>       | Operating junction temperature <sup>(2)</sup>                                                      | −55               |     | 150               | °C   |

- (2) Reliability data is based upon a temperature profile that is equivalent to 100000 power-on hours at 105°C junction temperature. See [图 5-1](#) for more details.



- (1) Silicon operating life design goal is 100000 power-on hours (POH) at 105°C junction temperature (does not include package interconnect life).
- (2) The predicted operating lifetime versus junction temperature is based on reliability modeling using electromigration as the dominant failure mechanism affecting device wearout for the specific device process and design characteristics.

图 5-1. TMS570LS3137-EP Operating Life Derating Chart

## 5.5 Power Consumption

over Recommended Operating Conditions

| PARAMETER           |                                                  | TEST CONDITIONS                                                                                    | MIN | TYP                | MAX                   | UNIT |
|---------------------|--------------------------------------------------|----------------------------------------------------------------------------------------------------|-----|--------------------|-----------------------|------|
| $I_{CC}, I_{CCPLL}$ | $V_{CC}$ Digital supply current (operating mode) | $f_{HCLK} = 180$ MHz<br>$f_{VCLK} = 90$ MHz, Flash in pipelined mode, $V_{CCmax}$                  |     | 220 <sup>(1)</sup> | 440 <sup>(2)</sup>    | mA   |
|                     | $V_{CC}$ Digital supply current (LBIST mode)     | LBIST clock rate = 90 MHz                                                                          |     |                    | 700 <sup>(3)(4)</sup> | mA   |
|                     | $V_{CC}$ Digital supply current (PBIST mode)     | PBIST ROM clock frequency = 90 MHz                                                                 |     |                    | 700 <sup>(3)(4)</sup> | mA   |
|                     | $V_{CC}$ Digital supply current (operating mode) | $f_{HCLK} = 160$ MHz<br>$f_{VCLK} = 80$ MHz, Flash in pipelined mode, $V_{CCmax}$ (–40°C to 125°C) |     | 200 <sup>(1)</sup> | 420 <sup>(2)</sup>    | mA   |
|                     | $V_{CC}$ Digital supply current (LBIST mode)     | LBIST clock rate = 80 MHz (–40°C to 125°C)                                                         |     |                    | 665 <sup>(3)(4)</sup> | mA   |
|                     | $V_{CC}$ Digital supply current (PBIST mode)     | PBIST ROM clock frequency = 80 MHz (–40°C to 125°C)                                                |     |                    | 665 <sup>(3)(4)</sup> | mA   |
| $I_{CCIO}$          | $V_{CCIO}$ supply current (operating mode)       | No DC load, $V_{CCmax}$                                                                            |     |                    | 10                    | mA   |
| $I_{CCAD}$          | $V_{CCAD}$ supply current (operating mode)       | Single ADC operational, $V_{CCADmax}$ (–40°C to 125°C)                                             |     |                    | 15                    | mA   |
|                     |                                                  | Both ADCs operational, $V_{CCADmax}$ (–40°C to 125°C)                                              |     |                    | 30                    |      |
| $I_{ADREFHI}$       | $AD_{REFHI}$ supply current (operating mode)     | Single ADC operational, $AD_{REFHImax}$ (–40°C to 125°C)                                           |     |                    | 3                     | mA   |
|                     |                                                  | Both ADCs operational, $AD_{REFHImax}$                                                             |     |                    | 6                     |      |
| $I_{CCP}$           | $V_{CCP}$ pump supply current                    | Read from 1 bank and program or erase another bank, $V_{CCPmax}$ (–40°C to 125°C)                  |     |                    | 60                    | mA   |

- (1) The typical value is the average current for the nominal process corner and junction temperature of 25°C.
- (2) The maximum  $I_{CC}$  value can be derated
- linearly with voltage
  - by 1 mA/MHz for lower operating frequency when  $f_{HCLK} = 2 \times f_{VCLK}$
  - for lower junction temperature by the equation below where  $T_{JK}$  is the junction temperature in Kelvin and the result is in milliamperes.  

$$235 - 0.15 e^{0.0174 T_{JK}}$$
- (3) The maximum  $I_{CC}$  value can be derated
- linearly with voltage
  - by 1.7 mA/MHz for lower operating frequency when  $f_{HCLK} = 2 \times f_{VCLK}$
  - for lower junction temperature by the equation below where  $T_{JK}$  is the junction temperature in Kelvin and the result is in milliamperes.  

$$235 - 0.15 e^{0.0174 T_{JK}}$$
- (4) LBIST and PBIST currents are for a short duration, typically less than 10 ms. They are usually ignored for thermal calculations for the device and the voltage regulator

## 5.6 Thermal Data

表 5-1 shows the thermal resistance characteristics for the BGA - GWT mechanical package.

**表 5-1. Thermal Resistance Characteristics  
(GWT Package)**

| PARAMETER       | °C/W |
|-----------------|------|
| $R_{\theta JA}$ | 18.8 |
| $R_{\theta JB}$ | 14.1 |
| $R_{\theta JC}$ | 7.1  |



## 5.7 Switching Characteristics

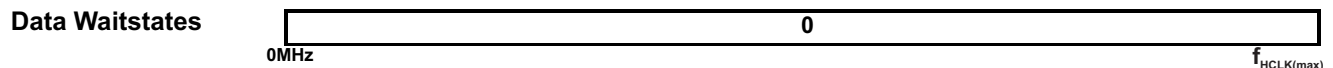
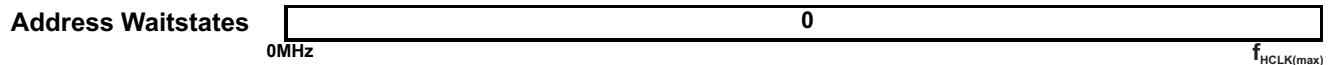
over Recommended Operating Conditions for clock domains

表 5-2. Clock Domain Timing Specifications

| PARAMETER                                                               | TEST CONDITIONS        | MIN | MAX        | UNIT |
|-------------------------------------------------------------------------|------------------------|-----|------------|------|
| $f_{HCLK}$ HCLK - System clock frequency                                | Pipeline mode enabled  |     | 180        | MHz  |
|                                                                         | Pipeline mode disabled |     | 50         |      |
| $f_{GCLK}$ GCLK - CPU clock frequency                                   |                        |     | $f_{HCLK}$ | MHz  |
| $f_{VCLK}$ VCLK - Primary peripheral clock frequency                    |                        |     | 100        | MHz  |
| $f_{VCLK2}$ VCLK2 - Secondary peripheral clock frequency                |                        |     | 100        | MHz  |
| $f_{VCLK3}$ VCLK3 - Secondary peripheral clock frequency                |                        |     | 100        | MHz  |
| $f_{VCLKA1}$ VCLKA1 - Primary asynchronous peripheral clock frequency   |                        |     | 100        | MHz  |
| $f_{VCLKA2}$ VCLKA2 - Secondary asynchronous peripheral clock frequency |                        |     | 100        | MHz  |
| $f_{VCLKA4}$ VCLKA4 - Secondary asynchronous peripheral clock frequency |                        |     | 50         | MHz  |
| $f_{RTICK}$ RTICK - clock frequency                                     |                        |     | $f_{VCLK}$ | MHz  |

## 5.8 Wait States Required

### RAM



### Flash

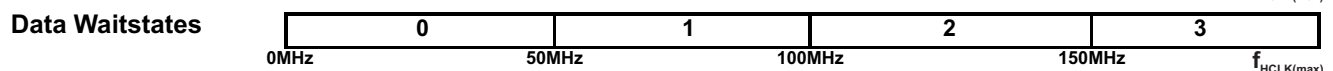
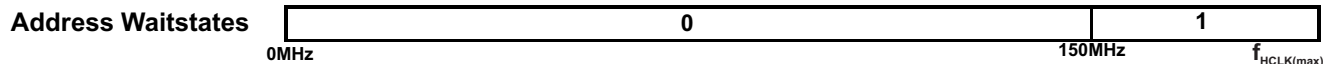


图 5-2. Wait States Scheme

As shown in the figure above, the TCM RAM can support program and data fetches at full CPU speed without any address or data wait states required.

The TCM flash can support zero address and data wait states up to a CPU speed of 50 MHz in non-pipelined mode. The flash supports a maximum CPU clock speed of 180MHz for the GWT package, with one address wait state and three data wait states.

The flash wrapper defaults to non-pipelined mode with zero address wait state and one random-read data wait state.

## 5.9 I/O Electrical Characteristics

over recommended operating conditions<sup>(1)</sup>

| PARAMETER                                            |                                 | TEST CONDITIONS                                                                      | TMS5703137CGWTQEP       |     |                       | TMS5703137CGWTMEP       |                       | UNIT |
|------------------------------------------------------|---------------------------------|--------------------------------------------------------------------------------------|-------------------------|-----|-----------------------|-------------------------|-----------------------|------|
|                                                      |                                 |                                                                                      | MIN                     | TYP | MAX                   | MIN                     | MAX                   |      |
| V <sub>OL</sub> Low-level output voltage             |                                 | I <sub>OL</sub> = I <sub>OLmax</sub>                                                 |                         |     | 0.2 V <sub>CCIO</sub> |                         | 0.2 V <sub>CCIO</sub> | V    |
|                                                      |                                 | I <sub>OL</sub> = 50 μA, standard output mode                                        |                         |     | 0.2                   |                         | 0.2                   |      |
|                                                      |                                 | I <sub>OL</sub> = 50 μA, low-EMI output mode (see 节 5.13)                            |                         |     | 0.2 V <sub>CCIO</sub> |                         | 0.2 V <sub>CCIO</sub> |      |
| V <sub>O<sub>H</sub></sub> High-level output voltage |                                 | I <sub>OH</sub> = I <sub>OHmax</sub>                                                 | 0.8 V <sub>CCIO</sub>   |     |                       | 0.8 V <sub>CCIO</sub>   |                       | V    |
|                                                      |                                 | I <sub>OH</sub> = 50 μA, standard output mode                                        | V <sub>CCIO</sub> – 0.3 |     |                       | V <sub>CCIO</sub> – 0.3 |                       |      |
|                                                      |                                 | I <sub>OH</sub> = 50 μA, low-EMI output mode (see 节 5.13)                            | 0.8 V <sub>CCIO</sub>   |     |                       | 0.8 V <sub>CCIO</sub>   |                       |      |
| I <sub>IC</sub> Input clamp current (I/O pins)       |                                 | V <sub>I</sub> < V <sub>SSIO</sub> - 0.3 or V <sub>I</sub> > V <sub>CCIO</sub> + 0.3 | -3.5 3.5                |     |                       | –3.5 3.5                |                       | mA   |
| I <sub>I</sub> Input current (I/O pins)              | I <sub>IH</sub> Pulldown 20 μA  | V <sub>I</sub> = V <sub>CCIO</sub>                                                   | 5 40                    |     |                       | 40                      |                       | μA   |
|                                                      | I <sub>IH</sub> Pulldown 100 μA | V <sub>I</sub> = V <sub>CCIO</sub>                                                   | 40 195                  |     |                       | 30                      |                       |      |
|                                                      | I <sub>IL</sub> Pullup 20 μA    | V <sub>I</sub> = V <sub>SS</sub>                                                     | -40 -5                  |     |                       | –60 –2                  |                       |      |
|                                                      | I <sub>IL</sub> Pullup 100 μA   | V <sub>I</sub> = V <sub>SS</sub>                                                     | -195 -40                |     |                       |                         |                       |      |
|                                                      | All other pins                  | No pullup or pulldown                                                                | -1 1                    |     |                       | –1.5 1.5                |                       |      |
| C <sub>I</sub> Input capacitance                     |                                 |                                                                                      | 2                       |     |                       |                         |                       | pF   |
| C <sub>O</sub> Output capacitance                    |                                 |                                                                                      | 3                       |     |                       |                         |                       | pF   |

(1) Source currents (out of the device) are negative while sink currents (into the device) are positive.

## 5.10 Output Buffer Drive Strengths

表 5-3. Output Buffer Drive Strengths

| Low-Level Output Current,<br>$I_{OL}$ for $V_I = V_{OLmax}$<br>or<br>High-Level Output Current,<br>$I_{OH}$ for $V_I = V_{OHmin}$ | Signals                                                                                                                                                                                                                                                                                                                          |
|-----------------------------------------------------------------------------------------------------------------------------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 8 mA                                                                                                                              | FRAYTX2, FRAYTX1, FRAYTXEN1, FRAYTXEN2,<br>MIBSPI5CLK, MIBSPI5SOMI[0], MIBSPI5SOMI[1], MIBSPI5SOMI[2], MIBSPI5SOMI[3],<br>MIBSPI5SIMO[0], MIBSPI5SIMO[1], MIBSPI5SIMO[2], MIBSPI5SIMO[3],<br>TMS, TDI, TDO, RTCK,<br>SPI4CLK, SPI4SIMO, SPI4SOMI, nERROR,<br>N2HET2[1], N2HET2[3],<br>All EMIF Outputs and I/Os, All ETM Outputs |
| 4 mA                                                                                                                              | MIBSPI3SOMI, MIBSPI3SIMO, MIBSPI3CLK, MIBSPI1SIMO, MIBSPI1SOMI, MIBSPI1CLK,<br>nRST                                                                                                                                                                                                                                              |

表 5-3. Output Buffer Drive Strengths (continued)

| Low-Level Output Current,<br>$I_{OL}$ for $V_I = V_{OLmax}$<br>or<br>High-Level Output Current,<br>$I_{OH}$ for $V_I = V_{OHmin}$ | Signals                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                              |
|-----------------------------------------------------------------------------------------------------------------------------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 2 mA zero-dominant                                                                                                                | AD1EVT,<br>CAN1RX, CAN1TX, CAN2RX, CAN2TX, CAN3RX, CAN3TX,<br>DMM_CLK, DMM_DATA[0], DMM_DATA[1], DMM_nENA, DMM_SYNC,<br>GIOA[0-7], GIOB[0-7],<br>LINRX, LINTX,<br>MIBSPI1NCS[0], MIBSPI1NCS[1-3], MIBSPI1NENA, MIBSPI3NCS[0-3], MIBSPI3NENA,<br>MIBSPI5NCS[0-3], MIBSPI5NENA,<br>N2HET1[0-31], N2HET2[0], N2HET2[2], N2HET2[4], N2HET2[5], N2HET2[6], N2HET2[7],<br>N2HET2[8], N2HET2[9], N2HET2[10], N2HET2[11], N2HET2[12], N2HET2[13], N2HET2[14],<br>N2HET2[15], N2HET2[16], N2HET2[18],<br>SPI4NCS[0], SPI4NENA |
| selectable 8 mA / 2 mA                                                                                                            | ECLK,<br>SPI2CLK, SPI2SIMO, SPI2SOMI<br>The default output buffer drive strength is 8mA for these signals.                                                                                                                                                                                                                                                                                                                                                                                                           |

表 5-4. Selectable 8 mA/2 mA Control

| Signal   | Control Bit | Address       | 8 mA | 2 mA |
|----------|-------------|---------------|------|------|
| ECLK     | SYSPC10[0]  | 0xFFFF FF78   | 0    | 1    |
| SPI2CLK  | SPI2PC9[9]  | 0xFFFF 7 F668 | 0    | 1    |
| SPI2SIMO | SPI2PC9[10] | 0xFFFF 7 F668 | 0    | 1    |
| SPI2SOMI | SPI2PC9[11] | 0xFFFF 7 F668 | 0    | 1    |

## 5.11 Input Timings



图 5-3. TTL-Level Inputs

表 5-5. Timing Requirements for Inputs<sup>(1)</sup>

|          |                           | MIN            | MAX                      | UNIT |
|----------|---------------------------|----------------|--------------------------|------|
| $t_{pw}$ | Input minimum pulse width | -40°C to 125°C | $t_{c(VCLK)} + 10^{(2)}$ | ns   |

(1)  $t_{c(VCLK)}$  = peripheral VBUS clock cycle time =  $1 / f_{(VCLK)}$

(2) The timing shown above is only valid for pin used in GPIO mode.

## 5.12 Output Timings

**表 5-6. Switching Characteristics for Output Timings versus Load Capacitance ( $C_L$ )**

$C_L = 15\text{ pF}$ ,  $C_L = 50\text{ pF}$ ,  $C_L = 100\text{ pF}$   $T_A = T_J = -40^\circ\text{C}$  to  $125^\circ\text{C}$ , but for  $C_L = 150\text{ pF}$  load  $T_A = T_J = -55^\circ\text{C}$  to  $125^\circ\text{C}$

| PARAMETER                 |                                              |                         | MIN                     | MAX                     | UNIT |    |    |
|---------------------------|----------------------------------------------|-------------------------|-------------------------|-------------------------|------|----|----|
| Rise time, t <sub>r</sub> | 8 mA low EMI pins<br>(see 表 5-3)             | CL = 15 pF              |                         | 2.5                     | ns   |    |    |
|                           |                                              | C <sub>L</sub> = 50 pF  |                         | 4                       |      |    |    |
|                           |                                              | C <sub>L</sub> = 100 pF |                         | 7.2                     |      |    |    |
|                           |                                              | C <sub>L</sub> = 150 pF |                         | 12.5                    |      |    |    |
| Fall time, t <sub>f</sub> |                                              | C <sub>L</sub> = 15 pF  |                         | 2.5                     | ns   |    |    |
|                           |                                              | C <sub>L</sub> = 50 pF  |                         | 4                       |      |    |    |
|                           |                                              | C <sub>L</sub> = 100 pF |                         | 7.2                     |      |    |    |
|                           |                                              | C <sub>L</sub> = 150 pF |                         | 12.5                    |      |    |    |
| Rise time, t <sub>r</sub> | 4 mA low EMI pins<br>(see 表 5-3)             | C <sub>L</sub> = 15 pF  |                         | 5.6                     | ns   |    |    |
|                           |                                              | C <sub>L</sub> = 50 pF  |                         | 10.4                    |      |    |    |
|                           |                                              | C <sub>L</sub> = 100 pF |                         | 16.8                    |      |    |    |
|                           |                                              | C <sub>L</sub> = 150 pF |                         | 23.2                    |      |    |    |
| Fall time, t <sub>f</sub> |                                              | C <sub>L</sub> = 15 pF  |                         | 5.6                     | ns   |    |    |
|                           |                                              | C <sub>L</sub> = 50 pF  |                         | 10.4                    |      |    |    |
|                           |                                              | C <sub>L</sub> = 100 pF |                         | 16.8                    |      |    |    |
|                           |                                              | C <sub>L</sub> = 150 pF |                         | 23.2                    |      |    |    |
| Rise time, t <sub>r</sub> | 2 mA-z low EMI pins<br>(see 表 5-3)           | C <sub>L</sub> = 15 pF  |                         | 8                       | ns   |    |    |
|                           |                                              | C <sub>L</sub> = 50 pF  |                         | 15                      |      |    |    |
|                           |                                              | C <sub>L</sub> = 100 pF |                         | 23                      |      |    |    |
|                           |                                              | C <sub>L</sub> = 150 pF |                         | 33                      |      |    |    |
| Fall time, t <sub>f</sub> |                                              | C <sub>L</sub> = 15 pF  |                         | 8                       | ns   |    |    |
|                           |                                              | C <sub>L</sub> = 50 pF  |                         | 15                      |      |    |    |
|                           |                                              | C <sub>L</sub> = 100 pF |                         | 23                      |      |    |    |
|                           |                                              | C <sub>L</sub> = 150 pF |                         | 33                      |      |    |    |
| Rise time, t <sub>r</sub> | Selectable 8 mA / 2 mA-z pins<br>(see 表 5-3) | 8mA mode                | C <sub>L</sub> = 15 pF  |                         | 2.5  | ns |    |
|                           |                                              |                         | C <sub>L</sub> = 50 pF  |                         | 4    |    |    |
|                           |                                              |                         | C <sub>L</sub> = 100 pF |                         | 7.2  |    |    |
|                           |                                              |                         | C <sub>L</sub> = 150 pF |                         | 12.5 |    |    |
| Fall time, t <sub>f</sub> |                                              | 8mA mode                | C <sub>L</sub> = 15 pF  |                         | 2.5  | ns |    |
|                           |                                              |                         | C <sub>L</sub> = 50 pF  |                         | 4    |    |    |
|                           |                                              |                         | C <sub>L</sub> = 100 pF |                         | 7.2  |    |    |
|                           |                                              |                         | C <sub>L</sub> = 150 pF |                         | 12.5 |    |    |
| Rise time, t <sub>r</sub> |                                              | 2mA-z mode              | C <sub>L</sub> = 15 pF  |                         | 8    | ns |    |
|                           |                                              |                         | C <sub>L</sub> = 50 pF  |                         | 15   |    |    |
|                           |                                              |                         | C <sub>L</sub> = 100 pF |                         | 23   |    |    |
|                           |                                              |                         | C <sub>L</sub> = 150 pF |                         | 33   |    |    |
| Fall time, t <sub>f</sub> |                                              |                         | 2mA-z mode              | C <sub>L</sub> = 15 pF  |      | 8  | ns |
|                           |                                              |                         |                         | C <sub>L</sub> = 50 pF  |      | 15 |    |
|                           |                                              |                         |                         | C <sub>L</sub> = 100 pF |      | 23 |    |
|                           |                                              |                         |                         | C <sub>L</sub> = 150 pF |      | 33 |    |

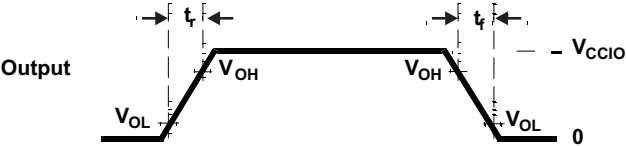


图 5-4. CMOS-Level Outputs

表 5-7. Timing Requirements for Outputs<sup>(1)</sup>

|                               |                                                                                                                                                                                                                           |                | MIN | MAX | UNIT |
|-------------------------------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|----------------|-----|-----|------|
| $t_{d(\text{parallel\_out})}$ | Delay between low to high, or high to low transition of general-purpose output signals that can be configured by an application in parallel, for example, all signals in a GIOA port, or all N2HET1 signals, and so forth | –40°C to 125°C |     | 5   | ns   |

(1) This specification does not account for any output buffer drive strength differences or any external capacitive loading differences. Check [表 5-3](#) for output buffer drive strength information on each signal.

### 5.13 Low-EMI Output Buffers

The low-EMI output buffer has been designed explicitly to address the issue of decoupling sources of emissions from the pins which they drive. This is accomplished by adaptively controlling the impedance of the output buffer, and is particularly effective with capacitive loads.

This is not the default mode of operation of the low-EMI output buffers and must be enabled by setting the system module GPCR1 register for the desired module or signal, as shown in 表 5-8. The adaptive impedance control circuit monitors the DC bias point of the output signal. The buffer internally generates two reference levels, VREFLOW and VREFHIGH, which are set to approximately 10% and 90% of VCCIO, respectively.

Once the output buffer has driven the output to a low level, if the output voltage is below VREFLOW, then the output buffer's impedance will increase to hi-Z. A high degree of decoupling between the internal ground bus and the output pin will occur with capacitive loads, or any load in which no current is flowing, e.g. the buffer is driving low on a resistive path to ground. Current loads on the buffer which attempt to pull the output voltage above VREFLOW will be opposed by the buffer's output impedance so as to maintain the output voltage at or below VREFLOW.

Conversely, once the output buffer has driven the output to a high level, if the output voltage is above VREFHIGH then the output buffer's impedance will again increase to hi-Z. A high degree of decoupling between internal power bus and output pin will occur with capacitive loads or any loads in which no current is flowing, e.g. buffer is driving high on a resistive path to VCCIO. Current loads on the buffer which attempt to pull the output voltage below VREFHIGH will be opposed by the buffer's output impedance so as to maintain the output voltage at or above VREFHIGH.

The bandwidth of the control circuitry is relatively low, so that the output buffer in adaptive impedance control mode cannot respond to high-frequency noise coupling into the buffer's power buses. In this manner, internal bus noise approaching 20% peak-to-peak of VCCIO can be rejected.

Unlike standard output buffers which clamp to the rails, an output buffer in impedance control mode will allow a positive current load to pull the output voltage up to VCCIO + 0.6V without opposition. Also, a negative current load will pull the output voltage down to VSSIO – 0.6V without opposition. This is not an issue since the actual clamp current capability is always greater than the IOH / IOL specifications.

The low-EMI output buffers are automatically configured to be in the standard buffer mode when the device enters a low-power mode.

**表 5-8. Low-EMI Output Buffer Hookup**

| Module or Signal Name | Control Register to Enable Low-EMI Mode |
|-----------------------|-----------------------------------------|
| Module: MibSPI1       | GPREG1.0                                |
|                       | GPREG1.1                                |
| Module: MibSPI3       | GPREG1.2                                |
| Reserved              | GPREG1.3                                |
| Module: MibSPI5       | GPREG1.4                                |
| Signal: TMS           | GPREG1.8                                |
| Signal: TDI           | GPREG1.9                                |
| Signal: TDO           | GPREG1.10                               |
| Signal: RTCK          | GPREG1.11                               |
| Signal: TEST          | GPREG1.12                               |
| Signal: nERROR        | GPREG1.13                               |
| Reserved              | GPREG1.14                               |

## 6 System Information and Electrical Specifications

### 6.1 Device Power Domains

The device core logic is split up into multiple power domains in order to optimize the power for a given application use case. There are 8 core power domains in total: PD1, PD2, PD3, PD4, PD5, RAM\_PD1, RAM\_PD2, and RAM\_PD3.

The actual contents of these power domains are indicated in [节 1.4](#).

PD1 is an "always-ON" power domain, which cannot be turned off. Each of the other core power domains can be turned ON/OFF one time during device initialization as per the application requirement. Refer to the Power Management Module (PMM) chapter of TMS570LS31X/21X Technical Reference Manual ([SPNU499](#)) for more details.

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注

The clocks to a module must be turned off before powering down the core domain that contains the module.

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注

The logic in the modules that are powered down lose power completely. Any access to modules that are powered down results in an abort being generated. When power is restored, the modules power-up to their default states (after normal power-up). No register or memory contents are preserved in the core domains that are turned off.

---

## 6.2 Voltage Monitor Characteristics

A voltage monitor is implemented on this device. The purpose of this voltage monitor is to eliminate the requirement for a specific sequence when powering up the core and I/O voltage supplies.

### 6.2.1 Important Considerations

- The voltage monitor does not eliminate the need of a voltage supervisor circuit to ensure that the device is held in reset when the voltage supplies are out of range.
- The voltage monitor only monitors the core supply (VCC) and the I/O supply (VCCIO). The other supplies are not monitored by the VMON. For example, if the VCCAD or VCCP are supplied from a source different from that for VCCIO, then there is no internal voltage monitor for the VCCAD and VCCP supplies.

### 6.2.2 Voltage Monitor Operation

The voltage monitor generates the Power Good MCU signal (PGMCU) as well as the I/Os Power Good IO signal (PGIO) on the device. During power-up or power-down, the PGMCU and PGIO are driven low when the core or I/O supplies are lower than the specified minimum monitoring thresholds. The PGIO and PGMCU being low isolates the core logic as well as the I/O controls during the power-up or power-down of the supplies. This allows the core and I/O supplies to be powered up or down in any order.

When the voltage monitor detects a low voltage on the I/O supply, it will assert a power-on reset. When the voltage monitor detects an out-of-range voltage on the core supply, it asynchronously makes all output pins high impedance, and asserts a power-on reset. The voltage monitor is disabled when the device enters a low power mode.

The VMON also incorporates a glitch filter for the nPORRST input. Refer to [节 6.3.3.1](#) for the timing information on this glitch filter.

**表 6-1. Voltage Monitoring Specifications**

| PARAMETER        |                                                                      | MIN  | TYP | MAX  | UNIT |
|------------------|----------------------------------------------------------------------|------|-----|------|------|
| V <sub>MON</sub> | VCC low - VCC level below this threshold is detected as too low.     | 0.75 | 0.9 | 1.13 | V    |
|                  | VCC high - VCC level above this threshold is detected as too high.   | 1.40 | 1.7 | 2.1  |      |
|                  | VCCIO low - VCCIO level below this threshold is detected as too low. | 1.85 | 2.4 | 2.9  |      |

### 6.2.3 Supply Filtering

The VMON has the capability to filter glitches on the VCC and VCCIO supplies.

The following table shows the characteristics of the supply filtering. Glitches in the supply larger than the maximum specification cannot be filtered.

**表 6-2. VMON Supply Glitch Filtering Capability**

| PARAMETER                                     | MIN | MAX  | UNIT |
|-----------------------------------------------|-----|------|------|
| Width of glitch on VCC that can be filtered   | 250 | 1000 | ns   |
| Width of glitch on VCCIO that can be filtered | 250 | 1000 |      |



## 6.3 Power Sequencing and Power On Reset

### 6.3.1 Power-Up Sequence

There is no timing dependency between the ramp of the VCCIO and the VCC supply voltage. The power-up sequence starts with the I/O voltage rising above the minimum I/O supply threshold, (see 表 6-4 for more details), core voltage rising above the minimum core supply threshold and the release of power-on reset. The high frequency oscillator will start up first and its amplitude will grow to an acceptable level. The oscillator start up time is dependent on the type of oscillator and is provided by the oscillator vendor. The different supplies to the device can be powered up in any order.

The device goes through the following sequential phases during power up.

表 6-3. Power-Up Phases

| Phases                                 | Oscillator Cycles             |
|----------------------------------------|-------------------------------|
| Oscillator start-up and validity check | 1032 oscillator cycles        |
| eFuse autoload                         | 1180 oscillator cycles        |
| Flash pump power-up                    | 688 oscillator cycles         |
| Flash bank power-up                    | 617 oscillator cycles         |
| <b>Total</b>                           | <b>3517 oscillator cycles</b> |

The CPU reset is released at the end of the above sequence and fetches the first instruction from address 0x00000000.

### 6.3.2 Power-Down Sequence

The different supplies to the device can be powered down in any order.

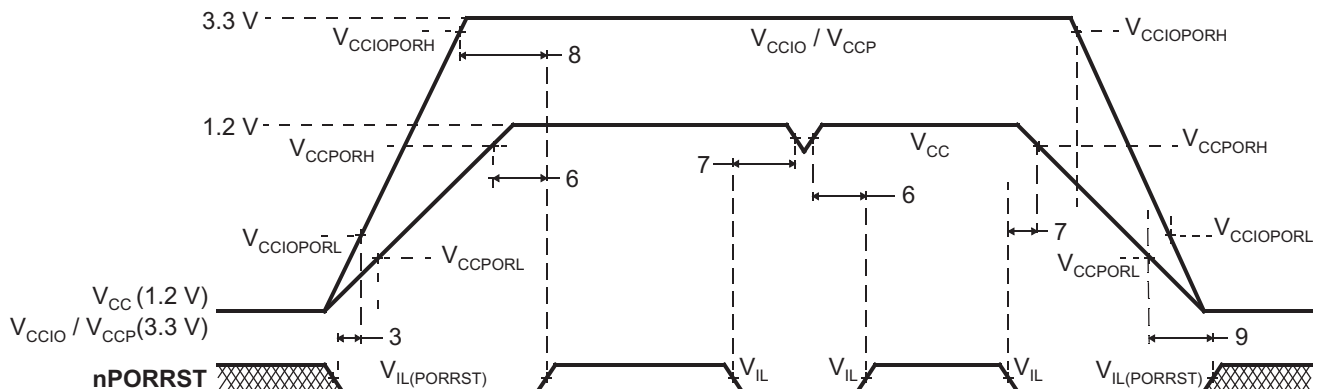
### 6.3.3 Power-On Reset: nPORRST

This is the power-on reset. This reset must be asserted by an external circuitry whenever the I/O or core supplies are outside the specified recommended range. This signal has a glitch filter on it. It also has an internal pulldown.

#### 6.3.3.1 nPORRST Electrical and Timing Requirements

表 6-4. Electrical Requirements for nPORRST

| NO. | PARAMETER        | TEST CONDITIONS                                                                                                            | MIN                   | MAX  | UNIT    |
|-----|------------------|----------------------------------------------------------------------------------------------------------------------------|-----------------------|------|---------|
|     | $V_{CCPORL}$     | $V_{CC}$ low supply level when nPORRST must be active during power-up                                                      |                       | 0.5  | V       |
|     | $V_{CCPORH}$     | $V_{CC}$ high supply level when nPORRST must remain active during power-up and become active during power down             | 1.14                  |      | V       |
|     | $V_{CCIOPORL}$   | $V_{CCIO} / V_{CCP}$ low supply level when nPORRST must be active during power-up                                          |                       | 1.1  | V       |
|     | $V_{CCIOPORH}$   | $V_{CCIO} / V_{CCP}$ high supply level when nPORRST must remain active during power-up and become active during power down | 3.0                   |      | V       |
|     | $V_{IL(PORRST)}$ | Low-level input voltage of nPORRST $V_{CCIO} > 2.5$ V                                                                      | $0.2 \times V_{CCIO}$ |      | V       |
|     |                  | Low-level input voltage of nPORRST $V_{CCIO} < 2.5$ V                                                                      | 0.5                   |      | V       |
| 3   | $t_{su(PORRST)}$ | Setup time, nPORRST active before $V_{CCIO}$ and $V_{CCP} > V_{CCIOPORL}$ during power-up                                  | 0                     |      | ms      |
| 6   | $t_h(PORRST)$    | Hold time, nPORRST active after $V_{CC} > V_{CCPORH}$                                                                      | 1                     |      | ms      |
| 7   | $t_{su(PORRST)}$ | Setup time, nPORRST active before $V_{CC} < V_{CCPORH}$ during power down                                                  | 2                     |      | $\mu$ s |
| 8   | $t_h(PORRST)$    | Hold time, nPORRST active after $V_{CCIO}$ and $V_{CCP} > V_{CCIOPORH}$                                                    | 1                     |      | ms      |
| 9   | $t_h(PORRST)$    | Hold time, nPORRST active after $V_{CC} < V_{CCPORL}$                                                                      | 0                     |      | ms      |
|     | $t_{f(nPORRST)}$ | Filter time nPORRST pin;<br>Pulses less than MIN will be filtered out, pulses greater than MAX will generate a reset.      | 500                   | 2000 | ns      |



NOTE: There is no timing dependency between the ramp of the VCCIO and the VCC supply voltage; this is just an exemplary drawing.

图 6-1. nPORRST Timing Diagram

## 6.4 Warm Reset (nRST)

This is a bidirectional reset signal. The internal circuitry drives the signal low on detecting any device reset condition. An external circuit can assert a device reset by forcing the signal low. On this terminal, the output buffer is implemented as an open drain (drives low only). To ensure an external reset is not arbitrarily generated, TI recommends that an external pullup resistor is connected to this terminal.

This terminal has a glitch filter. It also has an internal pullup

### 6.4.1 Causes of Warm Reset

表 6-5. Causes of Warm Reset

| DEVICE EVENT                        | SYSTEM STATUS FLAG                   |
|-------------------------------------|--------------------------------------|
| Power-Up Reset                      | Exception Status Register, bit 15    |
| Oscillator fail                     | Global Status Register, bit 0        |
| PLL slip                            | Global Status Register, bits 8 and 9 |
| Watchdog exception / Debugger reset | Exception Status Register, bit 13    |
| CPU Reset (driven by the CPU STC)   | Exception Status Register, bit 5     |
| Software Reset                      | Exception Status Register, bit 4     |
| External Reset                      | Exception Status Register, bit 3     |

### 6.4.2 nRST Timing Requirements

表 6-6. nRST Timing Requirements<sup>(1)</sup>

|                      |                                                                                                                   |                | MIN                        | MAX  | UNIT |
|----------------------|-------------------------------------------------------------------------------------------------------------------|----------------|----------------------------|------|------|
| t <sub>V(RST)</sub>  | Valid time, nRST active after nPORRST inactive                                                                    | –40°C to 125°C | 2252 × t <sub>c(OSC)</sub> |      | ns   |
|                      | Valid time, nRST active (all other system reset conditions)                                                       | –40°C to 125°C | 32 × t <sub>c(VCLK)</sub>  |      |      |
| t <sub>f(nRST)</sub> | Filter time nRST pin;<br>Pulses less than MIN will be filtered out, pulses greater than MAX will generate a reset |                | 475                        | 2000 | ns   |

(1) Specified values do NOT include rise/fall times. For rise and fall timings, see 表 5-6.

## 6.5 ARM® Cortex™-R4F CPU Information

### 6.5.1 Summary of ARM Cortex-R4F CPU Features

The features of the ARM Cortex-R4F CPU include:

- An integer unit with integral EmbeddedICE-RT logic
- High-speed Advanced Microprocessor Bus Architecture (AMBA) Advanced eXtensible Interfaces (AXI) for Level two (L2) master and slave interfaces
- Floating Point Coprocessor
- Dynamic branch prediction with a global history buffer, and a 4-entry return stack
- Low interrupt latency
- Non-maskable interrupt
- A Harvard Level one (L1) memory system with:
  - Tightly-Coupled Memory (TCM) interfaces with support for error correction or parity checking memories
  - ARMv7-R architecture Memory Protection Unit (MPU) with 12 regions
- Dual core logic for fault detection in safety-critical applications
- An L2 memory interface:
  - Single 64-bit master AXI interface
  - 64-bit slave AXI interface to TCM RAM blocks
- A debug interface to a CoreSight Debug Access Port (DAP)
- A trace interface to a CoreSight ETM-R4
- A Performance Monitoring Unit (PMU)
- A Vectored Interrupt Controller (VIC) port

For more information on the ARM Cortex-R4F CPU, see [www.arm.com](http://www.arm.com).

### 6.5.2 ARM Cortex-R4F CPU Features Enabled by Software

The following CPU features are disabled on reset and must be enabled by the application if required.

- ECC On Tightly-Coupled Memory (TCM) Accesses
- Hardware Vectored Interrupt (VIC) Port
- Floating Point Coprocessor
- Memory Protection Unit (MPU)

### 6.5.3 Dual Core Implementation

The device has two Cortex-R4F cores, where the output signals of both CPUs are compared in the CCM-R4 unit. To avoid common mode impacts the signals of the CPUs to be compared are delayed by 2 clock cycles as shown in 图 6-3.

The CPUs have a diverse CPU placement given by following requirements:

- Different orientation; for example, CPU1 = "north" orientation, CPU2 = "flip west" orientation
- Dedicated guard ring for each CPU



图 6-2. Dual - CPU Orientation

### 6.5.4 Duplicate Clock Tree After GCLK

The CPU clock domain is split into two clock trees, one for each CPU, with the clock of the 2nd CPU running at the same frequency and in phase to the clock of CPU1. See 图 6-3.

### 6.5.5 ARM Cortex-R4F CPU Compare Module (CCM-R4) for Safety

This device has two ARM Cortex-R4F CPU cores, where the output signals of both CPUs are compared in the CCM-R4 unit. To avoid common mode impacts the signals of the CPUs to be compared are delayed in a different way as shown in the figure below.

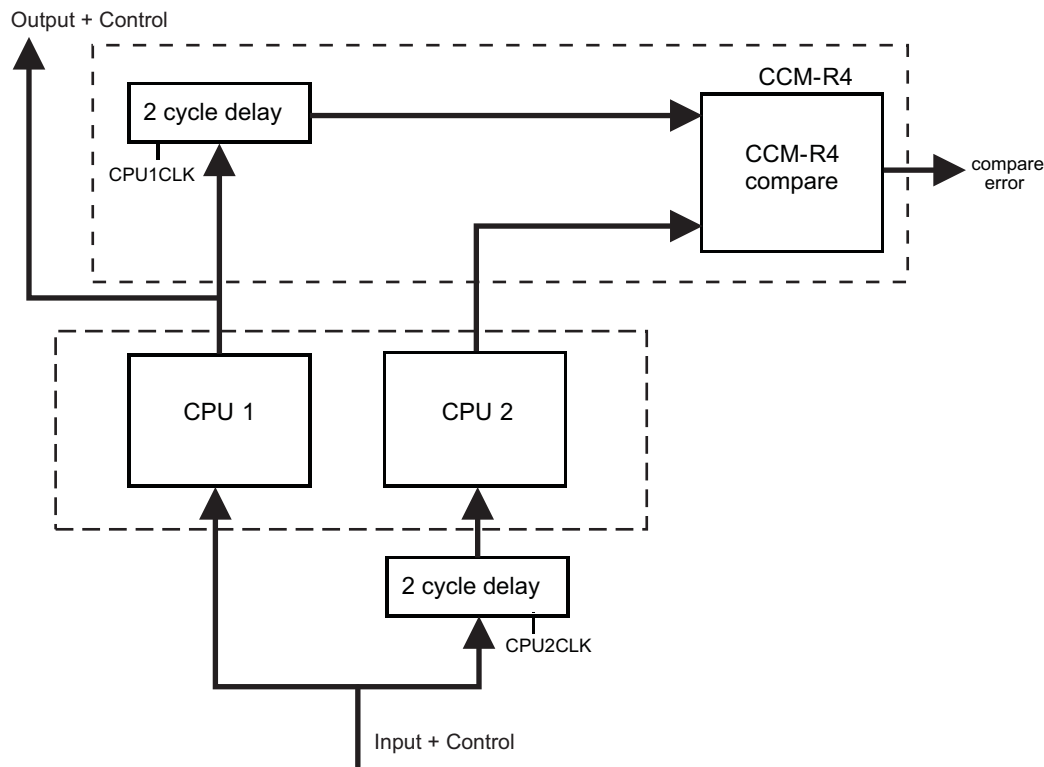


图 6-3. Dual Core Implementation

To avoid an erroneous CCM-R4 compare error, the application software must initialize the registers of both CPUs before the registers are used, including function calls where the register values are pushed onto the stack.

### 6.5.6 CPU Self-Test

The CPU STC (Self-Test Controller) is used to test the two Cortex-R4F CPU Cores using the Deterministic Logic BIST Controller as the test engine.

The main features of the self-test controller are:

- Ability to divide the complete test run into independent test intervals
- Capable of running the complete test as well as running few intervals at a time
- Ability to continue from the last executed interval (test set) as well as ability to restart from the beginning (First test set)
- Complete isolation of the self-tested CPU core from rest of the system during the self-test run
- Ability to capture the Failure interval number
- Timeout counter for the CPU self-test run as a fail-safe feature

### 6.5.6.1 Application Sequence for CPU Self-Test

1. Configure clock domain frequencies.
2. Select number of test intervals to be run.
3. Configure the timeout period for the self-test run.
4. Enable self-test.
5. Wait for CPU reset.
6. In the reset handler, read CPU self-test status to identify any failures.
7. Retrieve CPU state if required.

For more information see the device specific technical reference manual.

### 6.5.6.2 CPU Self-Test Clock Configuration

The maximum clock rate for the self-test is 90MHz. The STCCLK is divided down from the CPU clock. This divider is configured by the STCCLKDIV register at address 0xFFFFE108.

For more information see the device specific technical reference manual.

### 6.5.6.3 CPU Self-Test Coverage

表 6-7 shows CPU test coverage achieved for each self-test interval. It also lists the cumulative test cycles. The test time can be calculated by multiplying the number of test cycles with the STC clock period.

**表 6-7. CPU Self-Test Coverage**

| INTERVALS | TEST COVERAGE (%) | TEST CYCLES |
|-----------|-------------------|-------------|
| 0         | 0                 | 0           |
| 1         | 62.13             | 1365        |
| 2         | 70.09             | 2730        |
| 3         | 74.49             | 4095        |
| 4         | 77.28             | 5460        |
| 5         | 79.28             | 6825        |
| 6         | 80.90             | 8190        |
| 7         | 82.02             | 9555        |
| 8         | 83.10             | 10920       |
| 9         | 84.08             | 12285       |
| 10        | 84.87             | 13650       |
| 11        | 85.59             | 15015       |
| 12        | 86.11             | 16380       |
| 13        | 86.67             | 17745       |
| 14        | 87.16             | 19110       |
| 15        | 87.61             | 20475       |
| 16        | 87.98             | 21840       |
| 17        | 88.38             | 23205       |
| 18        | 88.69             | 24570       |
| 19        | 88.98             | 25935       |
| 20        | 89.28             | 27300       |
| 21        | 89.50             | 28665       |
| 22        | 89.76             | 30030       |
| 23        | 90.01             | 31395       |
| 24        | 90.21             | 32760       |

## 6.6 Clocks

### 6.6.1 Clock Sources

The table below lists the available clock sources on the device. Each of the clock sources can be enabled or disabled using the CSDISx registers in the system module. The clock source number in the table corresponds to the control bit in the CSDISx register for that clock source.

The table also shows the default state of each clock source.

表 6-8. Available Clock Sources

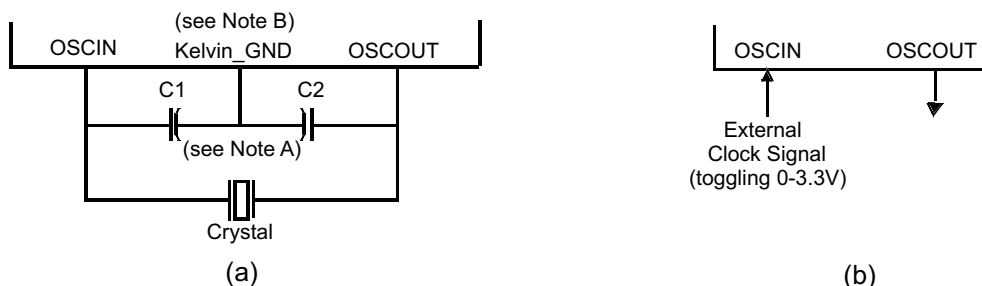
| Clock Source Number | Name      | Description                                            | Default State |
|---------------------|-----------|--------------------------------------------------------|---------------|
| 0                   | OSCIN     | Main oscillator                                        | Enabled       |
| 1                   | PLL1      | Output from PLL1                                       | Disabled      |
| 2                   | Reserved  | Reserved                                               | Disabled      |
| 3                   | EXTCLKIN1 | External clock input 1                                 | Disabled      |
| 4                   | CLK80K    | Low frequency output of internal reference oscillator  | Enabled       |
| 5                   | CLK10M    | High frequency output of internal reference oscillator | Enabled       |
| 6                   | PLL2      | Output from PLL2                                       | Disabled      |
| 7                   | EXTCLKIN2 | External clock input 2                                 | Disabled      |
| 7                   | Reserved  | Reserved                                               | Disabled      |

#### 6.6.1.1 Main Oscillator

The oscillator is enabled by connecting the appropriate fundamental resonator/crystal and load capacitors across the external OSCIN and OSCOUT pins as shown in 图 6-4. The oscillator is a single stage inverter held in bias by an integrated bias resistor. This resistor is disabled during leakage test measurement and low power modes.

**TI strongly encourages each customer to submit samples of the device to the resonator/crystal vendors for validation. The vendors are equipped to determine what load capacitors will best tune their resonator/crystal to the microcontroller device for optimum start-up and operation over temperature/voltage extremes.**

An external oscillator source can be used by connecting a 3.3V clock signal to the OSCIN pin and leaving the OSCOUT pin unconnected (open) as shown in the figure below.



Note A: The values of C1 and C2 should be provided by the resonator/crystal vendor.

Note B: Kelvin\_GND should not be connected to any other GND.

图 6-4. Recommended Crystal/Clock Connection

### 6.6.1.1.1 Timing Requirements for Main Oscillator

表 6-9. Timing Requirements for Main Oscillator

|                   |                                                                       |                | MIN | MAX | UNIT |
|-------------------|-----------------------------------------------------------------------|----------------|-----|-----|------|
| $t_{c(OSC)}$      | Cycle time, OSCIN (when using a sine-wave input)                      |                | 50  | 200 | ns   |
| $t_{c(OSC\_SQR)}$ | Cycle time, OSCIN, (when input to the OSCIN is a square wave)         |                | 50  | 200 | ns   |
| $t_{w(OSCIL)}$    | Pulse duration, OSCIN low (when input to the OSCIN is a square wave)  | –40°C to 125°C | 6   |     | ns   |
| $t_{w(OSCIH)}$    | Pulse duration, OSCIN high (when input to the OSCIN is a square wave) | –40°C to 125°C | 6   |     | ns   |



### 6.6.1.2 Low Power Oscillator (LPO)

The LPO is comprised of two oscillators — HF LPO and LF LPO, in a single macro.

#### 6.6.1.2.1 Features

The main features of the LPO are:

- Supplies a clock at extremely low power for power-saving modes. This is connected as clock source # 4 of the Global Clock Module.
- Supplies a high-frequency clock for non-timing-critical systems. This is connected as clock source # 5 of the Global Clock Module.
- Provides a comparison clock for the crystal oscillator failure detection circuit.

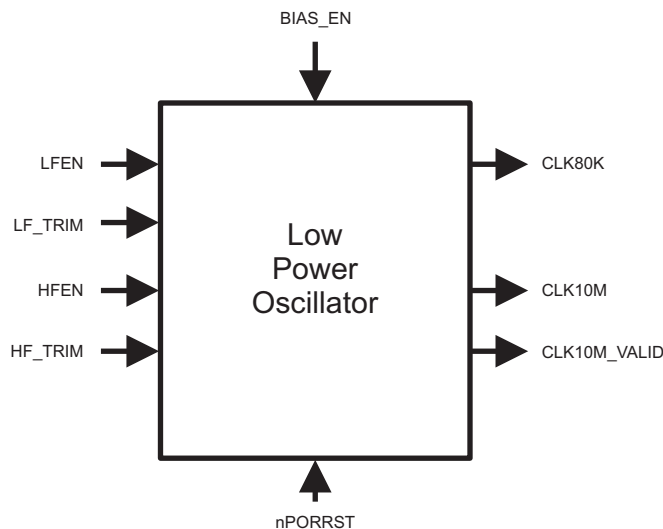


图 6-5. LPO Block Diagram

图 6-5 shows a block diagram of the internal reference oscillator. This is a low power oscillator (LPO) and provides two clock sources: one nominally 80KHz and one nominally 10MHz.

#### 6.6.1.2.2 LPO Electrical and Timing Specifications

表 6-10. LPO Specifications

|                     |                                                                       | MIN | NOM | MAX  | UNIT    |
|---------------------|-----------------------------------------------------------------------|-----|-----|------|---------|
| LPO - HF oscillator | Untrimmed frequency                                                   | 5.5 | 9.6 | 19.5 | MHz     |
|                     | Startup time from STANDBY (LPO BIAS_EN High for at least 900 $\mu$ s) |     |     | 10   | $\mu$ s |
|                     | Cold startup time                                                     |     |     | 900  | $\mu$ s |
| LPO - LF oscillator | Untrimmed frequency                                                   | 36  | 85  | 180  | kHz     |
|                     | Startup time from STANDBY (LPO BIAS_EN High for at least 900 $\mu$ s) |     |     | 100  | $\mu$ s |
|                     | Cold startup time                                                     |     |     | 2000 | $\mu$ s |

### 6.6.1.3 Phase Locked Loop (PLL) Clock Modules

The PLL is used to multiply the input frequency to some higher frequency.

The main features of the PLL are:

- Frequency modulation can be optionally superimposed on the synthesized frequency of PLL1. The frequency modulation capability of PLL2 is permanently disabled.
- Configurable frequency multipliers and dividers.
- Built-in PLL Slip monitoring circuit.
- Option to reset the device on a PLL slip detection.

#### 6.6.1.3.1 Block Diagram

The 图 6-6 shows a high-level block diagram of the two PLL macros on this microcontroller. PLLCTL1 and PLLCTL2 are used to configure the multiplier and dividers for the PLL1. PLLCTL3 is used to configure the multiplier and dividers for PLL2.

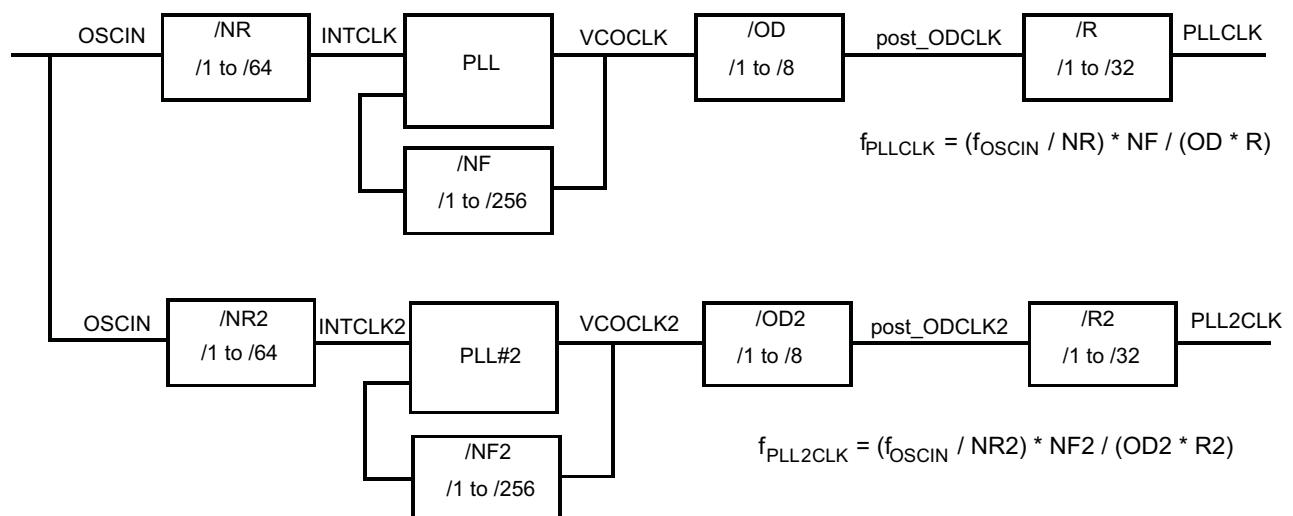


图 6-6. GWT PLLx Block Diagram

#### 6.6.1.3.2 PLL Timing Specifications

表 6-11. PLL Timing Specifications

|                           |                                                         | MIN | MAX | UNIT |
|---------------------------|---------------------------------------------------------|-----|-----|------|
| $f_{\text{INTCLK}}$       | PLL1 reference clock frequency                          | 1   | 20  | MHz  |
| $f_{\text{post\_ODCLK}}$  | Post-ODCLK – PLL1 post-divider input clock frequency    |     | 400 | MHz  |
| $f_{\text{VCOCLK}}$       | VCOCLK – PLL1 output divider (OD) input clock frequency | 150 | 550 | MHz  |
| $f_{\text{INTCLK2}}$      | PLL2 reference clock frequency                          | 1   | 20  | MHz  |
| $f_{\text{post\_ODCLK2}}$ | Post-ODCLK – PLL2 post-divider input clock frequency    |     | 400 | MHz  |
| $f_{\text{VCOCLK2}}$      | VCOCLK – PLL2 output divider (OD) input clock frequency | 150 | 550 | MHz  |

#### 6.6.1.4 External Clock Inputs

The device supports up to two external clock inputs. This clock input must be a square wave input. The electrical and timing requirements for these clock inputs are specified below. The external clock sources are not checked for validity. They are assumed valid when enabled.

表 6-12. External Clock Timing and Electrical Specifications

| PARAMETER                                     | TEST CONDITIONS | MIN  | MAX         | UNIT |
|-----------------------------------------------|-----------------|------|-------------|------|
| $f_{EXTCLKx}$ External clock input frequency  | –40°C to 125°C  |      | 80          | MHz  |
| $t_{w(EXTCLKIN)H}$ EXTCLK high-pulse duration | –40°C to 125°C  | 6    |             | ns   |
| $t_{w(EXTCLKIN)L}$ EXTCLK low-pulse duration  | –40°C to 125°C  | 6    |             | ns   |
| $V_{IL(EXTCLKIN)}$ Low-level input voltage    | –40°C to 125°C  | –0.3 | 0.8         | V    |
| $V_{IH(EXTCLKIN)}$ High-level input voltage   |                 | 2    | VCCIO + 0.3 | V    |

### 6.6.2 Clock Domains

#### 6.6.2.1 Clock Domain Descriptions

表 6-13 lists the device clock domains and their default clock sources. The table also shows the system module control register that is used to select an available clock source for each clock domain.

表 6-13. Clock Domain Descriptions

| Clock Domain Name | Default Clock Source | Clock Source Selection Register | Description                                                                                                                                                                                                                                                                                                                             |
|-------------------|----------------------|---------------------------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| HCLK              | OSCIN                | GHVSR                           | <ul style="list-style-type: none"> <li>Is disabled via the CDDISx registers bit 1</li> <li>Used for all system modules including DMA, ESM</li> </ul>                                                                                                                                                                                    |
| GCLK              | OSCIN                | GHVSR                           | <ul style="list-style-type: none"> <li>Always the same frequency as HCLK</li> <li>In phase with HCLK</li> <li>Is disabled separately from HCLK via the CDDISx registers bit 0</li> <li>Can be divided by 1 up to 8 when running CPU self-test (LBIST) using the CLKDIV field of the STCCLKDIV register at address 0xFFFFE108</li> </ul> |
| GCLK2             | OSCIN                | GHVSR                           | <ul style="list-style-type: none"> <li>Always the same frequency as GCLK</li> <li>2 cycles delayed from GCLK</li> <li>Is disabled along with GCLK</li> <li>Gets divided by the same divider setting as that for GCLK when running CPU self-test (LBIST)</li> </ul>                                                                      |
| VCLK              | OSCIN                | GHVSR                           | <ul style="list-style-type: none"> <li>Divided down from HCLK</li> <li>Can be HCLK/1, HCLK/2, ... or HCLK/16</li> <li>Is disabled separately from HCLK via the CDDISx registers bit 2</li> </ul>                                                                                                                                        |
| VCLK2             | OSCIN                | GHVSR                           | <ul style="list-style-type: none"> <li>Divided down from HCLK</li> <li>Can be HCLK/1, HCLK/2, ... or HCLK/16</li> <li>Frequency must be an integer multiple of VCLK frequency</li> <li>Is disabled separately from HCLK via the CDDISx registers bit 3</li> </ul>                                                                       |
| VCLK3             | OSCIN                | GHVSR                           | <ul style="list-style-type: none"> <li>Divided down from HCLK</li> <li>Can be HCLK/1, HCLK/2, ... or HCLK/16</li> <li>Is disabled separately from HCLK via the CDDISx registers bit 8</li> </ul>                                                                                                                                        |
| VCLKA1            | VCLK                 | VCLKASRC                        | <ul style="list-style-type: none"> <li>Defaults to VCLK as the source</li> <li>Is disabled via the CDDISx registers bit 4</li> </ul>                                                                                                                                                                                                    |
| VCLKA2            | VCLK                 | VCLKASRC                        | <ul style="list-style-type: none"> <li>Defaults to VCLK as the source</li> <li>Is disabled via the CDDISx registers bit 5</li> </ul>                                                                                                                                                                                                    |

**表 6-13. Clock Domain Descriptions (continued)**

| Clock Domain Name | Default Clock Source | Clock Source Selection Register | Description                                                                                                                                                                                                                                                                                                                                                                                                                  |
|-------------------|----------------------|---------------------------------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| VCLKA3_S          | VCLK                 | VCLKACON                        | <ul style="list-style-type: none"> <li>Defaults to VCLK as the source</li> <li>Frequency can be as fast as HCLK frequency.</li> <li>Is disabled via the CDDISx registers bit 10</li> </ul>                                                                                                                                                                                                                                   |
| VCLKA3_DIVR       | VCLK                 | VCLKACON1                       | <ul style="list-style-type: none"> <li>Divided down from the VCLKA3_S using the VCLKA3R field of the VCLKACON1 register at address 0xFFFFE140</li> <li>Frequency can be VCLKA3_S/1, VCLKA3_S/2, ..., or VCLKA3_S/8</li> <li>Default frequency is VCLKA3_S/2</li> <li>Is disabled separately via the VCLKACON1 register VCLKA3_DIV_CDDIS bit only if the VCLKA3_S clock is not disabled</li> </ul>                            |
| VCLKA4            | VCLK                 | VCLKACON1                       | <ul style="list-style-type: none"> <li>Defaults to VCLK as the source</li> <li>Is disabled via the CDDISx registers bit 11</li> </ul>                                                                                                                                                                                                                                                                                        |
| RTICKL            | VCLK                 | RCLKSRC                         | <ul style="list-style-type: none"> <li>Defaults to VCLK as the source</li> <li>If a clock source other than VCLK is selected for RTICKL, then the RTICKL frequency must be less than or equal to VCLK/3 <ul style="list-style-type: none"> <li>Application can ensure this by programming the RTI1DIV field of the RCLKSRC register, if necessary</li> </ul> </li> <li>Is disabled via the CDDISx registers bit 6</li> </ul> |

### 6.6.2.2 Mapping of Clock Domains to Device Modules

Each clock domain has a dedicated functionality as shown in the figures below.

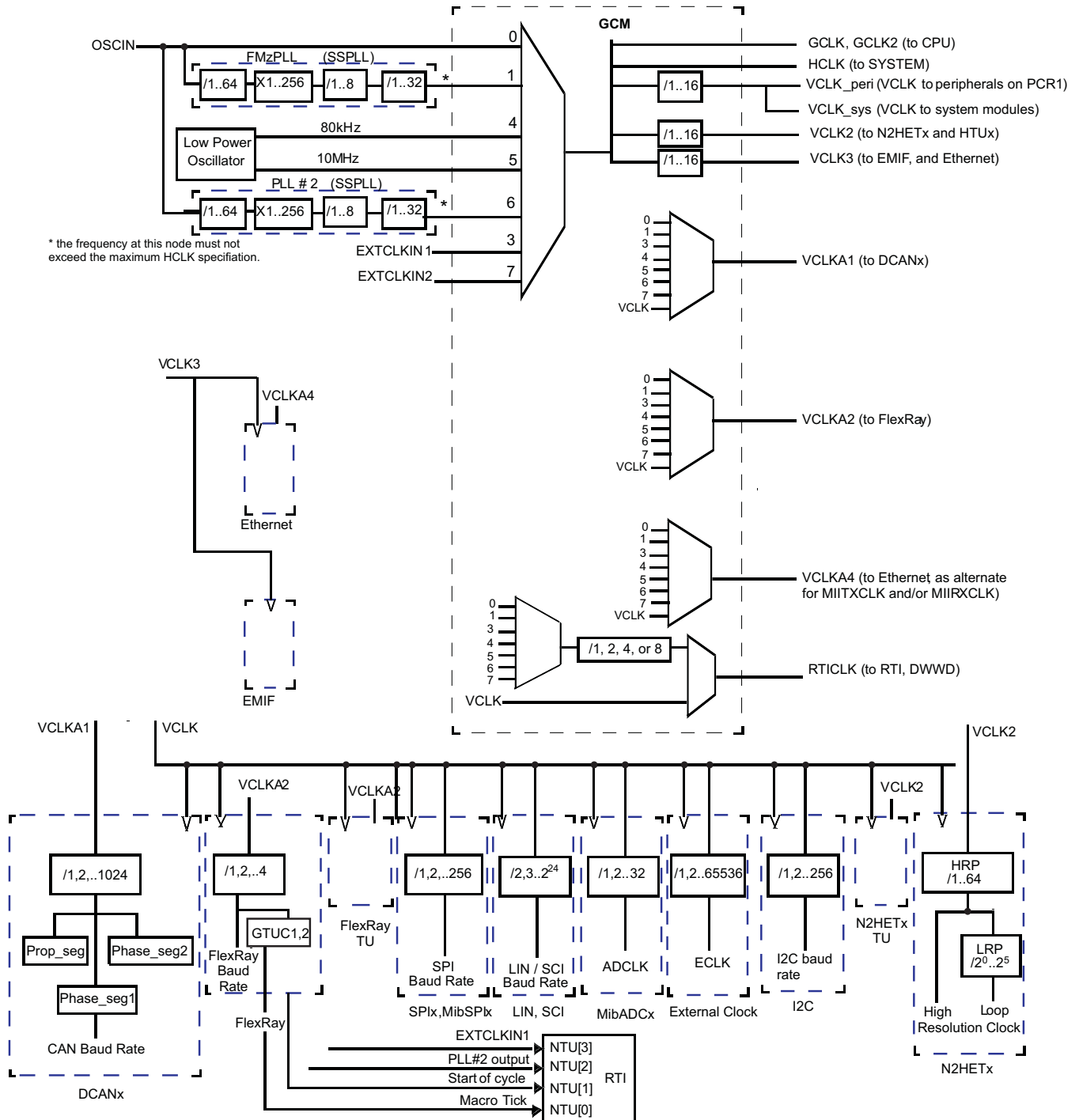


图 6-7. Device Clock Domains

### 6.6.3 Clock Test Mode

The TMS570 platform architecture defines a special mode that allows various clock signals to be brought out on to the ECLK pin and N2HET1[12] device outputs. This mode is called the Clock Test mode. It is very useful for debugging purposes and can be configured via the CLKTEST register in the system module.

表 6-14. Clock Test Mode Options

| SEL_ECP_PIN<br>= CLKTEST[3-0] | SIGNAL ON ECLK                          | SEL_GPIO_PIN<br>= CLKTEST[11-8] | SIGNAL ON N2HET1[12]       |
|-------------------------------|-----------------------------------------|---------------------------------|----------------------------|
| 0000                          | Oscillator                              | 0000                            | Oscillator Valid Status    |
| 0001                          | Main PLL free-running clock output      | 0001                            | Main PLL Valid status      |
| 0010                          | Reserved                                | 0010                            | Reserved                   |
| 0011                          | EXTCLKIN1                               | 0011                            | Reserved                   |
| 0100                          | CLK80K                                  | 0100                            | Reserved                   |
| 0101                          | CLK10M                                  | 0101                            | CLK10M Valid status        |
| 0110                          | Secondary PLL free-running clock output | 0110                            | Secondary PLL Valid Status |
| 0111                          |                                         | 0111                            | Reserved                   |
| 1000                          | GCLK                                    | 1000                            | CLK80K                     |
| 1001                          | RTI Base                                | 1001                            | Reserved                   |
| 1010                          | Reserved                                | 1010                            | Reserved                   |
| 1011                          | VCLKA1                                  | 1011                            | Reserved                   |
| 1100                          | VCLKA2                                  | 1100                            | Reserved                   |
| 1101                          | Reserved                                | 1101                            | Reserved                   |
| 1110                          | VCLKA4                                  | 1110                            | Reserved                   |
| 1111                          | Reserved                                | 1111                            | Reserved                   |

## 6.7 Clock Monitoring

The LPO Clock Detect (LPOCLKDET) module consists of a clock monitor (CLKDET) and an internal low power oscillator (LPO).

The LPO provides two different clock sources – a low frequency (CLK80K) and a high frequency (CLK10M).

The CLKDET is a supervisor circuit for an externally supplied clock signal (OSCIN). In case the OSCIN frequency falls out of a frequency window, the CLKDET flags this condition in the global status register (GLBSTAT bit 0: OSC FAIL) and switches all clock domains sourced by OSCIN to the CLK10M clock (limp mode clock).

The valid OSCIN frequency range is defined as:  $f_{CLK10M} / 4 < f_{OSCIN} < f_{CLK10M} * 4$ .

### 6.7.1 Clock Monitor Timings

表 6-15. LPO and Clock Detection

| PARAMETER           |                                                                          | TEST CONDITIONS | MIN   | NOM  | MAX   | UNIT |
|---------------------|--------------------------------------------------------------------------|-----------------|-------|------|-------|------|
| Clock Detection     | oscillator fail frequency - lower threshold, using untrimmed LPO output  |                 | 1.375 | 2.4  | 4.875 | MHz  |
|                     | oscillator fail frequency - higher threshold, using untrimmed LPO output |                 | 22    | 38.4 | 78    | MHz  |
| LPO - HF oscillator | untrimmed frequency                                                      |                 | 5.5   | 9.6  | 19.5  | MHz  |
|                     | startup time from STANDBY (LPO BIAS_EN High for at least 900ms)          |                 |       |      | 10    | μs   |
|                     | cold startup time                                                        |                 |       |      | 900   | μs   |
|                     | ICC, CLK10M and CLK80K active                                            | –40°C to 125°C  |       |      | 150   | μA   |
| LPO - LF oscillator | untrimmed frequency                                                      |                 | 36    | 85   | 180   | kHz  |
|                     | startup time from STANDBY (LPO BIAS_EN High for at least 900ms)          |                 |       |      | 100   | μs   |
|                     | cold startup time                                                        |                 |       |      | 2000  | μs   |
|                     | ICC, only CLK80K active                                                  | –40°C to 125°C  |       |      | 27    | μA   |
| LPO                 | total ICC STANDBY current                                                | –40°C to 125°C  |       |      | 20    | μA   |

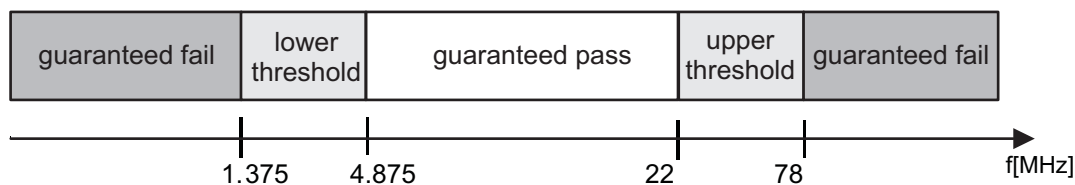


图 6-8. LPO and Clock Detection, Untrimmed CLK10M

### 6.7.2 External Clock (ECLK) Output Functionality

The ECLK pin can be configured to output a pre-scaled clock signal indicative of an internal device clock. This output can be externally monitored as a safety diagnostic.

### 6.7.3 Dual Clock Comparators

The Dual Clock Comparator (DCC) module determines the accuracy of selectable clock sources by counting the pulses of two independent clock sources (counter 0 and counter 1). If one clock is out of spec, an error signal is generated. For example, the DCC1 can be configured to use CLK10M as the reference clock (for counter 0) and VCLK as the "clock under test" (for counter 1). This configuration allows the DCC1 to monitor the PLL output clock when VCLK is using the PLL output as its source.

An additional use of this module is to measure the frequency of a selectable clock source, using the input clock as a reference, by counting the pulses of two independent clock sources. Counter 0 generates a fixed-width counting window after a preprogrammed number of pulses. Counter 1 generates a fixed-width pulse (1 cycle) after a pre-programmed number of pulses. This pulse sets as an error signal if counter 1 does not reach 0 within the counting window generated by counter 0.

### 6.7.3.1 Features

- Takes two different clock sources as input to two independent counter blocks.
- One of the clock sources is the known-good, or reference clock; the second clock source is the "clock under test."
- Each counter block is programmable with initial, or seed values.
- The counter blocks start counting down from their seed values at the same time; a mismatch from the expected frequency for the clock under test generates an error signal which is used to interrupt the CPU.

### 6.7.3.2 Mapping of DCC Clock Source Inputs

**表 6-16. DCC1 Counter 0 Clock Sources**

| CLOCK SOURCE [3:0] | CLOCK NAME         |
|--------------------|--------------------|
| others             | oscillator (OSCIN) |
| 0x5                | high frequency LPO |
| 0xA                | test clock (TCK)   |

**表 6-17. DCC1 Counter 1 Clock Sources**

| KEY [3:0] | CLOCK SOURCE [3:0] | CLOCK NAME                         |
|-----------|--------------------|------------------------------------|
| others    | —                  | N2HET1[31]                         |
| 0xA       | 0x0                | Main PLL free-running clock output |
|           | 0x1                |                                    |
|           | 0x2                | low frequency LPO                  |
|           | 0x3                | high frequency LPO                 |
|           | 0x4                | flash HD pump oscillator           |
|           | 0x5                | EXTCLKIN1                          |
|           | 0x6                |                                    |
|           | 0x7                | ring oscillator                    |
|           | 0x8 - 0xF          | VCLK                               |

**表 6-18. DCC2 Counter 0 Clock Sources**

| CLOCK SOURCE [3:0] | CLOCK NAME         |
|--------------------|--------------------|
| others             | oscillator (OSCIN) |
| 0xA                | test clock (TCK)   |

**表 6-19. DCC2 Counter 1 Clock Sources**

| KEY [3:0] | CLOCK SOURCE [3:0] | CLOCK NAME |
|-----------|--------------------|------------|
| others    | —                  | N2HET2[0]  |
| 0xA       | 00x0 - 0x7         | Reserved   |
|           | 0x8 - 0xF          | VCLK       |



## 6.8 Glitch Filters

A glitch filter is present on the following signals.

表 6-20. Glitch Filter Timing Specifications

| PIN         | PARAMETER                                                                                                                              | TMS5703137CGWTQEP |     |      | TMS5703137CGWTMEP |      | UNIT |
|-------------|----------------------------------------------------------------------------------------------------------------------------------------|-------------------|-----|------|-------------------|------|------|
|             |                                                                                                                                        | MIN               | TYP | MAX  | MIN               | MAX  |      |
| tf(nPORRST) | Filter time nPORRST pin;<br>pulses less than MIN will be filtered out,<br>pulses greater than MAX will generate a reset <sup>(1)</sup> | 500               |     | 2000 | 475               | 2000 | ns   |
| tf(nRST)    | Filter time nRST pin;<br>pulses less than MIN will be filtered out,<br>pulses greater than MAX will generate a reset                   | 475               |     | 2000 | 450               | 2000 | ns   |
| tf(TEST)    | Filter time TEST pin;<br>pulses less than MIN will be filtered out,<br>pulses greater than MAX will pass through                       | 500               |     | 2000 | 475               | 2000 | ns   |

- (1) The glitch filter design on the nPORRST signal is designed such that no size pulse will reset any part of the microcontroller (flash pump, I/O pins, etc.) without also generating a valid reset signal to the CPU.

## 6.9 Device Memory Map

### 6.9.1 Memory Map Diagram

The figure below shows the device memory map.

|            |                                                                         |                                        |                                  |
|------------|-------------------------------------------------------------------------|----------------------------------------|----------------------------------|
| 0xFFFFFFFF | SYSTEM Modules                                                          |                                        | 0xFFFF80000                      |
|            | -----                                                                   |                                        |                                  |
|            | Peripherals - Frame 1                                                   |                                        |                                  |
| 0xFF000000 | CRC                                                                     |                                        |                                  |
| 0xFE000000 | RESERVED                                                                |                                        |                                  |
| 0xFCFFFFFF | Peripherals - Frame 2                                                   |                                        |                                  |
| 0xFC000000 | RESERVED                                                                |                                        |                                  |
| 0xF07FFFFF | Flash Module Bus2 Interface<br><br>(Flash ECC, OTP and EEPROM accesses) |                                        |                                  |
| 0xF0000000 | RESERVED                                                                |                                        |                                  |
| 0x87FFFFFF | EMIF (128MB)                                                            |                                        |                                  |
| 0x80000000 | CS0                                                                     | SDRAM                                  |                                  |
|            | RESERVED                                                                |                                        |                                  |
| 0x6FFFFFFF | reserved<br>CS4<br>CS3<br>CS2                                           | 0x6C000000<br>0x68000000<br>0x64000000 | EMIF (16MB * 3)<br><br>Async RAM |
| 0x60000000 | RESERVED                                                                |                                        |                                  |
|            | RESERVED                                                                |                                        |                                  |
| 0x202FFFFF | Flash (3MB) (Mirrored Image)                                            |                                        |                                  |
| 0x20000000 | RESERVED                                                                |                                        |                                  |
| 0x0843FFFF | RAM - ECC                                                               |                                        |                                  |
| 0x08400000 | RESERVED                                                                |                                        |                                  |
| 0x0803FFFF | RAM (256KB)                                                             |                                        |                                  |
| 0x08000000 | RESERVED                                                                |                                        |                                  |
| 0x002FFFFF | Flash (3MB)                                                             |                                        |                                  |
| 0x00000000 |                                                                         |                                        |                                  |

图 6-9. Memory Map

The Flash memory is mirrored to support ECC logic testing. The base address of the mirrored Flash image is 0x2000 0000.

## 6.9.2 Memory Map Table

表 6-21. Device Memory Map

| Module Name                                        | Frame Chip Select  | Frame Address Range |             | Frame Size | Actual Size | Response for Access to Unimplemented Locations in Frame |
|----------------------------------------------------|--------------------|---------------------|-------------|------------|-------------|---------------------------------------------------------|
|                                                    |                    | Start               | End         |            |             |                                                         |
| Memories Tightly Coupled to the ARM Cortex-R4F CPU |                    |                     |             |            |             |                                                         |
| TCM Flash                                          | CS0                | 0x0000_0000         | 0x00FF_FFFF | 16MB       | 3MB         | Abort                                                   |
| TCM RAM + RAM ECC                                  | CSRAM0             | 0x0800_0000         | 0x0BFF_FFFF | 64MB       | KB          |                                                         |
| Mirrored Flash                                     | Flash mirror frame | 0x2000_0000         | 0x20FF_FFFF | 16MB       | MB          |                                                         |
| External Memory Accesses                           |                    |                     |             |            |             |                                                         |
| EMIF Chip Select 2 (asynchronous)                  | EMIF select 2      | 0x6000_0000         | 0x63FF_FFFF | 64MB       | 16MB        | Access to "Reserved" space will generate Abort          |
| EMIF Chip Select 3 (asynchronous)                  | EMIF select 3      | 0x6400_0000         | 0x67FF_FFFF | 64MB       | 16MB        |                                                         |
| EMIF Chip Select 4 (asynchronous)                  | EMIF select 4      | 0x6800_0000         | 0x6BFF_FFFF | 64MB       | 16MB        |                                                         |
| EMIF Chip Select 0 (synchronous)                   | EMIF select 0      | 0x8000_0000         | 0x87FF_FFFF | 128MB      | 128MB       |                                                         |
| Flash Module Bus2 Interface                        |                    |                     |             |            |             |                                                         |
| Customer OTP, TCM Flash Bank 0                     |                    | 0xF000_0000         | 0xF000_1FFF | 8KB        | 4KB         | Abort                                                   |
| Customer OTP, TCM Flash Bank 1                     |                    | 0xF000_2000         | 0xF000_3FFF | 8KB        | 4KB         |                                                         |
| Customer OTP, EEPROM Bank 7                        |                    | 0xF000_E000         | 0xF000_FFFF | 8KB        | 4KB         |                                                         |
| Customer OTP–ECC, TCM Flash Bank 0                 |                    | 0xF004_0000         | 0xF004_03FF | 1KB        | 512B        |                                                         |
| Customer OTP–ECC, TCM Flash Bank 1                 |                    | 0xF004_0400         | 0xF004_07FF | 1KB        | 512B        |                                                         |
| Customer OTP–ECC, EEPROM Bank 7                    |                    | 0xF004_1C00         | 0xF004_1FFF | 1KB        | 1KB         |                                                         |
| TI OTP, TCM Flash Bank 0                           |                    | 0xF008_0000         | 0xF008_1FFF | 8KB        | 4KB         |                                                         |
| TI OTP, TCM Flash Bank 1                           |                    | 0xF008_2000         | 0xF008_3FFF | 8KB        | 4KB         |                                                         |
| TI OTP, EEPROM Bank 7                              |                    | 0xF008_E000         | 0xF008_FFFF | 8KB        | 4KB         |                                                         |
| TI OTP–ECC, TCM Flash Bank 0                       |                    | 0xF00C_0000         | 0xF00C_03FF | 1KB        | 512B        |                                                         |
| TI OTP–ECC, TCM Flash Bank 1                       |                    | 0xF00C_0400         | 0xF00C_07FF | 1KB        | 512B        |                                                         |
| TI OTP–ECC, EEPROM Bank 7                          |                    | 0xF00C_1C00         | 0xF00C_1FFF | 1KB        | 1KB         |                                                         |
| EEPROM Bank–ECC                                    |                    | 0xF010_0000         | 0xF013_FFFF | 256KB      | 8KB         |                                                         |
| EEPROM Bank                                        |                    | 0xF020_0000         | 0xF03F_FFFF | 2MB        | 64KB        |                                                         |
| Flash Data Space ECC                               |                    | 0xF040_0000         | 0xF04F_FFFF | 1MB        | 384KB       |                                                         |

**表 6-21. Device Memory Map (continued)**

| Module Name                                      | Frame Chip Select | Frame Address Range |             | Frame Size | Actual Size | Response for Access to Unimplemented Locations in Frame                                                                       |
|--------------------------------------------------|-------------------|---------------------|-------------|------------|-------------|-------------------------------------------------------------------------------------------------------------------------------|
|                                                  |                   | Start               | End         |            |             |                                                                                                                               |
| EMIF Slave Interfaces                            |                   |                     |             |            |             |                                                                                                                               |
| CPPI Memory Slave (Ethernet RAM)                 |                   | 0xFC52_0000         | 0xFC52_1FFF | 8KB        | 8KB         | Abort                                                                                                                         |
| EMAC Slave (Ethernet Slave)                      |                   | 0xFCF7_8000         | 0xFCF7_87FF | 2KB        | 2KB         | No error                                                                                                                      |
| EMACSS Wrapper (Ethernet Wrapper)                |                   | 0xFCF7_8800         | 0xFCF7_88FF | 256B       | 256B        | No error                                                                                                                      |
| Ethernet MDIO Interface                          |                   | 0xFCF7_8900         | 0xFCF7_89FF | 256B       | 256B        | No error                                                                                                                      |
| EMIF Registers                                   |                   | 0xFCFF_E800         | 0xFCFF_E8FF | 256B       | 256B        | Abort                                                                                                                         |
| Cyclic Redundancy Checker (CRC) Module Registers |                   |                     |             |            |             |                                                                                                                               |
| CRC                                              | CRC frame         | 0xFE00_0000         | 0xFEFF_FFFF | 16MB       | 512B        | Accesses above 0x200 generate abort.                                                                                          |
| Peripheral Memories                              |                   |                     |             |            |             |                                                                                                                               |
| MIBSPI5 RAM                                      | PCS[5]            | 0xFF0A_0000         | 0xFF0B_FFFF | 128KB      | 2KB         | Abort for accesses above 2KB                                                                                                  |
| MIBSPI3 RAM                                      | PCS[6]            | 0xFF0C_0000         | 0xFF0D_FFFF | 128KB      | 2KB         | Abort for accesses above 2KB                                                                                                  |
| MIBSPI1 RAM                                      | PCS[7]            | 0xFF0E_0000         | 0xFF0F_FFFF | 128KB      | 2KB         | Abort for accesses above 2KB                                                                                                  |
| DCAN3 RAM                                        | PCS[13]           | 0xFF1A_0000         | 0xFF1B_FFFF | 128KB      | 2KB         | Wrap around for accesses to unimplemented address offsets lower than 0x7FF. Abort generated for accesses beyond offset 0x800. |
| DCAN2 RAM                                        | PCS[14]           | 0xFF1C_0000         | 0xFF1D_FFFF | 128KB      | 2KB         | Wrap around for accesses to unimplemented address offsets lower than 0x7FF. Abort generated for accesses beyond offset 0x800. |
| DCAN1 RAM                                        | PCS[15]           | 0xFF1E_0000         | 0xFF1F_FFFF | 128KB      | 2KB         | Wrap around for accesses to unimplemented address offsets lower than 0x7FF. Abort generated for accesses beyond offset 0x800. |
| MIBADC2 RAM                                      | PCS[29]           | 0xFF3A_0000         | 0xFF3B_FFFF | 128KB      | 8KB         | Wrap around for accesses to unimplemented address offsets lower than 0x1FFF. Abort generated for accesses beyond 0x1FFF.      |
| MIBADC1 RAM                                      | PCS[31]           | 0xFF3E_0000         | 0xFF3F_FFFF | 128KB      | 8KB         | Wrap around for accesses to unimplemented address offsets lower than 0x1FFF. Abort generated for accesses beyond 0x1FFF.      |
| N2HET2 RAM                                       | PCS[34]           | 0xFF44_0000         | 0xFF45_FFFF | 128KB      | 16KB        | Wrap around for accesses to unimplemented address offsets lower than 0x3FFF. Abort generated for accesses beyond 0x3FFF.      |
| N2HET1 RAM                                       | PCS[35]           | 0xFF46_0000         | 0xFF47_FFFF | 128KB      | 16KB        | Wrap around for accesses to unimplemented address offsets lower than 0x3FFF. Abort generated for accesses beyond 0x3FFF.      |
| N2HET2 TU2 RAM                                   | PCS[38]           | 0xFF4C_0000         | 0xFF4D_FFFF | 128KB      | 1KB         | Abort                                                                                                                         |
| N2HET1 TU1 RAM                                   | PCS[39]           | 0xFF4E_0000         | 0xFF4F_FFFF | 128KB      | 1KB         | Abort                                                                                                                         |
| FlexRay TU RAM                                   | PCS[40]           | 0xFF50_0000         | 0xFF51_FFFF | 128KB      | 1KB         | Abort                                                                                                                         |
| Debug Components                                 |                   |                     |             |            |             |                                                                                                                               |
| CoreSight Debug ROM                              | CSCS0             | 0xFFA0_0000         | 0xFFA0_0FFF | 4KB        | 4KB         | Reads: 0, writes: no effect                                                                                                   |

表 6-21. Device Memory Map (continued)

| MODULE NAME                                          | FRAME CHIP SELECT | FRAME ADDRESS RANGE |              | FRAME SIZE | ACTUAL SIZE | RESPONSE FOR ACCESS TO UNIMPLEMENTED LOCATIONS IN FRAME                        |
|------------------------------------------------------|-------------------|---------------------|--------------|------------|-------------|--------------------------------------------------------------------------------|
|                                                      |                   | START               | END          |            |             |                                                                                |
| Cortex-R4F Debug                                     | CSCS1             | 0xFFFA0_1000        | 0xFFFA0_1FFF | 4KB        | 4KB         | Reads: 0, writes: no effect                                                    |
| ETM-R4                                               | CSCS2             | 0xFFFA0_2000        | 0xFFFA0_2FFF | 4KB        | 4KB         | Reads: 0, writes: no effect                                                    |
| CoreSight TPIU                                       | CSCS3             | 0xFFFA0_3000        | 0xFFFA0_3FFF | 4KB        | 4KB         | Reads: 0, writes: no effect                                                    |
| POM                                                  | CSCS4             | 0xFFFA0_4000        | 0xFFFA0_4FFF | 4KB        | 4KB         | Abort                                                                          |
| <b>Peripheral Control Registers</b>                  |                   |                     |              |            |             |                                                                                |
| HTU1                                                 | PS[22]            | 0xFFFF7_A400        | 0xFFFF7_A4FF | 256B       | 256B        | Reads: 0, writes: no effect                                                    |
| HTU2                                                 | PS[22]            | 0xFFFF7_A500        | 0xFFFF7_A5FF | 256B       | 256B        | Reads: 0, writes: no effect                                                    |
| N2HET1                                               | PS[17]            | 0xFFFF7_B800        | 0xFFFF7_B8FF | 256B       | 256B        | Reads: 0, writes: no effect                                                    |
| N2HET2                                               | PS[17]            | 0xFFFF7_B900        | 0xFFFF7_B9FF | 256B       | 256B        | Reads: 0, writes: no effect                                                    |
| GPIO                                                 | PS[16]            | 0xFFFF7_BC00        | 0xFFFF7_BCFF | 256B       | 256B        | Reads: 0, writes: no effect                                                    |
| MIBADC1                                              | PS[15]            | 0xFFFF7_C000        | 0xFFFF7_C1FF | 512B       | 512B        | Reads: 0, writes: no effect                                                    |
| MIBADC2                                              | PS[15]            | 0xFFFF7_C200        | 0xFFFF7_C3FF | 512B       | 512B        | Reads: 0, writes: no effect                                                    |
| FlexRay                                              | PS[12]+PS[13]     | 0xFFFF7_C800        | 0xFFFF7_CFFF | 2KB        | 2KB         | Reads: 0, writes: no effect                                                    |
| I2C                                                  | PS[10]            | 0xFFFF7_D400        | 0xFFFF7_D4FF | 256B       | 256B        | Reads: 0, writes: no effect                                                    |
| DCAN1                                                | PS[8]             | 0xFFFF7_DC00        | 0xFFFF7_DFFF | 512B       | 512B        | Reads: 0, writes: no effect                                                    |
| DCAN2                                                | PS[8]             | 0xFFFF7_DE00        | 0xFFFF7_DFFF | 512B       | 512B        | Reads: 0, writes: no effect                                                    |
| DCAN3                                                | PS[7]             | 0xFFFF7_E000        | 0xFFFF7_E1FF | 512B       | 512B        | Reads: 0, writes: no effect                                                    |
| LIN                                                  | PS[6]             | 0xFFFF7_E400        | 0xFFFF7_E4FF | 256B       | 256B        | Reads: 0, writes: no effect                                                    |
| SCI                                                  | PS[6]             | 0xFFFF7_E500        | 0xFFFF7_E5FF | 256B       | 256B        | Reads: 0, writes: no effect                                                    |
| MibSPI1                                              | PS[2]             | 0xFFFF7_F400        | 0xFFFF7_F5FF | 512B       | 512B        | Reads: 0, writes: no effect                                                    |
| SPI2                                                 | PS[2]             | 0xFFFF7_F600        | 0xFFFF7_F7FF | 512B       | 512B        | Reads: 0, writes: no effect                                                    |
| MibSPI3                                              | PS[1]             | 0xFFFF7_F800        | 0xFFFF7_F9FF | 512B       | 512B        | Reads: 0, writes: no effect                                                    |
| SPI4                                                 | PS[1]             | 0xFFFF7_FA00        | 0xFFFF7_FBFF | 512B       | 512B        | Reads: 0, writes: no effect                                                    |
| MibSPI5                                              | PS[0]             | 0xFFFF7_FC00        | 0xFFFF7_FDF  | 512B       | 512B        | Reads: 0, writes: no effect                                                    |
| <b>System Modules Control Registers and Memories</b> |                   |                     |              |            |             |                                                                                |
| DMA RAM                                              | PPCS0             | 0xFFFF8_0000        | 0xFFFF8_0FFF | 4KB        | 4KB         | Abort                                                                          |
| VIM RAM                                              | PPCS2             | 0xFFFF8_2000        | 0xFFFF8_2FFF | 4KB        | 1KB         | Wrap around for accesses to unimplemented address offsets between 1kB and 4kB. |
| RTP RAM                                              | PPCS3             | 0xFFFF8_3000        | 0xFFFF8_3FFF | 4KB        | 4KB         | Abort                                                                          |
| Flash Module                                         | PPCS7             | 0xFFFF8_7000        | 0xFFFF8_7FFF | 4KB        | 4KB         | Abort                                                                          |
| eFuse Controller                                     | PPCS12            | 0xFFFF8_C000        | 0xFFFF8_CFFF | 4KB        | 4KB         | Abort                                                                          |
| Power Management Module (PMM)                        | PPSE0             | 0xFFFFF_0000        | 0xFFFFF_01FF | 512B       | 512B        | Abort                                                                          |
| Test Controller (FMTM)                               | PPSE1             | 0xFFFFF_0400        | 0xFFFFF_07FF | 1KB        | 1KB         | Reads: 0, writes: no effect                                                    |
| PCR registers                                        | PPS0              | 0xFFFFF_E000        | 0xFFFFF_E0FF | 256B       | 256B        | Reads: 0, writes: no effect                                                    |
| System Module - Frame 2 (see device TRM)             | PPS0              | 0xFFFFF_E100        | 0xFFFFF_E1FF | 256B       | 256B        | Reads: 0, writes: no effect                                                    |
| PBIST                                                | PPS1              | 0xFFFFF_E400        | 0xFFFFF_E5FF | 512B       | 512B        | Reads: 0, writes: no effect                                                    |
| STC                                                  | PPS1              | 0xFFFFF_E600        | 0xFFFFF_E6FF | 256B       | 256B        | Generates address error interrupt, if enabled                                  |
| IOMM Multiplexing Control Module                     | PPS2              | 0xFFFFF_EA00        | 0xFFFFF_EBFF | 512B       | 512B        | Reads: 0, writes: no effect                                                    |
| DCC1                                                 | PPS3              | 0xFFFFF_EC00        | 0xFFFFF_ECFF | 256B       | 256B        | Reads: 0, writes: no effect                                                    |

**表 6-21. Device Memory Map (continued)**

| MODULE NAME                              | FRAME CHIP SELECT | FRAME ADDRESS RANGE |             | FRAME SIZE | ACTUAL SIZE | RESPONSE FOR ACCESS TO UNIMPLEMENTED LOCATIONS IN FRAME |
|------------------------------------------|-------------------|---------------------|-------------|------------|-------------|---------------------------------------------------------|
|                                          |                   | START               | END         |            |             |                                                         |
| DMA                                      | PPS4              | 0xFFFF_F000         | 0xFFFF_F3FF | 1KB        | 1KB         | Reads: 0, writes: no effect                             |
| DCC2                                     | PPS5              | 0xFFFF_F400         | 0xFFFF_F4FF | 256B       | 256B        | Reads: 0, writes: no effect                             |
| ESM                                      | PPS5              | 0xFFFF_F500         | 0xFFFF_F5FF | 256B       | 256B        | Reads: 0, writes: no effect                             |
| CCMR4                                    | PPS5              | 0xFFFF_F600         | 0xFFFF_F6FF | 256B       | 256B        | Reads: 0, writes: no effect                             |
| DMM                                      | PPS5              | 0xFFFF_F700         | 0xFFFF_F7FF | 256B       | 256B        | Reads: 0, writes: no effect                             |
| RAM ECC even                             | PPS6              | 0xFFFF_F800         | 0xFFFF_F8FF | 256B       | 256B        | Reads: 0, writes: no effect                             |
| RAM ECC odd                              | PPS6              | 0xFFFF_F900         | 0xFFFF_F9FF | 256B       | 256B        | Reads: 0, writes: no effect                             |
| RTI + DWWD                               | PPS7              | 0xFFFF_FC00         | 0xFFFF_FCFE | 256B       | 256B        | Reads: 0, writes: no effect                             |
| VIM Parity                               | PPS7              | 0xFFFF_FD00         | 0xFFFF_FDFF | 256B       | 256B        | Reads: 0, writes: no effect                             |
| VIM                                      | PPS7              | 0xFFFF_FE00         | 0xFFFF_FEFF | 256B       | 256B        | Reads: 0, writes: no effect                             |
| System Module - Frame 1 (see device TRM) | PPS7              | 0xFFFF_FF00         | 0xFFFF_FFFF | 256B       | 256B        | Reads: 0, writes: no effect                             |

### 6.9.3 Master/Slave Access Privileges

The table below lists the access permissions for each bus master on the device. A bus master is a module that can initiate a read or a write transaction on the device.

Each slave module on the main interconnect is listed in the table. A "Yes" indicates that the module listed in the "MASTERS" column can access that slave module.

表 6-22. Master / Slave Access Matrix

| MASTERS   | ACCESS MODE    | SLAVES ON MAIN SCR                                          |                                                             |     |                     |                                                                                                                      |
|-----------|----------------|-------------------------------------------------------------|-------------------------------------------------------------|-----|---------------------|----------------------------------------------------------------------------------------------------------------------|
|           |                | Flash Module<br>Bus2 Interface:<br>OTP, ECC,<br>EEPROM Bank | Non-CPU<br>Accesses to<br>Program Flash and<br>CPU Data RAM | CRC | Slave<br>Interfaces | Peripheral Control Registers,<br>All Peripheral Memories, and<br>All System Module Control<br>Registers and Memories |
| CPU READ  | User/Privilege | Yes                                                         | Yes                                                         | Yes | Yes                 | Yes                                                                                                                  |
| CPU WRITE | User/Privilege | No                                                          | Yes                                                         | Yes | Yes                 | Yes                                                                                                                  |
| DMA       | User           | Yes                                                         | Yes                                                         | Yes | Yes                 | Yes                                                                                                                  |
| POM       | User           | Yes                                                         | Yes                                                         | Yes | Yes                 | Yes                                                                                                                  |
| DAP       | Privilege      | Yes                                                         | Yes                                                         | Yes | Yes                 | Yes                                                                                                                  |
| HTU1      | Privilege      | No                                                          | Yes                                                         | Yes | Yes                 | Yes                                                                                                                  |
| HTU2      | Privilege      | No                                                          | Yes                                                         | Yes | Yes                 | Yes                                                                                                                  |

#### 6.9.3.1 Special Notes on Accesses to Certain Slaves

Write accesses to the Power Domain Management Module (PMM) control registers are limited to the CPU (master id = 1). The other masters can only read from these registers.

A debugger can also write to the PMM registers. The master-id check is disabled in debug mode.

The device contains dedicated logic to generate a bus error response on any access to a module that is in a power domain that has been turned OFF.

#### **6.9.4 POM Overlay Considerations**

- The POM overlay can map onto up to 8MB of the internal or external memory space. The starting address and the size of the memory overlay are configurable via the POM module control registers. Care must be taken to ensure that the overlay is mapped on to available memory.
- ECC must be disabled by software via CP15 in case POM overlay is enabled; otherwise ECC errors will be generated.
- POM overlay must not be enabled when the flash and internal RAM memories are swapped via the MEM SWAP field of the Bus Matrix Module Control Register 1 (BMMCR1).
- When POM is used to overlay the flash onto internal or external RAM, there is a bus contention possibility when another master accesses the TCM flash. This results in a system hang.
  - The POM module implements a timeout feature to detect this exact scenario. The timeout needs to be enabled whenever POM overlay is enabled.
  - The timeout can be enabled by writing 1010 to the Enable TimeOut (ETO) field of the POM Global Control register (POMGLBCTRL, address = 0xFFA04000).
  - In case a read request by the POM cannot be completed within 32 HCLK cycles, the timeout (TO) flag is set in the POM Flag register (POMFLG, address = 0xFFA0400C). Also, an abort is generated to the CPU. This can be a prefetch abort for an instruction fetch or a data abort for a data fetch.
  - The prefetch- and data-abort handlers must be modified to check if the TO flag in the POM module is set. If so, then the application can assume that the timeout is caused by a bus contention between the POM transaction and another master accessing the same memory region. The abort handlers need to clear the TO flag, so that any further aborts are not misinterpreted as having been caused due to a timeout from the POM.



## 6.10 Flash Memory

### 6.10.1 Flash Memory Configuration

**Flash Bank:** A separate block of logic consisting of 1 to 16 sectors. Each flash bank normally has a customer-OTP and a TI-OTP area. These flash sectors share input/output buffers, data paths, sense amplifiers, and control logic.

**Flash Sector:** A contiguous region of flash memory which must be erased simultaneously due to physical construction constraints.

**Flash Pump:** A charge pump which generates all the voltages required for reading, programming, or erasing the flash banks.

**Flash Module:** Interface circuitry required between the host CPU and the flash banks and pump module.

表 6-23. Flash Memory Banks and Sectors

| Memory Arrays (or Banks) <sup>(1)</sup>                 | Sector No. | Segment    | Low Address | High Address |
|---------------------------------------------------------|------------|------------|-------------|--------------|
| BANK0 (1.5MBytes)                                       | 0          | 32K Bytes  | 0x0000_0000 | 0x0000_7FFF  |
|                                                         | 1          | 32K Bytes  | 0x0000_8000 | 0x0000_FFFF  |
|                                                         | 2          | 32K Bytes  | 0x0001_0000 | 0x0001_7FFF  |
|                                                         | 3          | 32K Bytes  | 0x0001_8000 | 0x0001_FFFF  |
|                                                         | 4          | 128K Bytes | 0x0002_0000 | 0x0003_FFFF  |
|                                                         | 5          | 128K Bytes | 0x0004_0000 | 0x0005_FFFF  |
|                                                         | 6          | 128K Bytes | 0x0006_0000 | 0x0007_FFFF  |
|                                                         | 7          | 128K Bytes | 0x0008_0000 | 0x0009_FFFF  |
|                                                         | 8          | 128K Bytes | 0x000A_0000 | 0x000B_FFFF  |
|                                                         | 9          | 128K Bytes | 0x000C_0000 | 0x000D_FFFF  |
|                                                         | 10         | 128K Bytes | 0x000E_0000 | 0x000F_FFFF  |
|                                                         | 11         | 128K Bytes | 0x0010_0000 | 0x0011_FFFF  |
|                                                         | 12         | 128K Bytes | 0x0012_0000 | 0x0013_FFFF  |
|                                                         | 13         | 128K Bytes | 0x0014_0000 | 0x0015_FFFF  |
|                                                         | 14         | 128K Bytes | 0x0016_0000 | 0x0017_FFFF  |
| BANK1 (1.5MBytes)                                       | 0          | 128K Bytes | 0x0018_0000 | 0x0019_FFFF  |
|                                                         | 1          | 128K Bytes | 0x001A_0000 | 0x001B_FFFF  |
|                                                         | 2          | 128K Bytes | 0x001C_0000 | 0x001D_FFFF  |
|                                                         | 3          | 128K Bytes | 0x001E_0000 | 0x001F_FFFF  |
|                                                         | 4          | 128K Bytes | 0x0020_0000 | 0x0021_FFFF  |
|                                                         | 5          | 128K Bytes | 0x0022_0000 | 0x0023_FFFF  |
|                                                         | 6          | 128K Bytes | 0x0024_0000 | 0x0025_FFFF  |
|                                                         | 7          | 128K Bytes | 0x0026_0000 | 0x0027_FFFF  |
|                                                         | 8          | 128K Bytes | 0x0028_0000 | 0x0029_FFFF  |
|                                                         | 9          | 128K Bytes | 0x002A_0000 | 0x002B_FFFF  |
|                                                         | 10         | 128K Bytes | 0x002C_0000 | 0x002D_FFFF  |
|                                                         | 11         | 128K Bytes | 0x002E_0000 | 0x002F_FFFF  |
| BANK7 (64kBytes) for EEPROM emulation <sup>(2)(3)</sup> | 0          | 16K Bytes  | 0xF020_0000 | 0xF020_3FFF  |
|                                                         | 1          | 16K Bytes  | 0xF020_4000 | 0xF020_7FFF  |
|                                                         | 2          | 16K Bytes  | 0xF020_8000 | 0xF020_BFFF  |
|                                                         | 3          | 16K Bytes  | 0xF020_C000 | 0xF020_FFFF  |

(1) The Flash banks are 144-bit wide bank with ECC support.

(2) The flash bank7 can be programmed while executing code from flash bank0 or bank1.

(3) Code execution is not allowed from flash bank7.

### 6.10.2 Main Features of Flash Module

- Support for multiple flash banks for program and/or data storage
- Simultaneous read access on a bank while performing program or erase operation on any other bank
- Integrated state machines to automate flash erase and program operations
- Software interface for flash program and erase operations
- Pipelined mode operation to improve instruction access interface bandwidth
- Support for Single Error Correction Double Error Detection (SECCDED) block inside Cortex-R4F CPU
  - Error address is captured for host system debugging
- Support for a rich set of diagnostic features

### 6.10.3 ECC Protection for Flash Accesses

All accesses to the program flash memory are protected by Single Error Correction Double Error Detection (SECCDED) logic embedded inside the CPU. The flash module provides 8 bits of ECC code for 64 bits of instructions or data fetched from the flash memory. The CPU calculates the expected ECC code based on the 64 bits received and compares it with the ECC code returned by the flash module. A single-bit error is corrected and flagged by the CPU, while a multi-bit error is only flagged. The CPU signals an ECC error via its Event bus. This signaling mechanism is not enabled by default and must be enabled by setting the "X" bit of the Performance Monitor Control Register, c9.

```
MRC p15, #0, r1, c9, c12, #0      ;Enabling Event monitor states
ORR r1, r1, #0x00000010
MCR p15, #0, r1, c9, c12, #0      ;Set 4th bit ('X') of PMNC register
MRC p15, #0, r1, c9, c12, #0
```

The application must also explicitly enable the CPU's ECC checking for accesses on the CPU's ATCM and BTCM interfaces. These are connected to the program flash and data RAM respectively. ECC checking for these interfaces can be done by setting the B1TCMPCEN, B0TCMPCEN and ATCMPCEN bits of the System Control coprocessor's Auxiliary Control Register, c1.

```
MRC p15, #0, r1, c1, c0, #1
ORR r1, r1, #0x0e000000           ;Enable ECC checking for ATCM and BTCMs
DMB
MCR p15, #0, r1, c1, c0, #1
```

### 6.10.4 Flash Access Speeds

For information on flash memory access speeds and the relevant wait states required, refer to [节 5.8](#).

### 6.10.5 Flash Program and Erase Timings for Program Flash

表 6-24. Timing Specifications for Program Flash

|                             |                                        |                                  | MIN | NOM  | MAX  | UNIT   |
|-----------------------------|----------------------------------------|----------------------------------|-----|------|------|--------|
| t <sub>prog</sub> (144 bit) | Wide Word (144 bit) programming time   |                                  |     | 40   | 300  | μs     |
| t <sub>prog</sub> (Total)   | 3MByte programming time <sup>(1)</sup> | -40°C to 125°C                   |     |      | 32   | s      |
|                             |                                        | 0°C to 60°C, for first 25 cycles |     | 8    | 16   | s      |
| t <sub>erase</sub>          | Sector/Bank erase time <sup>(2)</sup>  | -40°C to 125°C                   |     | 0.03 | 4    | s      |
|                             |                                        | 0°C to 60°C, for first 25 cycles |     | 16   | 100  | ms     |
| t <sub>wec</sub>            | Write/erase cycles                     | -40°C to 125°C                   |     |      | 1000 | cycles |
| t <sub>ret</sub>            | Data retention <sup>(3)</sup>          | 125°C                            |     |      | 5    | years  |

- (1) This programming time includes overhead of state machine, but does not include data transfer time. The programming time assumes programming 144 bits at a time at the maximum specified operating frequency.
- (2) During bank erase, the selected sectors are erased simultaneously. The time to erase the bank is specified as equal to the time to erase a sector.
- (3) The data retention specification is based on process qualification testing at 250°C for 168 hours and using an Arrhenius model with activation energy of 0.8 eV.

## 6.10.6 Flash Program and Erase Timings for Data Flash

表 6-25. Timing Specifications for Data Flash

|                             |                                       |                                  | MIN | NOM | MAX    | UNIT          |
|-----------------------------|---------------------------------------|----------------------------------|-----|-----|--------|---------------|
| $t_{\text{prog}}$ (144 bit) | Wide Word (144 bit) programming time  |                                  |     | 40  | 300    | $\mu\text{s}$ |
| $t_{\text{prog}}$ (Total)   | 64KB programming time <sup>(1)</sup>  | -40°C to 125°C                   |     |     | 660    | ms            |
|                             |                                       | 0°C to 60°C, for first 25 cycles |     | 165 | 330    | ms            |
| $t_{\text{erase}}$          | Sector/Bank erase time <sup>(2)</sup> | --40°C to 125°C                  |     | 0.2 | 8      | s             |
|                             |                                       | 0°C to 60°C, for first 25 cycles |     | 14  | 100    | ms            |
| $t_{\text{wec}}$            | Write/erase cycles                    | -40°C to 125°C                   |     |     | 100000 | cycles        |
| $t_{\text{ret}}$            | Data retention <sup>(3)</sup>         | 125°C                            |     |     | 5      | years         |

- (1) This programming time includes overhead of state machine, but does not include data transfer time. The programming time assumes programming 144 bits at a time at the maximum specified operating frequency.
- (2) During bank erase, the selected sectors are erased simultaneously. The time to erase the bank is specified as equal to the time to erase a sector.
- (3) The data retention specification is based on process qualification testing at 250°C for 168 hours and using an Arrhenius model with activation energy of 0.8 eV.

## 6.11 Tightly-Coupled RAM Interface Module

图 6-10 illustrates the connection of the tightly coupled RAM (TCRAM) to the Cortex-R4F CPU.

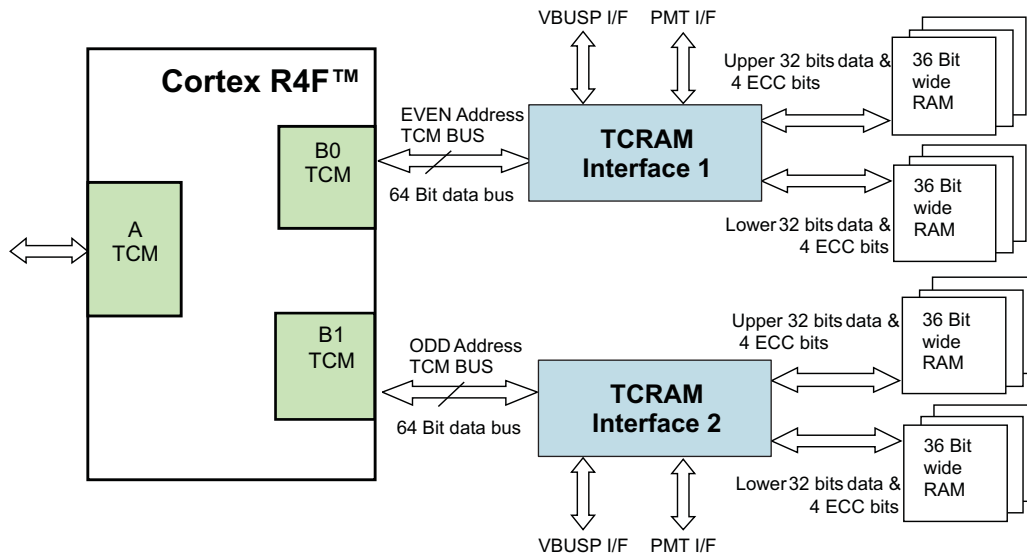


图 6-10. TCRAM Block Diagram

### 6.11.1 Features

The features of the Tightly Coupled RAM (TCRAM) Module are:

- Acts as slave to the Cortex-R4F CPU's BTCM interface
- Supports CPU's internal ECC scheme by providing 64-bit data and 8-bit ECC code
- Monitors CPU Event Bus and generates single or multi-bit error interrupts
- Stores addresses for single and multi-bit errors
- Supports RAM trace module
- Provides CPU address bus integrity checking by supporting parity checking on the address bus
- Performs redundant address decoding for the RAM bank chip select and ECC select generation logic
- Provides enhanced safety for the RAM addressing by implementing two 36-bit wide byte-interleaved RAM banks and generating independent RAM access control signals to the two banks
- Supports auto-initialization of the RAM banks along with the ECC bits
- No support for bit-wise RAM accesses

### 6.11.2 TCRAMW ECC Support

The TCRAMW passes on the ECC code for each data read by the Cortex-R4F CPU from the RAM. It also stores the CPU's ECC port contents in the ECC RAM when the CPU does a write to the RAM. The TCRAMW monitors the CPU's event bus and provides registers for indicating single/multi-bit errors and also for identifying the address that caused the single or multi-bit error. The event signaling and the ECC checking for the RAM accesses must be enabled inside the CPU.

For more information see the device specific technical reference manual.

## 6.12 Parity Protection for Peripheral RAMs

Most peripheral RAMs are protected by odd/even parity checking. During a read access the parity is calculated based on the data read from the peripheral RAM and compared with the good parity value stored in the parity RAM for that peripheral. If any word fails the parity check, the module generates a parity error signal that is mapped to the Error Signaling Module. The module also captures the peripheral RAM address that caused the parity error.

The parity protection for peripheral RAMs is not enabled by default and must be enabled by the application. Each individual peripheral contains control registers to enable the parity protection for accesses to its RAM.

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The CPU read access gets the actual data from the peripheral. The application can choose to generate an interrupt whenever a peripheral RAM parity error is detected.

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## 6.13 On-Chip SRAM Initialization and Testing

### 6.13.1 On-Chip SRAM Self-Test Using PBIST

#### 6.13.1.1 Features

- Extensive instruction set to support various memory test algorithms
- ROM-based algorithms allow application to run TI production-level memory tests
- Independent testing of all on-chip SRAM

#### 6.13.1.2 PBIST RAM Groups

表 6-26. PBIST RAM Grouping

| Memory    | RAM Group | Test Clock | MEM Type    | Test Pattern (Algorithm) |                          |                                                  |                                                     |
|-----------|-----------|------------|-------------|--------------------------|--------------------------|--------------------------------------------------|-----------------------------------------------------|
|           |           |            |             | triple read<br>slow read | triple read<br>fast read | March 13N <sup>(1)</sup><br>two port<br>(cycles) | March 13N <sup>(1)</sup><br>single port<br>(cycles) |
|           |           |            |             | ALGO MASK<br>0x1         | ALGO MASK<br>0x2         | ALGO MASK<br>0x4                                 | ALGO MASK<br>0x8                                    |
| PBIST_ROM | 1         | ROM CLK    | ROM         | 24578                    | 8194                     |                                                  |                                                     |
| STC_ROM   | 2         | ROM CLK    | ROM         | 19586                    | 6530                     |                                                  |                                                     |
| DCAN1     | 3         | VCLK       | Dual Port   |                          |                          | 25200                                            |                                                     |
| DCAN2     | 4         | VCLK       | Dual Port   |                          |                          | 25200                                            |                                                     |
| DCAN3     | 5         | VCLK       | Dual Port   |                          |                          | 25200                                            |                                                     |
| ESRAM1    | 6         | HCLK       | Single Port |                          |                          |                                                  | 266280                                              |
| MIBSPI1   | 7         | VCLK       | Dual Port   |                          |                          | 33440                                            |                                                     |
| MIBSPI3   | 8         | VCLK       | Dual Port   |                          |                          | 33440                                            |                                                     |
| MIBSPI5   | 9         | VCLK       | Dual Port   |                          |                          | 33440                                            |                                                     |
| VIM       | 10        | VCLK       | Dual Port   |                          |                          | 12560                                            |                                                     |
| MIBADC1   | 11        | VCLK       | Dual Port   |                          |                          | 4200                                             |                                                     |
| DMA       | 12        | HCLK       | Dual Port   |                          |                          | 18960                                            |                                                     |
| N2HET1    | 13        | VCLK       | Dual Port   |                          |                          | 31680                                            |                                                     |
| HET TU1   | 14        | VCLK       | Dual Port   |                          |                          | 6480                                             |                                                     |
| RTP       | 15        | HCLK       | Dual Port   |                          |                          | 37800                                            |                                                     |
| FLEXRAY   | 16        | VCLK       | Dual Port   |                          |                          | 75400                                            |                                                     |
|           | 17        |            | Single Port |                          |                          |                                                  | 133160                                              |
| MIBADC2   | 18        | VCLK       | Dual Port   |                          |                          | 4200                                             |                                                     |
| N2HET2    | 19        | VCLK       | Dual Port   |                          |                          | 31680                                            |                                                     |
| HET TU2   | 20        | VCLK       | Dual Port   |                          |                          | 6480                                             |                                                     |
| ESRAM5    | 21        | HCLK       | Single Port |                          |                          |                                                  | 266280                                              |
| ESRAM6    | 22        | HCLK       | Single Port |                          |                          |                                                  | 266280                                              |
| ETHERNET  | 23        | VCLK3      | Dual Port   |                          |                          | 8700                                             |                                                     |
|           | 24        |            |             |                          |                          | 6360                                             |                                                     |
|           | 25        |            | Single Port |                          |                          |                                                  | 133160                                              |
| ESRAM8    | 28        | HCLK       | Single Port |                          |                          |                                                  | 266280                                              |

- (1) There are several memory testing algorithms stored in the PBIST ROM. However, TI recommends the March13N algorithm for application testing.

The PBIST ROM clock frequency is limited to 90MHz, if  $90\text{MHz} < \text{HCLK} \leq \text{HCLKmax}$ , or HCLK, if  $\text{HCLK} \leq 90\text{MHz}$ .

The PBIST ROM clock is divided down from HCLK. The divider is selected by programming the ROM\_DIV field of the Memory Self-Test Global Control Register (MSTGCR) at address 0xFFFFF58.

### 6.13.2 On-Chip SRAM Auto Initialization

This microcontroller allows some of the on-chip memories to be initialized to zero via the Memory Hardware Initialization mechanism in the System module. This hardware mechanism allows an application to program the memory arrays with error detection capability to a known state based on their error detection scheme (odd/even parity or ECC).

The MINITGCR register enables the memory initialization sequence, and the MSINENA register selects the memories that are to be initialized.

For more information on these registers see the device specific technical reference manual.

The mapping of the different on-chip memories to the specific bits of the MSINENA registers is shown in [表 6-27](#).

**表 6-27. Memory Initialization**

| CONNECTING MODULE                | ADDRESS RANGE              |                | MSINENA REGISTER BIT # |
|----------------------------------|----------------------------|----------------|------------------------|
|                                  | BASE ADDRESS               | ENDING ADDRESS |                        |
| RAM (PD#1)                       | 0x08000000                 | 0x0800FFFF     | 0 <sup>(1)</sup>       |
| RAM (RAM_PD#1)                   | 0x08010000                 | 0x0801FFFF     | 0 <sup>(1)</sup>       |
| RAM (RAM_PD#2)                   | 0x08020000                 | 0x0802FFFF     | 0 <sup>(1)</sup>       |
| MIBSPI5 RAM                      | 0xFF0A0000                 | 0xFF0BFFFF     | 12 <sup>(2)</sup>      |
| MIBSPI3 RAM                      | 0xFF0C0000                 | 0xFF0DFFFF     | 11 <sup>(2)</sup>      |
| MIBSPI1 RAM                      | 0xFF0E0000                 | 0xFF0FFFFF     | 7 <sup>(2)</sup>       |
| DCAN3 RAM                        | 0xFF1A0000                 | 0xFF1BFFFF     | 10                     |
| DCAN2 RAM                        | 0xFF1C0000                 | 0xFF1DFFFF     | 6                      |
| DCAN1 RAM                        | 0xFF1E0000                 | 0xFF1FFFFF     | 5                      |
| FlexRay RAM                      | RAM is not CPU-Addressable |                | n/a <sup>(3)</sup>     |
| MIBADC2 RAM                      | 0xFF3A0000                 | 0xFF3BFFFF     | 14                     |
| MIBADC1 RAM                      | 0xFF3E0000                 | 0xFF3FFFFF     | 8                      |
| N2HET2 RAM                       | 0xFF440000                 | 0xFF57FFFF     | 15                     |
| N2HET1 RAM                       | 0xFF460000                 | 0xFF47FFFF     | 3                      |
| HET TU2 RAM                      | 0xFF4C0000                 | 0xFF4DFFFF     | 16                     |
| HET TU1 RAM                      | 0xFF4E0000                 | 0xFF4FFFFF     | 4                      |
| DMA RAM                          | 0xFFF80000                 | 0xFFF80FFF     | 1                      |
| VIM RAM                          | 0xFFF82000                 | 0xFFF82FFF     | 2                      |
| RTP RAM                          | 0xFFF83000                 | 0xFFF83FFF     | n/a                    |
| FlexRay TU RAM                   | 0xFF500000                 | 0xFF51FFFF     | 13                     |
| Ethernet RAM (CPPI Memory Slave) | 0xFC520000                 | 0xFC521FFF     | n/a                    |

(1) The TCM RAM wrapper has separate control bits to select the RAM power domain that is to be auto-initialized.

(2) The MibSPIx modules perform an initialization of the transmit and receive RAMs as soon as the module is released from its local reset via the SPIGCR0 register. This is independent of whether the application chooses to initialize the MibSPIx RAMs using the system module auto-initialization method. Before the MibSPI RAM can be initialized using the system module auto-initialization method: (i) The module must be released from its local reset, AND (ii) The application must poll for the "BUF INIT ACTIVE" status flag in the SPIFLG register to become cleared (zero)

(3) Reserved only. The FlexRay RAM has its own initialization mechanism.

## 6.14 External Memory Interface (EMIF)

### 6.14.1 Features

The EMIF includes many features to enhance the ease and flexibility of connecting to external asynchronous memories or SDRAM devices. The EMIF features includes support for:

- 3 addressable chip select for asynchronous memories of up to 16MB each
- 1 addressable chip select space for SDRAMs up to 128MB
- 8 or 16-bit data bus width
- Programmable cycle timings such as setup, strobe, and hold times as well as turnaround time
- Select strobe mode
- Extended Wait mode
- Data bus parking

### 6.14.2 Electrical and Timing Specifications

#### 6.14.2.1 Asynchronous RAM

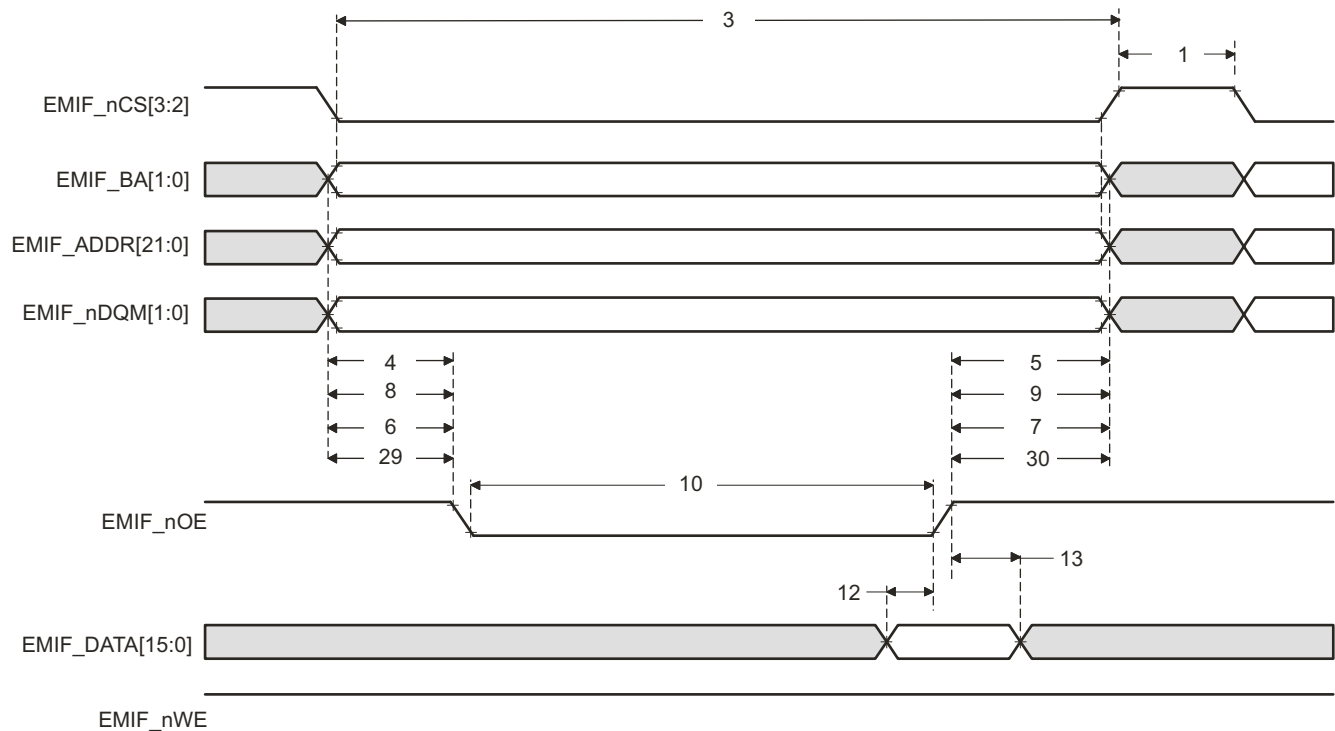


图 6-11. Asynchronous Memory Read Timing



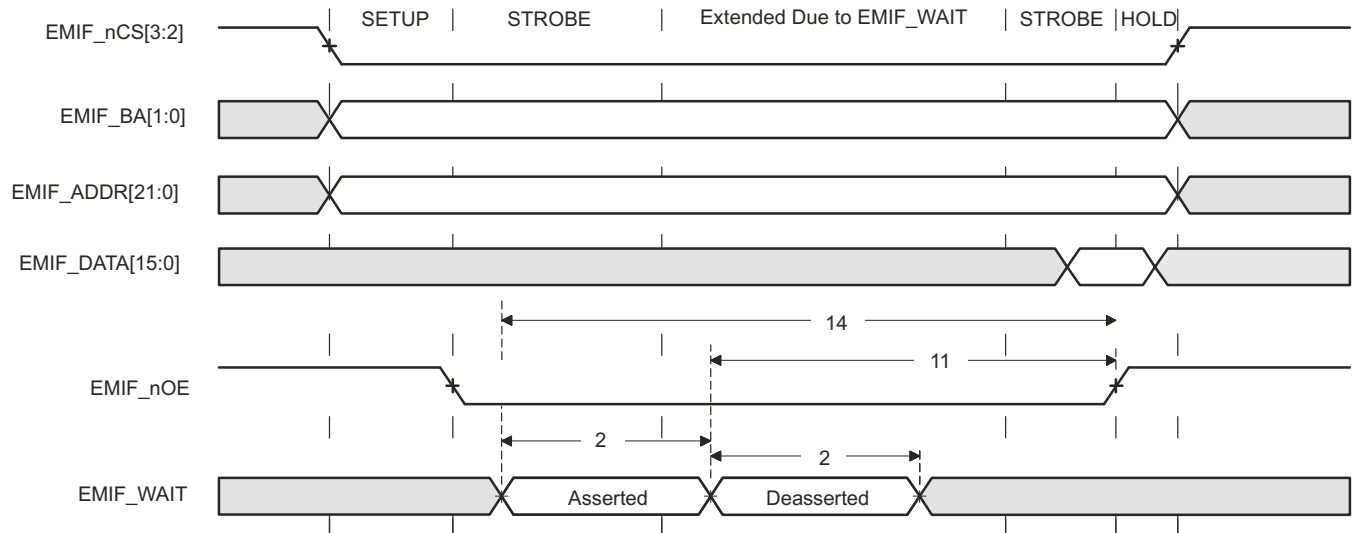


图 6-12. EMIFnWAIT Read Timing Requirements

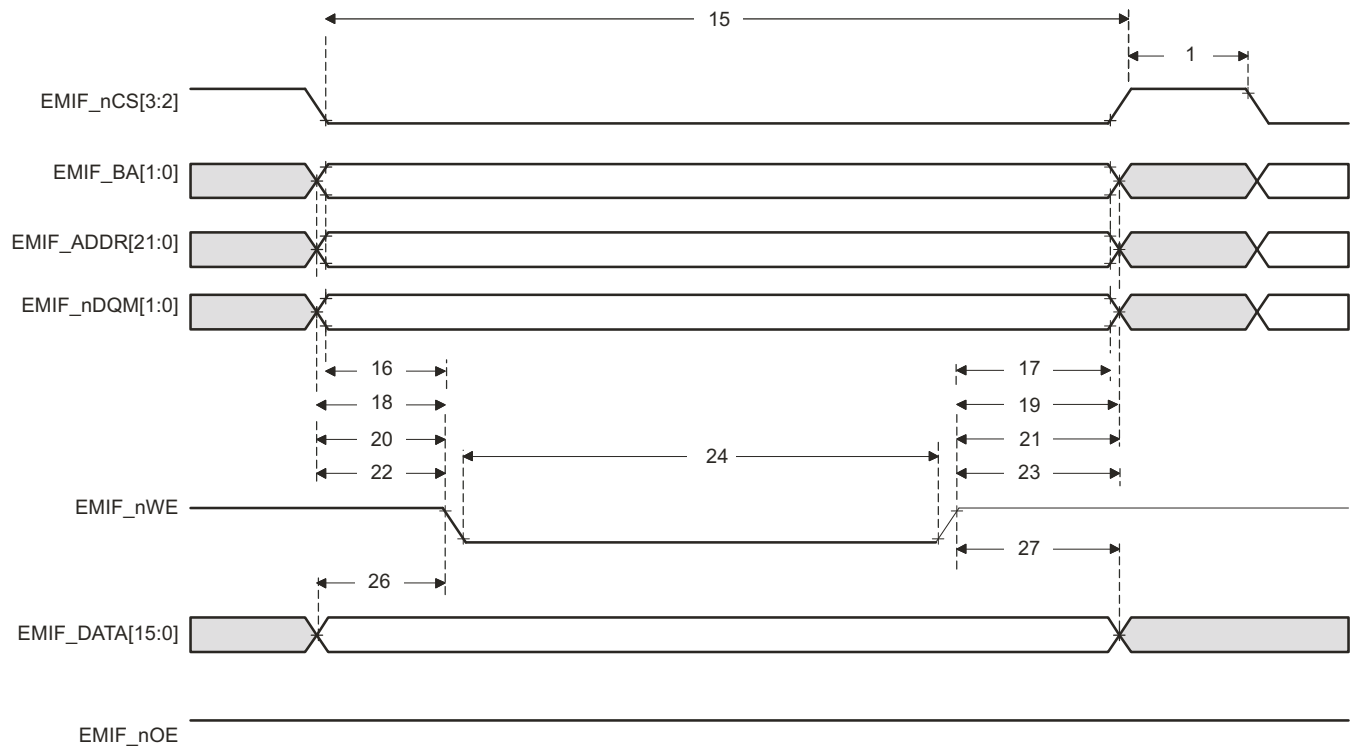


图 6-13. Asynchronous Memory Write Timing

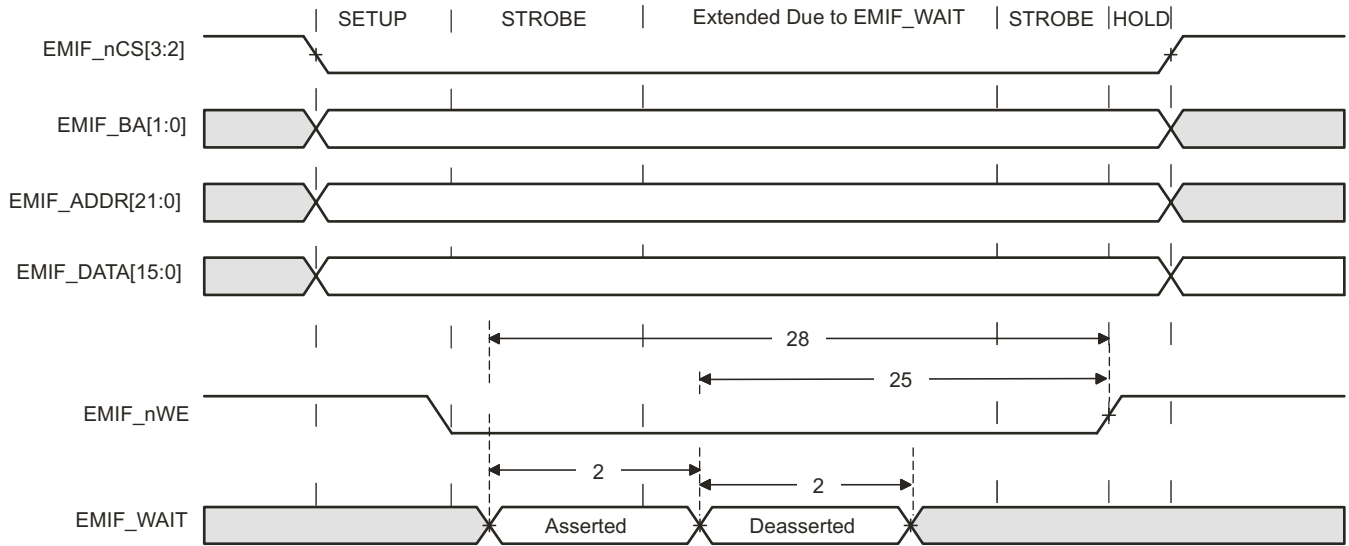


图 6-14. EMIFnWAIT Write Timing Requirements

表 6-28. EMIF Asynchronous Memory Timing Requirements

| NO.                     |                        |                                                                          | MIN   | NOM | MAX | UNIT |
|-------------------------|------------------------|--------------------------------------------------------------------------|-------|-----|-----|------|
| <b>Reads and Writes</b> |                        |                                                                          |       |     |     |      |
|                         | E                      | EMIF clock period                                                        |       |     |     | ns   |
| 2                       | $t_{w(EM\_WAIT)}$      | Pulse duration, EMIFnWAIT assertion and deassertion                      | 2E    |     |     | ns   |
| <b>Reads</b>            |                        |                                                                          |       |     |     |      |
| 12                      | $t_{su(EMDV-EMOE H)}$  | Setup time, EMIFDATA[15:0] valid before EMIFnOE high                     | 30    |     |     | ns   |
| 13                      | $t_{h(EMOE H-EMDIV)}$  | Hold time, EMIFDATA[15:0] valid after EMIFnOE high                       | 0.5   |     |     | ns   |
| 14                      | $t_{su(EMOEL-EMWAIT)}$ | Setup Time, EMIFnWAIT asserted before end of Strobe Phase <sup>(1)</sup> | 4E+30 |     |     | ns   |
| <b>Writes</b>           |                        |                                                                          |       |     |     |      |
| 28                      | $t_{su(EMWEL-EMWAIT)}$ | Setup Time, EMIFnWAIT asserted before end of Strobe Phase <sup>(1)</sup> | 4E+30 |     |     | ns   |

- (1) Setup before end of STROBE phase (if no extended wait states are inserted) by which EMIFnWAIT must be asserted to add extended wait states. Figure 图 6-12 and Figure 图 6-14 describe EMIF transactions that include extended wait states inserted during the STROBE phase. However, cycles inserted as part of this extended wait period should not be counted; the 4E requirement is to the start of where the HOLD phase would begin if there were no extended wait cycles.

表 6-29. EMIF Asynchronous Memory Switching Characteristics<sup>(1)(2)(3)</sup>

| NO.                     | PARAMETER         |                  | MIN          | NOM      | MAX          | UNIT |
|-------------------------|-------------------|------------------|--------------|----------|--------------|------|
| <b>Reads and Writes</b> |                   |                  |              |          |              |      |
| 1                       | $t_d(TURNAROUND)$ | Turn around time | (TA) × E - 4 | (TA) × E | (TA) × E + 3 | ns   |
| <b>Reads</b>            |                   |                  |              |          |              |      |

- (1) TA = Turn around, RS = Read setup, RST = Read strobe, RH = Read hold, WS = Write setup, WST = Write strobe, WH = Write hold, MEWC = Maximum external wait cycles. These parameters are programmed via the Asynchronous Bank and Asynchronous Wait Cycle Configuration Registers. These support the following ranges of values: TA[4–1], RS[16–1], RST[64–1], RH[8–1], WS[16–1], WST[64–1], WH[8–1], and MEWC[1–256]. See the for more information.
- (2) E = EMIF\_CLK period in ns.
- (3) EWC = external wait cycles determined by EMIFnWAIT input signal. EWC supports the following range of values. EWC[256–1]. Note that the maximum wait time before timeout is specified by bit field MEWC in the Asynchronous Wait Cycle Configuration Register. See the for more information.

表 6-29. EMIF Asynchronous Memory Switching Characteristics<sup>(1)(2)(3)</sup> (continued)

| NO.           | PARAMETER              |                                                              | MIN                                       | NOM                                    | MAX                                        | UNIT |
|---------------|------------------------|--------------------------------------------------------------|-------------------------------------------|----------------------------------------|--------------------------------------------|------|
| 3             | $t_{c(EMRCYCLE)}$      | EMIF read cycle time (EW = 0)                                | $(RS+RST+RH) \times E -3$                 | $(RS+RST+RH) \times E$                 | $(RS+RST+RH) \times E + 3$                 | ns   |
|               |                        | EMIF read cycle time (EW = 1)                                | $(RS+RST+RH+(EWC \times 16)) \times E -3$ | $(RS+RST+RH+(EWC \times 16)) \times E$ | $(RS+RST+RH+(EWC \times 16)) \times E + 3$ | ns   |
| 4             | $t_{su(EMCEL-EMOEL)}$  | Output setup time, EMIFnCS[4:2] low to EMIFnOE low (SS = 0)  | $(RS) \times E -4$                        | $(RS) \times E$                        | $(RS) \times E +3$                         | ns   |
|               |                        | Output setup time, EMIFnCS[4:2] low to EMIFnOE low (SS = 1)  | -3                                        | 0                                      | +3                                         | ns   |
| 5             | $t_{h(EMOEH-EMCEH)}$   | Output hold time, EMIFnOE high to EMIFnCS[4:2] high (SS = 0) | $(RH) \times E -4$                        | $(RH) \times E$                        | $(RH) \times E + 3$                        | ns   |
|               |                        | Output hold time, EMIFnOE high to EMIFnCS[4:2] high (SS = 1) | -3                                        | 0                                      | +3                                         | ns   |
| 6             | $t_{su(EMBAV-EMOEL)}$  | Output setup time, EMIFBA[1:0] valid to EMIFnOE low          | $(RS) \times E -4$                        | $(RS) \times E$                        | $(RS) \times E +3$                         | ns   |
| 7             | $t_{h(EMOEH-EMBAIV)}$  | Output hold time, EMIFnOE high to EMIFBA[1:0] invalid        | $(RH) \times E -4$                        | $(RH) \times E$                        | $(RH) \times E +3$                         | ns   |
| 8             | $t_{su(EMAV-EMOEL)}$   | Output setup time, EMIFADDR[21:0] valid to EMIFnOE low       | $(RS) \times E -4$                        | $(RS) \times E$                        | $(RS) \times E +3$                         | ns   |
| 9             | $t_{h(EMOEH-EMAIV)}$   | Output hold time, EMIFnOE high to EMIFADDR[21:0] invalid     | $(RH) \times E -4$                        | $(RH) \times E$                        | $(RH) \times E +3$                         | ns   |
| 10            | $t_{w(EMOEL)}$         | EMIFnOE active low width (EW = 0)                            | $(RST) \times E -3$                       | $(RST) \times E$                       | $(RST) \times E +3$                        | ns   |
|               |                        | EMIFnOE active low width (EW = 1)                            | $(RST+(EWC \times 16)) \times E -3$       | $(RST+(EWC \times 16)) \times E$       | $(RST+(EWC \times 16)) \times E +3$        | ns   |
| 11            | $t_{d(EMWAITH-EMOEH)}$ | Delay time from EMIFnWAIT deasserted to EMIFnOE high         | 3E-3                                      | 4E                                     | 4E+30                                      | ns   |
| 29            | $t_{su(EMDQMV-EMOEL)}$ | Output setup time, EMIFnDQM[1:0] valid to EMIFnOE low        | $(RS) \times E -4$                        | $(RS) \times E$                        | $(RS) \times E +3$                         | ns   |
| 30            | $t_{h(EMOEH-EMDQMIV)}$ | Output hold time, EMIFnOE high to EMIFnDQM[1:0] invalid      | $(RH) \times E -4$                        | $(RH) \times E$                        | $(RH) \times E +3$                         | ns   |
| <b>Writes</b> |                        |                                                              |                                           |                                        |                                            |      |
| 15            | $t_{c(EMWCYCLE)}$      | EMIF write cycle time (EW = 0)                               | $(WS+WST+WH) \times E -3$                 | $(WS+WST+WH) \times E$                 | $(WS+WST+WH) \times E +3$                  | ns   |
|               |                        | EMIF write cycle time (EW = 1)                               | $(WS+WST+WH+(EWC \times 16)) \times E -3$ | $(WS+WST+WH+(EWC \times 16)) \times E$ | $(WS+WST+WH+(EWC \times 16)) \times E + 3$ | ns   |
| 16            | $t_{su(EMCEL-EMWEL)}$  | Output setup time, EMIFnCS[4:2] low to EMIFnWE low (SS = 0)  | $(WS) \times E -4$                        | $(WS) \times E$                        | $(WS) \times E + 3$                        | ns   |
|               |                        | Output setup time, EMIFnCS[4:2] low to EMIFnWE low (SS = 1)  | -4                                        | 0                                      | +3                                         | ns   |
| 17            | $t_{h(EMWEH-EMCEH)}$   | Output hold time, EMIFnWE high to EMIFnCS[4:2] high (SS = 0) | $(WH) \times E -4$                        | $(WH) \times E$                        | $(WH) \times E +3$                         | ns   |
|               |                        | Output hold time, EMIFnWE high to EMIFCS[4:2] high (SS = 1)  | -4                                        | 0                                      | +3                                         | ns   |
| 18            | $t_{su(EMDQMV-EMWEL)}$ | Output setup time, EMIFBA[1:0] valid to EMIFnWE low          | $(WS) \times E -4$                        | $(WS) \times E$                        | $(WS) \times E +3$                         | ns   |
| 19            | $t_{h(EMWEH-EMDQMIV)}$ | Output hold time, EMIFnWE high to EMIFBA[1:0] invalid        | $(WH) \times E -4$                        | $(WH) \times E$                        | $(WH) \times E +3$                         | ns   |

表 6-29. EMIF Asynchronous Memory Switching Characteristics<sup>(1)(2)(3)</sup> (continued)

| NO. | PARAMETER                      |                                                          | MIN                    | NOM                  | MAX                    | UNIT |
|-----|--------------------------------|----------------------------------------------------------|------------------------|----------------------|------------------------|------|
| 20  | t <sub>SU</sub> (EMBAV-EMWEL)  | Output setup time, EMIFBA[1:0] valid to EMIFnWE low      | (WS) × E-4             | (WS) × E             | (WS) × E+3             | ns   |
| 21  | t <sub>H</sub> (EMWEH-EMBAIV)  | Output hold time, EMIFnWE high to EMIFBA[1:0] invalid    | (WH) × E-4             | (WH) × E             | (WH) × E+3             | ns   |
| 22  | t <sub>SU</sub> (EMAV-EMWEL)   | Output setup time, EMIFADDR[21:0] valid to EMIFnWE low   | (WS) × E-4             | (WS) × E             | (WS) × E+3             | ns   |
| 23  | t <sub>H</sub> (EMWEH-EMAIV)   | Output hold time, EMIFnWE high to EMIFADDR[21:0] invalid | (WH) × E-4             | (WH) × E             | (WH) × E+3             | ns   |
| 24  | t <sub>W</sub> (EMWEL)         | EMIFnWE active low width (EW = 0)                        | (WST) × E-3            | (WST) × E            | (WST) × E+3            | ns   |
|     |                                | EMIFnWE active low width (EW = 1)                        | (WST+(EWC × 16)) × E-3 | (WST+(EWC × 16)) × E | (WST+(EWC × 16)) × E+3 | ns   |
| 25  | t <sub>D</sub> (EMWAITH-EMWEH) | Delay time from EMIFnWAIT deasserted to EMIFnWE high     | 3E-4                   | 4E                   | 4E+30                  | ns   |
| 26  | t <sub>SU</sub> (EMDV-EMWEL)   | Output setup time, EMIFDATA[15:0] valid to EMIFnWE low   | (WS) × E-4             | (WS) × E             | (WS) × E+3             | ns   |
| 27  | t <sub>H</sub> (EMWEH-EMDIV)   | Output hold time, EMIFnWE high to EMIFDATA[15:0] invalid | (WH) × E-4             | (WH) × E             | (WH) × E+3             | ns   |
| 31  | t <sub>SU</sub> (EMDQMV-EMWEL) | Output setup time, EMIFnDQM[1:0] valid to EMIFnWE low    | (WH) × E-4             | (WH) × E             | (WH) × E+3             | ns   |
| 32  | t <sub>H</sub> (EMWEH-EMDQMIV) | Output hold time, EMIFnWE hight to EMIFnDQM[1:0] invalid | (WH) × E-4             | (WH) × E             | (WH) × E+3             | ns   |

### 6.14.2.2 Synchronous Timing

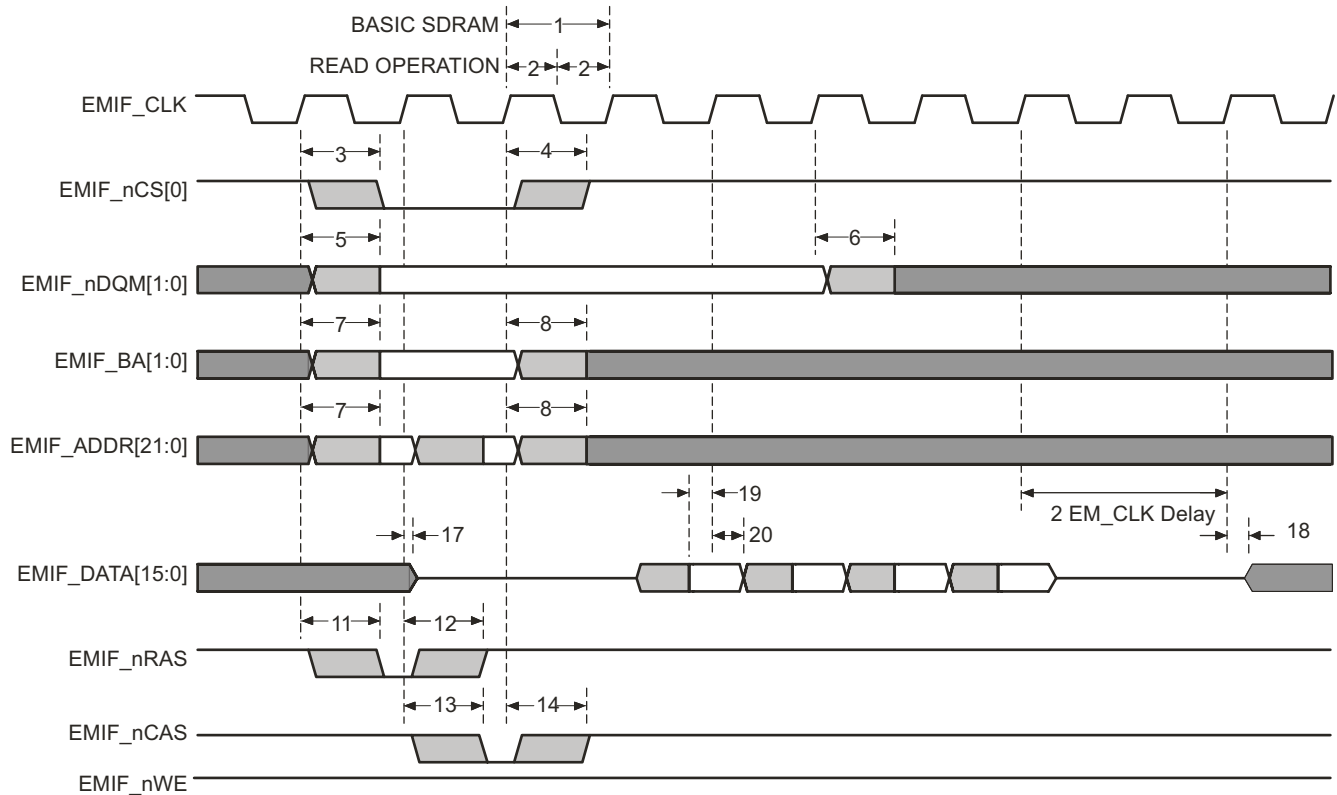


图 6-15. Basic SDRAM Read Operation

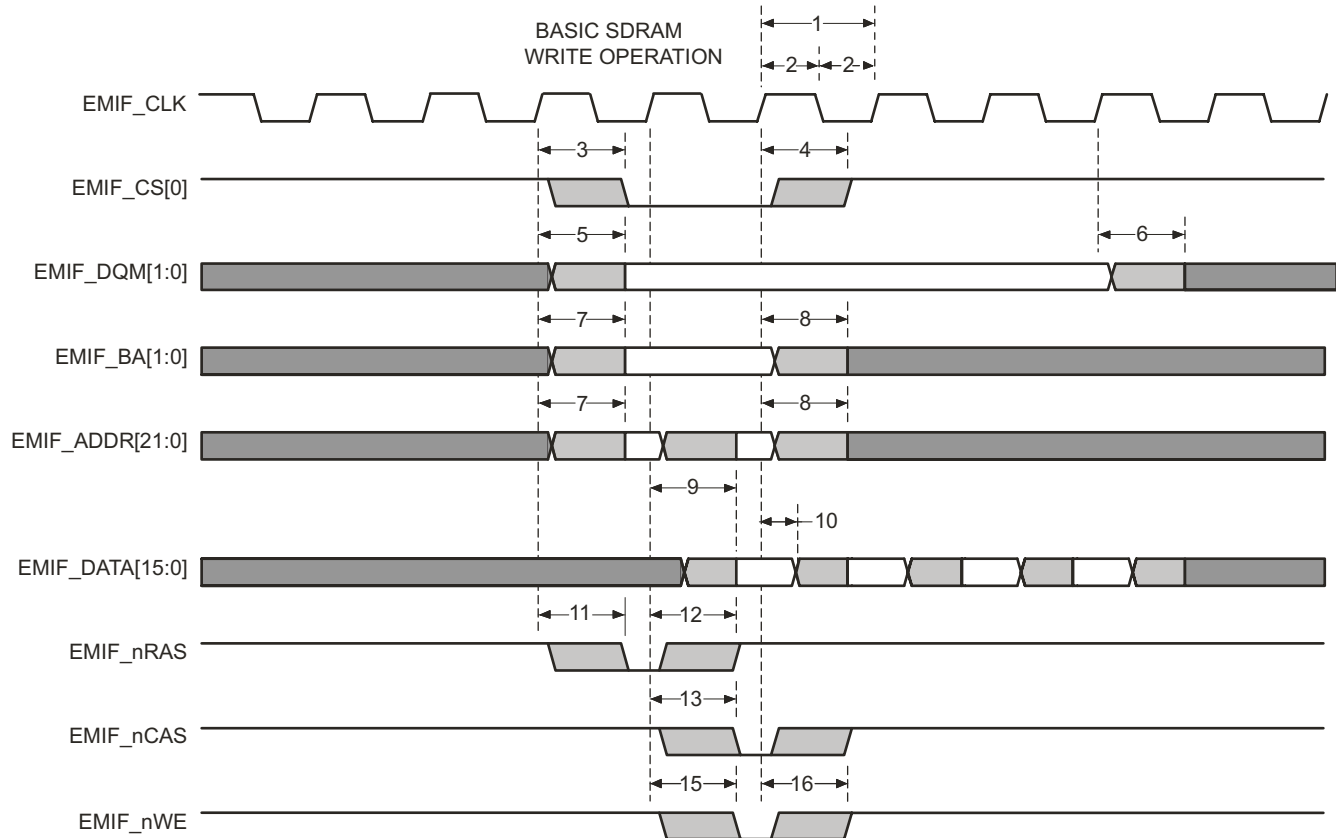


图 6-16. Basic SDRAM Write Operation

表 6-30. EMIF Synchronous Memory Timing Requirements

| NO. | PARAMETER                 |                                                                            | MIN | MAX | UNIT |
|-----|---------------------------|----------------------------------------------------------------------------|-----|-----|------|
| 19  | $t_{su}(EMIFDV-EM\_CLKH)$ | Input setup time, read data valid on EMIFDATA[15:0] before EMIF_CLK rising | 2   |     | ns   |
| 20  | $t_h(CLKH-DIV)$           | Input hold time, read data valid on EMIFDATA[15:0] after EMIF_CLK rising   | 1.5 |     | ns   |

表 6-31. EMIF Synchronous Memory Switching Characteristics

| NO. | PARAMETER            |                                                                             | MIN | MAX | UNIT |
|-----|----------------------|-----------------------------------------------------------------------------|-----|-----|------|
| 1   | $t_c(CLK)$           | Cycle time, EMIF clock EMIF_CLK                                             |     |     | ns   |
| 2   | $t_w(CLK)$           | Pulse width, EMIF clock EMIF_CLK high or low                                | 5   |     | ns   |
| 3   | $t_d(CLKH-CSV)$      | Delay time, EMIF_CLK rising to EMIFnCS[0] valid                             |     | 13  | ns   |
| 4   | $t_{oh}(CLKH-CSIV)$  | Output hold time, EMIF_CLK rising to EMIFnCS[0] invalid                     | 1   |     | ns   |
| 5   | $t_d(CLKH-DQMV)$     | Delay time, EMIF_CLK rising to EMIFnDQM[1:0] valid                          |     | 13  | ns   |
| 6   | $t_{oh}(CLKH-DQMIV)$ | Output hold time, EMIF_CLK rising to EMIFnDQM[1:0] invalid                  | 1   |     | ns   |
| 7   | $t_d(CLKH-AV)$       | Delay time, EMIF_CLK rising to EMIFADDR[21:0] and EMIFBA[1:0] valid         |     | 13  | ns   |
| 8   | $t_{oh}(CLKH-AIV)$   | Output hold time, EMIF_CLK rising to EMIFADDR[21:0] and EMIFBA[1:0] invalid | 1   |     | ns   |
| 9   | $t_d(CLKH-DV)$       | Delay time, EMIF_CLK rising to EMIFDATA[15:0] valid                         |     | 13  | ns   |
| 10  | $t_{oh}(CLKH-DIV)$   | Output hold time, EMIF_CLK rising to EMIFDATA[15:0] invalid                 | 1   |     | ns   |
| 11  | $t_d(CLKH-RASV)$     | Delay time, EMIF_CLK rising to EMIFnRAS valid                               |     | 13  | ns   |
| 12  | $t_{oh}(CLKH-RASIV)$ | Output hold time, EMIF_CLK rising to EMIFnRAS invalid                       | 1   |     | ns   |
| 13  | $t_d(CLKH-CASV)$     | Delay time, EMIF_CLK rising to EMIFnCAS valid                               |     | 13  | ns   |

**表 6-31. EMIF Synchronous Memory Switching Characteristics (continued)**

| NO. | PARAMETER                   |                                                             | MIN | MAX | UNIT |
|-----|-----------------------------|-------------------------------------------------------------|-----|-----|------|
| 14  | $t_{oh}(\text{CLKH-CASIV})$ | Output hold time, EMIF_CLK rising to EMIFnCAS invalid       | 1   |     | ns   |
| 15  | $t_d(\text{CLKH-WEV})$      | Delay time, EMIF_CLK rising to EMIFnWE valid                |     | 13  | ns   |
| 16  | $t_{oh}(\text{CLKH-WEIV})$  | Output hold time, EMIF_CLK rising to EMIFnWE invalid        | 1   |     | ns   |
| 17  | $t_{dis}(\text{CLKH-DHZ})$  | Delay time, EMIF_CLK rising to EMIFDATA[15:0] tri-stated    |     | 7   | ns   |
| 18  | $t_{ena}(\text{CLKH-DLZ})$  | Output hold time, EMIF_CLK rising to EMIFDATA[15:0] driving | 1   |     | ns   |

## 6.15 Vectored Interrupt Manager

The vectored interrupt manager (VIM) provides hardware assistance for prioritizing and controlling the many interrupt sources present on this device. Interrupts are caused by events outside of the normal flow of program execution. Normally, these events require a timely response from the central processing unit (CPU); therefore, when an interrupt occurs, the CPU switches execution from the normal program flow to an interrupt service routine (ISR).

### 6.15.1 VIM Features

The VIM module has the following features:

- Supports 96 interrupt channels.
  - Provides programmable priority and enable for interrupt request lines.
- Provides a direct hardware dispatch mechanism for fastest IRQ dispatch.
- Provides two software dispatch mechanisms when the CPU VIC port is not used.
  - Index interrupt
  - Register vectored interrupt
- Parity protected vector interrupt table

### 6.15.2 Interrupt Request Assignments

表 6-32. Interrupt Request Assignments

| Modules  | Interrupt Sources              | Default VIM Interrupt Channel |
|----------|--------------------------------|-------------------------------|
| ESM      | ESM High level interrupt (NMI) | 0                             |
| Reserved | Reserved                       | 1                             |
| RTI      | RTI compare interrupt 0        | 2                             |
| RTI      | RTI compare interrupt 1        | 3                             |
| RTI      | RTI compare interrupt 2        | 4                             |
| RTI      | RTI compare interrupt 3        | 5                             |
| RTI      | RTI overflow interrupt 0       | 6                             |
| RTI      | RTI overflow interrupt 1       | 7                             |
| RTI      | RTI timebase interrupt         | 8                             |
| GPIO     | GPIO interrupt A               | 9                             |
| N2HET1   | N2HET1 level 0 interrupt       | 10                            |
| HET TU1  | HET TU1 level 0 interrupt      | 11                            |
| MIBSPI1  | MIBSPI1 level 0 interrupt      | 12                            |
| LIN      | LIN level 0 interrupt          | 13                            |
| MIBADC1  | MIBADC1 event group interrupt  | 14                            |
| MIBADC1  | MIBADC1 sw group 1 interrupt   | 15                            |
| DCAN1    | DCAN1 level 0 interrupt        | 16                            |
| SPI2     | SPI2 level 0 interrupt         | 17                            |
| FlexRay  | FlexRay level 0 interrupt      | 18                            |
| CRC      | CRC Interrupt                  | 19                            |
| ESM      | ESM Low level interrupt        | 20                            |
| SYSTEM   | Software interrupt (SSI)       | 21                            |
| CPU      | PMU Interrupt                  | 22                            |
| GPIO     | GPIO interrupt B               | 23                            |
| N2HET1   | N2HET1 level 1 interrupt       | 24                            |
| HET TU1  | HET TU1 level 1 interrupt      | 25                            |
| MIBSPI1  | MIBSPI1 level 1 interrupt      | 26                            |

**表 6-32. Interrupt Request Assignments (continued)**

| Modules    | Interrupt Sources                         | Default VIM Interrupt Channel |
|------------|-------------------------------------------|-------------------------------|
| LIN        | LIN level 1 interrupt                     | 27                            |
| MIBADC1    | MIBADC1 sw group 2 interrupt              | 28                            |
| DCAN1      | DCAN1 level 1 interrupt                   | 29                            |
| SPI2       | SPI2 level 1 interrupt                    | 30                            |
| MIBADC1    | MIBADC1 magnitude compare interrupt       | 31                            |
| FlexRay    | FlexRay level 1 interrupt                 | 32                            |
| DMA        | FTCA interrupt                            | 33                            |
| DMA        | LFSA interrupt                            | 34                            |
| DCAN2      | DCAN2 level 0 interrupt                   | 35                            |
| DMM        | DMM level 0 interrupt                     | 36                            |
| MIBSPI3    | MIBSPI3 level 0 interrupt                 | 37                            |
| MIBSPI3    | MIBSPI3 level 1 interrupt                 | 38                            |
| DMA        | HBCA interrupt                            | 39                            |
| DMA        | BTCA interrupt                            | 40                            |
| EMIF       | AEMIFINT3                                 | 41                            |
| DCAN2      | DCAN2 level 1 interrupt                   | 42                            |
| DMM        | DMM level 1 interrupt                     | 43                            |
| DCAN1      | DCAN1 IF3 interrupt                       | 44                            |
| DCAN3      | DCAN3 level 0 interrupt                   | 45                            |
| DCAN2      | DCAN2 IF3 interrupt                       | 46                            |
| FPU        | "OR" of the six Cortex R4F FPU Exceptions | 47                            |
| FlexRay TU | FlexRay TU Transfer Status interrupt      | 48                            |
| SPI4       | SPI4 level 0 interrupt                    | 49                            |
| MIBADC2    | MibADC2 event group interrupt             | 50                            |
| MIBADC2    | MibADC2 sw group1 interrupt               | 51                            |
| FlexRay    | FlexRay T0C interrupt                     | 52                            |
| MIBSPI5    | MIBSPI5 level 0 interrupt                 | 53                            |
| SPI4       | SPI4 level 1 interrupt                    | 54                            |
| DCAN3      | DCAN3 level 1 interrupt                   | 55                            |
| MIBSPI5    | MIBSPI5 level 1 interrupt                 | 56                            |
| MIBADC2    | MibADC2 sw group2 interrupt               | 57                            |
| FlexRay TU | FlexRay TU Error interrupt                | 58                            |
| MIBADC2    | MibADC2 magnitude compare interrupt       | 59                            |
| DCAN3      | DCAN3 IF3 interrupt                       | 60                            |
| FMC        | FSM_DONE interrupt                        | 61                            |
| FlexRay    | FlexRay T1C interrupt                     | 62                            |
| N2HET2     | N2HET2 level 0 interrupt                  | 63                            |
| SCI        | SCI level 0 interrupt                     | 64                            |
| HET TU2    | HET TU2 level 0 interrupt                 | 65                            |
| I2C        | I2C level 0 interrupt                     | 66                            |
| Reserved   | Reserved                                  | 67-72                         |
| N2HET2     | N2HET2 level 1 interrupt                  | 73                            |
| SCI        | SCI level 1 interrupt                     | 74                            |
| HET TU2    | HET TU2 level 1 interrupt                 | 75                            |
| Ethernet   | C0_MISC_PULSE                             | 76                            |
| Ethernet   | C0_TX_PULSE                               | 77                            |
| Ethernet   | C0_THRESH_PULSE                           | 78                            |



表 6-32. Interrupt Request Assignments (continued)

| Modules  | Interrupt Sources   | Default VIM Interrupt Channel |
|----------|---------------------|-------------------------------|
| Ethernet | C0_RX_PULSE         | 79                            |
| HWAG1    | HWA_INT_REQ_H       | 80                            |
| HWAG2    | HWA_INT_REQ_H       | 81                            |
| DCC1     | DCC1 done interrupt | 82                            |
| DCC2     | DCC2 done interrupt | 83                            |
| Reserved | Reserved            | 84                            |
| PBIST    | PBIST_DONE          | 85                            |
| Reserved | Reserved            | 86                            |
| Reserved | Reserved            | 87                            |
| HWAG1    | HWA_INT_REQ_L       | 88                            |
| HWAG2    | HWA_INT_REQ_L       | 89                            |
| Reserved | Reserved            | 90-95                         |

## 注

Address location 0x00000000 in the VIM RAM is reserved for the phantom interrupt ISR entry; therefore only request channels 0..94 can be used and are offset by 1 address in the VIM RAM.

## 注

The EMIF\_nWAIT signal has a pull-up on it. The EMIF module generates a "Wait Rise" interrupt whenever it detects a rising edge on the EMIF\_nWAIT signal. This interrupt condition is indicated as soon as the device is powered up. This can be ignored if the EMIF\_nWAIT signal is not used in the application. If the EMIF\_nWAIT signal is actually used in the application, then the external slave memory must always drive the EMIF\_nWAIT signal such that an interrupt is not caused due to the default pull-up on this signal.

## 注

The lower-order interrupt channels are higher priority channels than the higher-order interrupt channels.

## 注

The application can change the mapping of interrupt sources to the interrupt channels via the interrupt channel control registers (CHANCTRLx) inside the VIM module.

## **6.16 DMA Controller**

The DMA controller is used to transfer data between two locations in the memory map in the background of CPU operations. Typically, the DMA is used to:

- Transfer blocks of data between external and internal data memories
- Restructure portions of internal data memory
- Continually service a peripheral

### **6.16.1 DMA Features**

- CPU independent data transfer
- One master port - PortB (64 bits wide) that interfaces to the TMS570 Memory System.
- FIFO buffer(4 entries deep and each 64bit wide)
- Channel control information is stored in RAM protected by parity
- 16 channels with individual enable
- Channel chaining capability
- 32 peripheral DMA requests
- Hardware and Software DMA requests
- 8, 16, 32 or 64-bit transactions supported
- Multiple addressing modes for source/destination (fixed, increment, offset)
- Auto-initiation
- Power-management mode
- Memory Protection with four configurable memory regions

## 6.16.2 Default DMA Request Map

The DMA module on this microcontroller has 16 channels and up to 32 hardware DMA requests. The module contains DREQASx registers which are used to map the DMA requests to the DMA channels. By default, channel 0 is mapped to request 0, channel 1 to request 1, and so on.

Some DMA requests have multiple sources, as shown in 表 6-33. The application must ensure that only one of these DMA request sources is enabled at any time.

表 6-33. DMA Request Line Connection

| Modules                             | DMA Request Sources                                                  | DMA Request |
|-------------------------------------|----------------------------------------------------------------------|-------------|
| MIBSPI1                             | MIBSPI1[1] <sup>(1)</sup>                                            | DMAREQ[0]   |
| MIBSPI1                             | MIBSPI1[0] <sup>(2)</sup>                                            | DMAREQ[1]   |
| SPI2                                | SPI2 receive                                                         | DMAREQ[2]   |
| SPI2                                | SPI2 transmit                                                        | DMAREQ[3]   |
| MIBSPI1 / MIBSPI3 / DCAN2           | MIBSPI1[2] / MIBSPI3[2] / DCAN2 IF3                                  | DMAREQ[4]   |
| MIBSPI1 / MIBSPI3 / DCAN2           | MIBSPI1[3] / MIBSPI3[3] / DCAN2 IF2                                  | DMAREQ[5]   |
| DCAN1 / MIBSPI5                     | DCAN1 IF2 / MIBSPI5[2]                                               | DMAREQ[6]   |
| MIBADC1 / MIBSPI5                   | MIBADC1 event / MIBSPI5[3]                                           | DMAREQ[7]   |
| MIBSPI1 / MIBSPI3 / DCAN1           | MIBSPI1[4] / MIBSPI3[4] / DCAN1 IF1                                  | DMAREQ[8]   |
| MIBSPI1 / MIBSPI3 / DCAN2           | MIBSPI1[5] / MIBSPI3[5] / DCAN2 IF1                                  | DMAREQ[9]   |
| MIBADC1 / I2C / MIBSPI5             | MIBADC1 G1 / I2C receive / MIBSPI5[4]                                | DMAREQ[10]  |
| MIBADC1 / I2C / MIBSPI5             | MIBADC1 G2 / I2C transmit / MIBSPI5[5]                               | DMAREQ[11]  |
| RTI / MIBSPI1 / MIBSPI3             | RTI DMAREQ0 / MIBSPI1[6] / MIBSPI3[6]                                | DMAREQ[12]  |
| RTI / MIBSPI1 / MIBSPI3             | RTI DMAREQ1 / MIBSPI1[7] / MIBSPI3[7]                                | DMAREQ[13]  |
| MIBSPI3 / MibADC2 / MIBSPI5         | MIBSPI3[1] <sup>(1)</sup> / MibADC2 event / MIBSPI5[6]               | DMAREQ[14]  |
| MIBSPI3 / MIBSPI5                   | MIBSPI3[0] <sup>(2)</sup> / MIBSPI5[7]                               | DMAREQ[15]  |
| MIBSPI1 / MIBSPI3 / DCAN1 / MibADC2 | MIBSPI1[8] / MIBSPI3[8] / DCAN1 IF3 / MibADC2 G1                     | DMAREQ[16]  |
| MIBSPI1 / MIBSPI3 / DCAN3 / MibADC2 | MIBSPI1[9] / MIBSPI3[9] / DCAN3 IF1 / MibADC2 G2                     | DMAREQ[17]  |
| RTI / MIBSPI5                       | RTI DMAREQ2 / MIBSPI5[8]                                             | DMAREQ[18]  |
| RTI / MIBSPI5                       | RTI DMAREQ3 / MIBSPI5[9]                                             | DMAREQ[19]  |
| N2HET1 / N2HET2 / DCAN3             | N2HET1 DMAREQ[4] / N2HET2 DMAREQ[4] / DCAN3 IF2                      | DMAREQ[20]  |
| N2HET1 / N2HET2 / DCAN3             | N2HET1 DMAREQ[5] / N2HET2 DMAREQ[5] / DCAN3 IF3                      | DMAREQ[21]  |
| MIBSPI1 / MIBSPI3 / MIBSPI5         | MIBSPI1[10] / MIBSPI3[10] / MIBSPI5[10]                              | DMAREQ[22]  |
| MIBSPI1 / MIBSPI3 / MIBSPI5         | MIBSPI1[11] / MIBSPI3[11] / MIBSPI5[11]                              | DMAREQ[23]  |
| N2HET1 / N2HET2 / SPI4 / MIBSPI5    | N2HET1 DMAREQ[6] / N2HET2 DMAREQ[6] / SPI4 receive / MIBSPI5[12]     | DMAREQ[24]  |
| N2HET1 / N2HET2 / SPI4 / MIBSPI5    | N2HET1 DMAREQ[7] / N2HET2 DMAREQ[7] / SPI4 transmit / MIBSPI5[13]    | DMAREQ[25]  |
| CRC / MIBSPI1 / MIBSPI3             | CRC DMAREQ[0] / MIBSPI1[12] / MIBSPI3[12]                            | DMAREQ[26]  |
| CRC / MIBSPI1 / MIBSPI3             | CRC DMAREQ[1] / MIBSPI1[13] / MIBSPI3[13]                            | DMAREQ[27]  |
| LIN / MIBSPI5                       | LIN receive / MIBSPI5[14]                                            | DMAREQ[28]  |
| LIN / MIBSPI5                       | LIN transmit / MIBSPI5[15]                                           | DMAREQ[29]  |
| MIBSPI1 / MIBSPI3 / SCI / MIBSPI5   | MIBSPI1[14] / MIBSPI3[14] / SCI receive / MIBSPI5[1] <sup>(1)</sup>  | DMAREQ[30]  |
| MIBSPI1 / MIBSPI3 / SCI / MIBSPI5   | MIBSPI1[15] / MIBSPI3[15] / SCI transmit / MIBSPI5[0] <sup>(2)</sup> | DMAREQ[31]  |

(1) SPI1, SPI3, SPI5 receive in standard SPI mode

(2) SPI1, SPI3, SPI5 transmit in standard SPI mode

## 6.17 Real Time Interrupt Module

The real-time interrupt (RTI) module provides timer functionality for operating systems and for benchmarking code. The RTI module can incorporate several counters that define the timebases needed for scheduling an operating system.

The timers also allow you to benchmark certain areas of code by reading the values of the counters at the beginning and the end of the desired code range and calculating the difference between the values.

In addition the RTI provides a mechanism to synchronize the operating system to the FlexRay communication cycle. Clock supervision can detect issues on the FlexRay bus with an automatic switch to an internally generated timebase.

### 6.17.1 Features

The RTI module has the following features:

- Two independent 64 bit counter blocks
- Four configurable compares for generating operating system ticks or DMA requests. Each event can be driven by either counter block 0 or counter block 1.
- One counter block usable for application synchronization to FlexRay network including clock supervision
- Fast enabling/disabling of events
- Two time-stamp (capture) functions for system or peripheral interrupts, one for each counter block

### 6.17.2 Block Diagrams

图 6-17 shows a high-level block diagram for one of the two 64-bit counter blocks inside the RTI module. Both the counter blocks are identical except the Network Time Unit (NTUx) inputs are only available as time base inputs for the counter block 0.

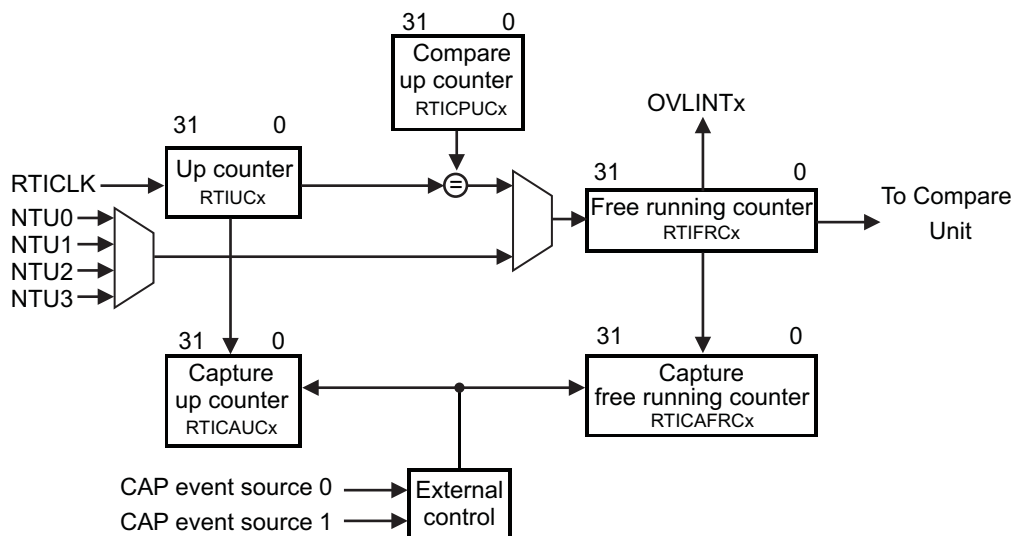


图 6-17. Counter Block Diagram

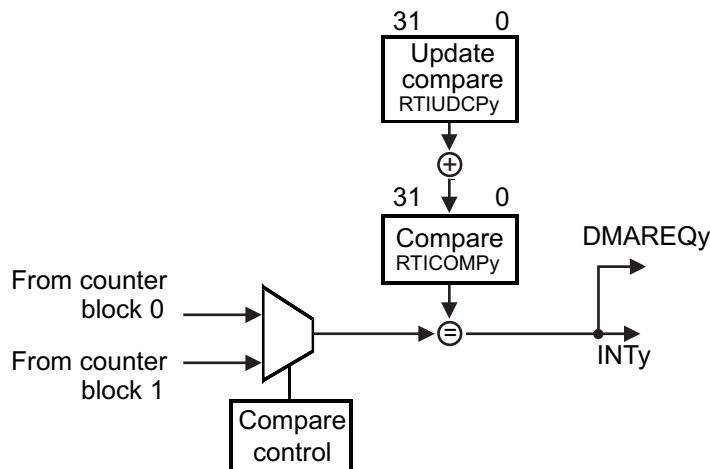


图 6-18. Compare Block Diagram

### 6.17.3 Clock Source Options

The RTI module uses the RTI1CLK clock domain for generating the RTI time bases.

The application can select the clock source for the RTI1CLK by configuring the RCLKSRC register in the System module at address 0xFFFFF50. The default source for RTI1CLK is VCLK.

For more information on clock sources refer to 表 6-8 and 表 6-13.

### 6.17.4 Network Time Synchronization Inputs

The RTI module supports 4 Network Time Unit (NTU) inputs that signal internal system events, and which can be used to synchronize the time base used by the RTI module. On this device, these NTU inputs are connected as shown below.

表 6-34. Network Time Synchronization Inputs

| NTU Input | Source                |
|-----------|-----------------------|
| 0         | Macro tick            |
| 1         | Start of Cycle        |
| 2         | PLL2 Clock output     |
| 3         | EXTCLKIN1 clock input |

## 6.18 Error Signaling Module

The Error Signaling Module (ESM) manages the various error conditions on the TMS570 microcontroller. The error condition is handled based on a fixed severity level assigned to it. Any severe error condition can be configured to drive a low level on a dedicated device terminal called nERROR. This can be used as an indicator to an external monitor circuit to put the system into a safe state.

### 6.18.1 Features

The features of the Error Signaling Module are:

- 128 interrupt/error channels are supported, divided into 3 different groups
  - 64 channels with maskable interrupt and configurable error pin behavior
  - 32 error channels with non-maskable interrupt and predefined error pin behavior
  - 32 channels with predefined error pin behavior only
- Error pin to signal severe device failure
- Configurable timebase for error signal
- Error forcing capability

### 6.18.2 ESM Channel Assignments

The Error Signaling Module (ESM) integrates all the device error conditions and groups them in the order of severity. Group1 is used for errors of the lowest severity while Group3 is used for errors of the highest severity. The device response to each error is determined by the severity group it is connected to. 表 6-36 shows the channel assignment for each group.

表 6-35. ESM Groups

| ERROR GROUP | INTERRUPT CHARACTERISTICS      | INFLUENCE ON ERROR PIN |
|-------------|--------------------------------|------------------------|
| Group1      | maskable, low or high priority | configurable           |
| Group2      | non-maskable, high priority    | fixed                  |
| Group3      | no interrupt generated         | fixed                  |

表 6-36. ESM Channel Assignments

| ERROR SOURCES                                                                                   | GROUP  | CHANNELS |
|-------------------------------------------------------------------------------------------------|--------|----------|
| Reserved                                                                                        | Group1 | 0        |
| MibADC2 - parity                                                                                | Group1 | 1        |
| DMA - MPU                                                                                       | Group1 | 2        |
| DMA - parity                                                                                    | Group1 | 3        |
| Reserved                                                                                        | Group1 | 4        |
| DMA - imprecise read error                                                                      | Group1 | 5        |
| FMC - correctable error: bus1 and bus2 interfaces<br>(does not include accesses to EEPROM bank) | Group1 | 6        |
| N2HET1/N2HET2 - parity                                                                          | Group1 | 7        |
| HET TU1/HET TU2 - parity                                                                        | Group1 | 8        |
| HET TU1/HET TU2 - MPU                                                                           | Group1 | 9        |
| PLL - Slip                                                                                      | Group1 | 10       |
| Clock Monitor - interrupt                                                                       | Group1 | 11       |
| FlexRay - parity                                                                                | Group1 | 12       |
| DMA - imprecise write error                                                                     | Group1 | 13       |
| FlexRay TU - parity                                                                             | Group1 | 14       |
| VIM RAM - parity                                                                                | Group1 | 15       |
| FlexRay TU - MPU                                                                                | Group1 | 16       |
| MibSPI1 - parity                                                                                | Group1 | 17       |

表 6-36. ESM Channel Assignments (continued)

| ERROR SOURCES                                                                                                                                                                                                                                             | GROUP  | CHANNELS |
|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|--------|----------|
| MibSPI3 - parity                                                                                                                                                                                                                                          | Group1 | 18       |
| MibADC1 - parity                                                                                                                                                                                                                                          | Group1 | 19       |
| Reserved                                                                                                                                                                                                                                                  | Group1 | 20       |
| DCAN1 - parity                                                                                                                                                                                                                                            | Group1 | 21       |
| DCAN3 - parity                                                                                                                                                                                                                                            | Group1 | 22       |
| DCAN2 - parity                                                                                                                                                                                                                                            | Group1 | 23       |
| MibSPI5 - parity                                                                                                                                                                                                                                          | Group1 | 24       |
| Reserved                                                                                                                                                                                                                                                  | Group1 | 25       |
| RAM even bank (B0TCM) - correctable error                                                                                                                                                                                                                 | Group1 | 26       |
| CPU - selftest                                                                                                                                                                                                                                            | Group1 | 27       |
| RAM odd bank (B1TCM) - correctable error                                                                                                                                                                                                                  | Group1 | 28       |
| Reserved                                                                                                                                                                                                                                                  | Group1 | 29       |
| DCC1 - error                                                                                                                                                                                                                                              | Group1 | 30       |
| CCM-R4 - selftest                                                                                                                                                                                                                                         | Group1 | 31       |
| Reserved                                                                                                                                                                                                                                                  | Group1 | 32       |
| Reserved                                                                                                                                                                                                                                                  | Group1 | 33       |
| Reserved                                                                                                                                                                                                                                                  | Group1 | 34       |
| FMC - correctable error (EEPROM bank access)                                                                                                                                                                                                              | Group1 | 35       |
| FMC - uncorrectable error (EEPROM bank access)                                                                                                                                                                                                            | Group1 | 36       |
| IOMM - Mux configuration error                                                                                                                                                                                                                            | Group1 | 37       |
| Power domain controller compare error                                                                                                                                                                                                                     | Group1 | 38       |
| Power domain controller self-test error                                                                                                                                                                                                                   | Group1 | 39       |
| eFuse Controller Error – this error signal is generated when any bit in the eFuse controller error status register is set. The application can choose to generate an interrupt whenever this bit is set to service any eFuse controller error conditions. | Group1 | 40       |
| eFuse Controller - Self Test Error. This error signal is generated only when a self test on the eFuse controller generates an error condition. When an ECC self test error is detected, group 1 channel 40 error signal will also be set.                 | Group1 | 41       |
| PLL2 - Slip                                                                                                                                                                                                                                               | Group1 | 42       |
| Ethernet Controller master interface                                                                                                                                                                                                                      | Group1 | 43       |
| Reserved                                                                                                                                                                                                                                                  | Group1 | 44       |
| Reserved                                                                                                                                                                                                                                                  | Group1 | 45       |
| Reserved                                                                                                                                                                                                                                                  | Group1 | 46       |
| Reserved                                                                                                                                                                                                                                                  | Group1 | 47       |
| Reserved                                                                                                                                                                                                                                                  | Group1 | 48       |
| Reserved                                                                                                                                                                                                                                                  | Group1 | 49       |
| Reserved                                                                                                                                                                                                                                                  | Group1 | 50       |
| Reserved                                                                                                                                                                                                                                                  | Group1 | 51       |
| Reserved                                                                                                                                                                                                                                                  | Group1 | 52       |
| Reserved                                                                                                                                                                                                                                                  | Group1 | 53       |
| Reserved                                                                                                                                                                                                                                                  | Group1 | 54       |
| Reserved                                                                                                                                                                                                                                                  | Group1 | 55       |
| Reserved                                                                                                                                                                                                                                                  | Group1 | 56       |
| Reserved                                                                                                                                                                                                                                                  | Group1 | 57       |
| Reserved                                                                                                                                                                                                                                                  | Group1 | 58       |
| Reserved                                                                                                                                                                                                                                                  | Group1 | 59       |
| Reserved                                                                                                                                                                                                                                                  | Group1 | 60       |
| Reserved                                                                                                                                                                                                                                                  | Group1 | 61       |

**表 6-36. ESM Channel Assignments (continued)**

| ERROR SOURCES                                                                                                                        | GROUP  | CHANNELS |
|--------------------------------------------------------------------------------------------------------------------------------------|--------|----------|
| DCC2 - error                                                                                                                         | Group1 | 62       |
| Reserved                                                                                                                             | Group1 | 63       |
| <b>GROUP 2</b>                                                                                                                       |        |          |
| Reserved                                                                                                                             | Group2 | 0        |
| Reserved                                                                                                                             | Group2 | 1        |
| CCMR4 - compare                                                                                                                      | Group2 | 2        |
| Reserved                                                                                                                             | Group2 | 3        |
| FMC - uncorrectable error (address parity on bus1 accesses)                                                                          | Group2 | 4        |
| Reserved                                                                                                                             | Group2 | 5        |
| RAM even bank (B0TCM) - uncorrectable error                                                                                          | Group2 | 6        |
| Reserved                                                                                                                             | Group2 | 7        |
| RAM odd bank (B1TCM) - uncorrectable error                                                                                           | Group2 | 8        |
| Reserved                                                                                                                             | Group2 | 9        |
| RAM even bank (B0TCM) - address bus parity error                                                                                     | Group2 | 10       |
| Reserved                                                                                                                             | Group2 | 11       |
| RAM odd bank (B1TCM) - address bus parity error                                                                                      | Group2 | 12       |
| Reserved                                                                                                                             | Group2 | 13       |
| Reserved                                                                                                                             | Group2 | 14       |
| Reserved                                                                                                                             | Group2 | 15       |
| TCM - ECC live lock detect                                                                                                           | Group2 | 16       |
| Reserved                                                                                                                             | Group2 | 17       |
| Reserved                                                                                                                             | Group2 | 18       |
| Reserved                                                                                                                             | Group2 | 19       |
| Reserved                                                                                                                             | Group2 | 20       |
| Reserved                                                                                                                             | Group2 | 21       |
| Reserved                                                                                                                             | Group2 | 22       |
| Reserved                                                                                                                             | Group2 | 23       |
| RTI_WWD_NMI                                                                                                                          | Group2 | 24       |
| Reserved                                                                                                                             | Group2 | 25       |
| Reserved                                                                                                                             | Group2 | 26       |
| Reserved                                                                                                                             | Group2 | 27       |
| Reserved                                                                                                                             | Group2 | 28       |
| Reserved                                                                                                                             | Group2 | 29       |
| Reserved                                                                                                                             | Group2 | 30       |
| Reserved                                                                                                                             | Group2 | 31       |
| <b>GROUP 3</b>                                                                                                                       |        |          |
| Reserved                                                                                                                             | Group3 | 0        |
| eFuse Controller - autolock error                                                                                                    | Group3 | 1        |
| Reserved                                                                                                                             | Group3 | 2        |
| RAM even bank (B0TCM) - ECC uncorrectable error                                                                                      | Group3 | 3        |
| Reserved                                                                                                                             | Group3 | 4        |
| RAM odd bank (B1TCM) - ECC uncorrectable error                                                                                       | Group3 | 5        |
| Reserved                                                                                                                             | Group3 | 6        |
| FMC - uncorrectable error: bus1 and bus2 interfaces<br>(does not include address parity error and errors on accesses to EEPROM bank) | Group3 | 7        |
| Reserved                                                                                                                             | Group3 | 8        |
| Reserved                                                                                                                             | Group3 | 9        |
| Reserved                                                                                                                             | Group3 | 10       |



表 6-36. ESM Channel Assignments (continued)

| ERROR SOURCES | GROUP  | CHANNELS |
|---------------|--------|----------|
| Reserved      | Group3 | 11       |
| Reserved      | Group3 | 12       |
| Reserved      | Group3 | 13       |
| Reserved      | Group3 | 14       |
| Reserved      | Group3 | 15       |
| Reserved      | Group3 | 16       |
| Reserved      | Group3 | 17       |
| Reserved      | Group3 | 18       |
| Reserved      | Group3 | 19       |
| Reserved      | Group3 | 20       |
| Reserved      | Group3 | 21       |
| Reserved      | Group3 | 22       |
| Reserved      | Group3 | 23       |
| Reserved      | Group3 | 24       |
| Reserved      | Group3 | 25       |
| Reserved      | Group3 | 26       |
| Reserved      | Group3 | 27       |
| Reserved      | Group3 | 28       |
| Reserved      | Group3 | 29       |
| Reserved      | Group3 | 30       |
| Reserved      | Group3 | 31       |

## 6.19 Reset / Abort / Error Sources

表 6-37. Reset/Abort/Error Sources

| ERROR SOURCE                                                                                             | SYSTEM MODE    | ERROR RESPONSE                                  | ESM HOOKUP group.channel |
|----------------------------------------------------------------------------------------------------------|----------------|-------------------------------------------------|--------------------------|
| <b>CPU TRANSACTIONS</b>                                                                                  |                |                                                 |                          |
| Precise write error (NCNB/Strongly Ordered)                                                              | User/Privilege | Precise Abort (CPU)                             | n/a                      |
| Precise read error (NCB/Device or Normal)                                                                | User/Privilege | Precise Abort (CPU)                             | n/a                      |
| Imprecise write error (NCB/Device or Normal)                                                             | User/Privilege | Imprecise Abort (CPU)                           | n/a                      |
| Illegal instruction                                                                                      | User/Privilege | Undefined Instruction Trap (CPU) <sup>(1)</sup> | n/a                      |
| MPU access violation                                                                                     | User/Privilege | Abort (CPU)                                     | n/a                      |
| <b>SRAM</b>                                                                                              |                |                                                 |                          |
| B0 TCM (even) ECC single error (correctable)                                                             | User/Privilege | ESM                                             | 1.26                     |
| B0 TCM (even) ECC double error (non-correctable)                                                         | User/Privilege | Abort (CPU), ESM => nERROR                      | 3.3                      |
| B0 TCM (even) uncorrectable error (i.e. redundant address decode)                                        | User/Privilege | ESM => NMI => nERROR                            | 2.6                      |
| B0 TCM (even) address bus parity error                                                                   | User/Privilege | ESM => NMI => nERROR                            | 2.10                     |
| B1 TCM (odd) ECC single error (correctable)                                                              | User/Privilege | ESM                                             | 1.28                     |
| B1 TCM (odd) ECC double error (non-correctable)                                                          | User/Privilege | Abort (CPU), ESM => nERROR                      | 3.5                      |
| B1 TCM (odd) uncorrectable error (i.e. redundant address decode)                                         | User/Privilege | ESM => NMI => nERROR                            | 2.8                      |
| B1 TCM (odd) address bus parity error                                                                    | User/Privilege | ESM => NMI => nERROR                            | 2.12                     |
| <b>FLASH</b>                                                                                             |                |                                                 |                          |
| FMC correctable error - Bus1 and Bus2 interfaces (does not include accesses to EEPROM bank)              | User/Privilege | ESM                                             | 1.6                      |
| FMC uncorrectable error - Bus1 accesses (does not include address parity error)                          | User/Privilege | Abort (CPU), ESM => nERROR                      | 3.7                      |
| FMC uncorrectable error - Bus2 accesses (does not include address parity error and EEPROM bank accesses) | User/Privilege | ESM => nERROR                                   | 3.7                      |
| FMC uncorrectable error - address parity error on Bus1 accesses                                          | User/Privilege | ESM => NMI => nERROR                            | 2.4                      |
| FMC correctable error - Accesses to EEPROM bank                                                          | User/Privilege | ESM                                             | 1.35                     |
| FMC uncorrectable error - Accesses to EEPROM bank                                                        | User/Privilege | ESM                                             | 1.36                     |
| <b>DMA TRANSACTIONS</b>                                                                                  |                |                                                 |                          |
| External imprecise error on read (Illegal transaction with ok response)                                  | User/Privilege | ESM                                             | 1.5                      |
| External imprecise error on write (Illegal transaction with ok response)                                 | User/Privilege | ESM                                             | 1.13                     |
| Memory access permission violation                                                                       | User/Privilege | ESM                                             | 1.2                      |
| Memory parity error                                                                                      | User/Privilege | ESM                                             | 1.3                      |
| <b>DMM TRANSACTIONS</b>                                                                                  |                |                                                 |                          |
| External imprecise error on read (Illegal transaction with ok response)                                  | User/Privilege | ESM                                             | 1.5                      |
| External imprecise error on write (Illegal transaction with ok response)                                 | User/Privilege | ESM                                             | 1.13                     |
| <b>HET TU1 (HTU1)</b>                                                                                    |                |                                                 |                          |
| NCNB (Strongly Ordered) transaction with slave error response                                            | User/Privilege | Interrupt => VIM                                | n/a                      |
| External imprecise error (Illegal transaction with ok response)                                          | User/Privilege | Interrupt => VIM                                | n/a                      |
| Memory access permission violation                                                                       | User/Privilege | ESM                                             | 1.9                      |

(1) The Undefined Instruction TRAP is NOT detectable outside the CPU. The trap is taken only if the instruction reaches the execute stage of the CPU.

表 6-37. Reset/Abort/Error Sources (continued)

| ERROR SOURCE                                                    | SYSTEM MODE    | ERROR RESPONSE       | ESM HOOKUP<br>group.channel |
|-----------------------------------------------------------------|----------------|----------------------|-----------------------------|
| Memory parity error                                             | User/Privilege | ESM                  | 1.8                         |
| <b>HET TU2 (HTU2)</b>                                           |                |                      |                             |
| NCNB (Strongly Ordered) transaction with slave error response   | User/Privilege | Interrupt => VIM     | n/a                         |
| External imprecise error (Illegal transaction with ok response) | User/Privilege | Interrupt => VIM     | n/a                         |
| Memory access permission violation                              | User/Privilege | ESM                  | 1.9                         |
| Memory parity error                                             | User/Privilege | ESM                  | 1.8                         |
| <b>N2HET1</b>                                                   |                |                      |                             |
| Memory parity error                                             | User/Privilege | ESM                  | 1.7                         |
| <b>N2HET2</b>                                                   |                |                      |                             |
| Memory parity error                                             | User/Privilege | ESM                  | 1.7                         |
| <b>FLEXRAY</b>                                                  |                |                      |                             |
| Memory parity error                                             | User/Privilege | ESM                  | 1.12                        |
| <b>FLEXRAY TU</b>                                               |                |                      |                             |
| NCNB (Strongly Ordered) transaction with slave error response   | User/Privilege | Interrupt => VIM     | n/a                         |
| External imprecise error (Illegal transaction with ok response) | User/Privilege | Interrupt => VIM     | n/a                         |
| Memory access permission violation                              | User/Privilege | ESM                  | 1.16                        |
| Memory parity error                                             | User/Privilege | ESM                  | 1.14                        |
| <b>ETHERNET MASTER INTERFACE</b>                                |                |                      |                             |
| Any error reported by slave being accessed                      | User/Privilege | ESM                  | 1.43                        |
| <b>MIBSPI</b>                                                   |                |                      |                             |
| MibSPI1 memory parity error                                     | User/Privilege | ESM                  | 1.17                        |
| MibSPI3 memory parity error                                     | User/Privilege | ESM                  | 1.18                        |
| MibSPI5 memory parity error                                     | User/Privilege | ESM                  | 1.24                        |
| <b>MIBADC</b>                                                   |                |                      |                             |
| MibADC1 Memory parity error                                     | User/Privilege | ESM                  | 1.19                        |
| MibADC2 Memory parity error                                     | User/Privilege | ESM                  | 1.1                         |
| <b>DCAN</b>                                                     |                |                      |                             |
| DCAN1 memory parity error                                       | User/Privilege | ESM                  | 1.21                        |
| DCAN2 memory parity error                                       | User/Privilege | ESM                  | 1.23                        |
| DCAN3 memory parity error                                       | User/Privilege | ESM                  | 1.22                        |
| <b>PLL</b>                                                      |                |                      |                             |
| PLL slip error                                                  | User/Privilege | ESM                  | 1.10                        |
| PLL #2 slip error                                               | User/Privilege | ESM                  | 1.42                        |
| <b>CLOCK MONITOR</b>                                            |                |                      |                             |
| Clock monitor interrupt                                         | User/Privilege | ESM                  | 1.11                        |
| <b>DCC</b>                                                      |                |                      |                             |
| DCC1 error                                                      | User/Privilege | ESM                  | 1.30                        |
| DCC2 error                                                      | User/Privilege | ESM                  | 1.62                        |
| <b>CCM-R4</b>                                                   |                |                      |                             |
| Self test failure                                               | User/Privilege | ESM                  | 1.31                        |
| Compare failure                                                 | User/Privilege | ESM => NMI => nERROR | 2.2                         |
| <b>VIM</b>                                                      |                |                      |                             |
| Memory parity error                                             | User/Privilege | ESM                  | 1.15                        |
| <b>VOLTAGE MONITOR</b>                                          |                |                      |                             |
| VMON out of voltage range                                       | n/a            | Reset                | n/a                         |
| <b>CPU SELFTEST (LBIST)</b>                                     |                |                      |                             |
| CPU Selftest (LBIST) error                                      | User/Privilege | ESM                  | 1.27                        |

**表 6-37. Reset/Abort/Error Sources (continued)**

| ERROR SOURCE                                                | SYSTEM MODE    | ERROR RESPONSE       | ESM HOOKUP<br>group.channel |
|-------------------------------------------------------------|----------------|----------------------|-----------------------------|
| <b>PIN MULTIPLEXING CONTROL</b>                             |                |                      |                             |
| Mux configuration error                                     | User/Privilege | ESM                  | 1.37                        |
| <b>POWER DOMAIN CONTROL</b>                                 |                |                      |                             |
| PSCON compare error                                         | User/Privilege | ESM                  | 1.38                        |
| PSCON self-test error                                       | User/Privilege | ESM                  | 1.39                        |
| <b>eFuse Controller</b>                                     |                |                      |                             |
| eFuse Controller Autoload error                             | User/Privilege | ESM => nERROR        | 3.1                         |
| eFuse Controller - Any bit set in the error status register | User/Privilege | ESM                  | 1.40                        |
| eFuse Controller self-test error                            | User/Privilege | ESM                  | 1.41                        |
| <b>WINDOWED WATCHDOG</b>                                    |                |                      |                             |
| WWD Non-Maskable Interrupt exception                        | n/a            | ESM => NMI => nERROR | 2.24                        |
| <b>ERRORS REFLECTED IN THE SYSESR REGISTER</b>              |                |                      |                             |
| Power-Up Reset                                              | n/a            | Reset                | n/a                         |
| Oscillator fail / PLL slip <sup>(2)</sup>                   | n/a            | Reset                | n/a                         |
| Watchdog exception                                          | n/a            | Reset                | n/a                         |
| CPU Reset (driven by the CPU STC)                           | n/a            | Reset                | n/a                         |
| Software Reset                                              | n/a            | Reset                | n/a                         |
| External Reset                                              | n/a            | Reset                | n/a                         |

(2) Oscillator fail/PLL slip can be configured in the system register (SYS.PLLCTL1) to generate a reset.

## 6.20 Digital Windowed Watchdog

This device includes a digital windowed watchdog (DWWD) module that protects against runaway code execution.

The DWWD module allows the application to configure the time window within which the DWWD module expects the application to service the watchdog. A watchdog violation occurs if the application services the watchdog outside of this window, or fails to service the watchdog at all. The application can choose to generate a system reset or a non-maskable interrupt to the CPU in case of a watchdog violation.

The watchdog is disabled by default and must be enabled by the application. Once enabled, the watchdog can only be disabled upon a system reset.

## 6.21 Debug Subsystem

### 6.21.1 Block Diagram

The device contains an ICEPICK module to allow JTAG access to the scan chains.

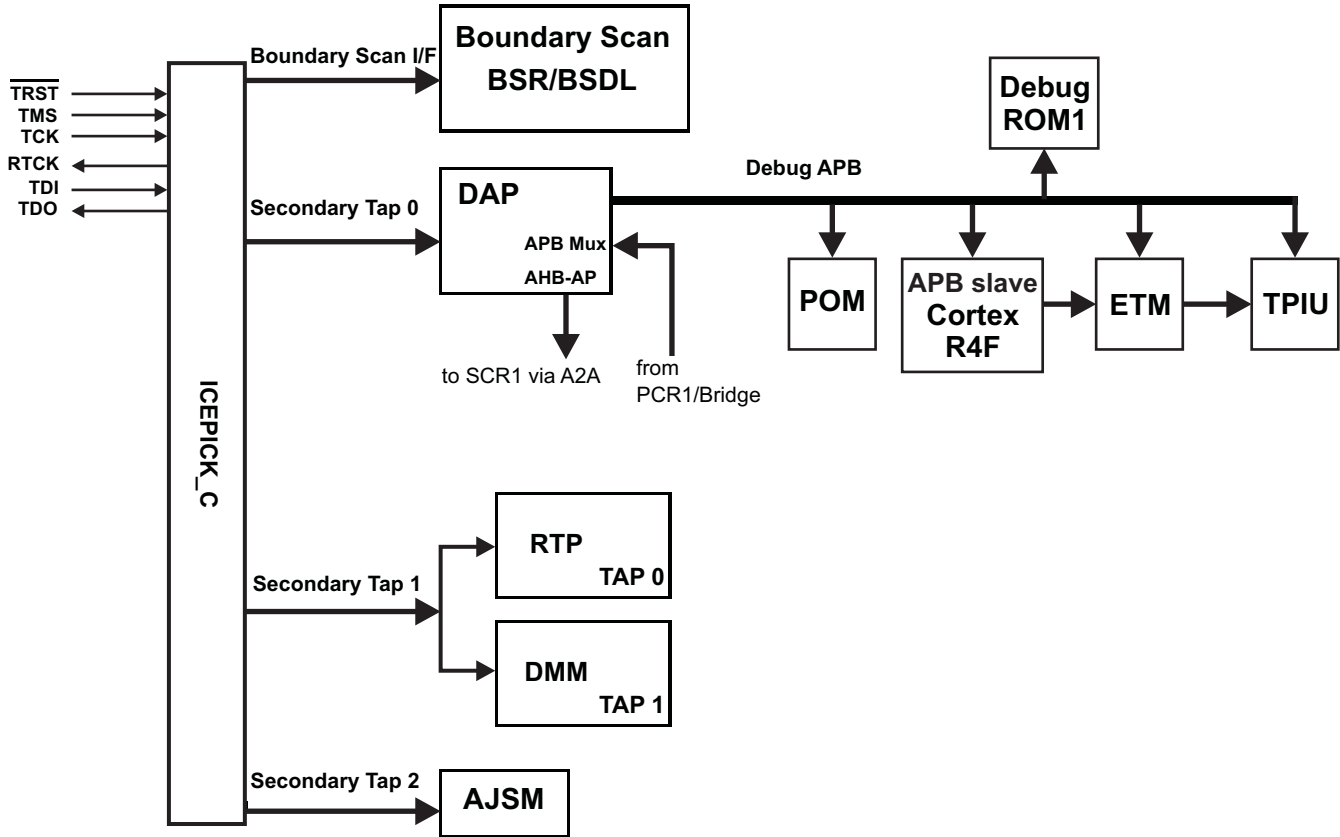


图 6-19. Debug Subsystem Block Diagram

### 6.21.2 Debug Components Memory Map

表 6-38. Debug Components Memory Map

| MODULE NAME         | FRAME CHIP SELECT | FRAME ADDRESS RANGE |             | FRAME SIZE | ACTUAL SIZE | RESPNSE FOR ACCESS TO UNIMPLEMENTED LOCATIONS IN FRAME |
|---------------------|-------------------|---------------------|-------------|------------|-------------|--------------------------------------------------------|
|                     |                   | START               | END         |            |             |                                                        |
| CoreSight Debug ROM | CSCS0             | 0xFFA0_0000         | 0xFFA0_0FFF | 4KB        | 4KB         | Reads: 0, writes: no effect                            |
| Cortex-R4F Debug    | CSCS1             | 0xFFA0_1000         | 0xFFA0_1FFF | 4KB        | 4KB         | Reads: 0, writes: no effect                            |
| ETM-R4              | CSCS2             | 0xFFA0_2000         | 0xFFA0_2FFF | 4KB        | 4KB         | Reads: 0, writes: no effect                            |
| CoreSight TPIU      | CSCS3             | 0xFFA0_3000         | 0xFFA0_3FFF | 4KB        | 4KB         | Reads: 0, writes: no effect                            |

### 6.21.3 JTAG Identification Code

The JTAG ID code for this device is the same as the device ICEPick Identification Code.

#### JTAG ID Code

| Silicon Revision | ID         |
|------------------|------------|
| Rev A            | 0x0D8A002F |

### JTAG ID Code (continued)

| Silicon Revision | ID         |
|------------------|------------|
| Rev B            | 0x2D8A002F |
| Rev C            | 0x3D8A002F |

#### 6.21.4 Debug ROM

The Debug ROM stores the location of the components on the Debug APB bus:

表 6-39. Debug ROM table

| ADDRESS | DESCRIPTION           | VALUE       |
|---------|-----------------------|-------------|
| 0x000   | pointer to Cortex-R4F | 0x0000 1003 |
| 0x001   | ETM-R4                | 0x0000 2003 |
| 0x002   | TPIU                  | 0x0000 3003 |
| 0x003   | POM                   | 0x0000 4003 |
| 0x004   | end of table          | 0x0000 0000 |

### 6.21.5 JTAG Scan Interface Timings

表 6-40. JTAG Scan Interface Timing<sup>(1)</sup>

| NO. |                                                                       | MIN | MAX | UNIT |
|-----|-----------------------------------------------------------------------|-----|-----|------|
|     | $f_{TCK}$ TCK frequency (at HCLKmax)                                  |     | 12  | MHz  |
|     | $f_{RTCK}$ RTCK frequency (at TCKmax and HCLKmax)                     | 10  |     | MHz  |
| 1   | $t_{d(TCK-RTCK)}$ Delay time, TCK to RTCK                             |     | 24  | ns   |
| 2   | $t_{su(TDI/TMS-RTCKr)}$ Setup time, TDI, TMS before RTCK rise (RTCKr) | 26  |     | ns   |
| 3   | $t_{h(RTCKr-TDI/TMS)}$ Hold time, TDI, TMS after RTCKr                | 0   |     | ns   |
| 4   | $t_{h(RTCKr-TDO)}$ Hold time, TDO after RTCKf                         | 0   |     | ns   |
| 5   | $t_{d(TCKf-TDO)}$ Delay time, TDO valid after RTCK fall (RTCKf)       |     | 12  | ns   |

(1) Timings for TDO are specified for a maximum of 50pF load on TDO

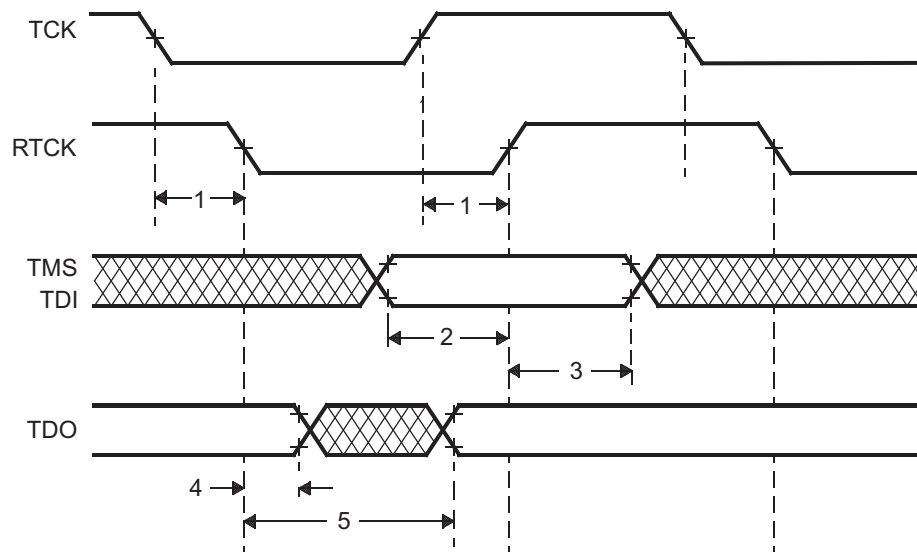


图 6-20. JTAG Timing

### 6.21.6 Advanced JTAG Security Module

This device includes an Advanced JTAG Security Module (AJSM), which provides maximum security to the device's memory content by allowing users to secure the device after programming.

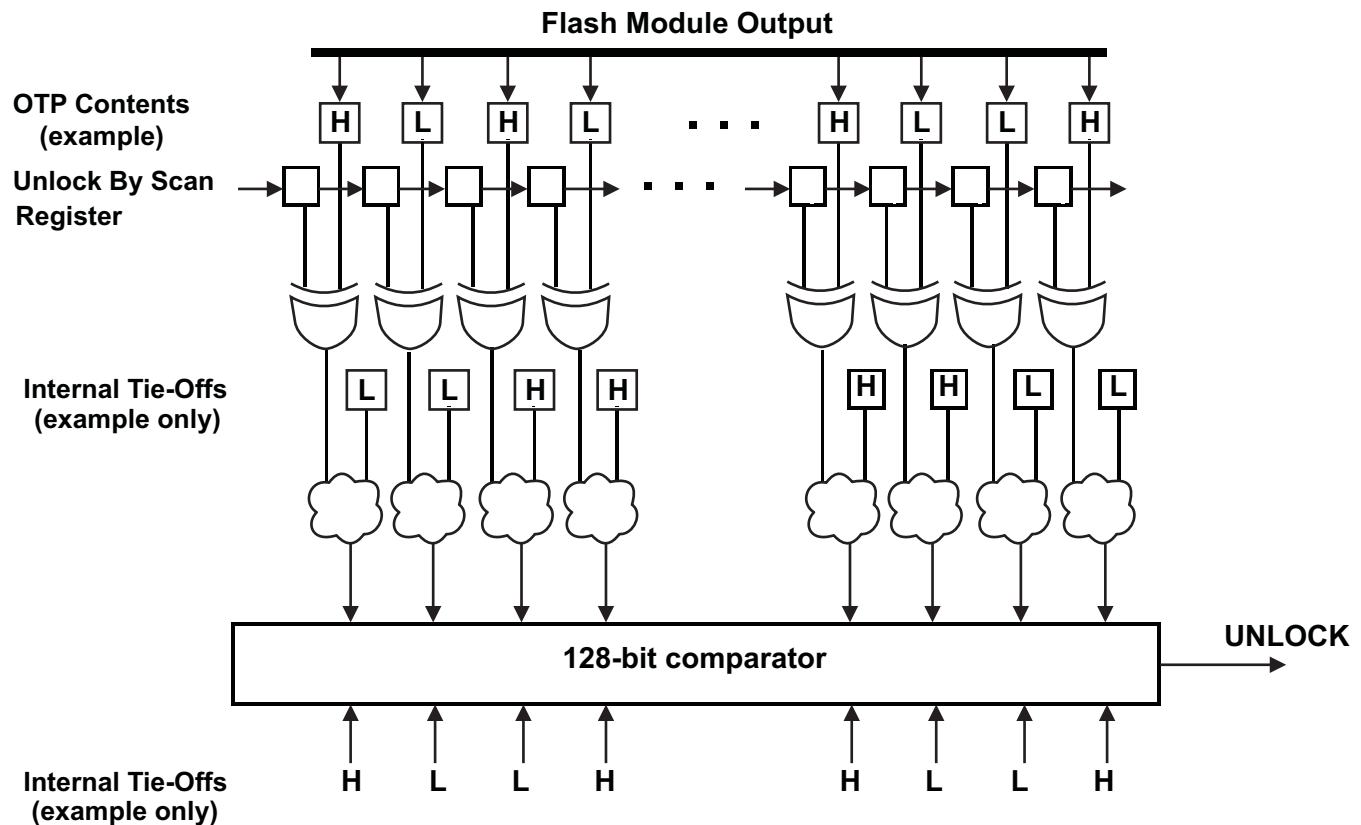


图 6-21. AJSM Unlock

The device is unsecure by default by virtue of a 128-bit visible unlock code programmed in the OTP address 0xF0000000. The OTP contents are XOR-ed with the "Unlock By Scan" register contents. The outputs of these XOR gates are again combined with a set of secret internal tie-offs. The output of this combinational logic is compared against a secret hard-wired 128-bit value. A match results in the UNLOCK signal being asserted, so that the device is now unsecure.

A user can secure the device by changing at least one bit in the visible unlock code from 1 to 0. Changing a 0 to 1 is not possible since the visible unlock code is stored in the One Time Programmable (OTP) flash region. Also, changing all the 128 bits to zeros is not a valid condition and will permanently secure the device.

Once secured, a user can unsecure the device by scanning an appropriate value into the "Unlock By Scan" register of the AJSM module. The value to be scanned is such that the XOR of the OTP contents and the Unlock-By-Scan register contents results in the original visible unlock code.

The Unlock-By-Scan register is reset only upon asserting power-on reset (nPORRST).

A secure device only permits JTAG accesses to the AJSM scan chain via the Secondary Tap 2 of the ICEPick module. All other secondary taps, test taps and the boundary scan interface are not accessible in this state.



### 6.21.7 Embedded Trace Macrocell (ETM-R4)

The device contains a ETM-R4 module with a 32-bit internal data port. The ETM-R4 module is connected to a TPIU with a 32-bit data bus; the TPIU provides a 35-bit (32-bit data, 3-bit control) external interface for trace. The ETM-R4 is CoreSight compliant and follows the ETM v3 specification; for more details see ARM CoreSight ETM-R4 TRM specification.

#### 6.21.7.1 ETM TRACECLKIN Selection

The ETM clock source can be selected as either VCLK or the external ETMTRACECLKIN pin. The selection is done by the EXTCTRL0UT[1:0] control bits of the TPIU; the default is '00'. The address of this register is TPIU base address + 0x404.

Before you begin accessing TPIU registers, TPIU should be unlocked via coresight key and 1 or 2 should be written to this register.

表 6-41. TPIU / TRACECLKIN Selection

| EXTCTRL0UT[1:0] | TPIU/TRACECLKIN |
|-----------------|-----------------|
| 00              | tied-zero       |
| 01              | VCLK            |
| 10              | ETMTRACECLKIN   |
| 11              | tied-zero       |

#### 6.21.7.2 Timing Specifications

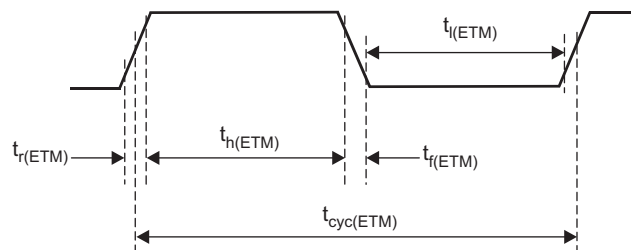


图 6-22. ETMTRACECLKOUT Timing

表 6-42. ETMTRACECLK Timing

|                |                          | MIN                   | MAX | UNIT |
|----------------|--------------------------|-----------------------|-----|------|
| $t_{cyc(ETM)}$ | Clock period             | $t_{(HCLK)} \times 4$ |     |      |
| $t_{l(ETM)}$   | Low pulse width          | 20                    |     | ns   |
| $t_{h(ETM)}$   | High pulse width         | 20                    |     | ns   |
| $t_{r(ETM)}$   | Clock and data rise time |                       | 3   | ns   |
| $t_{f(ETM)}$   | Clock and data fall time |                       | 3   | ns   |

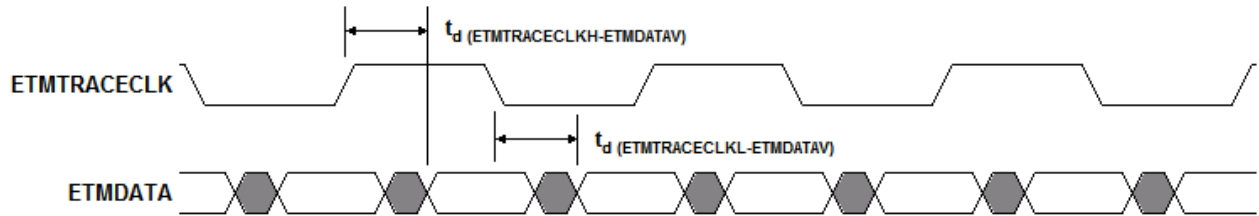


图 6-23. ETMDATA Timing

表 6-43. ETMDATA Timing

|                                     |                                                        | TMS5703137CGWTQEP |     | TMS5703137CGWTMEP |     | UNIT |
|-------------------------------------|--------------------------------------------------------|-------------------|-----|-------------------|-----|------|
|                                     |                                                        | MIN               | MAX | MIN               | MAX |      |
| $t_d(\text{ETMTRACECLKH-ETMDATAV})$ | Delay time from ETM trace clock high to ETM data valid | 1.5               | 7   | 1.3               | 7   | ns   |
| $t_d(\text{ETMTRACECLKL-ETMDATAV})$ | Delay time from ETM trace clock low to ETM data valid  | 1.5               | 7   | 1.3               | 7   |      |

注

The ETMTRACECLK and ETMDATA timing is based on a 15pF load and for ambient temperature lower than 85°C.

### 6.21.8 RAM Trace Port (RTP)

The RTP provides the ability to datalog the RAM contents of the devices or accesses to peripherals without program intrusion. It can trace all data write or read accesses to internal RAM. In addition, it provides the capability to directly transfer data to a FIFO to support a CPU-controlled transmission of the data. The trace data is transmitted over a dedicated external interface.

#### 6.21.8.1 Features

The RTP offers the following features:

- Two modes of operation - Trace Mode and Direct Data Mode
  - Trace Mode
    - Non-intrusive data trace on write or read operation
    - Visibility of RAM content at any time on external capture hardware
    - Trace of peripheral accesses
    - Two configurable trace regions for each RAM module to limit amount of data to be traced
    - FIFO to store data and address of data of multiple read/write operations
    - Trace of CPU and/or DMA accesses with indication of the master in the transmitted data packet
  - Direct Data Mode
    - Directly write data with the CPU or trace read operations to a FIFO, without transmitting header and address information
- Dedicated synchronous interface to transmit data to external devices
- Free-running clock generation or clock stop mode between transmissions
- Up to 100 Mbit per sec/pin transfer rate for transmitting data
- Pins not used in functional mode can be used as GPIOs

#### 6.21.8.2 Timing Specifications

表 6-44. RTPCLK Timing

|                       |                                                                     |                | MIN                                               | UNIT |
|-----------------------|---------------------------------------------------------------------|----------------|---------------------------------------------------|------|
| $t_{\text{cyc(RTP)}}$ | Clock period, prescaled from HCLK; must not be faster than HCLK / 2 | –40°C to 125°C | 11 (90 MHz)                                       | ns   |
| $t_{\text{h(RTP)}}$   | High pulse width                                                    | –40°C to 125°C | $((t_{\text{cyc(RTP)}}) / 2) - ((t_r + t_f) / 2)$ |      |
| $t_{\text{l(RTP)}}$   | Low pulse width                                                     | –40°C to 125°C | $((t_{\text{cyc(RTP)}}) / 2) - ((t_r + t_f) / 2)$ |      |

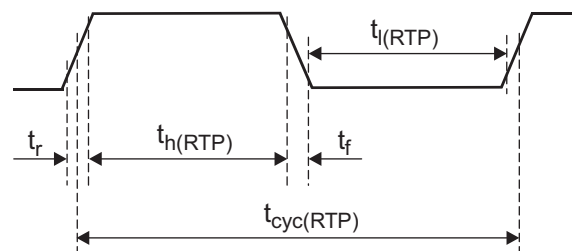


图 6-24. RTPCLK Timing

表 6-45. RTPDATA Timing

|                                   |                 | MIN | MAX | UNIT |
|-----------------------------------|-----------------|-----|-----|------|
| $t_{\text{d(RTPCLKH-RTPSYNCRV)}}$ | SYNC delay time | –5  | 4   | ns   |
| $t_{\text{d(RTPCLKH-RTPDATAV)}}$  | Data delay time | –5  | 4   |      |

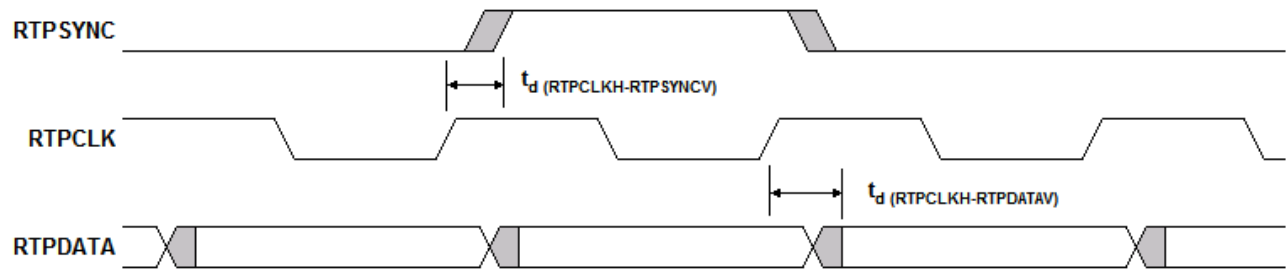


图 6-25. RTPDATA Timing

表 6-46. RTPnENA Timing

|                |                                                                                                     | MIN                                             | MAX                                             | UNIT |
|----------------|-----------------------------------------------------------------------------------------------------|-------------------------------------------------|-------------------------------------------------|------|
| $t_{dis(RTP)}$ | Time RTPnENA must go high before what would be the next RTPSYNC, to ensure delaying the next packet | $3t_{c(HCLK)} + t_{r(RTPSYNC)} + 12 \text{ ns}$ |                                                 |      |
| $t_{ena(RTP)}$ | Time after RTPnENA goes low before a packet that has been halted, resumes                           | $4t_{c(HCLK)} + t_{r(RTPSYNC)}$                 | $5t_{c(HCLK)} + t_{r(RTPSYNC)} + 12 \text{ ns}$ |      |

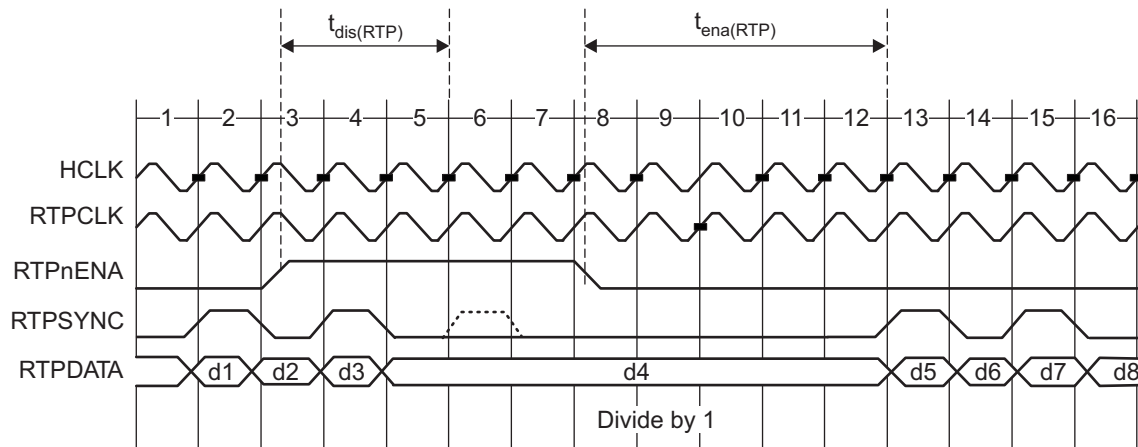


图 6-26. RTPnENA Timing

## 6.21.9 Data Modification Module (DMM)

The DMM provides the capability to modify data in the entire 4 GB address space of the devices from an external peripheral, with minimal interruption of the application.

### 6.21.9.1 Features

The DMM module has the following features:

- Acts as a bus master, thus enabling direct writes to the 4GB address space without CPU intervention
- Writes to memory locations specified in the received packet (leverages packets defined by trace mode of the RAM trace port (RTP) module)
- Writes received data to consecutive addresses, which are specified by the DMM module (leverages packets defined by direct data mode of RTP module)
- Configurable port width (1, 2, 4, 8, 16 pins)
- Up to 100 Mbit/s pin data rate
- Unused pins configurable as GPIO pins

### 6.21.9.2 Timing Specifications

表 6-47. DMMCLK Timing

|                |                  |                | MIN                                        | UNIT |
|----------------|------------------|----------------|--------------------------------------------|------|
| $t_{cyc}(DMM)$ | Clock period     |                | $t_{c(HCLK)} \times 2$                     |      |
| $t_h(DMM)$     | High pulse width | –40°C to 125°C | $((t_{cyc}(DMM)) / 2) - ((t_r + t_f) / 2)$ |      |
| $t_l(DMM)$     | Low pulse width  | –40°C to 125°C | $((t_{cyc}(DMM)) / 2) - ((t_r + t_f) / 2)$ |      |

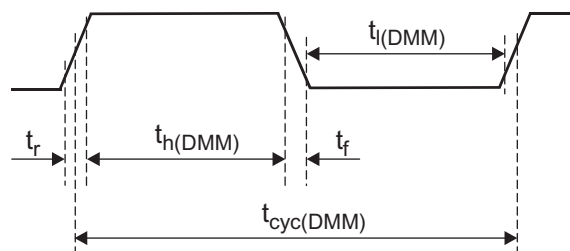


图 6-27. DMMCLK Timing

表 6-48. DMMDATA Timing

| PARAMETER      |                                             | MIN  | UNIT |
|----------------|---------------------------------------------|------|------|
| $t_{ssu}(DMM)$ | SYNC active to clk falling edge setup time  | 2 ns | ns   |
| $t_{sh}(DMM)$  | clk falling edge to SYNC deactive hold time | 3 ns |      |
| $t_{dsu}(DMM)$ | DATA to clk falling edge setup time         | 2 ns |      |
| $t_{dh}(DMM)$  | clk falling edge to DATA hold time          | 3 ns |      |

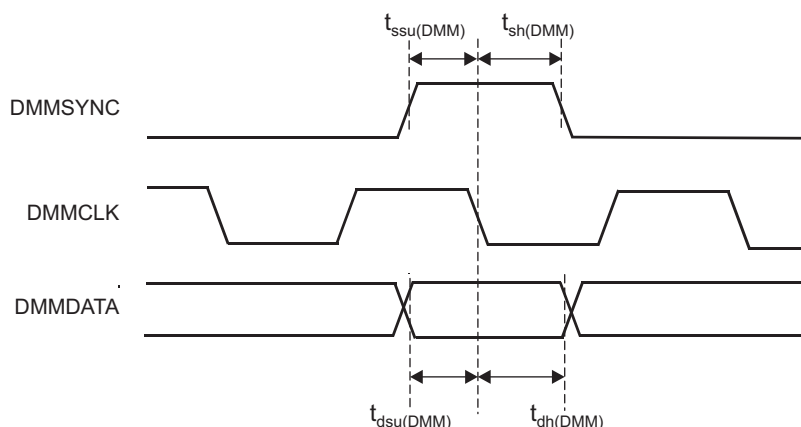


图 6-28. DMMDATA Timing

图 6-29 shows a case with 1 DMM packet per 2 DMMCLK cycles (Mode = Direct Data Mode, data width = 8, portwidth = 4) where none of the packets received by the DMM are sent out, leading to filling up of the internal buffers. The DMMnENA signal is shown asserted, after the first two packets have been received and synchronised to the HCLK domain. Here, the DMM has the capacity to accept packets D4x, D5x, D6x, D7x. Packet D8 would result in an overflow. Once DMMnENA is asserted, the DMM expects to stop receiving packets after 4 HCLK cycles; once DMMnENA is de-asserted, the DMM can handle packets immediately (after 0 HCLK cycles).

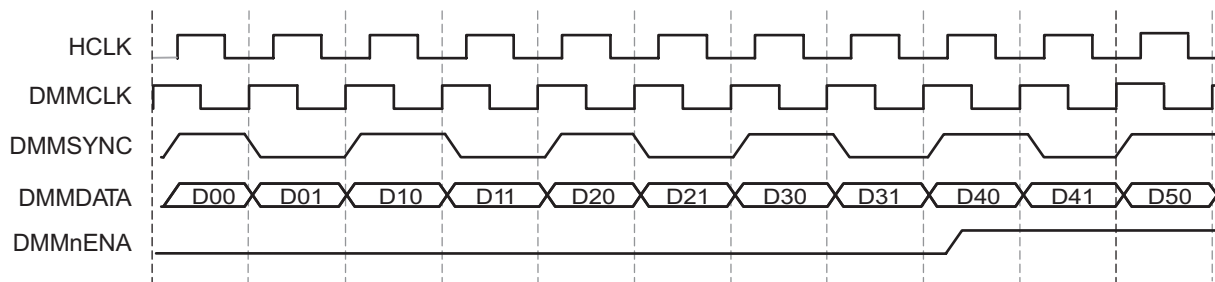


图 6-29. DMMnENA Timing

### 6.21.10 Boundary Scan Chain

The device supports IEEE1149.1-compliant boundary scan for testing pin-to-pin compatibility. The boundary scan chain is connected to the Boundary Scan Interface of the ICEPICK module.

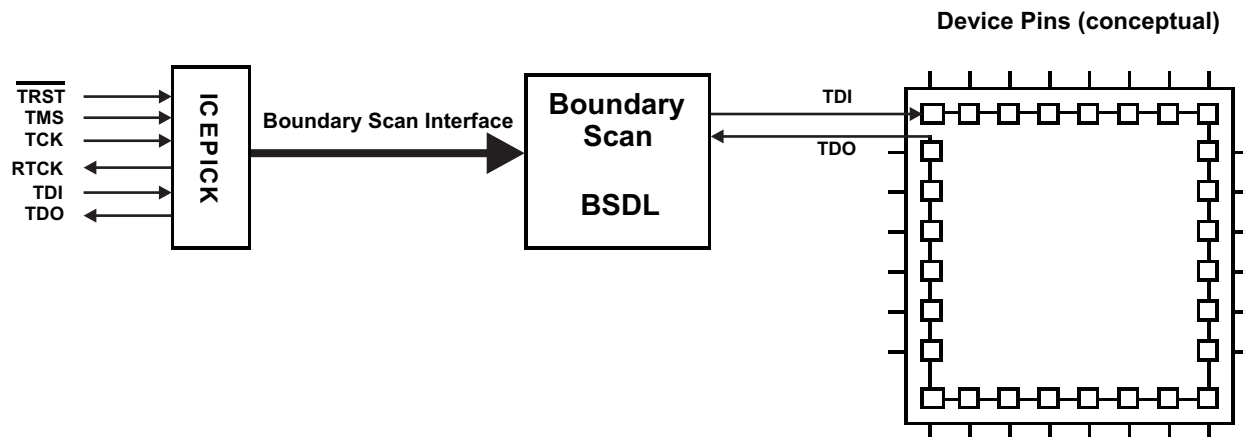


图 6-30. Boundary Scan Implementation (Conceptual Diagram)

Data is serially shifted into all boundary-scan buffers via TDI, and out via TDO.

## 7 Peripheral Information

### 7.1 Peripheral Legend

表 7-1. Peripheral Legend

| Abbreviation | Full Name                               |
|--------------|-----------------------------------------|
| MibADC       | Analog To Digital Converter             |
| CCM-R4F      | CPU Compare Module - CortexR4F          |
| CRC          | Cyclic Redundancy Check                 |
| DCAN         | Controller Area Network                 |
| DCC          | Dual Clock Comparator                   |
| DMA          | Direct Memory Access                    |
| DMM          | Data Modification Module                |
| EMIF         | External Memory Interface               |
| ESM          | Error Signaling Module                  |
| ETM-R4F      | Embedded Trace Macrocell - CortexR4F    |
| FTU          | FlexRay Transfer Unit                   |
| GPIO         | General-Purpose Input/Output            |
| HTU          | High End Timer Transfer Unit            |
| I2C          | Inter-Integrated Circuit                |
| LIN          | Local Interconnect Network              |
| MIBSPI       | Multibuffer Serial Peripheral Interface |
| N2HET        | Platform High-End Timer                 |
| POM          | Parameter Overlay Module                |
| RTI          | Real-Time Interrupt Module              |
| RTP          | RAM Trace Port                          |
| SCI          | Serial Communications Interface         |
| SPI          | Serial Peripheral Interface             |
| VIM          | Vectored Interrupt Manager              |

### 7.2 Multi-Buffered 12bit Analog-to-Digital Converter

The multibuffered A-to-D converter (MibADC) has a separate power bus for its analog circuitry that enhances the A-to-D performance by preventing digital switching noise on the logic circuitry which could be present on  $V_{SS}$  and  $V_{CC}$  from coupling into the A-to-D analog stage. All A-to-D specifications are given with respect to  $AD_{REFLO}$  unless otherwise noted.

表 7-2. MibADC Overview

| Description            | Value                                                                             |
|------------------------|-----------------------------------------------------------------------------------|
| Resolution             | 12 bits                                                                           |
| Monotonic              | Assured                                                                           |
| Output conversion code | 00h to FFFh [00 for $V_{AI} \leq AD_{REFLO}$ ; FFF for $V_{AI} \geq AD_{REFHI}$ ] |

#### 7.2.1 Features

- 10-/12-bit resolution
- $AD_{REFHI}$  and  $AD_{REFLO}$  pins (high and low reference voltages)
- Total Sample/Hold/Convert time: 600ns Typical Minimum at 30MHz ADCLK
- One memory region per conversion group is available (event, group 1, group 2)
- Allocation of channels to conversion groups is completely programmable
- Memory regions are serviced either by interrupt or by DMA



- Programmable interrupt threshold counter is available for each group
- Programmable magnitude threshold interrupt for each group for any one channel
- Option to read either 8-bit, 10-bit or 12-bit values from memory regions
- Single or continuous conversion modes
- Embedded self-test
- Embedded calibration logic
- Enhanced power-down mode
  - Optional feature to automatically power down ADC core when no conversion is in progress
- External event pin (ADEVT) programmable as general-purpose I/O

## 7.2.2 Event Trigger Options

The ADC module supports 3 conversion groups: Event Group, Group1 and Group2. Each of these 3 groups can be configured to be hardware event-triggered. In that case, the application can select from among 8 event sources to be the trigger for a group's conversions.

### 7.2.2.1 Default MIBADC1 Event Trigger Hookup

表 7-3. MIBADC1 Event Trigger Hookup

| Event Number | Source Select Bits For G1, G2 Or Event<br>(G1SRC[2:0], G2SRC[2:0] or EVSRC[2:0]) | Trigger                 |
|--------------|----------------------------------------------------------------------------------|-------------------------|
| 1            | 000                                                                              | ADEVT                   |
| 2            | 001                                                                              | N2HET1[8]               |
| 3            | 010                                                                              | N2HET1[10]              |
| 4            | 011                                                                              | RTI compare 0 interrupt |
| 5            | 100                                                                              | N2HET1[12]              |
| 6            | 101                                                                              | N2HET1[14]              |
| 7            | 110                                                                              | GIOB[0]                 |
| 8            | 111                                                                              | GIOB[1]                 |

#### 注

For ADEVT, N2HET1 and GIOB trigger sources, the connection to the MibADC1 module trigger input is made from the output side of the input buffer. This way, a trigger condition can be generated either by configuring the function as output onto the pad (via the mux control), or by driving the function from an external trigger source as input. If the mux control module is used to select different functionality instead of the ADEVT, N2HET1[x] or GIOB[x] signals, then care must be taken to disable these signals from triggering conversions; there is no multiplexing on the input connections.

#### 注

For the RTI compare 0 interrupt source, the connection is made directly from the output of the RTI module. That is, the interrupt condition can be used as a trigger source even if the actual interrupt is not signaled to the CPU.

### 7.2.2.2 Alternate MIBADC1 Event Trigger Hookup

表 7-4. Alternate MIBADC1 Event Trigger Hookup

| Event Number | Source Select Bits for G1, G2 or Event<br>(G1SRC[2:0], G2SRC[2:0] or EVSRC[2:0]) | Trigger   |
|--------------|----------------------------------------------------------------------------------|-----------|
| 1            | 000                                                                              | ADEVT     |
| 2            | 001                                                                              | N2HET2[5] |

**表 7-4. Alternate MIBADC1 Event Trigger Hookup (continued)**

| Event Number | Source Select Bits for G1, G2 or Event<br>(G1SRC[2:0], G2SRC[2:0] or EVSRC[2:0]) | Trigger                 |
|--------------|----------------------------------------------------------------------------------|-------------------------|
| 3            | 010                                                                              | N2HET1[27]              |
| 4            | 011                                                                              | RTI compare 0 interrupt |
| 5            | 100                                                                              | N2HET1[17]              |
| 6            | 101                                                                              | N2HET1[19]              |
| 7            | 110                                                                              | N2HET1[11]              |
| 8            | 111                                                                              | N2HET2[13]              |

The selection between the default MIBADC1 event trigger hook-up versus the alternate event trigger hook-up is done by multiplexing control module register 30 bits 0 and 1.

If 30[0] = 1, then the default MibADC1 event trigger hook-up is used.

If 30[0] = 0 and 30[1] = 1, then the alternate MibADC1 event trigger hook-up is used.

#### 注

For ADEVT trigger source, the connection to the MibADC1 module trigger input is made from the output side of the input buffer. This way, a trigger condition can be generated either by configuring ADEVT as an output function on to the pad (via the mux control), or by driving the ADEVT signal from an external trigger source as input. If the mux control module is used to select different functionality instead of the ADEVT signal, then care must be taken to disable ADEVT from triggering conversions; there is no multiplexing on the input connection.

#### 注

For N2HETx trigger sources, the connection to the MibADC1 module trigger input is made from the input side of the output buffer (at the N2HETx module boundary). This way, a trigger condition can be generated even if the N2HETx signal is not selected to be output on the pad.

#### 注

For the RTI compare 0 interrupt source, the connection is made directly from the output of the RTI module. That is, the interrupt condition can be used as a trigger source even if the actual interrupt is not signaled to the CPU.

### 7.2.2.3 Default MIBADC2 Event Trigger Hookup

**表 7-5. MIBADC2 Event Trigger Hookup**

| Event Number | Source Select Bits for G1, G2 or Event<br>(G1SRC[2:0], G2SRC[2:0] or EVSRC[2:0]) | Trigger       |
|--------------|----------------------------------------------------------------------------------|---------------|
| 1            | 000                                                                              | AD2EVT        |
| 2            | 001                                                                              | N2HET1[8]     |
| 3            | 010                                                                              | N2HET1[10]    |
| 4            | 011                                                                              | RTI compare 0 |
| 5            | 100                                                                              | N2HET1[12]    |
| 6            | 101                                                                              | N2HET1[14]    |
| 7            | 110                                                                              | GIOB[0]       |
| 8            | 111                                                                              | GIOB[1]       |

## 注

For AD2EVT, N2HET1 and GIOB trigger sources, the connection to the MibADC2 module trigger input is made from the output side of the input buffer. This way, a trigger condition can be generated either by configuring the function as output onto the pad (via the mux control), or by driving the function from an external trigger source as input. If the mux control module is used to select different functionality instead of the AD2EVT, N2HET1[x] or GIOB[x] signals, then care must be taken to disable these signals from triggering conversions; there is no multiplexing on the input connections.

## 注

For the RTI compare 0 interrupt source, the connection is made directly from the output of the RTI module. That is, the interrupt condition can be used as a trigger source even if the actual interrupt is not signaled to the CPU.

#### 7.2.2.4 Alternate MIBADC2 Event Trigger Hookup

表 7-6. Alternate MIBADC2 Event Trigger Hookup

| Event Number | Source Select Bits for G1, G2 or Event<br>(G1SRC[2:0], G2SRC[2:0] or EVSRC[2:0]) | Trigger       |
|--------------|----------------------------------------------------------------------------------|---------------|
| 1            | 000                                                                              | AD2EVT        |
| 2            | 001                                                                              | N2HET2[5]     |
| 3            | 010                                                                              | N2HET1[27]    |
| 4            | 011                                                                              | RTI compare 0 |
| 5            | 100                                                                              | N2HET1[17]    |
| 6            | 101                                                                              | N2HET1[19]    |
| 7            | 110                                                                              | N2HET1[11]    |
| 8            | 111                                                                              | N2HET2[13]    |

The selection between the default MIBADC2 event trigger hook-up versus the alternate event trigger hook-up is done by multiplexing control module register 30 bits 0 and 1.

If 30[0] = 1, then the default MibADC2 event trigger hook-up is used.

If 30[0] = 0 and 30[1] = 1, then the alternate MibADC2 event trigger hook-up is used.

## 注

For AD2EVT trigger source, the connection to the MibADC2 module trigger input is made from the output side of the input buffer. This way, a trigger condition can be generated either by configuring AD2EVT as an output function on to the pad (via the mux control), or by driving the AD2EVT signal from an external trigger source as input. If the mux control module is used to select different functionality instead of the AD2EVT signal, then care must be taken to disable AD2EVT from triggering conversions; there is no multiplexing on the input connections.

## 注

For N2HETx trigger sources, the connection to the MibADC2 module trigger input is made from the input side of the output buffer (at the N2HETx module boundary). This way, a trigger condition can be generated even if the N2HETx signal is not selected to be output on the pad.

---

注

For the RTI compare 0 interrupt source, the connection is made directly from the output of the RTI module. That is, the interrupt condition can be used as a trigger source even if the actual interrupt is not signaled to the CPU.

---

## 7.2.3 ADC Electrical and Timing Specifications

表 7-7. MibADC Recommended Operating Conditions

|                     |                                                                                                                        | MIN                 | MAX                 | UNIT |
|---------------------|------------------------------------------------------------------------------------------------------------------------|---------------------|---------------------|------|
| AD <sub>REFHI</sub> | A-to-D high-voltage reference source                                                                                   | AD <sub>REFLO</sub> | V <sub>CCAD</sub>   | V    |
| AD <sub>REFLO</sub> | A-to-D low-voltage reference source                                                                                    | V <sub>SSAD</sub>   | AD <sub>REFHI</sub> | V    |
| V <sub>AI</sub>     | Analog input voltage                                                                                                   | AD <sub>REFLO</sub> | AD <sub>REFHI</sub> | V    |
| I <sub>AIC</sub>    | Analog input clamp current<br>(V <sub>AI</sub> < V <sub>SSAD</sub> – 0.3 or V <sub>AI</sub> > V <sub>CCAD</sub> + 0.3) | –2                  | 2                   | mA   |

表 7-8. MibADC Electrical Characteristics Over Full Ranges of Recommended Operating Conditions

| PARAMETER                         |                                         | DESCRIPTION / TEST CONDITIONS               |                                                                                                    | MIN   | TYP | MAX  | UNIT |
|-----------------------------------|-----------------------------------------|---------------------------------------------|----------------------------------------------------------------------------------------------------|-------|-----|------|------|
| R <sub>mux</sub>                  | Analog input mux on-resistance          | See 图 7-1                                   |                                                                                                    |       |     | 250  | Ω    |
| R <sub>samp</sub>                 | ADC sample switch on-resistance         | See 图 7-1                                   |                                                                                                    |       |     | 250  | Ω    |
| C <sub>mux</sub>                  | Input mux capacitance                   | See 图 7-1                                   |                                                                                                    |       |     | 16   | pF   |
| C <sub>samp</sub>                 | ADC sample capacitance                  | See 图 7-1                                   |                                                                                                    |       |     | 13   | pF   |
| I <sub>AIL</sub>                  | Analog off-state input leakage current  | V <sub>CCAD</sub> = 3.6 V maximum           | V <sub>SSAD</sub> ≤ V <sub>IN</sub> < V <sub>SSAD</sub> + 100 mV                                   | -300  |     | 200  | nA   |
|                                   |                                         |                                             | V <sub>SSAD</sub> + 100 mV ≤ V <sub>IN</sub> ≤ V <sub>CCAD</sub> - 200 mV                          | -200  |     | 200  | nA   |
|                                   |                                         |                                             | V <sub>CCAD</sub> - 200 mV < V <sub>IN</sub> ≤ V <sub>CCAD</sub>                                   | -200  |     | 500  | nA   |
|                                   | Analog off-state input leakage current  | V <sub>CCAD</sub> = 5.5 V maximum           | V <sub>SSAD</sub> ≤ V <sub>IN</sub> < V <sub>SSAD</sub> + 300 mV                                   | -1000 |     | 250  | nA   |
|                                   |                                         |                                             | V <sub>SSAD</sub> + 300 mV ≤ V <sub>IN</sub> ≤ V <sub>CCAD</sub> - 300 mV                          | -250  |     | 250  | nA   |
|                                   |                                         |                                             | V <sub>CCAD</sub> - 300 mV < V <sub>IN</sub> ≤ V <sub>CCAD</sub>                                   | -250  |     | 1000 | nA   |
| I <sub>AOSB1</sub> <sup>(1)</sup> | ADC1 Analog on-state input bias current | V <sub>CCAD</sub> = 3.6 V maximum           | V <sub>SSAD</sub> ≤ V <sub>IN</sub> < V <sub>SSAD</sub> + 100 mV                                   | -8    |     | 2    | μA   |
|                                   |                                         |                                             | V <sub>SSAD</sub> + 100 mV < V <sub>IN</sub> < V <sub>CCAD</sub> - 200 mV                          | -4    |     | 2    |      |
|                                   |                                         |                                             | V <sub>CCAD</sub> - 200 mV < V <sub>IN</sub> < V <sub>CCAD</sub>                                   | -4    |     | 12   |      |
| I <sub>AOSB2</sub> <sup>(1)</sup> | ADC2 Analog on-state input bias current | V <sub>CCAD</sub> = 3.6V maximum            | V <sub>SSAD</sub> ≤ V <sub>IN</sub> < V <sub>SSAD</sub> + 100 mV                                   | -7    |     | 2    | μA   |
|                                   |                                         |                                             | V <sub>SSAD</sub> + 100 mV ≤ V <sub>IN</sub> ≤ V <sub>CCAD</sub> - 200 mV                          | -4    |     | 2    |      |
|                                   |                                         |                                             | V <sub>CCAD</sub> - 200 mV < V <sub>IN</sub> ≤ V <sub>CCAD</sub>                                   | -4    |     | 10   |      |
| I <sub>AOSB1</sub> <sup>(1)</sup> | ADC1 Analog on-state input bias current | V <sub>CCAD</sub> = 5.5V maximum            | V <sub>SSAD</sub> ≤ V <sub>IN</sub> < V <sub>SSAD</sub> + 300 mV                                   | -10   |     | 3    | μA   |
|                                   |                                         |                                             | V <sub>SSAD</sub> + 300 mV ≤ V <sub>IN</sub> ≤ V <sub>CCAD</sub> - 300mV                           | -5    |     | 3    |      |
|                                   |                                         |                                             | V <sub>CCAD</sub> - 300 mV < V <sub>IN</sub> ≤ V <sub>CCAD</sub>                                   | -5    |     | 14   |      |
| I <sub>AOSB2</sub> <sup>(1)</sup> | ADC2 Analog on-state input bias current | V <sub>CCAD</sub> = 5.5V maximum            | V <sub>SSAD</sub> ≤ V <sub>IN</sub> < V <sub>SSAD</sub> + 300 mV                                   | -8    |     | 3    | μA   |
|                                   |                                         |                                             | V <sub>SSAD</sub> + 300 mV ≤ V <sub>IN</sub> ≤ V <sub>CCAD</sub> - 300 mV                          | -5    |     | 3    |      |
|                                   |                                         |                                             | V <sub>CCAD</sub> - 300 mV < V <sub>IN</sub> ≤ V <sub>CCAD</sub>                                   | -5    |     | 12   |      |
| I <sub>ADREFHI</sub>              |                                         | AD <sub>REFHI</sub> input current           | AD <sub>REFHI</sub> = V <sub>CCAD</sub> ; AD <sub>REFLO</sub> = V <sub>SSAD</sub> ; -40°C to 125°C |       |     | 3    | mA   |
| I <sub>CCAD</sub>                 | Static supply current                   | Normal operating mode; -40°C to 125°C       |                                                                                                    |       |     | 15   | mA   |
|                                   |                                         | ADC core in power down mode; -40°C to 125°C |                                                                                                    |       |     | 5    | μA   |

(1) If a shared channel is being converted by both ADC converters at the same time, the on-state leakage is equal to I<sub>AOSL1</sub> + I<sub>AOSL2</sub>

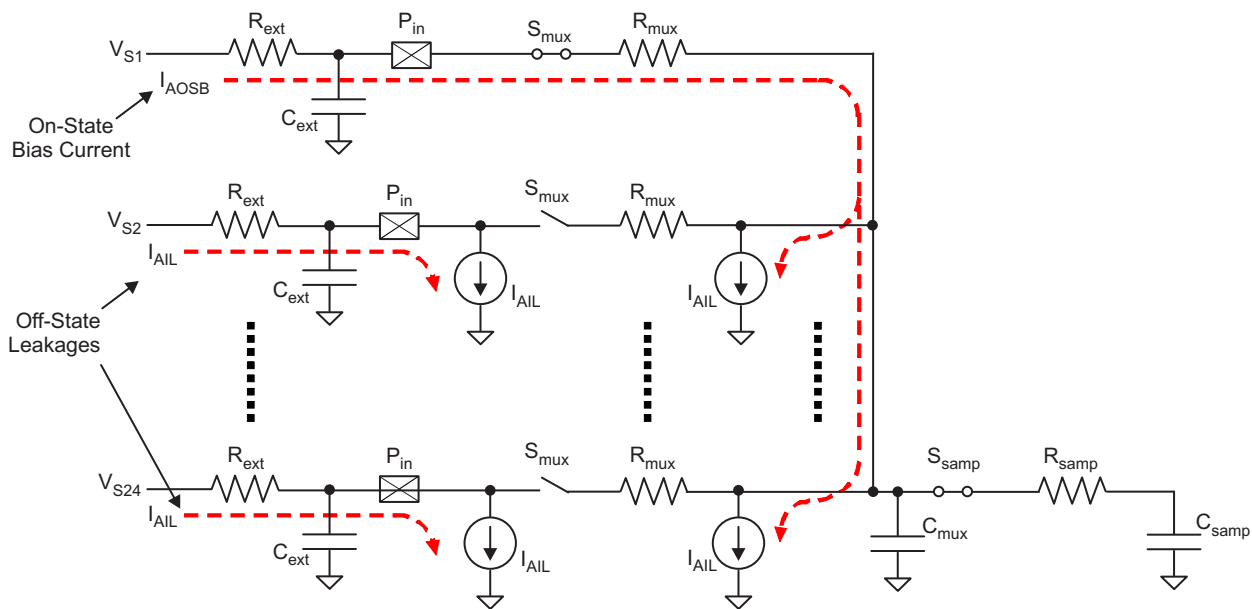


图 7-1. MibADC Input Equivalent Circuit

表 7-9. MibADC Timing Specifications

|                      |                                                               |                | MIN   | NOM | MAX | UNIT |
|----------------------|---------------------------------------------------------------|----------------|-------|-----|-----|------|
| $t_{c(ADCLK)}^{(1)}$ | Cycle time, MibADC clock                                      | -40°C to 125°C | 0.033 |     |     | μs   |
| $t_{d(SH)}^{(2)}$    | Delay time, sample and hold time                              | -40°C to 125°C | 0.2   |     |     | μs   |
| $t_{d(PU-ADV)}$      | Delay time from ADC power on until first input can be sampled | -40°C to 125°C | 1     |     |     | μs   |
| <b>12-bit mode</b>   |                                                               |                |       |     |     |      |
| $t_{d(c)}$           | Delay time, conversion time                                   | -40°C to 125°C | 0.4   |     |     | μs   |
| $t_{d(SHC)}^{(3)}$   | Delay time, total sample/hold and conversion time             | -40°C to 125°C | 0.6   |     |     | μs   |
| <b>10-bit mode</b>   |                                                               |                |       |     |     |      |
| $t_{d(c)}$           | Delay time, conversion time                                   | -40°C to 125°C | 0.33  |     |     | μs   |
| $t_{d(SHC)}^{(3)}$   | Delay time, total sample/hold and conversion time             | -40°C to 125°C | 0.53  |     |     | μs   |

- (1) The MibADC clock is the ADCLK, generated by dividing down the VCLK by a prescale factor defined by the ADCLOCKCR register bits 4:0.
- (2) The sample and hold time for the ADC conversions is defined by the ADCLK frequency and the AD<GP>SAMP register for each conversion group. The sample time needs to be determined by accounting for the external impedance connected to the input channel as well as the ADC's internal impedance.
- (3) This is the minimum sample/hold and conversion time that can be achieved. These parameters are dependent on many factors, e.g the prescale settings.

表 7-10. MibADC Operating Characteristics Over Full Ranges of Recommended Operating Conditions

| PARAMETER |                                                              | DESCRIPTION / TEST CONDITIONS                                                                                                        |                             | MIN | NOM | MAX  | UNIT               |
|-----------|--------------------------------------------------------------|--------------------------------------------------------------------------------------------------------------------------------------|-----------------------------|-----|-----|------|--------------------|
| CR        | Conversion range over which specified accuracy is maintained | $AD_{REFHI} - AD_{REFLO}$                                                                                                            | –40°C to 125°C              | 3   |     | 5.5  | V                  |
| $Z_{SET}$ | Zero Scale Offset                                            | Difference between the first ideal transition (from code 000h to 001h) and the actual transition                                     | 10-bit mode; –40°C to 125°C |     |     | 1    | LSB <sup>(1)</sup> |
|           |                                                              |                                                                                                                                      | 12-bit mode; –40°C to 125°C |     |     | 2    | LSB <sup>(2)</sup> |
| $F_{SET}$ | Full Scale Offset                                            | Difference between the range of the measured code transitions (from first to last) and the range of the ideal code transitions       | 10-bit mode; –40°C to 125°C |     |     | 2    | LSB                |
|           |                                                              |                                                                                                                                      | 12-bit mode; –40°C to 125°C |     |     | 3    | LSB                |
| $E_{DNL}$ | Differential nonlinearity error                              | Difference between the actual step width and the ideal value. (See Figure 76)                                                        | 10-bit mode                 |     |     | ±1.5 | LSB                |
|           |                                                              |                                                                                                                                      | 12-bit mode                 |     |     | ±2   | LSB                |
| $E_{INL}$ | Integral nonlinearity error                                  | Maximum deviation from the best straight line through the MibADC. MibADC transfer characteristics, excluding the quantization error. | 10-bit mode                 |     |     | ±2   | LSB                |
|           |                                                              |                                                                                                                                      | 12-bit mode                 |     |     | ±2   | LSB                |
| $E_{TOT}$ | Total unadjusted error                                       | Maximum value of the difference between an analog value and the ideal midstep value.                                                 | 10-bit mode                 |     |     | ±2   | LSB                |
|           |                                                              |                                                                                                                                      | 12-bit mode                 |     |     | ±4   | LSB                |

(1) 1 LSB =  $(AD_{REFHI} - AD_{REFLO}) / 2^{10}$  for 10-bit mode(2) 1 LSB =  $(AD_{REFHI} - AD_{REFLO}) / 2^{12}$  for 12-bit mode

## 7.2.4 Performance (Accuracy) Specifications

### 7.2.4.1 MibADC Nonlinearity Errors

The differential nonlinearity error shown in Figure 图 7-2 (sometimes referred to as differential linearity) is the difference between an actual step width and the ideal value of 1 LSB.

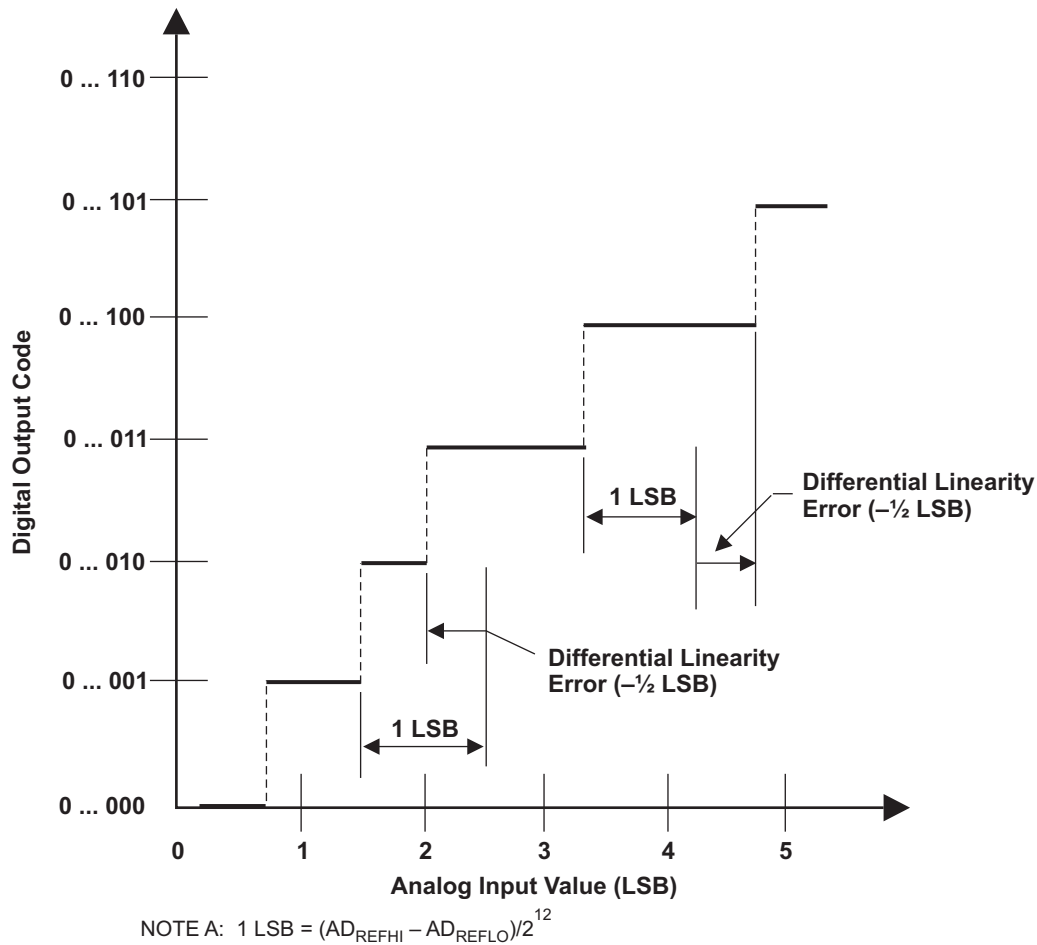


图 7-2. Differential Nonlinearity (DNL) Error



The integral nonlinearity error shown in Figure 图 7-3 (sometimes referred to as linearity error) is the deviation of the values on the actual transfer function from a straight line.

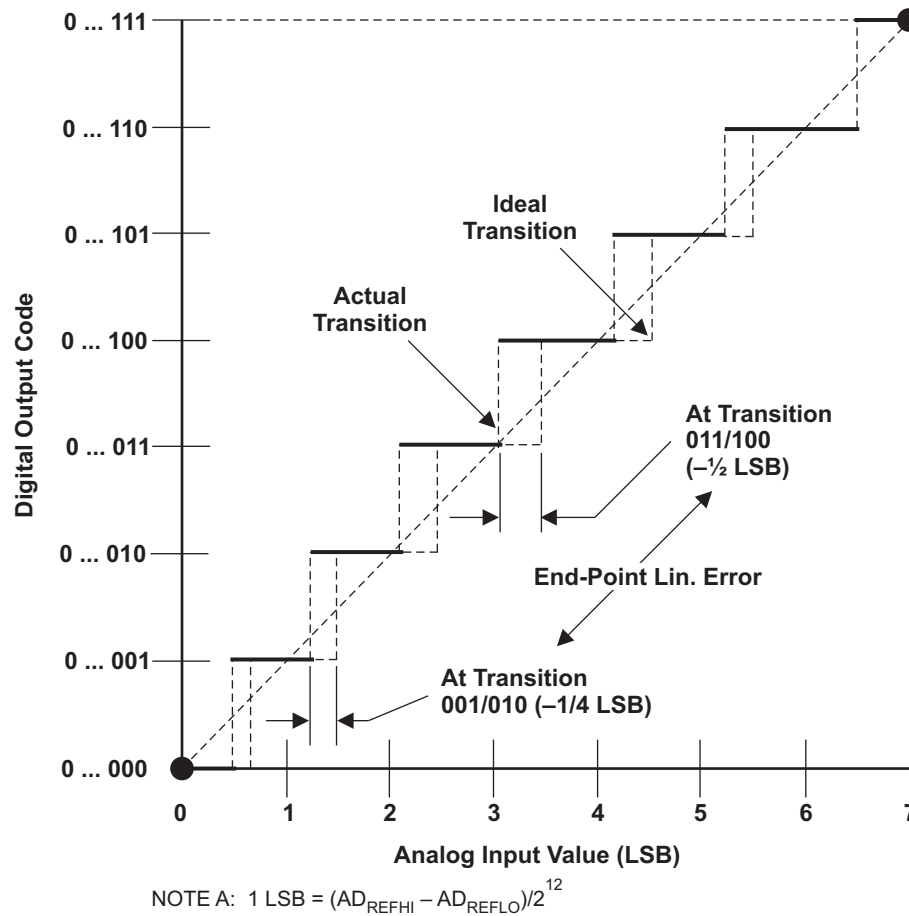


图 7-3. Integral Nonlinearity (INL) Error

#### 7.2.4.2 MibADC Total Error

The absolute accuracy or total error of an MibADC as shown in Figure 图 7-4 is the maximum value of the difference between an analog value and the ideal midstep value.

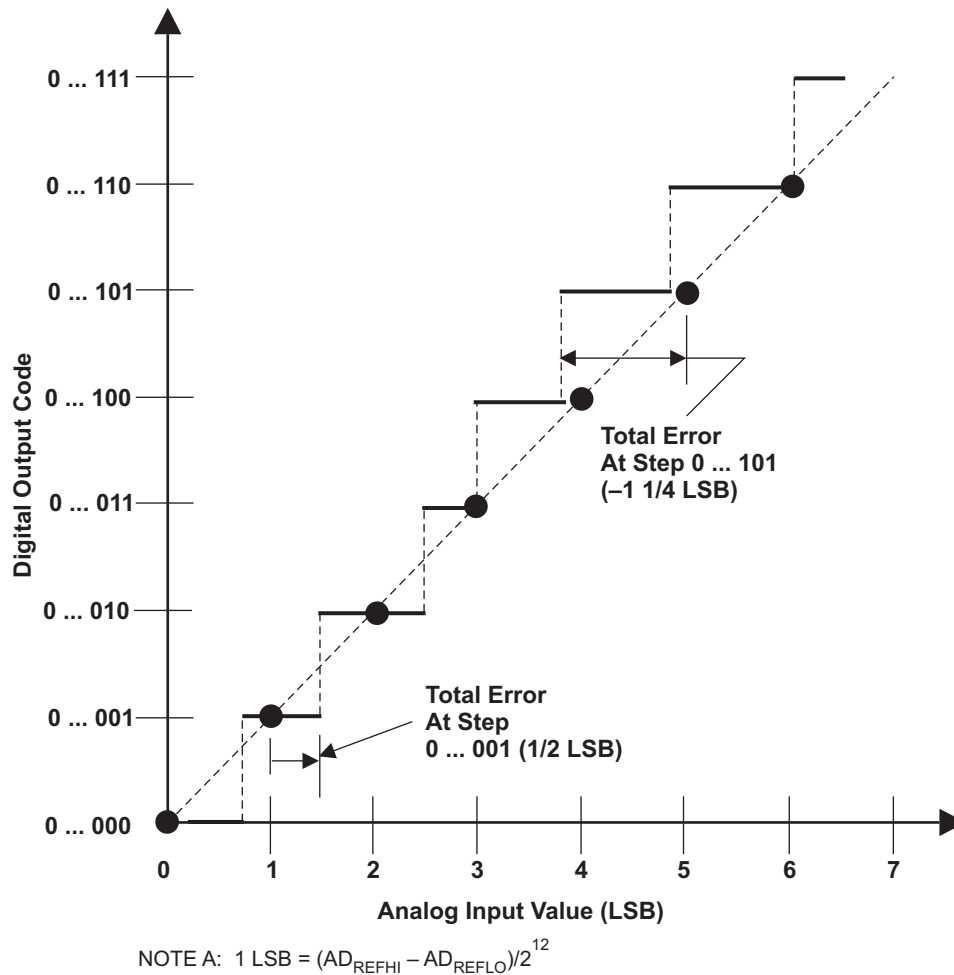


图 7-4. Absolute Accuracy (Total) Error

## 7.3 General-Purpose Input/Output

The GPIO module on this device supports two ports, GIOA and GIOB. The I/O pins are bidirectional and bit-programmable. Both GIOA and GIOB support external interrupt capability.

### 7.3.1 Features

The GPIO module has the following features:

- Each IO pin can be configured as:
  - Input
  - Output
  - Open Drain
- The interrupts have the following characteristics:
  - Programmable interrupt detection either on both edges or on a single edge (set in GIOINTDET)
  - Programmable edge-detection polarity, either rising or falling edge (set in GIOPOL register)
  - Individual interrupt flags (set in GIOFLG register)
  - Individual interrupt enables, set and cleared through GIOENASET and GIOENACLR registers respectively
  - Programmable interrupt priority, set through GIOLVLSET and GIOLVLCCLR registers
- Internal pullup/pulldown allows unused I/O pins to be left unconnected

For information on input and output timings see [节 5.11](#) and [节 5.12](#)

## 7.4 Enhanced High-End Timer (N2HET)

The N2HET is an advanced intelligent timer that provides sophisticated timing functions for real-time applications. The timer is software-controlled, using a reduced instruction set, with a specialized timer micromachine and an attached I/O port. The N2HET can be used for pulse width modulated outputs, capture or compare inputs, or general-purpose I/O.. It is especially well suited for applications requiring multiple sensor information and drive actuators with complex and accurate time pulses.

### 7.4.1 Features

The N2HET module has the following features:

- Programmable timer for input and output timing functions
- Reduced instruction set (30 instructions) for dedicated time and angle functions
- 160 words of instruction RAM protected by parity
- User defined number of 25-bit virtual counters for timer, event counters and angle counters
- 7-bit hardware counters for some pins allow up to 32-bit resolution in conjunction with the 25-bit virtual counters
- Up to 32 pins usable for input signal measurements or output signal generation
- Programmable suppression filter for each input pin with adjustable limiting frequency
- Low CPU overhead and interrupt load
- Efficient data transfer to or from the CPU memory with dedicated High-End-Timer Transfer Unit (HTU) or DMA
- Diagnostic capabilities with different loopback mechanisms and pin status readback functionality

### 7.4.2 N2HET RAM Organization

The timer RAM uses 4 RAM banks, where each bank has two port access capability. This means that one RAM address may be written while another address is read. The RAM words are 96-bits wide, which are split into three 32-bit fields (program, control, and data).

### 7.4.3 Input Timing Specifications

The N2HET instructions PCNT and WCAP impose some timing constraints on the input signals.

**表 7-11. Input Timing Requirements for the N2HET Input Capture Functionality**

|   |                                                                       |                | MIN <sup>(1) (2)</sup>         | MAX <sup>(1) (2)</sup>                | UNIT |
|---|-----------------------------------------------------------------------|----------------|--------------------------------|---------------------------------------|------|
| 1 | Input signal period, PCNT or WCAP for rising edge to rising edge      | –40°C to 125°C | 2 (hr) (lr) $t_{C(VCLK2)} + 2$ | $2^{25}$ (hr) (lr) $t_{C(VCLK2)} - 2$ | ns   |
| 2 | Input signal period, PCNT or WCAP for falling edge to falling edge    | –40°C to 125°C | 2 (hr) (lr) $t_{C(VCLK2)} + 2$ | $2^{25}$ (hr) (lr) $t_{C(VCLK2)} - 2$ | ns   |
| 3 | Input signal high phase, PCNT or WCAP for rising edge to falling edge | –40°C to 125°C | (hr) (lr) $t_{C(VCLK2)} + 2$   | $2^{25}$ (hr) (lr) $t_{C(VCLK2)} - 2$ | ns   |
| 4 | Input signal low phase, PCNT or WCAP for falling edge to rising edge  | –40°C to 125°C | (hr) (lr) $t_{C(VCLK2)} + 2$   | $2^{25}$ (hr) (lr) $t_{C(VCLK2)} - 2$ | ns   |

(1) hr = High-resolution prescaler, configured using the HRPFC field of the Prescale Factor Register (HETPFR).

(2) lr = Loop-resolution prescaler, configured using the LPPRC field of the Prescale Factor Register (HETPFR)

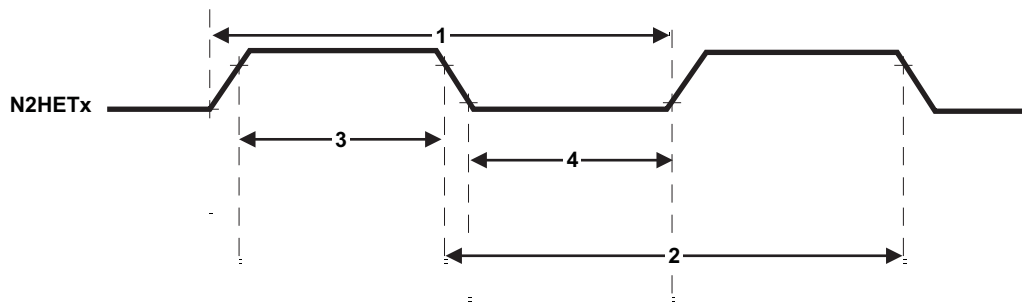


图 7-5. N2HET Input Capture Timings

Both N2HET1 and N2HET2 have channels that are enhanced to be able to capture inputs with smaller pulse widths than that specified in 表 7-11. See 表 7-13 for a list of which pins support small pulse capture.

The input capture capability for these channels is specified in the following table.

表 7-12. Input Timing Requirements for N2HET Channels With Enhanced Pulse Capture

|   |                                                                       |                | MIN                          | MAX                                   | UNIT |
|---|-----------------------------------------------------------------------|----------------|------------------------------|---------------------------------------|------|
| 1 | Input signal period, PCNT or WCAP for rising edge to rising edge      | –40°C to 125°C | (hr) (lr) $t_{C(VCLK2)} + 2$ | $2^{25}$ (hr) (lr) $t_{C(VCLK2)} - 2$ | ns   |
| 2 | Input signal period, PCNT or WCAP for falling edge to falling edge    | –40°C to 125°C | (hr) (lr) $t_{C(VCLK2)} + 2$ | $2^{25}$ (hr) (lr) $t_{C(VCLK2)} - 2$ | ns   |
| 3 | Input signal high phase, PCNT or WCAP for rising edge to falling edge | –40°C to 125°C | 2 (hr) $t_{C(VCLK2)} + 2$    | $2^{25}$ (hr) (lr) $t_{C(VCLK2)} - 2$ | ns   |
| 4 | Input signal low phase, PCNT or WCAP for falling edge to rising edge  | –40°C to 125°C | 2 (hr) $t_{C(VCLK2)} + 2$    | $2^{25}$ (hr) (lr) $t_{C(VCLK2)} - 2$ | ns   |

表 7-13. Input Capture Pin Capability

| Channel    | Supports 32-bit Capture | Enhanced Pulse Capture |
|------------|-------------------------|------------------------|
| N2HET1[00] | Yes                     | No                     |
| N2HET1[01] | Yes                     | No                     |
| N2HET1[02] | Yes                     | No                     |
| N2HET1[03] | Yes                     | No                     |
| N2HET1[04] | Yes                     | No                     |
| N2HET1[05] | Yes                     | No                     |
| N2HET1[06] | Yes                     | No                     |
| N2HET1[07] | Yes                     | No                     |
| N2HET1[08] | Yes                     | No                     |
| N2HET1[09] | Yes                     | No                     |
| N2HET1[10] | Yes                     | No                     |
| N2HET1[11] | Yes                     | No                     |
| N2HET1[12] | Yes                     | No                     |
| N2HET1[13] | Yes                     | No                     |
| N2HET1[14] | Yes                     | No                     |
| N2HET1[15] | Yes                     | Yes                    |
| N2HET1[16] | Yes                     | No                     |
| N2HET1[17] | Yes                     | No                     |
| N2HET1[18] | Yes                     | No                     |
| N2HET1[19] | Yes                     | No                     |
| N2HET1[20] | Yes                     | Yes                    |

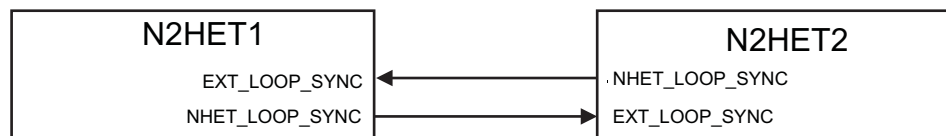
**表 7-13. Input Capture Pin Capability (continued)**

| Channel    | Supports 32-bit Capture | Enhanced Pulse Capture |
|------------|-------------------------|------------------------|
| N2HET1[21] | Yes                     | No                     |
| N2HET1[22] | Yes                     | No                     |
| N2HET1[23] | Yes                     | No                     |
| N2HET1[24] | Yes                     | No                     |
| N2HET1[25] | Yes                     | No                     |
| N2HET1[26] | Yes                     | No                     |
| N2HET1[27] | Yes                     | No                     |
| N2HET1[28] | Yes                     | No                     |
| N2HET1[29] | Yes                     | No                     |
| N2HET1[30] | Yes                     | No                     |
| N2HET1[31] | Yes                     | Yes                    |
| N2HET2[00] | Yes                     | No                     |
| N2HET2[01] | No                      | No                     |
| N2HET2[02] | No                      | No                     |
| N2HET2[03] | No                      | No                     |
| N2HET2[04] | Yes                     | No                     |
| N2HET2[05] | No                      | No                     |
| N2HET2[06] | Yes                     | No                     |
| N2HET2[07] | No                      | No                     |
| N2HET2[08] | No                      | No                     |
| N2HET2[09] | No                      | No                     |
| N2HET2[10] | No                      | No                     |
| N2HET2[11] | No                      | No                     |
| N2HET2[12] | Yes                     | Yes                    |
| N2HET2[13] | No                      | No                     |
| N2HET2[14] | Yes                     | Yes                    |
| N2HET2[15] | No                      | No                     |
| N2HET2[16] | Yes                     | Yes                    |
| N2HET2[18] | No                      | No                     |

#### 7.4.4 N2HET1-N2HET2 Interconnections

In some applications the N2HET resolutions must be synchronized. Some other applications require a single time base to be used for all PWM outputs and input timing captures.

The N2HET provides such a synchronization mechanism. The Clk\_master/slave (HETGCR.16) configures the N2HET in master or slave mode (default is slave mode). A N2HET in master mode provides a signal to synchronize the prescalers of the slave N2HET. The slave N2HET synchronizes its loop resolution to the loop resolution signal sent by the master. The slave does not require this signal after it receives the first synchronization signal. However, anytime the slave receives the re-synchronization signal from the master, the slave must synchronize itself again..



**图 7-6. N2HET1 – N2HET2 Synchronization Hookup**

## 7.4.5 N2HET Checking

### 7.4.5.1 Internal Monitoring

To assure correctness of the high-end timer operation and output signals, the two N2HET modules can be used to monitor each other's signals as shown in 图 7-7. The direction of the monitoring is controlled by the I/O multiplexing control module.

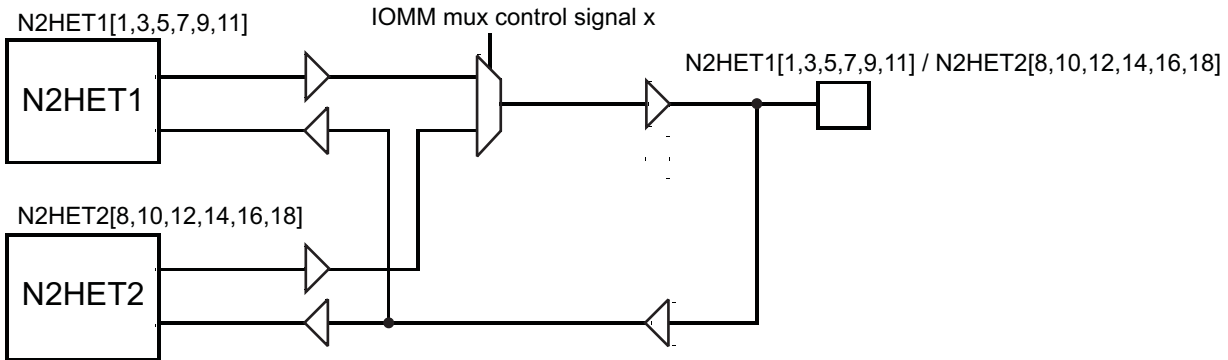


图 7-7. N2HET Monitoring

### 7.4.5.2 Output Monitoring using Dual Clock Comparator (DCC)

N2HET1[31] is connected as a clock source for counter 1 in DCC1. This allows the application to measure the frequency of the pulse-width modulated (PWM) signal on N2HET1[31].

Similarly, N2HET2[0] is connected as a clock source for counter 1 in DCC2. This allows the application to measure the frequency of the pulse-width modulated (PWM) signal on N2HET2[0].

Both N2HET1[31] and N2HET2[0] can be configured to be internal-only channels. That is, the connection to the DCC module is made directly from the output of the N2HETx module (from the input of the output buffer).

For more information on DCC see 节 6.7.3.

### 7.4.6 Disabling N2HET Outputs

Some applications require the N2HET outputs to be disabled under some fault condition. The N2HET module provides this capability via the "Pin Disable" input signal. This signal, when driven low, causes the N2HET outputs identified by a programmable register (HETPINDIS) to be tri-stated. Please refer to the device specific technical reference manual for more details on the "N2HET Pin Disable" feature.

GIOA[5] is connected to the "Pin Disable" input for N2HET1, and GIOB[2] is connected to the "Pin Disable" input for N2HET2.

### 7.4.7 High-End Timer Transfer Unit (HET-TU)

A High End Timer Transfer Unit (HET-TU) can perform DMA type transactions to transfer N2HET data to or from main memory. A Memory Protection Unit (MPU) is built into the HET-TU.

#### 7.4.7.1 Features

- CPU and DMA independent
- Master Port to access system memory
- 8 control packets supporting dual buffer configuration
- Control packet information is stored in RAM protected by parity
- Event synchronization (HET transfer requests)
- Supports 32 or 64 bit transactions
- Addressing modes for HET address (8 byte or 16 byte) and system memory address (fixed, 32 bit or 64bit)
- One shot, circular and auto switch buffer transfer modes
- Request lost detection

#### 7.4.7.2 Trigger Connections

表 7-14. HET TU1 Request Line Connection

| Modules | Request Source | HET TU1 Request |
|---------|----------------|-----------------|
| N2HET1  | HTUREQ[0]      | HET TU1 DCP[0]  |
| N2HET1  | HTUREQ[1]      | HET TU1 DCP[1]  |
| N2HET1  | HTUREQ[2]      | HET TU1 DCP[2]  |
| N2HET1  | HTUREQ[3]      | HET TU1 DCP[3]  |
| N2HET1  | HTUREQ[4]      | HET TU1 DCP[4]  |
| N2HET1  | HTUREQ[5]      | HET TU1 DCP[5]  |
| N2HET1  | HTUREQ[6]      | HET TU1 DCP[6]  |
| N2HET1  | HTUREQ[7]      | HET TU1 DCP[7]  |

表 7-15. HET TU2 Request Line Connection

| Modules | Request Source | HET TU2 Request |
|---------|----------------|-----------------|
| N2HET2  | HTUREQ[0]      | HET TU2 DCP[0]  |
| N2HET2  | HTUREQ[1]      | HET TU2 DCP[1]  |
| N2HET2  | HTUREQ[2]      | HET TU2 DCP[2]  |
| N2HET2  | HTUREQ[3]      | HET TU2 DCP[3]  |
| N2HET2  | HTUREQ[4]      | HET TU2 DCP[4]  |
| N2HET2  | HTUREQ[5]      | HET TU2 DCP[5]  |
| N2HET2  | HTUREQ[6]      | HET TU2 DCP[6]  |
| N2HET2  | HTUREQ[7]      | HET TU2 DCP[7]  |



## 7.5 FlexRay Interface

The FlexRay module performs communication according to the FlexRay protocol specification v2.1. The sample clock bitrate can be programmed to values up to 10 MBit per second. Additional bus driver (BD) hardware is required for connection to the physical layer.

For communication on a FlexRay network, individual message buffers with up to 254 data bytes are configurable. The message storage consists of a single-ported message RAM that holds up to 128 message buffers. All functions concerning the handling of messages are implemented in the message handler. Those functions are the acceptance filtering, the transfer of messages between the two FlexRay Channel Protocol Controllers and the message RAM, maintaining the transmission schedule as well as providing message status information.

The register set of the FlexRay module can be accessed directly by the CPU via the VBUS interface. These registers are used to control, configure and monitor the FlexRay channel protocol controllers, message handler, global time unit, system universal control, frame/symbol processing, network management, interrupt control, and to access the message RAM via the input / output buffer.

### 7.5.1 Features

The FlexRay module has the following features:

- Conformance with FlexRay protocol specification v2.1
- Data rates of up to 10 Mb/s on each channel
- Up to 128 message buffers
- 8 Kbyte of message RAM for storage of, for example, 128 message buffers with max 48 byte data section or up to 30 message buffers with 254 byte data section
- Configuration of message buffers with different payload lengths
- One configurable receive FIFO
- Each message buffer can be configured as receive buffer, as transmit buffer or as part of the receive FIFO
- CPU access to message buffers via input and output buffer
- FlexRay transfer unit (FTU) for automatic data transfer between data memory and message buffers without CPU interaction
- Filtering for slot counter, cycle counter, and channel ID
- Maskable module interrupts
- Supports Network Management

### 7.5.2 Electrical and Timing Specifications

表 7-16. Timing Requirements for FlexRay Inputs

|          |                                                                    |                                                | MIN                         | MAX | UNIT |
|----------|--------------------------------------------------------------------|------------------------------------------------|-----------------------------|-----|------|
| $t_{pw}$ | Input minimum pulse width to meet the FlexRay sampling requirement | $-40^{\circ}\text{C}$ to $125^{\circ}\text{C}$ | $t_{c(AVCLK2)} + 2.5^{(1)}$ |     | ns   |

(1)  $t_{RxAsymDelay}$  parameter

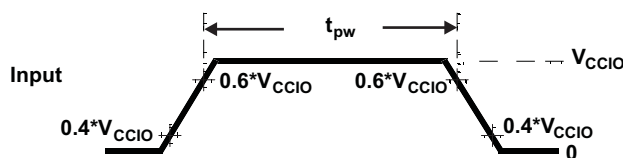


图 7-8. FlexRay Inputs

**表 7-17. FlexRay Jitter Timing**

|                   |                                                                                    |                | MIN   | MAX    | UNIT |
|-------------------|------------------------------------------------------------------------------------|----------------|-------|--------|------|
| $t_{Tx1bit}$      | Clock jitter and signal symmetry                                                   |                | 98    | 102    | ns   |
| $t_{Tx10bit}$     | FlexRay BSS (byte start sequence) to BSS                                           | –40°C to 125°C | 999   | 1001   | ns   |
| $t_{Tx10bitAvg}$  | Average over 10000 samples                                                         | –40°C to 125°C | 999.5 | 1000.5 | ns   |
| $t_{RxAsymDelay}$ | Delay difference between rise and fall from Rx pin to sample point in FlexRay core | –40°C to 125°C | —     | 2.5    | ns   |
| $t_{jit}(SCLK)$   | Jitter for the 80MHz Sample Clock generated by the PLL                             | –40°C to 125°C | —     | 0.5    | ns   |

### 7.5.3 FlexRay Transfer Unit

The FlexRay Transfer Unit is able to transfer data between the input buffer (IBF) and output buffer (OBF) of the communication controller and the system memory without CPU interaction.

Because the FlexRay module is accessed through the FTU, the FTU must be powered up by the setting bit 23 in the Peripheral Power Down Registers of the System Module before accessing any FlexRay module register.

For more information on the FTU see the TMS570LS31X/TMS570LS21X Technical Reference Manual ([SPNU499](#)).

## 7.6 Controller Area Network (DCAN)

The DCAN supports the CAN 2.0B protocol standard and uses a serial, multimaster communication protocol that efficiently supports distributed real-time control with robust communication rates of up to 1 megabit per second (Mbps). The DCAN is ideal for applications operating in noisy and harsh environments (e.g., automotive and industrial fields) that require reliable serial communication or multiplexed wiring.

### 7.6.1 Features

Features of the DCAN module include:

- Supports CAN protocol version 2.0 part A, B
- Bit rates up to 1 MBit/s
- The CAN kernel can be clocked by the oscillator for baud-rate generation.
- 64 mailboxes on each DCAN
- Individual identifier mask for each message object
- Programmable FIFO mode for message objects
- Programmable loop-back modes for self-test operation
- Automatic bus on after Bus-Off state by a programmable 32-bit timer
- Message RAM protected by parity
- Direct access to Message RAM during test mode
- CAN Rx / Tx pins configurable as general purpose IO pins
- Message RAM Auto Initialization
- DMA support

For more information on the DCAN see the TMS570LS31X/21X Technical Reference Manual ([SPNU499](#)).

### 7.6.2 Electrical and Timing Specifications

表 7-18. Dynamic Characteristics for the DCANx TX and RX pins

| PARAMETER       |                                                                  | MIN | MAX | UNIT |
|-----------------|------------------------------------------------------------------|-----|-----|------|
| $t_{d(CANnTX)}$ | Delay time, transmit shift register to CANnTX pin <sup>(1)</sup> |     | 15  | ns   |
| $t_{d(CANnRX)}$ | Delay time, CANnRX pin to receive shift register                 |     | 5   | ns   |

(1) These values do not include rise/fall times of the output buffer.

## 7.7 Local Interconnect Network Interface (LIN)

The SCI/LIN module can be programmed to work either as an SCI or as a LIN. The core of the module is an SCI. The SCI's hardware features are augmented to achieve LIN compatibility.

The SCI module is a universal asynchronous receiver-transmitter that implements the standard nonreturn to zero format. The SCI can be used to communicate, for example, through an RS-232 port or over a K-line.

The LIN standard is based on the SCI (UART) serial data link format. The communication concept is single-master/multiple-slave with a message identification for multi-cast transmission between any network nodes.

### 7.7.1 LIN Features

The following are features of the LIN module:

- Compatible to LIN 1.3, 2.0 and 2.1 protocols
- Multi-buffered receive and transmit units DMA capability for minimal CPU intervention
- Identification masks for message filtering
- Automatic Master Header Generation
  - Programmable Synch Break Field
  - Synch Field
  - Identifier Field
- Slave Automatic Synchronization
  - Synch break detection
  - Optional baudrate update
  - Synchronization Validation
- $2^{31}$  programmable transmission rates with 7 fractional bits
- Error detection
- 2 Interrupt lines with priority encoding

## 7.8 Serial Communication Interface (SCI)

### 7.8.1 Features

- Standard universal asynchronous receiver-transmitter (UART) communication
- Supports full- or half-duplex operation
- Standard nonreturn to zero (NRZ) format
- Double-buffered receive and transmit functions
- Configurable frame format of 3 to 13 bits per character based on the following:
  - Data word length programmable from one to eight bits
  - Additional address bit in address-bit mode
  - Parity programmable for zero or one parity bit, odd or even parity
  - Stop programmable for one or two stop bits
- Asynchronous or isosynchronous communication modes
- Two multiprocessor communication formats allow communication between more than two devices.
- Sleep mode is available to free CPU resources during multiprocessor communication.
- The 24-bit programmable baud rate supports  $2^{24}$  different baud rates provide high accuracy baud rate selection.
- Four error flags and Five status flags provide detailed information regarding SCI events.
- Capability to use DMA for transmit and receive data.

## 7.9 Inter-Integrated Circuit (I2C)

The inter-integrated circuit (I2C) module is a multi-master communication module providing an interface between the microcontroller and devices compliant with Philips Semiconductor I2C-bus specification version 2.1 and connected by an I2C-bus. This module will support any slave or master I2C compatible device.

### 7.9.1 Features

The I2C has the following features:

- Compliance to the Philips I2C bus specification, v2.1 (The I<sup>2</sup>C Specification, Philips document number 9398 393 40011)
  - Bit/Byte format transfer
  - 7-bit and 10-bit device addressing modes
  - General call
  - START byte
  - Multi-master transmitter/ slave receiver mode
  - Multi-master receiver/ slave transmitter mode
  - Combined master transmit/receive and receive/transmit mode
  - Transfer rates of 10 kbps up to 400 kbps (Phillips fast-mode rate)
- Free data format
- Two DMA events (transmit and receive)
- DMA event enable/disable capability
- Seven interrupts that can be used by the CPU
- Module enable/disable capability
- The SDA and SCL are optionally configurable as general purpose I/O
- Slew rate control of the outputs
- Open drain control of the outputs
- Programmable pullup/pulldown capability on the inputs
- Supports Ignore NACK mode

#### 注

This I2C module does not support:

- High-speed (HS) mode
- C-bus compatibility mode
- The combined format in 10-bit address mode (the I<sup>2</sup>C sends the slave address second byte every time it sends the slave address first byte)

## 7.9.2 I<sup>2</sup>C I/O Timing Specifications

表 7-19. I<sup>2</sup>C Signals (SDA and SCL) Switching Characteristics<sup>(1)</sup>

| PARAMETER           |                                                                             | STANDARD MODE |                     | FAST MODE |     | UNIT |
|---------------------|-----------------------------------------------------------------------------|---------------|---------------------|-----------|-----|------|
|                     |                                                                             | MIN           | MAX                 | MIN       | MAX |      |
| $t_{c(I2CCLK)}$     | Cycle time, internal module clock for I <sup>2</sup> C, prescaled from VCLK | 75.2          | 149                 | 75.2      | 149 | ns   |
| $f_{(SCL)}$         | SCL clock frequency                                                         | 0             | 100                 | 0         | 400 | kHz  |
| $t_{c(SCL)}$        | Cycle time, SCL                                                             | 10            |                     | 2.5       |     | μs   |
| $t_{su(SCLH-SDAL)}$ | Setup time, SCL high before SDA low (for a repeated START condition)        | 4.7           |                     | 0.6       |     | μs   |
| $t_{h(SCLL-SDAL)}$  | Hold time, SCL low after SDA low (for a repeated START condition)           | 4             |                     | 0.6       |     | μs   |
| $t_{w(SCLL)}$       | Pulse duration, SCL low                                                     | 4.7           |                     | 1.3       |     | μs   |
| $t_{w(SCLH)}$       | Pulse duration, SCL high                                                    | 4             |                     | 0.6       |     | μs   |
| $t_{su(SDA-SCLH)}$  | Setup time, SDA valid before SCL high                                       | 250           |                     | 100       |     | ns   |
| $t_{h(SDA-SCLL)}$   | Hold time, SDA valid after SCL low (for I2C bus devices)                    | 0             | 3.45 <sup>(2)</sup> | 0         | 0.9 | μs   |
| $t_{w(SDAH)}$       | Pulse duration, SDA high between STOP and START conditions                  | 4.7           |                     | 1.3       |     | μs   |
| $t_{su(SCLH-SDAH)}$ | Setup time, SCL high before SDA high (for STOP condition)                   | 4.0           |                     | 0.6       |     | μs   |
| $t_{w(SP)}$         | Pulse duration, spike (must be suppressed)                                  |               |                     | 0         | 50  | ns   |
| $C_b^{(3)}$         | Capacitive load for each bus line                                           |               | 400                 |           | 400 | pF   |

- (1) The I2C pins SDA and SCL do not feature fail-safe I/O buffers. These pins could potentially draw current when the device is powered down.
- (2) The maximum  $t_{h(SDA-SCLL)}$  for I2C bus devices has only to be met if the device does not stretch the low period ( $t_{w(SCLL)}$ ) of the SCL signal.
- (3)  $C_b$  = The total capacitance of one bus line in pF.

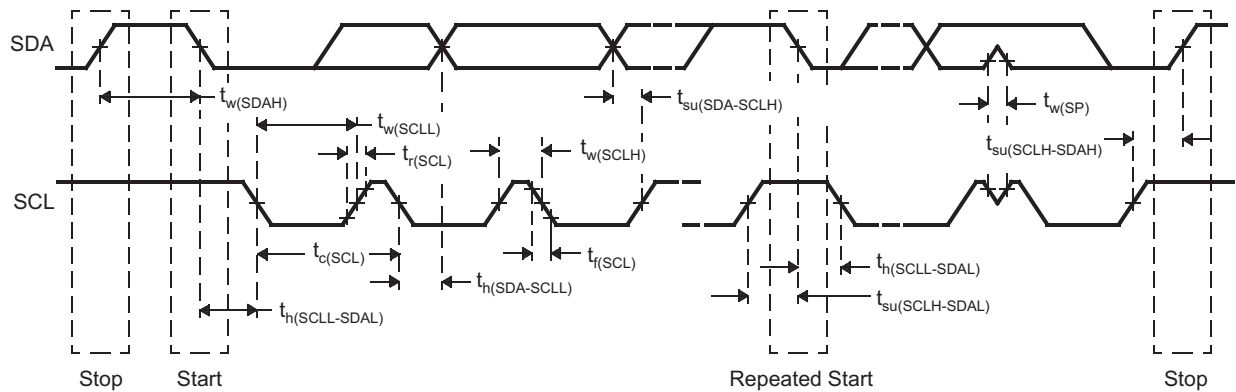


图 7-9. I<sup>2</sup>C Timings

---

注

- A device must internally provide a hold time of at least 300 ns for the SDA signal (referred to the VIHmin of the SCL signal) to bridge the undefined region of the falling edge of SCL.
  - The maximum  $t_{h(SDA-SCLL)}$  has only to be met if the device does not stretch the LOW period ( $t_{w(SCLL)}$ ) of the SCL signal.
  - A Fast-mode I2C-bus device can be used in a Standard-mode I2C-bus system, but the requirement  $t_{su(SDA-SCLH)} \geq 250$  ns must then be met. This will automatically be the case if the device does not stretch the LOW period of the SCL signal. If such a device does stretch the LOW period of the SCL signal, it must output the next data bit to the SDA line  $t_{r\ max} + t_{su(SDA-SCLH)}$ .
  - $C_b$  = total capacitance of one bus line in pF. If mixed with fast-mode devices, faster fall-times are allowed.
-



## 7.10 Multi-Buffered / Standard Serial Peripheral Interface

The MibSPI is a high-speed synchronous serial input/output port that allows a serial bit stream of programmed length (2 to 16 bits) to be shifted in and out of the device at a programmed bit-transfer rate. Typical applications for the SPI include interfacing to external peripherals, such as I/Os, memories, display drivers, and analog-to-digital converters.

### 7.10.1 Features

Both Standard and MibSPI modules have the following features:

- 16-bit shift register
- Receive buffer register
- 5-bit baud clock generator
- SPICLK can be internally-generated (master mode) or received from an external clock source (slave mode)
- Each word transferred can have a unique format
- SPI I/Os not used in the communication can be used as digital input/output signals

表 7-20. MibSPI/SPI Configurations

| MibSPIx/SPIx | I/Os                                                                         |
|--------------|------------------------------------------------------------------------------|
| MibSPI1      | MIBSPI1SIMO[1:0], MIBSPI1SOMI[1:0], MIBSPI1CLK, MIBSPI1nCS[5:0], MIBSPI1nENA |
| MibSPI3      | MIBSPI3SIMO, MIBSPI3SOMI, MIBSPI3CLK, MIBSPI3nCS[5:0], MIBSPI3nENA           |
| MibSPI5      | MIBSPI5SIMO[3:0], MIBSPI5SOMI[3:0], MIBSPI5CLK, MIBSPI5nCS[3:0], MIBSPI5nENA |
| SPI2         | SPI2SIMO, SPI2SOMI, SPI2CLK, SPI2nCS[1:0], SPI2nENA                          |
| SPI4         | SPI4SIMO, SPI4SOMI, SPI4CLK, SPI4nCS[0], SPI4nENA                            |

### 7.10.2 MibSPI Transmit and Receive RAM Organization

The Multibuffer RAM is comprised of 128 buffers. Each entry in the Multibuffer RAM consists of 4 parts: a 16-bit transmit field, a 16-bit receive field, a 16-bit control field and a 16-bit status field. The Multibuffer RAM can be partitioned into multiple transfer group with variable number of buffers each.

### 7.10.3 MibSPI Transmit Trigger Events

Each of the transfer groups can be configured individually. For each of the transfer groups a trigger event and a trigger source can be chosen. A trigger event can be for example a rising edge or a permanent low level at a selectable trigger source. For example, up to 15 trigger sources are available which can be utilized by each transfer group. These trigger options are listed in 表 7-21 for MIBSPI1, 节 7.10.3.2 for MIBSPI3 and 节 7.10.3.3 for MibSPI5.

### 7.10.3.1 MIBSPI1 Event Trigger Hookup

表 7-21. MIBSPI1 Event Trigger Hookup

| Event Number | TGxCTRL TRIGSRC[3:0] | Trigger               |
|--------------|----------------------|-----------------------|
| Disabled     | 0000                 | No trigger source     |
| EVENT0       | 0001                 | GIOA[0]               |
| EVENT1       | 0010                 | GIOA[1]               |
| EVENT2       | 0011                 | GIOA[2]               |
| EVENT3       | 0100                 | GIOA[3]               |
| EVENT4       | 0101                 | GIOA[4]               |
| EVENT5       | 0110                 | GIOA[5]               |
| EVENT6       | 0111                 | GIOA[6]               |
| EVENT7       | 1000                 | GIOA[7]               |
| EVENT8       | 1001                 | N2HET1[8]             |
| EVENT9       | 1010                 | N2HET1[10]            |
| EVENT10      | 1011                 | N2HET1[12]            |
| EVENT11      | 1100                 | N2HET1[14]            |
| EVENT12      | 1101                 | N2HET1[16]            |
| EVENT13      | 1110                 | N2HET1[18]            |
| EVENT14      | 1111                 | Internal Tick counter |

注

For N2HET1 trigger sources, the connection to the MibSPI1 module trigger input is made from the input side of the output buffer (at the N2HET1 module boundary). This way, a trigger condition can be generated even if the N2HET1 signal is not selected to be output on the pad.

注

For GIOx trigger sources, the connection to the MibSPI1 module trigger input is made from the output side of the input buffer. This way, a trigger condition can be generated either by selecting the GIOx pin as an output pin plus selecting the pin to be a GIOx pin, or by driving the GIOx pin from an external trigger source. If the mux control module is used to select different functionality instead of the GIOx signal, then care must be taken to disable GIOx from triggering MibSPI1 transfers; there is no multiplexing on the input connections.

### 7.10.3.2 MIBSPI3 Event Trigger Hookup

表 7-22. MIBSPI3 Event Trigger Hookup

| Event Number | TGxCTRL TRIGSRC[3:0] | Trigger           |
|--------------|----------------------|-------------------|
| Disabled     | 0000                 | No trigger source |
| EVENT0       | 0001                 | GIOA[0]           |
| EVENT1       | 0010                 | GIOA[1]           |
| EVENT2       | 0011                 | GIOA[2]           |
| EVENT3       | 0100                 | GIOA[3]           |
| EVENT4       | 0101                 | GIOA[4]           |
| EVENT5       | 0110                 | GIOA[5]           |
| EVENT6       | 0111                 | GIOA[6]           |
| EVENT7       | 1000                 | GIOA[7]           |

表 7-22. MIBSPI3 Event Trigger Hookup (continued)

| Event Number | TGxCTRL TRIGSRC[3:0] | Trigger               |
|--------------|----------------------|-----------------------|
| EVENT8       | 1001                 | HET[8]                |
| EVENT9       | 1010                 | N2HET1[10]            |
| EVENT10      | 1011                 | N2HET1[12]            |
| EVENT11      | 1100                 | N2HET1[14]            |
| EVENT12      | 1101                 | N2HET1[16]            |
| EVENT13      | 1110                 | N2HET1[18]            |
| EVENT14      | 1111                 | Internal Tick counter |

## 注

For N2HET1 trigger sources, the connection to the MibSPI3 module trigger input is made from the input side of the output buffer (at the N2HET1 module boundary). This way, a trigger condition can be generated even if the N2HET1 signal is not selected to be output on the pad.

## 注

For GIOx trigger sources, the connection to the MibSPI3 module trigger input is made from the output side of the input buffer. This way, a trigger condition can be generated either by selecting the GIOx pin as an output pin plus selecting the pin to be a GIOx pin, or by driving the GIOx pin from an external trigger source. If the mux control module is used to select different functionality instead of the GIOx signal, then care must be taken to disable GIOx from triggering MibSPI3 transfers; there is no multiplexing on the input connections.

## 7.10.3.3 MIBSPI5 Event Trigger Hookup

表 7-23. MIBSPI5 Event Trigger Hookup

| Event Number | TGxCTRL TRIGSRC[3:0] | Trigger               |
|--------------|----------------------|-----------------------|
| Disabled     | 0000                 | No trigger source     |
| EVENT0       | 0001                 | GIOA[0]               |
| EVENT1       | 0010                 | GIOA[1]               |
| EVENT2       | 0011                 | GIOA[2]               |
| EVENT3       | 0100                 | GIOA[3]               |
| EVENT4       | 0101                 | GIOA[4]               |
| EVENT5       | 0110                 | GIOA[5]               |
| EVENT6       | 0111                 | GIOA[6]               |
| EVENT7       | 1000                 | GIOA[7]               |
| EVENT8       | 1001                 | N2HET1[8]             |
| EVENT9       | 1010                 | N2HET1[10]            |
| EVENT10      | 1011                 | N2HET1[12]            |
| EVENT11      | 1100                 | N2HET1[14]            |
| EVENT12      | 1101                 | N2HET1[16]            |
| EVENT13      | 1110                 | N2HET1[18]            |
| EVENT14      | 1111                 | Internal Tick counter |

## 注

For N2HET1 trigger sources, the connection to the MibSPI5 module trigger input is made from the input side of the output buffer (at the N2HET1 module boundary). This way, a trigger condition can be generated even if the N2HET1 signal is not selected to be output on the pad.

---

注

For GIOx trigger sources, the connection to the MibSPI5 module trigger input is made from the output side of the input buffer. This way, a trigger condition can be generated either by selecting the GIOx pin as an output pin + selecting the pin to be a GIOx pin, or by driving the GIOx pin from an external trigger source. If the mux control module is used to select different functionality instead of the GIOx signal, then care must be taken to disable GIOx from triggering MibSPI5 transfers; there is no multiplexing on the input connections.

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### 7.10.4 MibSPI/SPI Master Mode I/O Timing Specifications

表 7-24. SPI Master Mode External Timing Parameters (CLOCK PHASE = 0, SPICLK = output, SPISIMO = output, and SPISOMI = input)<sup>(1)(2)(3)</sup>

| NO.              |                                          |                                                                       |            | MIN            | MAX                                                                                                         | UNIT                                                                                      |    |
|------------------|------------------------------------------|-----------------------------------------------------------------------|------------|----------------|-------------------------------------------------------------------------------------------------------------|-------------------------------------------------------------------------------------------|----|
| 1                | t <sub>c</sub> (SPC) <sub>M</sub>        | Cycle time, SPICLK <sup>(4)</sup>                                     |            | 40             | 256t <sub>c</sub> (VCLK)                                                                                    | ns                                                                                        |    |
| 2 <sup>(5)</sup> | t <sub>w</sub> (SPCH) <sub>M</sub>       | Pulse duration, SPICLK high (clock polarity = 0)                      |            | –40°C to 125°C | 0.5t <sub>c</sub> (SPC) <sub>M</sub> – t <sub>r</sub> (SPC) <sub>M</sub> – 3                                | 0.5t <sub>c</sub> (SPC) <sub>M</sub> + 3                                                  | ns |
|                  | t <sub>w</sub> (SPCL) <sub>M</sub>       | Pulse duration, SPICLK low (clock polarity = 1)                       |            | –40°C to 125°C | 0.5t <sub>c</sub> (SPC) <sub>M</sub> – t <sub>r</sub> (SPC) <sub>M</sub> – 3                                | 0.5t <sub>c</sub> (SPC) <sub>M</sub> + 3                                                  |    |
| 3 <sup>(5)</sup> | t <sub>w</sub> (SPCL) <sub>M</sub>       | Pulse duration, SPICLK low (clock polarity = 0)                       |            | –40°C to 125°C | 0.5t <sub>c</sub> (SPC) <sub>M</sub> – t <sub>r</sub> (SPC) <sub>M</sub> – 3                                | 0.5t <sub>c</sub> (SPC) <sub>M</sub> + 3                                                  | ns |
|                  | t <sub>w</sub> (SPCH) <sub>M</sub>       | Pulse duration, SPICLK high (clock polarity = 1)                      |            | –40°C to 125°C | 0.5t <sub>c</sub> (SPC) <sub>M</sub> – t <sub>r</sub> (SPC) <sub>M</sub> – 3                                | 0.5t <sub>c</sub> (SPC) <sub>M</sub> + 3                                                  |    |
| 4 <sup>(5)</sup> | t <sub>d</sub> (SPCH-SIMO) <sub>M</sub>  | Delay time, SPISIMO valid before SPICLK low (clock polarity = 0)      |            |                | 0.5t <sub>c</sub> (SPC) <sub>M</sub> – 6                                                                    |                                                                                           | ns |
|                  | t <sub>d</sub> (SPCL-SIMO) <sub>M</sub>  | Delay time, SPISIMO valid before SPICLK high (clock polarity = 1)     |            |                | 0.5t <sub>c</sub> (SPC) <sub>M</sub> – 6                                                                    |                                                                                           |    |
| 5 <sup>(5)</sup> | t <sub>v</sub> (SPCL-SIMO) <sub>M</sub>  | Valid time, SPISIMO data valid after SPICLK low (clock polarity = 0)  |            |                | 0.5t <sub>c</sub> (SPC) <sub>M</sub> – t <sub>r</sub> (SPC) – 4                                             |                                                                                           | ns |
|                  | t <sub>v</sub> (SPCH-SIMO) <sub>M</sub>  | Valid time, SPISIMO data valid after SPICLK high (clock polarity = 1) |            |                | 0.5t <sub>c</sub> (SPC) <sub>M</sub> – t <sub>r</sub> (SPC) – 4                                             |                                                                                           |    |
| 6 <sup>(5)</sup> | t <sub>su</sub> (SOMI-SPCL) <sub>M</sub> | Setup time, SPISOMI before SPICLK low (clock polarity = 0)            |            |                | t <sub>r</sub> (SPC) + 2.2                                                                                  |                                                                                           | ns |
|                  | t <sub>su</sub> (SOMI-SPCH) <sub>M</sub> | Setup time, SPISOMI before SPICLK high (clock polarity = 1)           |            |                | t <sub>r</sub> (SPC) + 2.2                                                                                  |                                                                                           |    |
| 7 <sup>(5)</sup> | t <sub>h</sub> (SPCL-SOMI) <sub>M</sub>  | Hold time, SPISOMI data valid after SPICLK low (clock polarity = 0)   |            |                | 10                                                                                                          |                                                                                           | ns |
|                  | t <sub>h</sub> (SPCH-SOMI) <sub>M</sub>  | Hold time, SPISOMI data valid after SPICLK high (clock polarity = 1)  |            |                | 10                                                                                                          |                                                                                           |    |
| 8 <sup>(6)</sup> | t <sub>C2DELAY</sub>                     | Setup time CS active until SPICLK high (clock polarity = 0)           | CSHOLD = 0 |                | C2DELAY*t <sub>c</sub> (VCLK) + 2*t <sub>c</sub> (VCLK) - t <sub>r</sub> (SPICS) + t <sub>r</sub> (SPC) - 7 | (C2DELAY+2) * t <sub>c</sub> (VCLK) - t <sub>r</sub> (SPICS) + t <sub>r</sub> (SPC) + 5.5 | ns |
|                  |                                          |                                                                       | CSHOLD = 1 |                | C2DELAY*t <sub>c</sub> (VCLK) + 3*t <sub>c</sub> (VCLK) - t <sub>r</sub> (SPICS) + t <sub>r</sub> (SPC) - 7 | (C2DELAY+3) * t <sub>c</sub> (VCLK) - t <sub>r</sub> (SPICS) + t <sub>r</sub> (SPC) + 5.5 |    |
|                  |                                          | Setup time CS active until SPICLK low (clock polarity = 1)            | CSHOLD = 0 |                | C2DELAY*t <sub>c</sub> (VCLK) + 2*t <sub>c</sub> (VCLK) - t <sub>r</sub> (SPICS) + t <sub>r</sub> (SPC) - 7 | (C2DELAY+2) * t <sub>c</sub> (VCLK) - t <sub>r</sub> (SPICS) + t <sub>r</sub> (SPC) + 5.5 | ns |
|                  |                                          |                                                                       | CSHOLD = 1 |                | C2DELAY*t <sub>c</sub> (VCLK) + 3*t <sub>c</sub> (VCLK) - t <sub>r</sub> (SPICS) + t <sub>r</sub> (SPC) - 7 | (C2DELAY+3) * t <sub>c</sub> (VCLK) - t <sub>r</sub> (SPICS) + t <sub>r</sub> (SPC) + 5.5 |    |

(1) The MASTER bit (SPIGCR1.0) is set and the CLOCK PHASE bit (SPIFMTx.16) is set.

(2)  $t_{c(VCLK)}$  = interface clock cycle time =  $1 / f_{(VCLK)}$

(3) For rise and fall timings, see 表 5-6.

(4) When the SPI is in master mode, the following must be true:

For PS values from 1 to 255:  $t_{c(SPC)M} \geq (PS + 1) t_{c(VCLK)} \geq 40$  ns, where PS is the prescale value set in the SPIFMTx.[15:8] register bits.

For PS values of 0:  $t_{c(SPC)M} = 2t_{c(VCLK)} \geq 40$  ns.

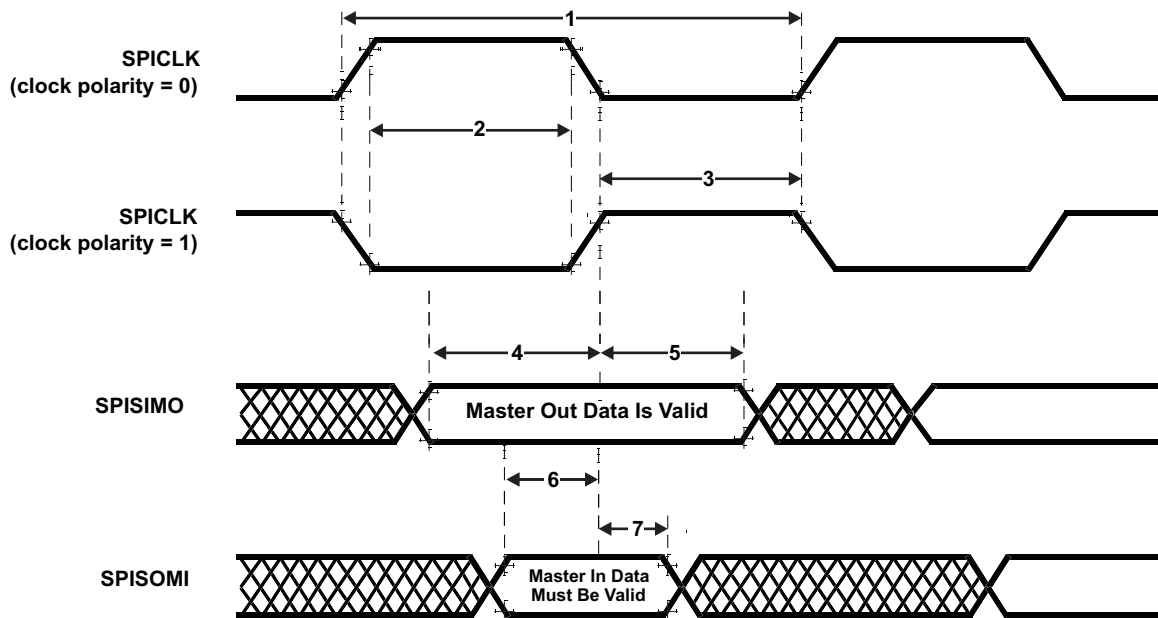
The external load on the SPICLK pin must be less than 60 pF.

(5) The active edge of the SPICLK signal referenced by the CLOCK POLARITY bit (SPIFMTx.17).

(6) C2DELAY and T2DELAY is programmed in the SPIDELAY register

**表 7-24. SPI Master Mode External Timing Parameters (CLOCK PHASE = 0, SPICLK = output, SPISIMO = output, and SPISOMI = input)<sup>(1)(2)(3)</sup> (continued)**

| NO.              |               |                                                              |                | MIN                                                                                            | MAX                                                                                             | UNIT |
|------------------|---------------|--------------------------------------------------------------|----------------|------------------------------------------------------------------------------------------------|-------------------------------------------------------------------------------------------------|------|
| 9 <sup>(6)</sup> | $t_{2CDELAY}$ | Hold time SPICLK low until CS inactive (clock polarity = 0)  |                | $0.5 \cdot t_{c(SPC)M} + T2CDELAY \cdot t_{c(VCLK)} + t_{c(VCLK)} - t_f(SPC) + t_f(SPICS) - 7$ | $0.5 \cdot t_{c(SPC)M} + T2CDELAY \cdot t_{c(VCLK)} + t_{c(VCLK)} - t_f(SPC) + t_f(SPICS) + 11$ | ns   |
|                  |               | Hold time SPICLK high until CS inactive (clock polarity = 1) |                | $0.5 \cdot t_{c(SPC)M} + T2CDELAY \cdot t_{c(VCLK)} + t_{c(VCLK)} - t_f(SPC) + t_r(SPICS) - 7$ | $0.5 \cdot t_{c(SPC)M} + T2CDELAY \cdot t_{c(VCLK)} + t_{c(VCLK)} - t_f(SPC) + t_r(SPICS) + 11$ | ns   |
| 10               | $t_{SPIENA}$  | SPIENAn Sample point                                         |                | $(C2TDELAY+1) \cdot t_{c(VCLK)} - t_f(SPICS) - 29$                                             | $(C2TDELAY+1) \cdot t_{c(VCLK)}$                                                                | ns   |
| 11               | $t_{SPIENAW}$ | SPIENAn Sample point from write to buffer                    | -40°C to 125°C |                                                                                                | $(C2TDELAY+2) \cdot t_{c(VCLK)}$                                                                | ns   |



**图 7-10. SPI Master Mode External Timing (CLOCK PHASE = 0)**

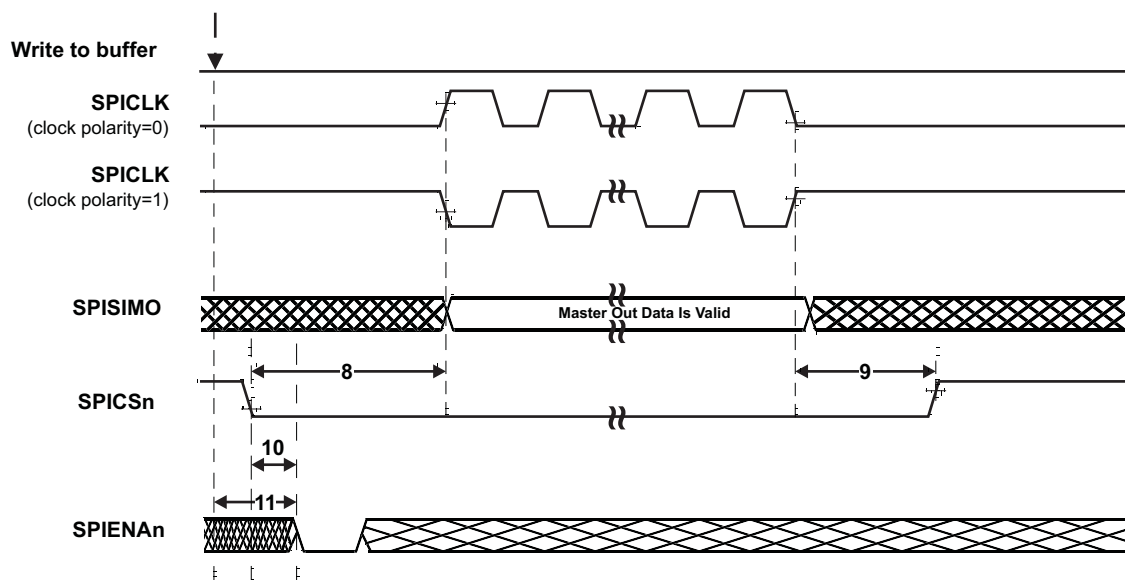


图 7-11. SPI Master Mode Chip Select Timing (CLOCK PHASE = 0)

**表 7-25. SPI Master Mode External Timing Parameters (CLOCK PHASE = 1, SPICLK = output, SPISIMO = output, and SPISOMI = input)<sup>(1)(2)(3)</sup>**

| NO.              |                      |                                                                       |                | MIN                                                                               | MAX                                                                                 | UNIT |
|------------------|----------------------|-----------------------------------------------------------------------|----------------|-----------------------------------------------------------------------------------|-------------------------------------------------------------------------------------|------|
| 1                | $t_{c(SPC)M}$        | Cycle time, SPICLK <sup>(4)</sup>                                     |                | 40                                                                                | $256t_{c(VCLK)}$                                                                    | ns   |
| 2 <sup>(5)</sup> | $t_{w(SPCH)M}$       | Pulse duration, SPICLK high (clock polarity = 0)                      | –40°C to 125°C | $0.5t_{c(SPC)M} - t_{f(SPC)M} - 3$                                                | $0.5t_{c(SPC)M} + 3$                                                                | ns   |
|                  | $t_{w(SPCL)M}$       | Pulse duration, SPICLK low (clock polarity = 1)                       | –40°C to 125°C | $0.5t_{c(SPC)M} - t_{f(SPC)M} - 3$                                                | $0.5t_{c(SPC)M} + 3$                                                                |      |
| 3 <sup>(5)</sup> | $t_{w(SPCL)M}$       | Pulse duration, SPICLK low (clock polarity = 0)                       | –40°C to 125°C | $0.5t_{c(SPC)M} - t_{f(SPC)M} - 3$                                                | $0.5t_{c(SPC)M} + 3$                                                                | ns   |
|                  | $t_{w(SPCH)M}$       | Pulse duration, SPICLK high (clock polarity = 1)                      | –40°C to 125°C | $0.5t_{c(SPC)M} - t_{f(SPC)M} - 3$                                                | $0.5t_{c(SPC)M} + 3$                                                                |      |
| 4 <sup>(5)</sup> | $t_{v(SIMO-SPCH)M}$  | Valid time, SPICLK high after SPISIMO data valid (clock polarity = 0) |                | $0.5t_{c(SPC)M} - 6$                                                              |                                                                                     | ns   |
|                  | $t_{v(SIMO-SPCL)M}$  | Valid time, SPICLK low after SPISIMO data valid (clock polarity = 1)  |                | $0.5t_{c(SPC)M} - 6$                                                              |                                                                                     |      |
| 5 <sup>(5)</sup> | $t_{v(SPCH-SIMO)M}$  | Valid time, SPISIMO data valid after SPICLK high (clock polarity = 0) |                | $0.5t_{c(SPC)M} - t_{f(SPC)} - 4$                                                 |                                                                                     | ns   |
|                  | $t_{v(SPCL-SIMO)M}$  | Valid time, SPISIMO data valid after SPICLK low (clock polarity = 1)  |                | $0.5t_{c(SPC)M} - t_{f(SPC)} - 4$                                                 |                                                                                     |      |
| 6 <sup>(5)</sup> | $t_{su(SOMI-SPCH)M}$ | Setup time, SPISOMI before SPICLK high (clock polarity = 0)           |                | $t_{f(SPC)} + 2.2$                                                                |                                                                                     | ns   |
|                  | $t_{su(SOMI-SPCL)M}$ | Setup time, SPISOMI before SPICLK low (clock polarity = 1)            |                | $t_{f(SPC)} + 2.2$                                                                |                                                                                     |      |
| 7 <sup>(5)</sup> | $t_{v(SPCH-SOMI)M}$  | Valid time, SPISOMI data valid after SPICLK high (clock polarity = 0) |                | 10                                                                                |                                                                                     | ns   |
|                  | $t_{v(SPCL-SOMI)M}$  | Valid time, SPISOMI data valid after SPICLK low (clock polarity = 1)  |                | 10                                                                                |                                                                                     |      |
| 8 <sup>(6)</sup> | $t_{C2DELAY}$        | Setup time CS active until SPICLK high (clock polarity = 0)           | CSHOLD = 0     | $0.5 * t_{c(SPC)M} + (C2DELAY + 2) * t_{c(VCLK)} - t_{f(SPICS)} + t_{f(SPC)} - 7$ | $0.5 * t_{c(SPC)M} + (C2DELAY + 2) * t_{c(VCLK)} - t_{f(SPICS)} + t_{f(SPC)} + 5.5$ | ns   |
|                  |                      |                                                                       | CSHOLD = 1     | $0.5 * t_{c(SPC)M} + (C2DELAY + 3) * t_{c(VCLK)} - t_{f(SPICS)} + t_{f(SPC)} - 7$ | $0.5 * t_{c(SPC)M} + (C2DELAY + 3) * t_{c(VCLK)} - t_{f(SPICS)} + t_{f(SPC)} + 5.5$ |      |
|                  |                      | Setup time CS active until SPICLK low (clock polarity = 1)            | CSHOLD = 0     | $0.5 * t_{c(SPC)M} + (C2DELAY + 2) * t_{c(VCLK)} - t_{f(SPICS)} + t_{f(SPC)} - 7$ | $0.5 * t_{c(SPC)M} + (C2DELAY + 2) * t_{c(VCLK)} - t_{f(SPICS)} + t_{f(SPC)} + 5.5$ | ns   |
|                  |                      |                                                                       | CSHOLD = 1     | $0.5 * t_{c(SPC)M} + (C2DELAY + 3) * t_{c(VCLK)} - t_{f(SPICS)} + t_{f(SPC)} - 7$ | $0.5 * t_{c(SPC)M} + (C2DELAY + 3) * t_{c(VCLK)} - t_{f(SPICS)} + t_{f(SPC)} + 5.5$ |      |
| 9 <sup>(6)</sup> | $t_{T2DELAY}$        | Hold time SPICLK low until CS inactive (clock polarity = 0)           |                | $T2DELAY * t_{c(VCLK)} + t_{c(VCLK)} - t_{f(SPC)} + t_{f(SPICS)} - 7$             | $T2DELAY * t_{c(VCLK)} + t_{c(VCLK)} - t_{f(SPC)} + t_{f(SPICS)} + 11$              | ns   |
|                  |                      | Hold time SPICLK high until CS inactive (clock polarity = 1)          |                | $T2DELAY * t_{c(VCLK)} + t_{c(VCLK)} - t_{f(SPC)} + t_{f(SPICS)} - 7$             | $T2DELAY * t_{c(VCLK)} + t_{c(VCLK)} - t_{f(SPC)} + t_{f(SPICS)} + 11$              | ns   |

(1) The MASTER bit (SPIGCR1.0) is set and the CLOCK PHASE bit (SPIFMTx.16) is set.

(2)  $t_{c(VCLK)}$  = interface clock cycle time =  $1 / f_{VCLK}$

(3) For rise and fall timings, see the 表 5-6.

(4) When the SPI is in Master mode, the following must be true:

For PS values from 1 to 255:  $t_{c(SPC)M} \geq (PS + 1)t_{c(VCLK)} \geq 40ns$ , where PS is the prescale value set in the SPIFMTx.[15:8] register bits.

For PS values of 0:  $t_{c(SPC)M} = 2t_{c(VCLK)} \geq 40ns$ .

The external load on the SPICLK pin must be less than 60pF.

(5) The active edge of the SPICLK signal referenced by the CLOCK POLARITY bit (SPIFMTx.17).

(6) C2DELAY and T2DELAY is programmed in the SPIDELAY register



表 7-25. SPI Master Mode External Timing Parameters (CLOCK PHASE = 1, SPICLK = output, SPISIMO = output, and SPISOMI = input)<sup>(1)(2)(3)</sup> (continued)

| NO. |                      |                                           | MIN            | MAX                                                                | UNIT |
|-----|----------------------|-------------------------------------------|----------------|--------------------------------------------------------------------|------|
| 10  | $t_{\text{SPIENA}}$  | SPIENAn Sample Point                      |                | $(C2TDELAY+1) \cdot t_{\text{c(VCLK)}} - t_{\text{f(SPICS)}} - 29$ | ns   |
| 11  | $t_{\text{SPIENAW}}$ | SPIENAn Sample point from write to buffer | -40°C to 125°C | $(C2TDELAY+2) \cdot t_{\text{c(VCLK)}}$                            | ns   |

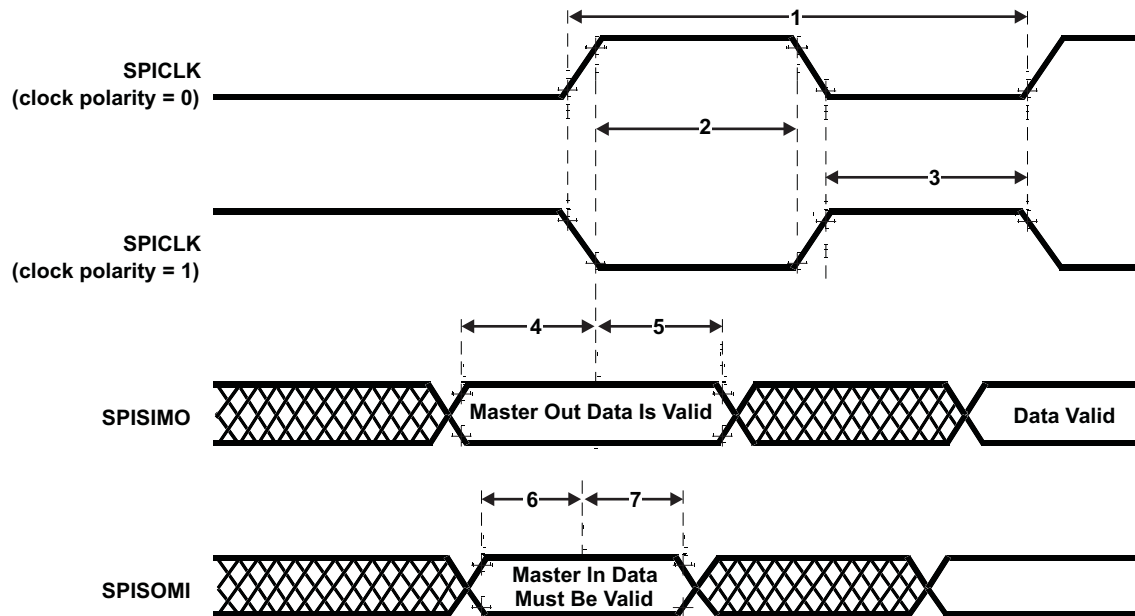


图 7-12. SPI Master Mode External Timing (CLOCK PHASE = 1)

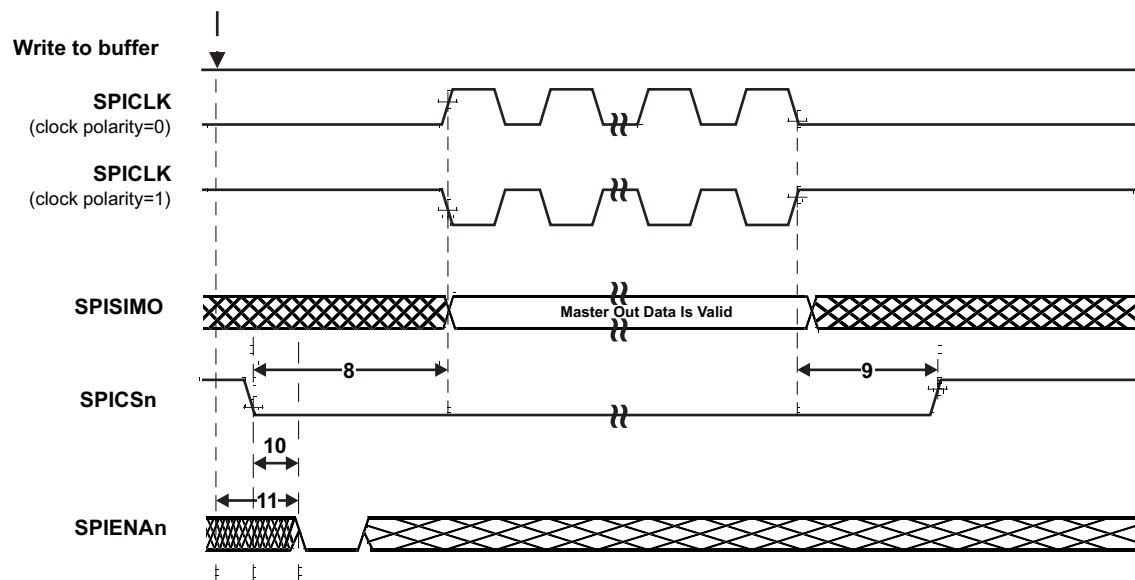


图 7-13. SPI Master Mode Chip Select Timing (CLOCK PHASE = 1)

### 7.10.5 SPI Slave Mode I/O Timings

**表 7-26. SPI Slave Mode External Timing Parameters (CLOCK PHASE = 0, SPICLK = input, SPISIMO = input, and SPISOMI = output)<sup>(1)(2)(3)(4)</sup>**

| NO.              |                      |                                                                                            | MIN              | MAX                                 | UNIT |
|------------------|----------------------|--------------------------------------------------------------------------------------------|------------------|-------------------------------------|------|
| 1                | $t_{c(SPC)S}$        | Cycle time, SPICLK <sup>(5)</sup>                                                          | 40               |                                     | ns   |
| 2 <sup>(6)</sup> | $t_{w(SPCH)S}$       | Pulse duration, SPICLK high (clock polarity = 0)                                           | 14               |                                     | ns   |
|                  | $t_{w(SPCL)S}$       | Pulse duration, SPICLK low (clock polarity = 1)                                            | 14               |                                     |      |
| 3 <sup>(6)</sup> | $t_{w(SPCL)S}$       | Pulse duration, SPICLK low (clock polarity = 0)                                            | 14               |                                     | ns   |
|                  | $t_{w(SPCH)S}$       | Pulse duration, SPICLK high (clock polarity = 1)                                           | 14               |                                     |      |
| 4 <sup>(6)</sup> | $t_{d(SPCH-SOMI)S}$  | Delay time, SPISOMI valid after SPICLK high (clock polarity = 0)                           |                  | $t_{r(SOMI)} + 20$                  | ns   |
|                  | $t_{d(SPCL-SOMI)S}$  | Delay time, SPISOMI valid after SPICLK low (clock polarity = 1)                            |                  | $t_{r(SOMI)} + 20$                  |      |
| 5 <sup>(6)</sup> | $t_{h(SPCH-SOMI)S}$  | Hold time, SPISOMI data valid after SPICLK high (clock polarity = 0)                       | 2                |                                     | ns   |
|                  | $t_{h(SPCL-SOMI)S}$  | Hold time, SPISOMI data valid after SPICLK low (clock polarity = 1)                        | 2                |                                     |      |
| 6 <sup>(6)</sup> | $t_{su(SIMO-SPCL)S}$ | Setup time, SPISIMO before SPICLK low (clock polarity = 0)                                 | 4                |                                     | ns   |
|                  | $t_{su(SIMO-SPCH)S}$ | Setup time, SPISIMO before SPICLK high (clock polarity = 1)                                | 4                |                                     |      |
| 7 <sup>(6)</sup> | $t_{h(SPCL-SIMO)S}$  | Hold time, SPISIMO data valid after SPICLK low (clock polarity = 0)                        | 2                |                                     | ns   |
|                  | $t_{h(SPCH-SIMO)S}$  | Hold time, SPISIMO data valid after SPICLK high (clock polarity = 1)                       | 2                |                                     |      |
| 8                | $t_{d(SPCL-SENAn)S}$ | Delay time, SPIENAn high after last SPICLK low (clock polarity = 0)                        | $1.5t_{c(VCLK)}$ | $2.5t_{c(VCLK)} + t_{r(ENAn)} + 22$ | ns   |
|                  | $t_{d(SPCH-SENAn)S}$ | Delay time, SPIENAn high after last SPICLK high (clock polarity = 1)                       | $1.5t_{c(VCLK)}$ | $2.5t_{c(VCLK)} + t_{r(ENAn)} + 22$ |      |
| 9                | $t_{d(SCSL-SENAL)S}$ | Delay time, SPIENAL low after SPICLSn low (if new data has been written to the SPI buffer) | $t_{f(ENAL)}$    | $t_{c(VCLK)} + t_{f(ENAL)} + 27$    | ns   |

- (1) The MASTER bit (SPIGCR1.0) is set and the CLOCK PHASE bit (SPIFMTx.16) is set.  
(2) If the SPI is in slave mode, the following must be true:  $t_{c(SPC)S} \geq (PS + 1) t_{c(VCLK)}$ , where PS = prescale value set in SPIFMTx.[15:8].  
(3) For rise and fall timings, see 表 5-6.  
(4)  $t_{c(VCLK)}$  = interface clock cycle time =  $1 / f_{(VCLK)}$   
(5) When the SPI is in Slave mode, the following must be true:  
For PS values from 1 to 255:  $t_{c(SPC)S} \geq (PS + 1)t_{c(VCLK)} \geq 40ns$ , where PS is the prescale value set in the SPIFMTx.[15:8] register bits.  
For PS values of 0:  $t_{c(SPC)S} = 2t_{c(VCLK)} \geq 40ns$ .  
(6) The active edge of the SPICLK signal referenced is controlled by the CLOCK POLARITY bit (SPIFMTx.17).

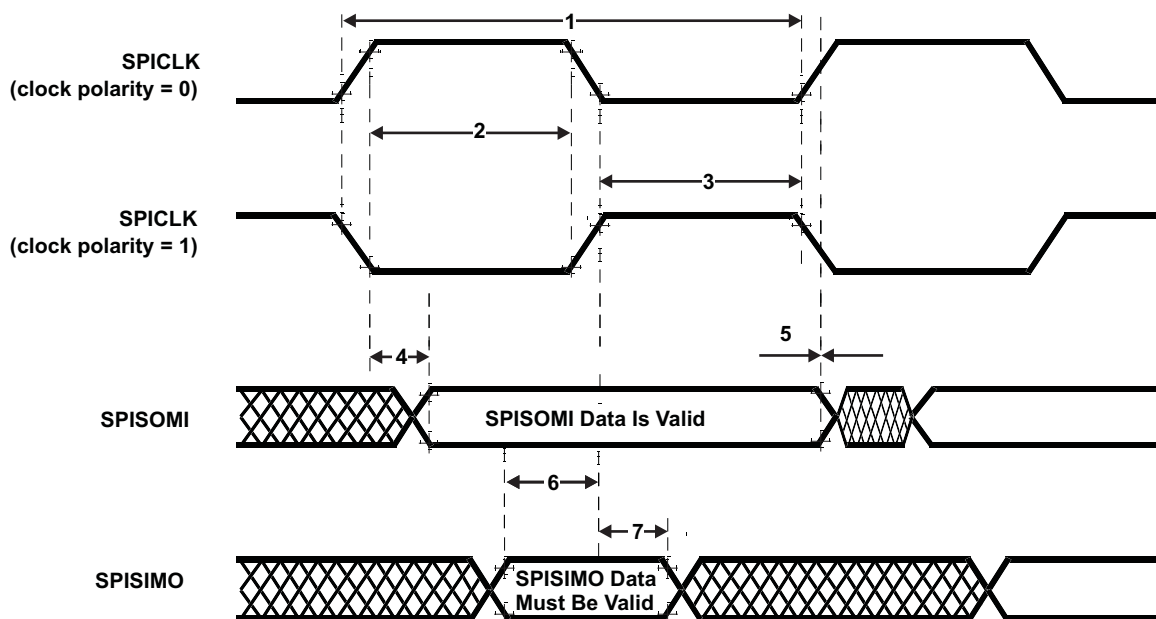


图 7-14. SPI Slave Mode External Timing (CLOCK PHASE = 0)

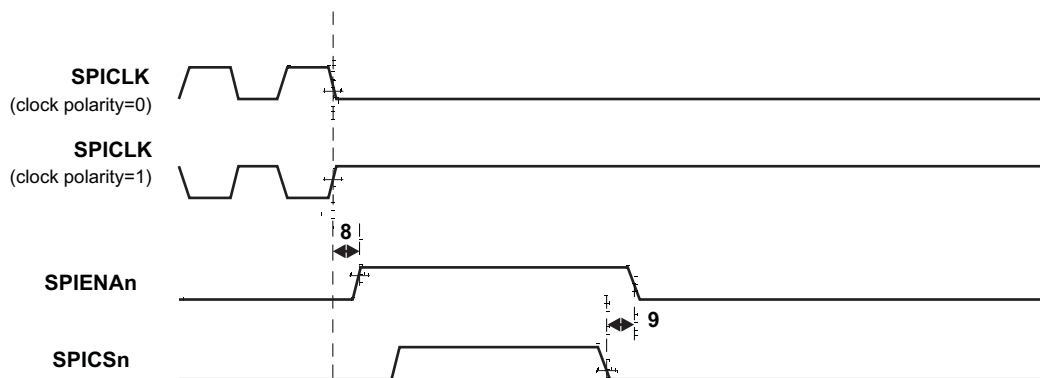


图 7-15. SPI Slave Mode Enable Timing (CLOCK PHASE = 0)

**表 7-27. SPI Slave Mode External Timing Parameters (CLOCK PHASE = 1, SPICLK = input, SPISIMO = input, and SPISOMI = output)<sup>(1)(2)(3)(4)</sup>**

| NO.              |                      |                                                                                           | MIN              | MAX                                  | UNIT |
|------------------|----------------------|-------------------------------------------------------------------------------------------|------------------|--------------------------------------|------|
| 1                | $t_{c(SPC)S}$        | Cycle time, SPICLK <sup>(5)</sup>                                                         | 40               |                                      | ns   |
| 2 <sup>(6)</sup> | $t_{w(SPCH)S}$       | Pulse duration, SPICLK high (clock polarity = 0)                                          | –40°C to 125°C   | 14                                   | ns   |
|                  | $t_{w(SPCL)S}$       | Pulse duration, SPICLK low (clock polarity = 1)                                           | –40°C to 125°C   | 14                                   |      |
| 3 <sup>(6)</sup> | $t_{w(SPCL)S}$       | Pulse duration, SPICLK low (clock polarity = 0)                                           | –40°C to 125°C   | 14                                   | ns   |
|                  | $t_{w(SPCH)S}$       | Pulse duration, SPICLK high (clock polarity = 1)                                          | –40°C to 125°C   | 14                                   |      |
| 4 <sup>(6)</sup> | $t_{d(SOMI-SPCL)S}$  | Dealy time, SPISOMI data valid after SPICLK low (clock polarity = 0)                      |                  | $t_{rf(SOMI)} + 20$                  | ns   |
|                  | $t_{d(SOMI-SPCH)S}$  | Delay time, SPISOMI data valid after SPICLK high (clock polarity = 1)                     |                  | $t_{rf(SOMI)} + 20$                  |      |
| 5 <sup>(6)</sup> | $t_{h(SPCL-SOMI)S}$  | Hold time, SPISOMI data valid after SPICLK high (clock polarity = 0)                      |                  | 2                                    | ns   |
|                  | $t_{h(SPCH-SOMI)S}$  | Hold time, SPISOMI data valid after SPICLK low (clock polarity = 1)                       |                  | 2                                    |      |
| 6 <sup>(6)</sup> | $t_{su(SIMO-SPCH)S}$ | Setup time, SPISIMO before SPICLK high (clock polarity = 0)                               |                  | 4                                    | ns   |
|                  | $t_{su(SIMO-SPCL)S}$ | Setup time, SPISIMO before SPICLK low (clock polarity = 1)                                |                  | 4                                    |      |
| 7 <sup>(6)</sup> | $t_{v(SPCH-SIMO)S}$  | High time, SPISIMO data valid after SPICLK high (clock polarity = 0)                      |                  | 2                                    | ns   |
|                  | $t_{v(SPCL-SIMO)S}$  | High time, SPISIMO data valid after SPICLK low (clock polarity = 1)                       |                  | 2                                    |      |
| 8                | $t_{d(SPCH-SENAn)S}$ | Delay time, SPIENAn high after last SPICLK high (clock polarity = 0)                      | $1.5t_{c(VCLK)}$ | $2.5t_{c(VCLK)} + t_{rf(ENAn)} + 22$ | ns   |
|                  | $t_{d(SPCL-SENAn)S}$ | Delay time, SPIENAn high after last SPICLK low (clock polarity = 1)                       | $1.5t_{c(VCLK)}$ | $2.5t_{c(VCLK)} + t_{rf(ENAn)} + 22$ |      |
| 9                | $t_{d(SCSL-SENAL)S}$ | Delay time, SPIENAn low after SPICSn low (if new data has been written to the SPI buffer) | $t_{f(ENAn)}$    | $t_{c(VCLK)} + t_{f(ENAn)} + 27$     | ns   |
| 10               | $t_{d(SCSL-SOMI)S}$  | Delay time, SOMI valid after SPICSn low (if new data has been written to the SPI buffer)  | $t_{c(VCLK)}$    | $2t_{c(VCLK)} + t_{rf(SOMI)} + 28$   | ns   |

- (1) The MASTER bit (SPIGCR1.0) is set and the CLOCK PHASE bit (SPIFMTx.16) is set.
- (2) If the SPI is in slave mode, the following must be true:  $t_{c(SPC)S} \leq (PS + 1) t_{c(VCLK)}$ , where PS = prescale value set in SPIFMTx.[15:8].
- (3) For rise and fall timings, see 表 5-6.
- (4)  $t_{c(VCLK)}$  = interface clock cycle time =  $1 / f_{(VCLK)}$
- (5) When the SPI is in Slave mode, the following must be true:  
For PS values from 1 to 255:  $t_{c(SPC)S} \geq (PS + 1)t_{c(VCLK)} \geq 40ns$ , where PS is the prescale value set in the SPIFMTx.[15:8] register bits.  
For PS values of 0:  $t_{c(SPC)S} = 2t_{c(VCLK)} \geq 40ns$ .
- (6) The active edge of the SPICLK signal referenced is controlled by the CLOCK POLARITY bit (SPIFMTx.17).

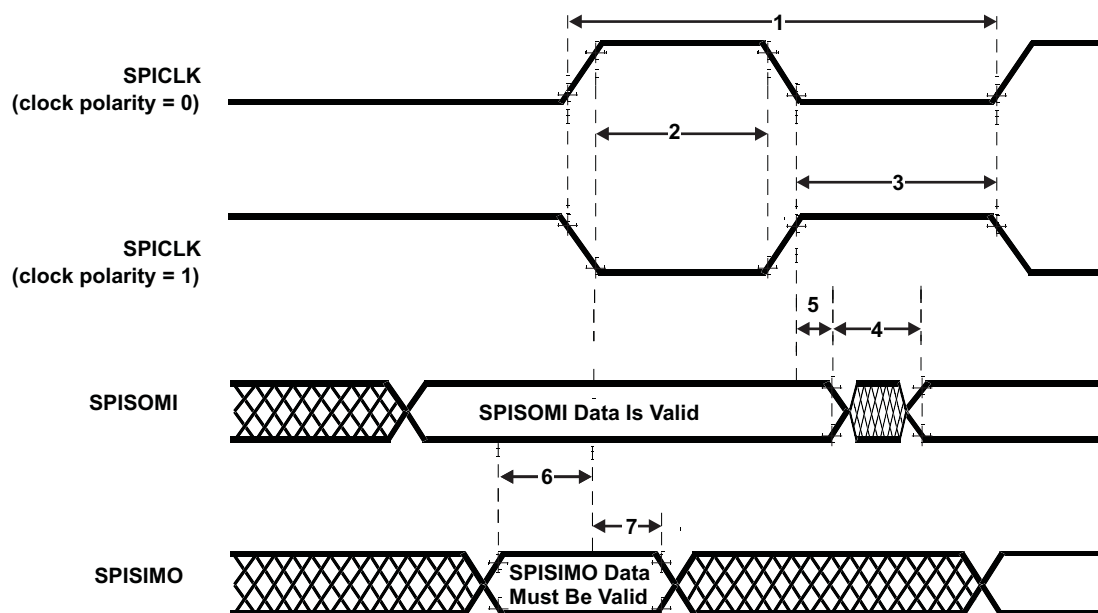


图 7-16. SPI Slave Mode External Timing (CLOCK PHASE = 1)

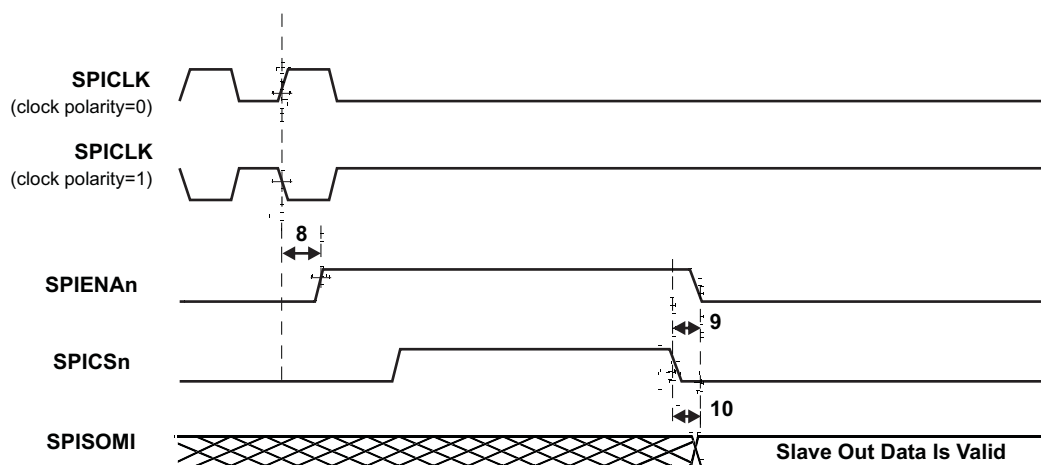


图 7-17. SPI Slave Mode Enable Timing (CLOCK PHASE = 1)

## 7.11 Ethernet Media Access Controller

The Ethernet Media Access Controller (EMAC) provides an efficient interface between the CPU and the network. The EMAC supports both 10Base-T and 100Base-TX, or 10 Mbits/second (Mbps) and 100 Mbps in either half- or full-duplex mode, with hardware flow control and quality of service (QoS) support.

The EMAC controls the flow of packet data from the device to the PHY. The MDIO module controls PHY configuration and status monitoring.

Both the EMAC and the MDIO modules interface to the device through a custom interface that allows efficient data transmission and reception. This custom interface is referred to as the EMAC control module, and is considered integral to the EMAC/MDIO peripheral. The control module is also used to multiplex and control interrupts.

### 7.11.1 Ethernet MII Electrical and Timing Specifications

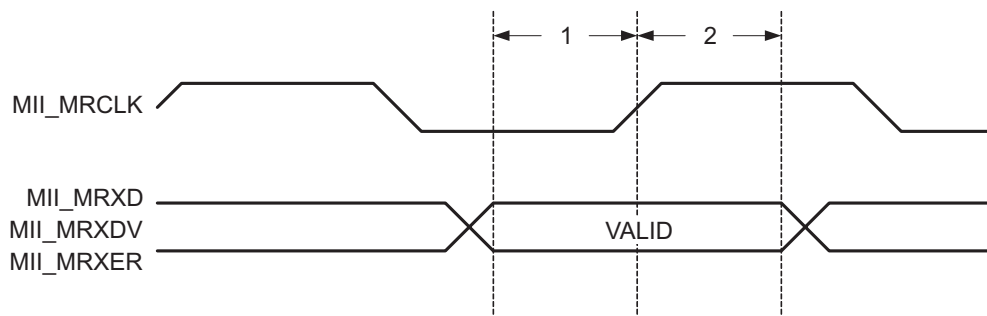


图 7-18. MII Receive Timing

表 7-28. MII Receive Timing

|                    |                                                     | MIN | MAX | UNIT |
|--------------------|-----------------------------------------------------|-----|-----|------|
| $t_{su}(MIIMRXD)$  | Setup time, MIIMRXD to MIIMRCLK rising edge         | 8   |     | ns   |
| $t_{su}(MIIMRXDV)$ | Setup time, MIIMRXDV to MIIMRCLK rising edge        | 8   |     | ns   |
| $t_{su}(MIIMRXER)$ | Setup time, MIIMRXER to MIIMRCLK rising edge        | 8   |     | ns   |
| $t_h(MIIMRXD)$     | Hold time, MIIMRXD valid after MIIRCLK rising edge  | 8   |     | ns   |
| $t_h(MIIMRXDV)$    | Hold time, MIIMRXDV valid after MIIRCLK rising edge | 8   |     | ns   |
| $t_h(MIIMRXER)$    | Hold time, MIIMRXDV valid after MIIRCLK rising edge | 8   |     | ns   |

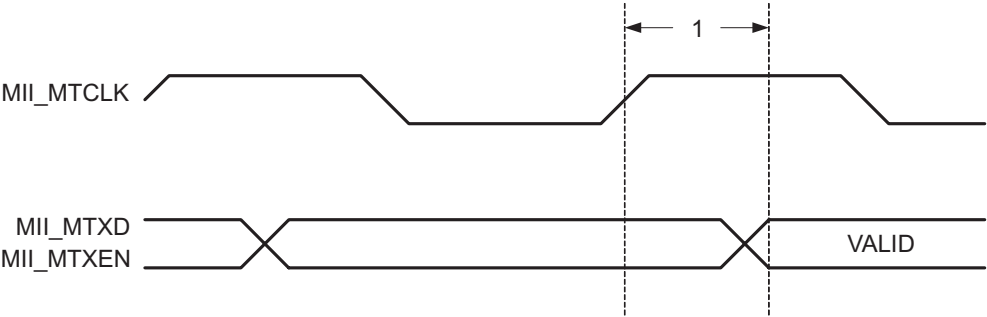


图 7-19. MII Transmit Timing

表 7-29. MII Transmit Timing

|                        |                                              | MIN | MAX | UNIT |
|------------------------|----------------------------------------------|-----|-----|------|
| $t_d(\text{MIIMTXD})$  | Delay time, MIIMTCLK rising edge to MIIMTXD  | 5   | 25  | ns   |
| $t_d(\text{MIIMTXEN})$ | Delay time, MIIMTCLK rising edge to MIIMTXEN | 5   | 25  | ns   |

### 7.11.2 Ethernet RMII Timing

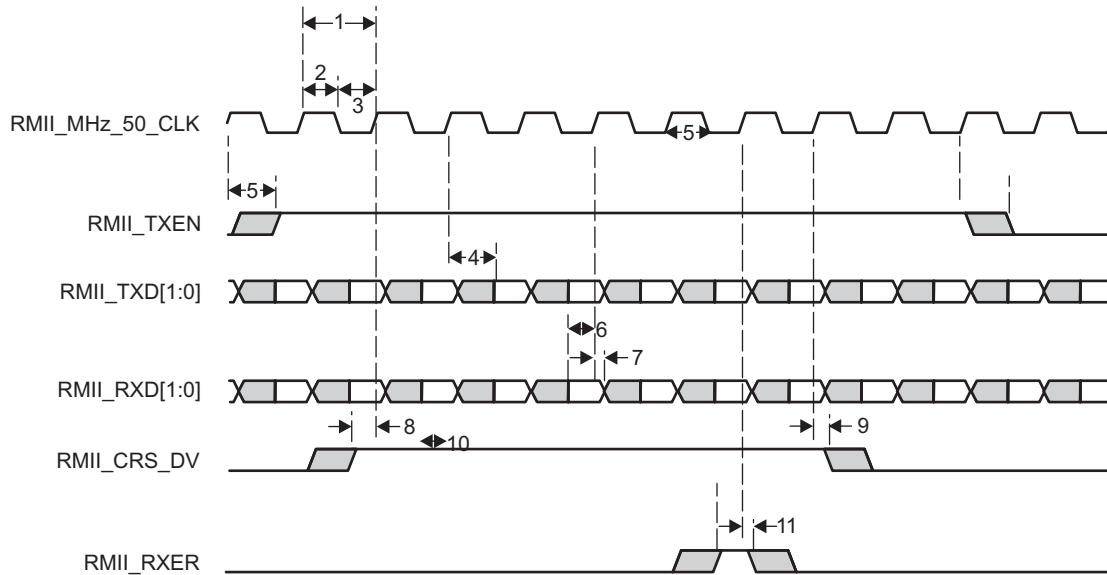


图 7-20. RMII Timing Diagram

表 7-30. RMII Timing Requirements

| NO. |                   |                                                             | MIN | NOM | MAX | UNIT |
|-----|-------------------|-------------------------------------------------------------|-----|-----|-----|------|
| 1   | tc(REFCLK)        | Cycle time, RMII_REF_CLK                                    | —   | 20  | —   | ns   |
| 2   | tw(REFCLKH)       | Pulse width, RMII_REF_CLK High                              | 7   | —   | 13  | ns   |
| 3   | tw(REFCLKL)       | Pulse width, RMII_REF_CLK Low                               | 7   | —   | 13  | ns   |
| 6   | tsu(RXD-REFCLK)   | Input setup time, RMII_RXD valid before RMII_REF_CLK High   | 4   | —   | —   | ns   |
| 7   | th(REFCLK-RXD)    | Input hold time, RMII_RXD valid after RMII_REF_CLK High     | 2   | —   | —   | ns   |
| 8   | tsu(CRSDV-REFCLK) | Input setup time, RMII_CRSDV valid before RMII_REF_CLK High | 4   | —   | —   | ns   |
| 9   | th(REFCLK-CRSDV)  | Input hold time, RMII_CRSDV valid after RMII_REF_CLK High   | 2   | —   | —   | ns   |
| 10  | tsu(RXER-REFCLK)  | Input setup time, RMII_RXER valid before RMII_REF_CLK High  | 4   | —   | —   | ns   |
| 11  | th(REFCLK-RXER)   | Input hold time, RMII_RXER valid after RMII_REF_CLK High    | 2   | —   | —   | ns   |
| 4   | td(REFCLK-TXD)    | Output delay time, RMII_REF_CLK High to RMII_TXD valid      | 2   | —   | —   | ns   |
| 5   | td(REFCLK-TXEN)   | Output delay time, RMII_REF_CLK High to RMII_TX_EN valid    | 2   | —   | —   | ns   |



### 7.11.3 Management Data Input/Output (MDIO)

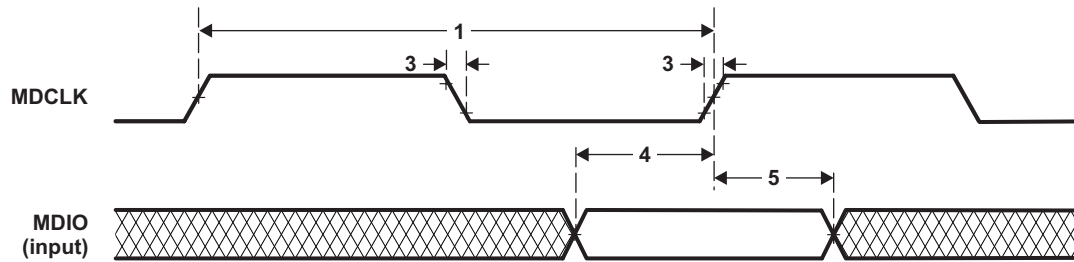


图 7-21. MDIO Input Timing

表 7-31. MDIO Input Timing Requirements

| NO. |                  |                                                     | MIN               | MAX | UNIT |
|-----|------------------|-----------------------------------------------------|-------------------|-----|------|
| 1   | tc(MDCLK)        | Cycle time, MDCLK                                   | 400               | —   | ns   |
| 2   | tw(MDCLK)        | Pulse duration, MDCLK high/low                      | 180               | —   | ns   |
| 3   | tt(MDCLK)        | Transition time, MDCLK                              | —                 | 5   | ns   |
| 4   | tsu(MDIO-MDCLKH) | Setup time, MDIO data input valid before MDCLK high | 33 <sup>(1)</sup> | —   | ns   |
| 5   | th(MDCLKH-MDIO)  | Hold time, MDIO data input valid after MDCLK high   | 10                | —   | ns   |

(1) This is a discrepancy to IEEE 802.3, but is compatible with many PHY devices.

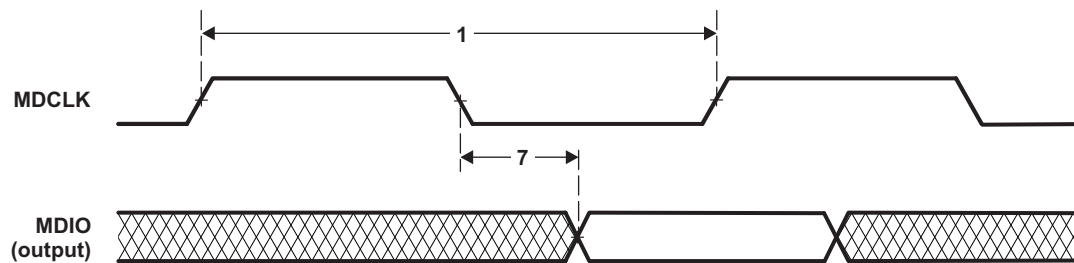


图 7-22. MDIO Output Timing

表 7-32. MDIO Output Timing Requirements

| NO. |                 |                                                 | MIN | MAX | UNIT |
|-----|-----------------|-------------------------------------------------|-----|-----|------|
| 1   | tc(MDCLK)       | Cycle time, MDCLK                               | 400 | —   | ns   |
| 7   | td(MDCLKL-MDIO) | Delay time, MDCLK low to MDIO data output valid | –7  | 100 | ns   |

## 8 Device and Documentation Support

### 8.1 Device and Development-Support Tool Nomenclature

To designate the stages in the product development cycle, TI assigns prefixes to the part numbers of all devices. Each commercial family member has one of three prefixes: TMX, TMP, or TMS (for example, **TMS570LS3137**). These prefixes represent evolutionary stages of product development from engineering prototypes (TMX) through fully qualified production devices/tools (TMS).

Device development evolutionary flow:

|            |                                                                                                                                       |
|------------|---------------------------------------------------------------------------------------------------------------------------------------|
| <b>TMX</b> | Experimental device that is not necessarily representative of the final device's electrical specifications.                           |
| <b>TMP</b> | Final silicon die that conforms to the device's electrical specifications but has not completed quality and reliability verification. |
| <b>TMS</b> | Fully-qualified production device.                                                                                                    |

TMX and TMP devices are shipped against the following disclaimer:

"Developmental product is intended for internal evaluation purposes."

TMS devices have been characterized fully, and the quality and reliability of the device have been demonstrated fully. TI's standard warranty applies.

Predictions show that prototype devices (TMX or TMP) have a greater failure rate than the standard production devices. Texas Instruments recommends that these devices not be used in any production system because their expected end-use failure rate still is undefined. Only qualified production devices are to be used.

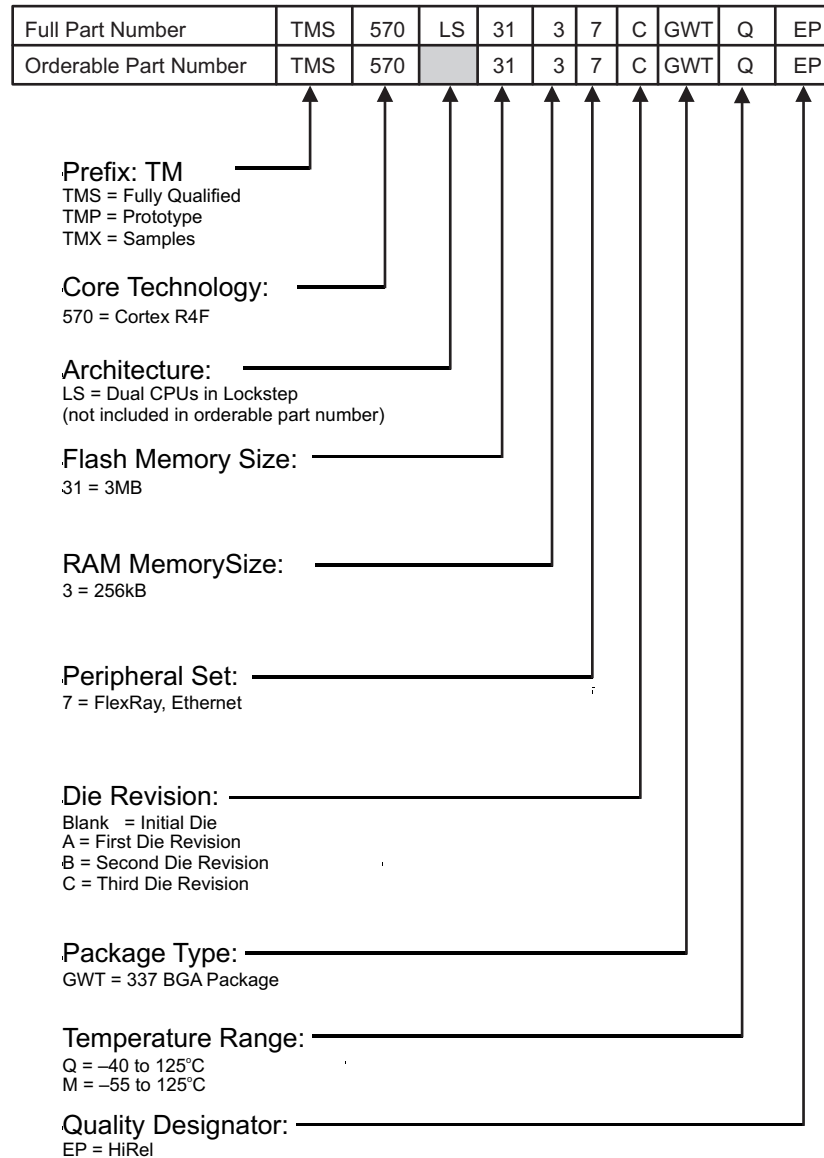


图 8-1. TMS570LS3137-EP Device Numbering Conventions

## 8.2 Documentation Support

### 8.2.1 Related Documentation from Texas Instruments

The following documents describe the TMS570LS3137-EP microcontroller.

[SPNU499](#)

*TMS570LS31x/21x 16/32-Bit RISC Flash Microcontroller Technical Reference Manual* details the integration, the environment, the functional description, and the programming models for each peripheral and subsystem in the device.

[SPNZ195](#)

*TMS570LS31x/21x Microcontroller Silicon Errata (Silicon Revision C)* describes the known exceptions to the functional specifications for the device silicon revision(s).

### 8.2.2 社区资源

下列链接提供到 TI 社区资源的连接。链接的内容由各个分销商“按照原样”提供。这些内容并不构成 TI 技术规范 and 标准且不一定反映 TI 的观点；请见 TI 的[使用条款](#)。

[TI E2E™ 在线社区](#) **TI 工程师对工程师 (E2E) 社区**。此社区的创建目的是为了促进工程师之间协作。在 e2e.ti.com 中，您可以咨询问题、共享知识、探索思路，在同领域工程师的帮助下解决问题。

[德州仪器 \(TI\) 嵌入式处理器维基网站](#) **德州仪器 (TI) 嵌入式处理器维基网站**。此网站的建立是为了帮助开发人员从德州仪器 (TI) 的嵌入式处理器入门并且也为了促进与这些器件相关的硬件和软件的总体知识的创新和增长。

## 8.3 商标

E2E is a trademark of Texas Instruments.

Cortex is a trademark of ARM Limited.

ARM is a registered trademark of ARM Limited.

All other trademarks are the property of their respective owners.

## 8.4 静电放电警告



这些装置包含有限的内置 ESD 保护。存储或装卸时，应将导线一起截短或将装置放置于导电泡棉中，以防止 MOS 门极遭受静电损伤。

## 8.5 术语表

[SLYZ022](#) — TI 术语表。

这份术语表列出并解释术语、首字母缩略词和定义。

## 8.6 Device Identification

### 8.6.1 Device Identification Code Register

The device identification code register identifies several aspects of the device including the silicon version. The details of the device identification code register are shown in 表 8-1. The device identification code register value for this device is:

- Rev A = 0x802AAD05
- Rev B = 0x802AAD15
- Rev C = 0x802AAD1D

图 8-2. Device ID Bit Allocation Register

|           |           |    |             |               |           |     |         |
|-----------|-----------|----|-------------|---------------|-----------|-----|---------|
| 31        | 30        | 29 | 28          | 27            | 26        | 25  | 24      |
| CP-15     | UNIQUE ID |    |             |               |           |     |         |
| R-1       | R-0000000 |    |             |               |           |     |         |
| 23        | 22        | 21 | 20          | 19            | 18        | 17  | 16      |
| UNIQUE ID |           |    |             |               |           |     | TECH    |
| R-0010101 |           |    |             |               |           |     | R-0     |
| 15        | 14        | 13 | 12          | 11            | 10        | 9   | 8       |
| TECH      |           |    | I/O VOLTAGE | PERIPH PARITY | FLASH ECC |     | RAM ECC |
| R-101     |           |    | R-0         | R-1           | R-10      |     | R-1     |
| 7         | 6         | 5  | 4           | 3             | 2         | 1   | 0       |
| VERSION   |           |    |             |               | 1         | 0   | 1       |
| R-00000   |           |    |             |               | R-1       | R-0 | R-1     |

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

表 8-1. Device ID Bit Allocation Register Field Descriptions

| Bit   | Field             | Value | Description                                                                                                         |
|-------|-------------------|-------|---------------------------------------------------------------------------------------------------------------------|
| 31    | CP15              | 1     | Indicates the presence of coprocessor 15<br>CP15 present                                                            |
| 30-17 | UNIQUE ID         | 10101 | Silicon version (revision) bits.<br>This bitfield holds a unique number for a dedicated device configuration (die). |
| 16-13 | TECH              | 0101  | Process technology on which the device is manufactured.<br>F021                                                     |
| 12    | I/O VOLTAGE       | 0     | I/O voltage of the device.<br>I/O are 3.3v                                                                          |
| 11    | PERIPHERAL PARITY | 1     | Peripheral Parity<br>Parity on peripheral memories                                                                  |
| 10-9  | FLASH ECC         | 10    | Flash ECC<br>Program memory with ECC                                                                                |
| 8     | RAM ECC           | 1     | Indicates if RAM memory ECC is present.<br>ECC implemented                                                          |
| 7-3   | REVISION          |       | Revision of the Device.                                                                                             |
| 2-0   | 101               |       | The platform family ID is always 0b101                                                                              |

## 8.6.2 Die Identification Registers

The four die ID registers at addresses 0xFFFFE1F0, 0xFFFFE1F4, 0xFFFFE1F8 and 0xFFFFE1FC form a 128-bit dieid with the information as shown in [表 8-2](#).

**表 8-2. Die-ID Registers**

| Item                  | Number of Bits | Bit Location                                          |
|-----------------------|----------------|-------------------------------------------------------|
| X-coordinate on wafer | 12             | 0xFFFFE1F0[11:0]                                      |
| Y-coordinate on wafer | 12             | 0xFFFFE1F0[23:12]                                     |
| Wafer number          | 8              | 0xFFFFE1F0[31:24]                                     |
| Lot number            | 24             | 0xFFFFE1F4[23:0]                                      |
| Reserved              | 72             | 0xFFFFE1F4[31:24], 0xFFFFE1F8[31:0], 0xFFFFE1FC[31:0] |

## 8.7 Module Certifications

The following communications modules have received certification of adherence to a standard.

## FlexRay™ Certifications

# FlexRay™ Protocol Conformance Certificate

**Device (IUT):**  
**Name:** TMS570LS3137 Rev C , TMS570LS3136 Rev C  
TMS570LS3135 Rev C , TMS570LS2135 Rev C  
TMS570LS2125 Rev C

**Package:** ZWT (S-PBGA-N337) Plastic Ball Grid Array

**Version:** Core Release Register: 0x10390206 (CREL[31:0])  
Device Identification Code: 0x802AAD1D (DEVID[31:0])

**Vendor:** Texas Instruments Incorporated  
12500 TI Boulevard  
Dallas, Texas 75243  
USA

**Test basis:**  
FlexRay™ protocol version: 2.1 / 2.1RevA  
Test specification version: 2.1.2

**Test execution:**  
Date: 27.04.2013  
Hour of completion: 04:37

**Test results:**  
Test cases executed: 275  
Test cases passed: 275  
Test cases failed: 0

**Test report:**  
Execution ID:  
TMP570LS3136ZWT1367030227819

Essen, 10.05.2013

Heiko Ehrich  
Digitally signed by Heiko Ehrich  
DN: cn=Heiko Ehrich, o=TÜV NORD  
Modul: Certificate, c=DE, ou=TÜV NORD  
Date: 2013.05.10 10:05:17 +0200

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TÜV NORD Mobilität GmbH & Co.KG  
Institute for Vehicle Technology and Mobility

---

**IUT-Details – According to the vendor's data sheet, the IUT has the following peculiarities and optional features:**

| Pecularity                                             | Value       | Supported/Unsupported |
|--------------------------------------------------------|-------------|-----------------------|
| MTS transmission activation adjustment time-string     | 0:x:x:0:0:0 | Unsupported           |
| MTS transmission deactivation adjustment time-string   | 0:x:x:0:0:0 | Supported             |
| MTS transmission deactivation required                 | False       | Supported             |
| clntDecoderDelay [ST]                                  | 8           | Supported             |
| cColdstartCollisionAbortDelay [µT]                     | 10          | Supported             |
| Message ID filtering impl. Via valid message indicator | False       |                       |

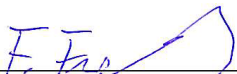
This certificate is valid for the hardware and software configuration documented in the test report.



图 8-3. Flexray Certification for GWT Package



**DCAN Certification**

|                                                                                                                                                                                                                                                                                                                                                                               |                                                                                                                                                                                                                                                                                                                                                                                                                                                               |                                                                                                                                                                                |
|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| <b>Testhouse</b><br>C&S group GmbH<br>Am Exer 19b<br>D-38302 Wolfenbuettel<br>Phone: +49 5331/90 555-0<br>Fax: +49 5331/90 555-110                                                                                                                                                                                                                                            |                                                                                                                                                                                                                                                                                                                                                                                                                                                               | <br><br> |
| <b>Authentication</b><br>on CAN Conformance                                                                                                                                                                                                                                                                                                                                   |                                                                                                                                                                                                                                                                                                                                                                                                                                                               | <b>Texas Instruments</b><br>P10_0294_021_CAN_DL_Test_Authentication_r01.doc<br>Date of Approval: 2011-Feb-08                                                                   |
| C&S is worldwide recognized as a neutral expert in testing of communication systems such as CAN Transceiver, CAN, CAN Software Drivers, (CAN) Network Management, FlexRay and LIN.<br>Herewith C&S group is proud to confirm that the followings tests on the subsequently specified device implementations have been performed by C&S resulting in the findings given below: |                                                                                                                                                                                                                                                                                                                                                                                                                                                               |                                                                                                                                                                                |
| <h2 style="text-align: center;">C&amp;S Conformance Test Results</h2>                                                                                                                                                                                                                                                                                                         |                                                                                                                                                                                                                                                                                                                                                                                                                                                               |                                                                                                                                                                                |
| <b>Manufacturer</b>                                                                                                                                                                                                                                                                                                                                                           | Texas Instruments                                                                                                                                                                                                                                                                                                                                                                                                                                             |                                                                                                                                                                                |
| <b>Component/Part Number</b>                                                                                                                                                                                                                                                                                                                                                  | TMSx70 x021 Microcontroller Family, DCAN Core Release<br>0xA3170504, 980 A2C0007940000 X470MUF C63C1<br>P80576 24 YFB-08A9X6W                                                                                                                                                                                                                                                                                                                                 |                                                                                                                                                                                |
| <b>Date of Tests</b>                                                                                                                                                                                                                                                                                                                                                          | February 2011                                                                                                                                                                                                                                                                                                                                                                                                                                                 |                                                                                                                                                                                |
| <b>Version of Test Specification</b>                                                                                                                                                                                                                                                                                                                                          | CAN Conformance Test<br>1 ISO CAN Conformance Tests according to "ISO 16845:2004 Road vehicles - Controller area network (CAN) - Conformance test plan" and C&S enhancement/ corrections according to "CAN CONFORMANCE TESTING Test Specification C&S Version 2.0 RC"<br>2 C&S Register Functionality Tests according to "C&S Register Functionality Test Specification V2.0"<br>3 C&S Robustness Tests according to "C&S Robustness Test Specification V1.4" |                                                                                                                                                                                |
| <b>Corresponding Test Report</b>                                                                                                                                                                                                                                                                                                                                              | P10_0294_020_CAN_DL_Test_report_r01                                                                                                                                                                                                                                                                                                                                                                                                                           |                                                                                                                                                                                |
| 1 ISO CAN conformance tests                                                                                                                                                                                                                                                                                                                                                   | Pass                                                                                                                                                                                                                                                                                                                                                                                                                                                          |                                                                                                                                                                                |
| 2 C&S Register Functionality tests                                                                                                                                                                                                                                                                                                                                            | Pass                                                                                                                                                                                                                                                                                                                                                                                                                                                          |                                                                                                                                                                                |
| 3 C&S Robustness tests                                                                                                                                                                                                                                                                                                                                                        | Pass                                                                                                                                                                                                                                                                                                                                                                                                                                                          |                                                                                                                                                                                |
| • Further Observations                                                                                                                                                                                                                                                                                                                                                        | None                                                                                                                                                                                                                                                                                                                                                                                                                                                          |                                                                                                                                                                                |
| <br>Frank Fischer, CTO                                                                                                                                                                                                                                                                     |                                                                                                                                                                                                                                                                                                                                                                                                                                                               | <br>Lothar Kukla, Project Manager                                                          |

Quote No. P10\_0294 R01

**图 8-4. DCAN Certification**

## **9 Mechanical, Packaging, and Orderable Information**

### **9.1 Packaging Information**

The following packaging information reflects the most current released data available for the designated device(s). This data is subject to change without notice and without revision of this document.

## PACKAGING INFORMATION

| Orderable part number             | Status<br>(1) | Material type<br>(2) | Package   Pins    | Package qty   Carrier | RoHS<br>(3) | Lead finish/<br>Ball material<br>(4) | MSL rating/<br>Peak reflow<br>(5) | Op temp (°C) | Part marking<br>(6)     |
|-----------------------------------|---------------|----------------------|-------------------|-----------------------|-------------|--------------------------------------|-----------------------------------|--------------|-------------------------|
| <a href="#">TMS5703137CGWTMEP</a> | Active        | Production           | NFBGA (GWT)   337 | 90   JEDEC TRAY (5+1) | No          | SNPB                                 | Level-3-220C-168 HR               | -55 to 125   | TMS570<br>LS3137CGWTMEP |
| <a href="#">TMS5703137CGWTQEP</a> | Active        | Production           | NFBGA (GWT)   337 | 90   JEDEC TRAY (5+1) | No          | SNPB                                 | Level-3-220C-168 HR               | -40 to 125   | TMS570<br>LS3137CGWTQEP |
| TMS5703137CGWTQEP.B               | Active        | Production           | NFBGA (GWT)   337 | 90   JEDEC TRAY (5+1) | No          | SNPB                                 | Level-3-220C-168 HR               | -55 to 125   | TMS570<br>LS3137CGWTQEP |
| <a href="#">V62/13629-01XE</a>    | Active        | Production           | NFBGA (GWT)   337 | 90   JEDEC TRAY (5+1) | No          | SNPB                                 | Level-3-220C-168 HR               | -40 to 125   | TMS570<br>LS3137CGWTQEP |
| <a href="#">V62/13629-02XE</a>    | Active        | Production           | NFBGA (GWT)   337 | 90   JEDEC TRAY (5+1) | No          | SNPB                                 | Level-3-220C-168 HR               | -55 to 125   | TMS570<br>LS3137CGWTMEP |

<sup>(1)</sup> **Status:** For more details on status, see our [product life cycle](#).

<sup>(2)</sup> **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

<sup>(3)</sup> **RoHS values:** Yes, No, RoHS Exempt. See the [TI RoHS Statement](#) for additional information and value definition.

<sup>(4)</sup> **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

<sup>(5)</sup> **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

<sup>(6)</sup> **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

**Important Information and Disclaimer:** The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

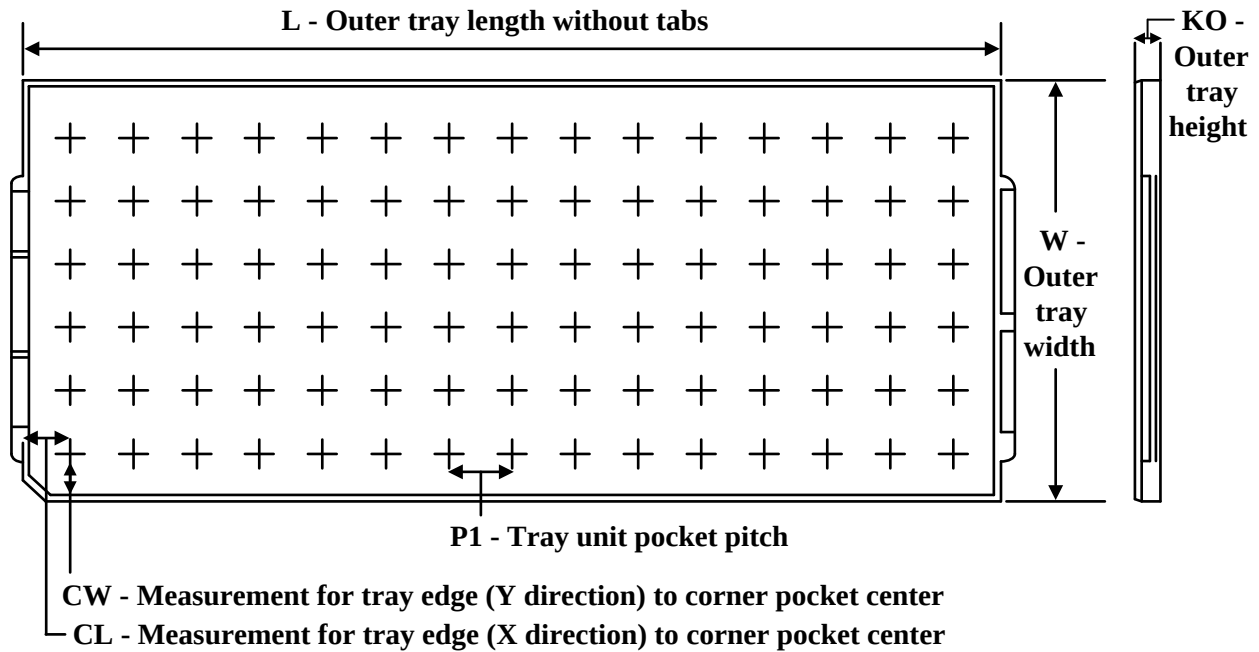
**OTHER QUALIFIED VERSIONS OF TMS570LS3137-EP :**

- Catalog : [TMS570LS3137](#)

NOTE: Qualified Version Definitions:

- Catalog - TI's standard catalog product

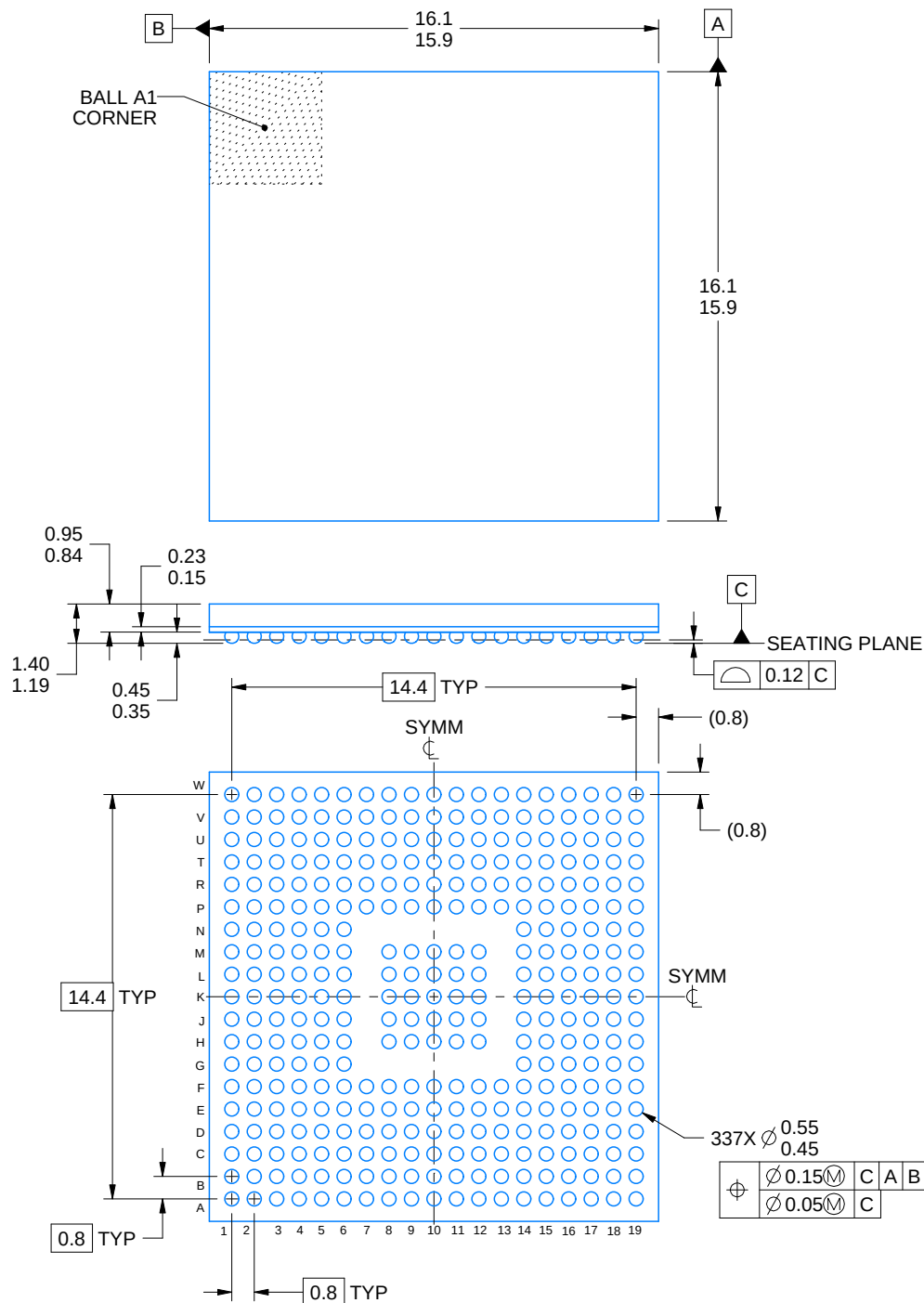
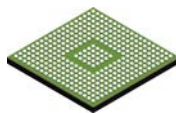
## TRAY



Chamfer on Tray corner indicates Pin 1 orientation of packed units.

\*All dimensions are nominal

| Device              | Package Name | Package Type | Pins | SPQ | Unit array matrix | Max temperature (°C) | L (mm) | W (mm) | K0 (µm) | P1 (mm) | CL (mm) | CW (mm) |
|---------------------|--------------|--------------|------|-----|-------------------|----------------------|--------|--------|---------|---------|---------|---------|
| TMS5703137CGWTMEP   | GWT          | NFBGA        | 337  | 90  | 6 X 15            | 150                  | 315    | 135.9  | 7620    | 20      | 17.5    | 15.45   |
| TMS5703137CGWTQEP   | GWT          | NFBGA        | 337  | 90  | 6 X 15            | 150                  | 315    | 135.9  | 7620    | 20      | 17.5    | 15.45   |
| TMS5703137CGWTQEP.B | GWT          | NFBGA        | 337  | 90  | 6 X 15            | 150                  | 315    | 135.9  | 7620    | 20      | 17.5    | 15.45   |
| V62/13629-01XE      | GWT          | NFBGA        | 337  | 90  | 6 X 15            | 150                  | 315    | 135.9  | 7620    | 20      | 17.5    | 15.45   |
| V62/13629-02XE      | GWT          | NFBGA        | 337  | 90  | 6 X 15            | 150                  | 315    | 135.9  | 7620    | 20      | 17.5    | 15.45   |



4229175/A 11/2022

## NOTES:

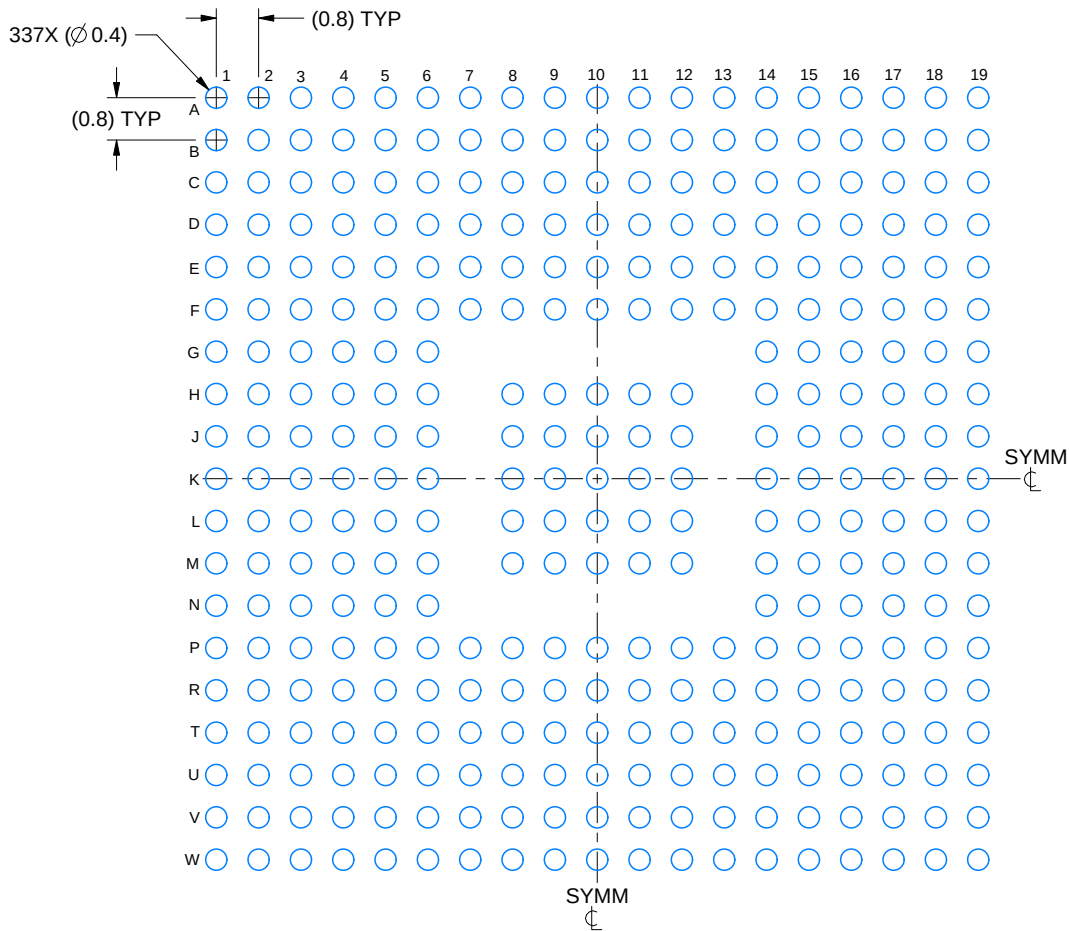
1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.

# EXAMPLE BOARD LAYOUT

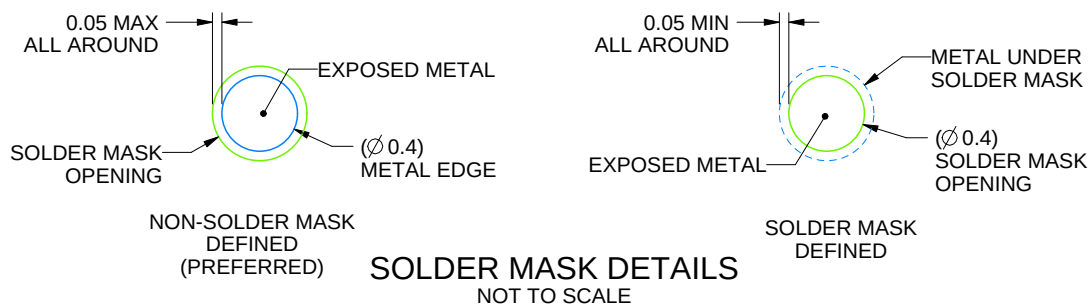
GWT0337A

NFBGA - 1.4 mm max height

PLASTIC BALL GRID ARRAY



**LAND PATTERN EXAMPLE**  
EXPOSED METAL SHOWN  
SCALE: 7X



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NOTES: (continued)

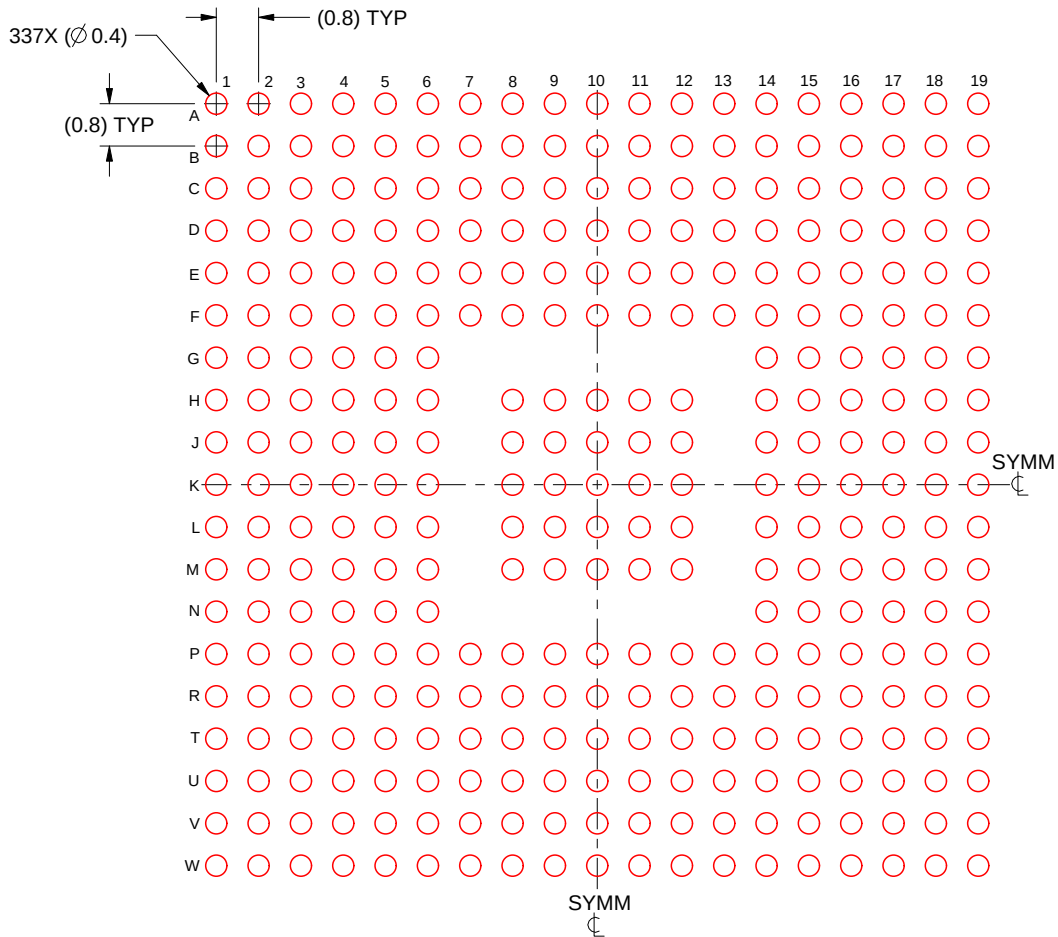
- Final dimensions may vary due to manufacturing tolerance considerations and also routing constraints. For information, see Texas Instruments literature number SPRAA99 ([www.ti.com/lit/spraa99](http://www.ti.com/lit/spraa99)).

# EXAMPLE STENCIL DESIGN

GWT0337A

NFBGA - 1.4 mm max height

PLASTIC BALL GRID ARRAY



**SOLDER PASTE EXAMPLE**  
BASED ON 0.150 mm THICK STENCIL  
SCALE: 7X

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NOTES: (continued)

4. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release.



## 重要通知和免责声明

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